# DATA BOOK **MICROPROCESSOR**



OKI

### DATA BOOK 1990/1991

CMOS MICROPROCESSOR LINE-UP

SYSTEM CONFIGURATION

PACKAGING



RELIABILITY INFORMATION

DATA SHEETS



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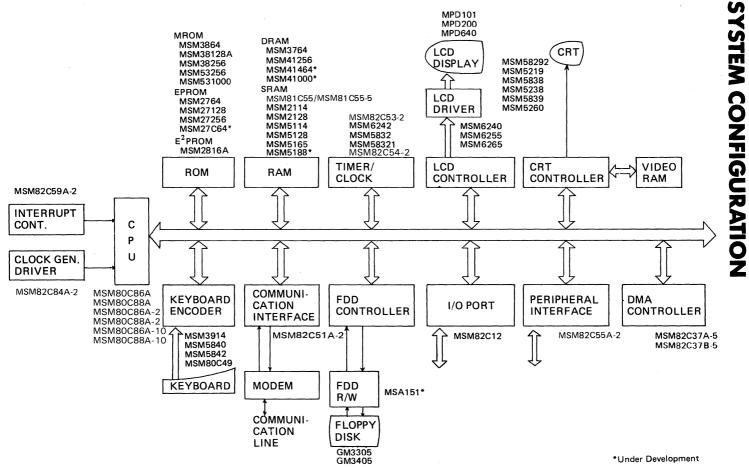
# CMOS MICROPROCESSOR LINE - UP

### CMOS MICROPROCESSOR LINE - UP

		POWER SUPPLY				COMPATIBILITY		
PRODUCTS	PART NAME	VOLTAGE	CURRENT (MAX)	PACKAGE	REMARKS	SUPPLIER	TYPE	
8 BIT CPU	MSM80C85A	5V	22mA	40 DIP 44 FLAT 44 PLCC	8 BIT MICROPROCESSOR 3 MHz	intel	8085A	
	MSM80C85A-2 MSM80C85AH	5V	20mA	40 DIP 44 FLAT 44 PLCC	8 BIT MICROPROCESSOR 5 MHz	Intel	8085A-2	
	MSM80C86A		55mA		16 BIT MICROPROCESSOR 5 MHz	Intel	8086	
16 BIT CPU	MSM80C86A-2	5V	80m A	40 DIP 56 FLAT 44 PLCC	8 MHz	Intel	8086-2	
	MSM80C86A-10		100mA		10 MHz			
	MSM80C88A		55mA		8 BIT MICROPROCESSOR 5 MHz	Intel	8088	
8 BIT CPU	MSM80C88A-2	5V	80mA	40 DIP 56 FLAT 40 PLCC	8 MHz	Intel	8088-2	
	MSM80C88A-10		100mA		5 MHz			
	MSM81C55 MSM81C55-5 MSM81C55H	5V	5mA	40 DIP 44 FLAT 44 PLCC		Intel	8155	
	MSM82C12	5V	1mA	24 DIP 24 FLAT	8 BIT INPUT/OUTPUT PORT	Intel	8212	
	MSM82C37A-5 MSM82C37B-5	5V	10mA	40 DIP 44 FLAT 44 PLCC		Intel	8237A	
	MSM82C43	5V	1mA	24 DIP 24 FLAT			8243	
	MSM82C51A-2	5V	5mA	28 DIP 32 FLAT 28 PLCC	PROGRAMMABLE COMMUNICA- TIONS INTERFACE	Intel	8251A	
	MSM82C53-2	5V	8mA	24 DIP 32 FLAT 28 PLCC	32 FLAT		8253	
	MSM82C54-2	5V	10mA	24 DIP 32 FLAT 28 PLCC PROGRAMMABLE COUNTER		Intel	8254	
I/O	MSM82C55A-2	5V	8mA	40 DIP 44 FLAT 44 PLCC *1	PROGRAMMABLE PERIPHERAL INTERFACE	Intel	8255	
	MSM82C59A-2	5V	5mA	28 DIP 32 FLAT 28 PLCC	PROGRAMMABLE INTERRUPT CONTROLLER	Intel	8259A-2	
	MSM82C84A-2	5∨	16mA	18 DIP 24 FLAT 20 PLCC	CLOCK GENERATOR and DRIVER (8MHz)	Intel	8284A	
	MSM82C88-2	5V	10m A	20 DIP 24 FLAT 20 PLCC	BUS CONTROLLER	Intel	8288	
	MSM5832	5V	0.1mA	18 DIP	REAL TIME CLOCK			
PERI-	MSM58321	5∨	0.1mA	16 DIP	REAL TIME CLOCK			
8 BIT CPU	MSM6242	5V	10µA	18 DIP 24 FLAT	REAL TIME CLOCK DIRECT BUS CONNECTED			

NOTE: MSM80C85AH and MSM81C55H are under development.

# SYSTEM CONFIGURATION



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# PACKAGING

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### PACKAGING

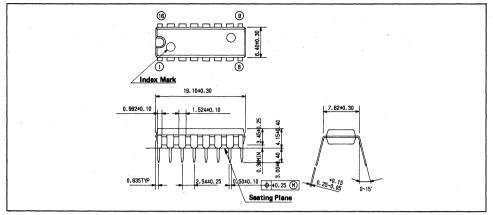
PRO-	PART NAME	PACKA	AGE/PIN C	OUNT
DUCTS	PARTNAME	DIP	QFP/SOP	PLCC
	M80C85A (Note: 1)	40	44	44
	M80C85A-2	40	44	44
	M80C86A	40	56 (L)	44
MPU	M80C86A-2/80C86A-10	40	56 (L)	44
	M80C88A	40	56 (L)	44
	M80C88A-2/80C88A-10	40	56 (L)	44
	M81C55/81C55-5	40	44	44
	M82C12	24	24	_
	M82C37A-5/M82C37B-5	40	44	44
	M82C43	24	24	
	M82C51A-2	28	32	28
1/0	M82C53-2	24	32	28
	M82C54-2	24	32	28
	M82C55A-2	40	44	44
	M82C59A-2	28	32	28
	M82C84A-2	18	24	20
	M82C88-2	20	24	20
PERI-	M5832	18		
PHER-	M58321	16	_	
ALS	M6242	18	24	-

Note: 1. Model numbers suffixed by RS denote plastic DIP, while GS denotes plastic QFP/SOP, and JS denote PLCC. Ex. MSM80C85ARS ..... plastic DIP

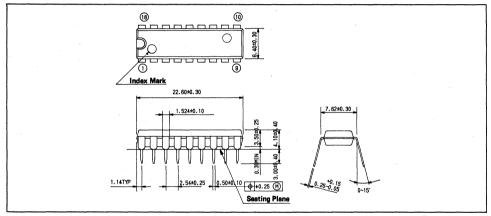
MSM80C85AGS	plastic QFP/SOP
MSM80C85AJS	PLCC

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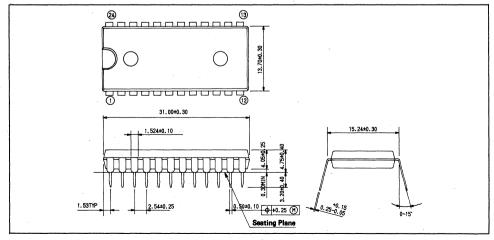
#### •16 PIN PLASTIC DIP DIP16-P-300



#### •18 PIN PLASTIC DIP DIP18-P-300

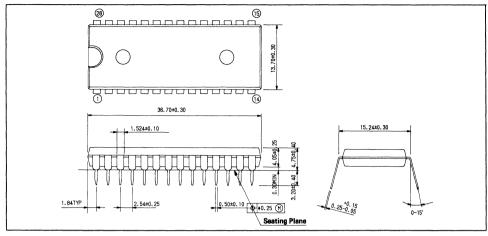


#### •24 PIN PLASTIC DIP DIP24-P-600

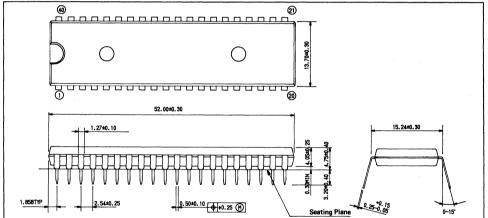


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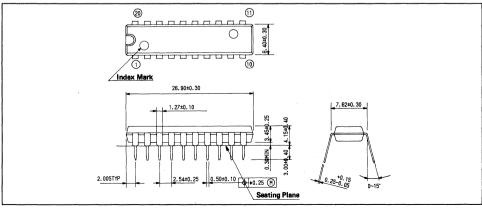
•28 PIN PLASTIC DIP DIP-P-600



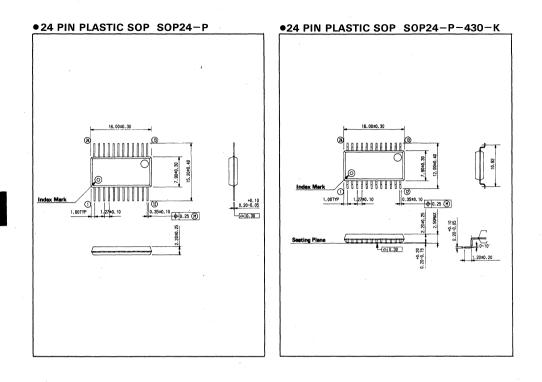
•40 PIN PLASTIC DIP DIP40-P-600



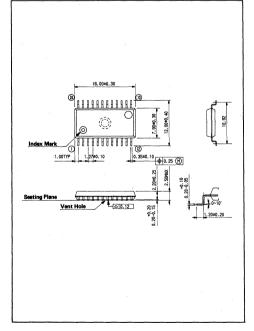
• 20 PIN PLASTIC SKINNY DIP DIP20-P-300-S1



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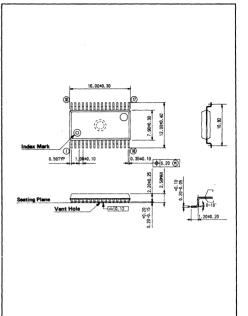


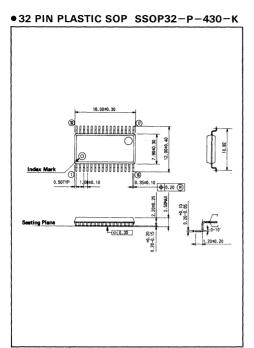
#### •24 PIN-V PLASTIC SOP SOP24-P-430-VK



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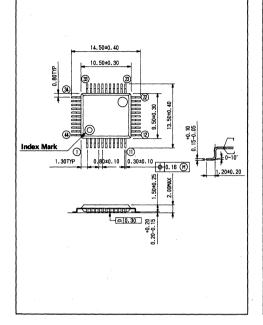
•32 PIN-V PLASTIC SOP SSOP32-P-430-VK



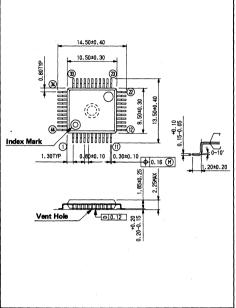


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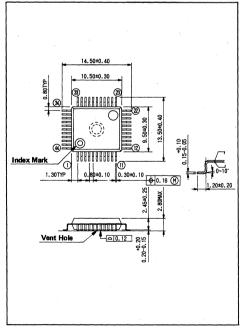
•44 PIN PLASTIC QFP QFP44-P-910-K



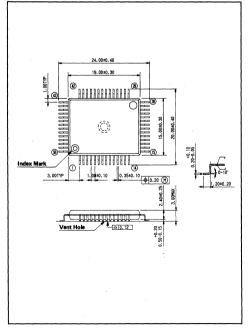
●44 PIN-V PLASTIC QFP QFP44-P-910-VK



●44 PIN-V1 PLASTIC QFP QFP44-P-910-VIK

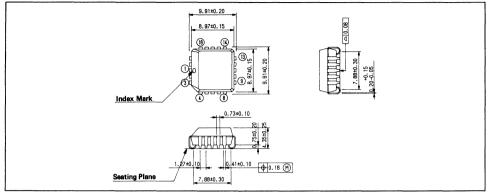


•56 PIN(L)-V PLASTIC QFP QFP56-P-1519-VK

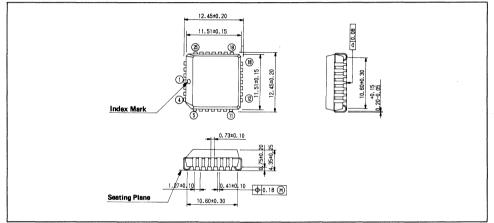


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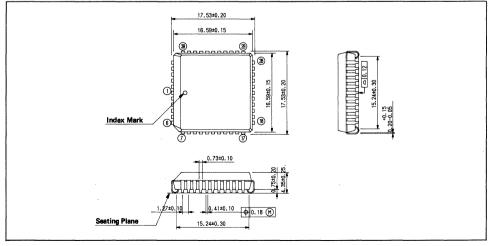
#### •20 PIN PLCC QFJ20-P-S350



#### •28 PIN PLCC QFJ28-P-S450



#### •44 PIN PLCC QFJ44-P-S650





## **RELIABILITY INFORMATION**

### RELIABILITY INFORMATION

#### **1. INTRODUCTION**

Semiconductor devices play a leading role in the explosive progress of semiconductor technology. They use some of the most advanced design and manufacturing technology developed to date. With greater integration, diversity and reliability, their applications have expanded enormously. Their use in large scale computers, control equipment, calculators, electronic games and in many other fields has increased at a fast rate.

A failure in electronic banking or telephone switching equipment, for example, could have far reaching effects and can cause incalculable losses. So, the demand, for stable high quality memory devices is strong.

We, at Oki are fully aware of this demand. So we have adopted a comprehensive quality assurance system based on the concept of consistency in development, manufacturing and sales.

With the increasing demand for improvement in function, capability and reliability, we will expand our efforts in the future. Our quality assurance system and the underlying concepts are outlined briefy below.

#### 2. QUALITY ASSURANCE SYSTEM AND UNDERLYING CONCEPTS

The quality assurance system employed by Oki can be divided into four major stages: device planning, developmental prototype, production prototype, and mass production. This system is outlined in the following block diagram (Fig. 1).

#### 1) Device planning stage

To manufacture devices that meet market demands and satisfy customer needs, we carefully consider functional and failure rate requirements, utilization form, environment and other conditions. Once we determine the proper type, material and structure, we check the design and manufacturing techniques, and the line processing capacity. Then we prepare the development planning and time schedule.

#### 2) Developmental prototype stage

We determine circuits, pattern design, process settings, assembly techniques and structural requirements during this stage. At the same time, we carry out actual prototype reliability testing. Since device quality is largely determined during

the designing stage, Oki pays careful attention to quality confirmation during this stage.

This is how we do it:

(1) After completion of circuit design (or pattern design), personnel from the design, process technology, production technology, installation technology and reliability departments get together for a thorough review to ensure design quality and to anticipate problems that may occur during mass production. Past experience and know-how guide these discussions.

- (2) Since many semiconductor memories involve new concepts and employ high level manufacturing technology, the TEG evaluation test is often used during this stage.
  - Note: TEG (Test Element Group) refers to the device group designed for stability evaluation of MOS transistors, diodes, resistors, capacitors and other circuit component element used in LSI memories.
- (3) Prototypes are subjected to repeated reliability and other special evaluation tests. In addition, the stability and capacity of the manufacturing process are checked.

#### 3) Production prototype stage

During this stage, various tests check the reliability and other special features of the production prototype at the mass production factory level. After confirming the quality of a device, we prepare the various standards required for mass production, and then start production. Although reliability and other special tests performed on the production prototype are much the same as those performed on the developmental prototype, the personnel, facilities and production site differ for the two prototypes, necessitating repeated confirmation tests.

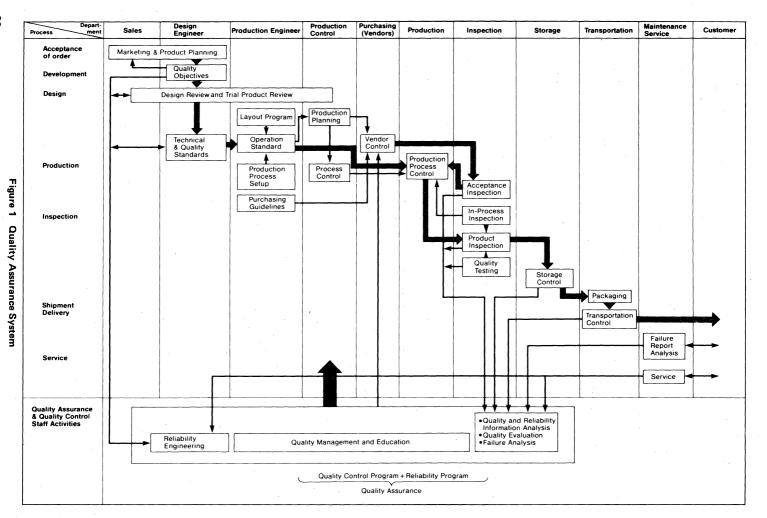
#### 4) Mass production

During the mass production stage, careful management of purchased materials, parts and facilities used during the manufacturing process, measuring equipment, manufacturing conditions and environment is necessary to ensure device quality first stipulated during the designing stages. The manufacturing process (including inspection of the completed device) is followed by a lot guarantee inspection to check that the specified quality is maintained under conditions identical to those under which a customer would actually use the device. This lot guarantee inspection is performed in three different forms as shown below.

- (1) Group A tests: appearance, labels, dimensions and electrical characteristics inspection
- (2) Group B tests: check of durability under thermal and mechanical environmental stresses, and operating life characteristics
- (3) Group C tests: performed periodically to check operational life, etc., on a long term basis.
- Note: Like the reliability tests, the group B tests conform to the following standards. MIL-STD-883B, JIS C 7022, EIAJ-IC-121



**RELIABILITY INFORMATION** 



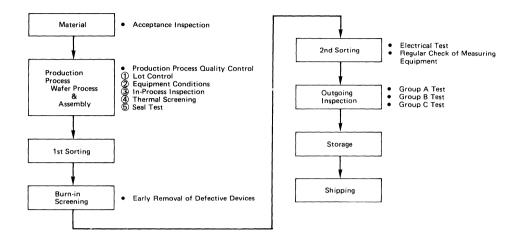


Figure 2 Manufacturing Process

Devices which pass these lot guarantee inspections are stored in a warehouse awaiting shipment to customers. Standards are also set up for handling, storage and transportation during this period, thereby ensuring quality prior to delivery. Figure 2 shows the manufacturing flow of the completed device. 5) At Oki, all devices are subjected to thorough quality checks. If, by chance, a failure does occur after delivery to the customer, defective devices are processed and the problem rectified immediately to minimize the inconvenience to the customer in accordance with the following flowchart.

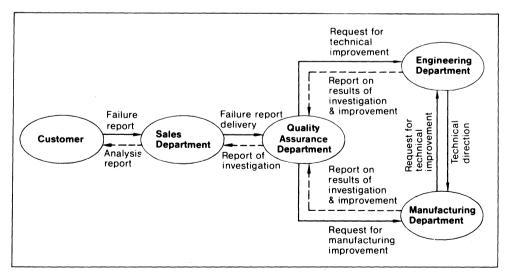
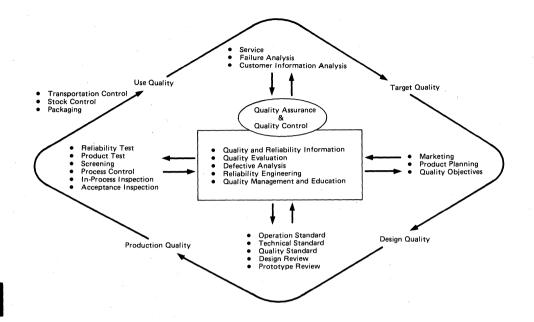


Figure 3 Failure report process

#### **RELIABILITY INFORMATION**



#### 3. EXAMPLE OF RELIABILITY TEST RESULTS

We have outlined the quality assurance system and the underlying concepts employed by Oki. Now, we will give a few examples of the reliability tests performed during the developmental and production prototype stages. All reliability tests performed by Oki conform to the following standards.

MIL-STD-883B, JIS C 7022, EIAJ-IC-121

Since these reliability tests must determine performance under actual working conditions in a short period of time, they are performed under severe test conditions. For example, the 125°C high temperature continuous operation test performed for 1000 hours is equivalent to testing device life from 2 to 300 years of use at Ta =  $40^{\circ}$ C.

By repeating these accelerated reliability tests, device quality is checked and defects analyzed. The resulting information is extremely useful in improving the manufacturing processes. Some of the more common defects in LSI elements and their analysis are described on next page.

	Part name	MSM	80C85/	A-2RS	MSI	M81C5	5RS	MSM	82C59/	A-2RS	
Function		8 BIT MICROPROCESSOR		2048 BIT CMOS STATIC RAM WITH I/O PORTS & TIMER			PROGRAMMABLE INTERRUPT CONTROLLER			Referred standard	
Test item	Test condition	Sample size (pcs)	Test hours or cycles	Failures	size (pcs)	Test hours & cycles		size (pcs)	Test hours & cycles	Failures	
Operating life test	Ta = 125°C Vcc = 6V	88	2000 (H)	0	22	2000 (H)	0	88	2000 (H)	0	MIL- STD-883C METHOD 1006
Temperature humidity test		100	2000 (H)	0	25	2000 (H)	0	100	2000 (H)	0	
Temperature cycling test	− 55°C <b>≓RT</b> ≓150°C (30 min) ↑ (30 min) (5 min)	100	500 (cy)	0	50	300 (cy)	0	100	500 (cy)	0	MIL-STD- 883C METHOD 1010
Pressure cooker test	Ta = 121°C RH = 100% 2 atm	50	200 (H)	0	50	200 (H)	0	50	200 (H)	0	

#### MICROPROCESSOR LIFE TEST RESULTS

	Part name	MSM8	88AJS		
	MICRC (STAT	Referred standard			
Test item	Test condition	Sample size (pcs)	Test hours & cycles	Failures	
Operating life test	Ta = 125°C Vcc = 6V	88	1000 (H)	0	MIL- STD-883C METHOD 1005
Temperature humidity test		100	1000 (H)	0	
Temperature cycling test	−55°C≓RT≓150°C (30 min) ↑ (30 min) (5 min)	100	500 (cy)	0	MIL-STD- 883C METHOD 1010
Pressure cooker test	Ta = 121°C RH = 100% 2 atm	50	200 (H)	0	

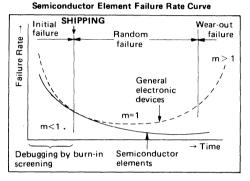
		Part name	MSM80C	85A-2RS	MSM81	C55RS	MSM82C	59A-2RS	
Function			8 BIT MICROPROCESSOR		2048 BIT CMOS STATIC RAM WITH I/O PORTS & TIMER		PROGRAMMABLE INTERRUPT CONTROLLER		Referred standard
Tes iten		Test condition	Sample size (pcs)	Failures	Sample size (pcs)	Failures	Sample size (pcs)	Failures	
PRE-	Bake	Bake (125°C, 6 hrs)	22	0	22	0	22	0	—
Solde Heat		260°C 10 SEC	22	0	22	0	22	0	MIL- STD-8830 METHOD 2003
	erature ng Test	– 55°C≓RT≓ 150°C (30min) (5min) (30min) 20 cycles	22	0	22	0	22	0	MIL- STD-883 METHOI 1010
The Sho Test		100°C <b>≓0°C</b> (5min) (5min) 10 cycles	22	0	22	0	22	0	MIL- STD-883 METHOI 1011
Lead Integrity	Tensile	500 g 10SEC	11	0	11	0	11	0	MIL- STD883
	Bending	250 g 90° BEND 3 TIMES							METHO 2004
Solde	erability	230°C 5 SEC	22	0	22	0	22	0	MIL STD883 METHO 2003

#### MICROPROCESSOR ENVIRONMENTAL TEST RESULTS

		Part name	MSM80C	36A/88AJS	
		Function	16 MICROPR (STATIC	Referred standard	
	Test item	i i i i i i i i i i i i i i i i i i i		Failures	
est	PRE-Bake	Bake (125°C, 6 hrs)	4		—
Environmental Test	◆ Soldering Heat Test	Vapor Phase Reflow (215±2°C,90+10,-0sec) 2 times	•		
Thermal Envir	Temperature Cycling Test	– 55°C ≓ RT ≓ 150°C (30min) (5min) (30min) 20 cycles	22	0	MIL- STD-883C METHOD 1010
	Thermal Shock Test	100°C <b>⇔0°C</b> (5min) (5min) 10 cycles			MIL- STD-883C METHOD 1011
Other Test	Solderability	<ul> <li>→ Bake (125°C, 24hrs)</li> <li>→ Immerse into Flux</li> <li>→ Immerse into Solder (215±2°C 10±1sec)</li> </ul>	22	0	

#### 4. SEMICONDUCTOR MEMORY FAILURES

The life-span characteristics of semiconductor elements in general (not only semiconductor IC devices) is described by the curve shown in the diagram below. Although semiconductor memory failures are similar to those of ordinary integrated circuits, the degree of integration (miniaturization), manufacturing complexity and other circuit element factors influence their incidence.



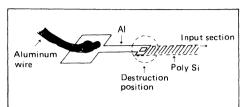
#### 1) Surge Destruction

This is destruction of the input/output stage circuits by external surge currents or static electricity. The accompanying photograph shows a point of contact between aluminum and polysilicon that has been dissolved by a surge current. A hole has formed in the substrate silicon, leading to a short circuit. This kind of failure is traceable in about 30% of defective devices returned to the manufacturer. Despite miniaturization of semiconductor memory component elements (which means the elements themselves are less resistant), these failures usually occur during assembly and other handling operations. At Oki, all devices are subjected to static electricity intensity tests (under simulated operation



Example of surge destruction

al conditions) in the development stage to reduce this type of failure. In addition to checking endurance against surge currents, special protective circuits are incorporated in the input and output sections.



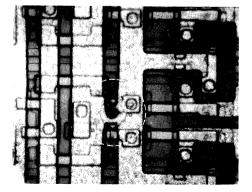
#### 2) Oxide Film Insulation Destruction (Pin Holes)

Unlike surge destruction, this kind of failure is caused by manufacturing defects. Local weakened sections are ruptured when subjected to external electrical stress. Although this problem is accentuated by the miniaturization of circuit elements, it can be resolved by maintaining an ultra-clean manufacturing environment and through 100% burn-in screening.

3) Surface Deterioration due to lonic Impurities Under some temperature and electric field conditions, charged ionic impurities moving within the oxide film previously resulted in occasional deterioration of silicon surfaces. This problem has been eliminated by new surface stabilization techniques.

#### 4) Photolithographic Defects

Integrated circuits are formed by repeated photographic etching processes. Dust and scratches on the mask (which corresponds to a photographic negative) can cause catastrophic defects. At present, component elements have been reduced in size to the order of 10 cm through miniaturization. However, the size of dust and scratches stays the same. At Oki, a high degree of automation, minimizing human intervention in the process, and unparalleled cleanliness, solves this problem.



Photolithographic Defect

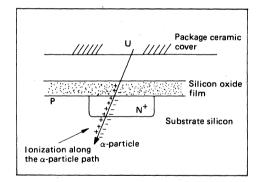
#### ■ RELIABILITY INFORMATION ■

#### 5) Aluminum Corrosion

Aluminum corrosion is due to electrolytic reactions caused by the presence of water and minute impurities. When aluminum dissolves, lines break. This problem is unique to the plastic capsules now used widely to reduce costs. Oki has carefully studied the possible cause and effect relationship between structure and manufacturing conditions on the one hand, and the generation of aluminum corrosion on the other. Refinements incorporated in Oki LSIs permit superior endurance to even the most severe high humidity conditions.

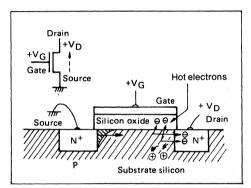
#### 6) Alpha-Particle Soft Failure

This problem occurs when devices are highly miniaturized, such as in 1 megabit RAMs. The inversion of memory cell data by alpha-particle generated by radio-active elements like uranium and thorium (present in minute quantities, measured in ppb) in the ceramic package material causes defects. Since failure is only temporary and normal operation restored quickly, this is referred to as a "soft" failure. At Oki we have eliminated the problem by coating the chip surface of 1 megabit RAMs with a resin which effectively screens out these alpha-particles.



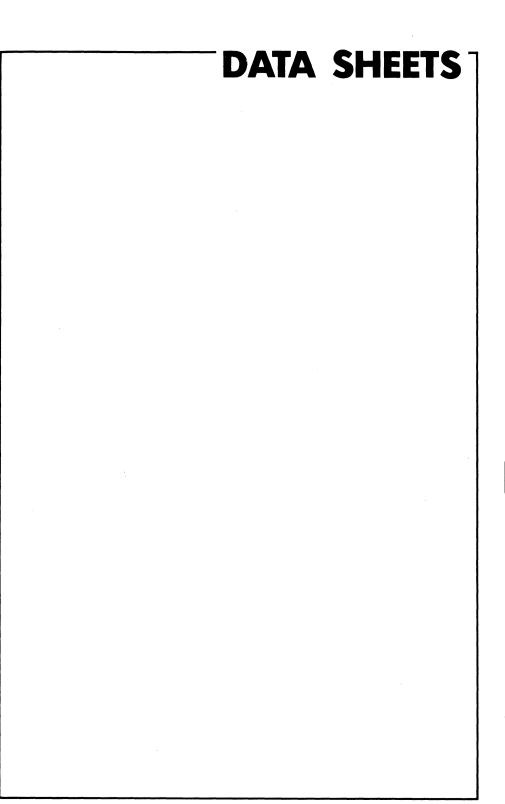
#### 7) Degradation in Performance Characteristics Due to Hot Electrons

With increased miniaturization of circuit elements, internal electric field strength in the channels increases since the applied voltage remains the same at 5V. As a result, electrons flowing in the channels, as shown in the accompanying diagram, tend to enter into the oxide film near the drain, leading to degradation of performance. Although previous low-temperature operation tests have indicated an increase of this failure, we have confirmed by our low-temperature acceleration tests, including checks on test element groups, that no such problem exists in Oki LSIs.

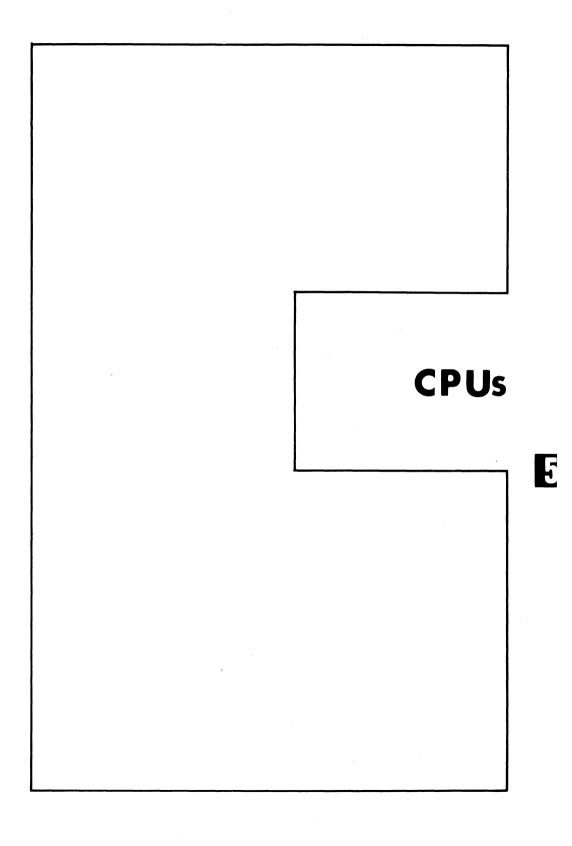




With further progress in the miniaturization of circuit components, failures related to pin hole oxide film destruction and photolithography have increased. To eliminate these defects during manufacturing, Oki has been continually improving its production processes based on reliability tests and information gained from the field. And we subject all devices to high-temperature burnin screening for 48 to 96 hours to ensure even greater reliability.



E



# **OKI** semiconductor MSM80C85A RS/GS/JS

8-BIT CMOS MICROPROCESSOR

# **GENERAL DESCRIPTION**

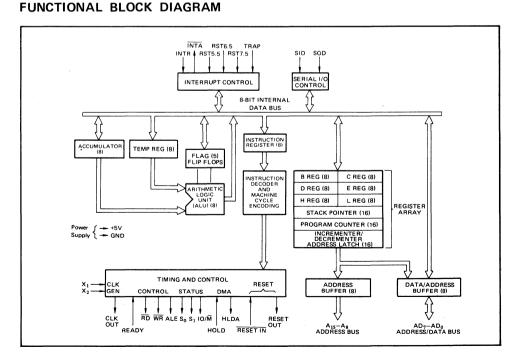
The MSM80C85A is a complete 8-bit parallel central processor implemented in silicon gate C-MOS technology. It is designed with the same processing speed and lower power consumption compared with MSM8085A, thereby offering a high level of system integration.

The MSM80C85A uses a multiplexed address/data bus. The address is split between the 8-bit address bus and the 8-bit data bus. The on-chip address latches of MSM81C55/MSM83C55 memory products allow a direct interface with the MSM80C85A.

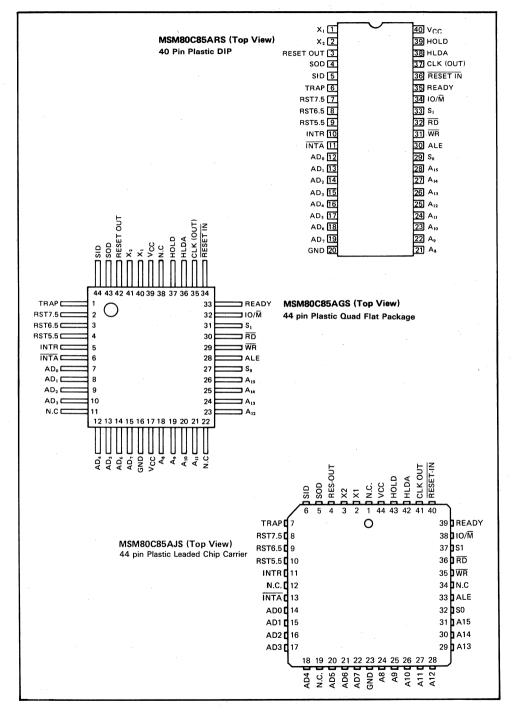
# FEATURES

- Low Power Dissipation: 50 mW Typ
- Single +4 to +6 V Power Supply
- -40 to +85°C, Operating Temperature
- 1.3µ Instruction Cycle
- On-Chip Clock Generator (with External Crystal)
- On-Chip System Controller; Advanced Cycle Status Information Available for Large System Control
- TTL Compatible

- Four Vectored Interrupt Inputs (One is non-maskable) Plus the 8080A-compatible interrupt.
- Serial In/Serial Out Port
- Decimal, Binary and Double Precision Arithmetic
- 40pin Plastic DIP (DIP40-P-600)
- 44pin PLCC (QFJ44-P-S650)
- 44pin Plastic QFP (QFP44-P-910-K)
- 44pin-V Plastic QFP (QFP 44-P-910-VK)



# **PIN CONFIGURATION**



# MSM80C85A FUNCTIONAL PIN DEFINITION

The following describes the function of each pin:

Symbol	Function						
A <sub>8</sub> -A <sub>15</sub>	Address Bus: The most significant 8-bits of the memory address or the 8-bits of the I/O						
(Output, 3-state)	address, 3-stated during Hold and Halt modes and during RESET.						
AD <sub>0</sub> -AD <sub>7</sub> (Input/Output) 3-state	Multiplexed Address/Data Bus: Lower 8-bits of the memory address (or I/O address) appear on the bus during the first clock cycle (T state) of a machine cycle. It then becomes the data bus during the second and third clock cycles.						
ALE (Output)	Address Latch Enable: It occurs during the first clock state of a machine cycle and enables the address to get latched into the on-chip latch of peripherals. The falling edge of ALE is set to guarantee setup and hold times for the address information. The falling edge of ALE can also be used to strobe the status information. ALE is never 3-stated.						
S <sub>0</sub> , S <sub>1</sub> , IO/M (Output)	$\begin{array}{c c c c c c c c c c c c c c c c c c c $						
RD (Output, 3-state)	READ control: A low level on $\overline{\text{RD}}$ indicates the selected memory or I/O device is to be read and that the Data Bus is available for the data transfer, 3-stated during Hold and Halt modes and during RESET.						
WR (Output, 3-state)	WRITE control: A low level on $\overline{WR}$ indicates the data on the Data Bus is to be written into the selected memory or I/O location. Data is set up at the trailing edge of WR, 3-stated during Hold and Halt modes and during RESET.						
READY (Input)	If READY is high during a read or write cycle, it indicates that the memory or peripheral is ready to send or receive data. If READY is low, the cpu will wait an integral number of clock cycles for READY to go high before completing the read or write cycle. READY must conform to specified setup and hold times.						
HOLD (Input)	HOLD indicates that another master is requesting the use of the address and data buses. The cpu, upon receiving the hold request, will relinquish the use of the bus as soon as the completion of the current bus transfer. Internal processing can continue. The processor can regain the bus only after the HOLD is removed. When the HOLD is acknowledged, the Address, Data, RD, WR, and IO/M lines are 3-stated.						
HLDA (Output)	HOLD ACKNOWLEDGE: Indicates that the cpu has received the HOLD request and that it will relinquish the bus in the next clock cycle. HLDA goes low after the Hold request is removed. The cpu takes the bus one half clock cycle after HLDA goes low.						
INTR (Input)	INTERRUPT REQUEST: Is used as a general purpose interrupt. It is sampled only during the next to the last clock cycle of an instruction and during Hold and Halt states. If it is active, the Program Counter (PC) will be inhibited from incrementing and an INTA will be issued. During this cycle a RESTART or CALL instruction can be inserted to jump to the interrupt service routine. The INTR is enabled and disabled by software. It is disabled by Reset and immediately after an interrupt is accepted.						
INTA (Output)	INTERRUPT ACKNOWLEDGE: Is used instead of (and has the same timing as) $\overline{RD}$ during the instruction cycle after an INTR is accepted.						
RST 5.5 RST 6.5 RST 7.5 (Input)	RESTART INTERRUPTS: These three inputs have the same timing as INTR except they cause an internal RESTART to be automatically inserted. The priority of these interrupts is ordered as shown in Table 1. These interrupts have a higher priority than INTR. In addition, they may be individually masked out using the SIM instruction.						
TRAP (Input)	Trap interrupt is a nonmaskable RESTART interrupt. It is recognized at the same timing as INTR or RST 5.5–7.5. It is unaffected by any mask or Interrupt Disable. It has the highest priority of any interrupt. (See Table 1.)						

Symbol	Function
RESET IN (Input)	Sets the Program Counter to zero and resets the Interrupt Enable and HLDA flip-flops. The data and address buses and the control lines are 3-stated during RESET and because of the asynchronous nature of RESET, the processor's internal registers and flags may be altered by RESET with unpredictable results. RESET IN is a Schmitt-triggered input, allowing connection to an R-C network for power-on RESET delay. The cpu is held in the reset condition as long as RESET IN is applied.
RESET OUT (Output)	Indicates cpu is being reset. Can be used as a system reset. The signal is synchronized to the processor clock and lasts an integral number of clock periods.
X <sub>1</sub> , X <sub>2</sub> (Input)	$X_1$ and $X_2$ are connected to a crystal to drive the internal clock generator. $X_1$ can also be an external clock input from a logic gate. The input frequency is divided by 2 to give the processor's internal operating frequency.
CLK (Output)	Clock Output for use as a system clock. The period of CLK is twice the $X_1, X_2$ input period.
SID (Input)	Serial input data line. The data on this line is loaded into accumulator bit 7 whenever a RIM instruction is executed.
SOD (Output)	Serial output data line. The output SOD is set or reset as specified by the SIM instruction.
Vcc	+5 volt supply.
GND	Ground Reference.

#### Table 1 Interrupt Priority, Restart Address, and Sensitivity

Name	Priority	Address Branched To (1) When Interrupt Occurs	Type Trigger	
TRAP	1	24H	Rising edge and high level until sampled.	
RST 7.5	2	ЗСН	Rising edge (latched).	
RST 6.5	3	34H	High level until sampled.	
RST 5.5	4	2CH	High level until sampled.	
INTR	5	(2)	High level until sampled.	

Notes: (1)

The processor pushes the PC on the stack before branching to the indicated address. The address branched to depends on the instruction provided to the cpu when the interrupt is ac-knowledged. (2)

## FUNCTIONAL DESCRIPTION

The MSM80C85A is a complete 8-bit parallel central processor. It is designed with silicon gate C-MOS technology and requires a single +5 volt supply. Its basic clock speed is 3MHz, thus improving on the present 8080A's performance with higher system speed. Also it is designed to fit into a minimum system of three IC's: The cpu (MSM80C85A), a RAM/IO (MSM81C55), and a ROM/IO chip (MSM83C55).

The MSM80C85A, has twelve addressable 8-bit registers. Four of them can function only as two 16-bit register pairs. Six others can be used interchangeably as 8-bit registers or a 16-bit register pairs. The MSM-80C85A register set is as follows:

Mnemonic	Register	Contents
ACC or A	Accumulator	8-bits
PC	Program Counter	16-bit address
BC, DE, HL	General-Purpose	8-bit x 6 or
	Registers;	16-bits x 3
	data pointer (HL)	
SP	Stack Pointer	16-bit address
Flags or F	Flag Register	5 flags (8-bit space)

The MSM80C85A uses a multiplexed Data Bus. The address is split between the higher 8-bit Address Bus and the lower 8-bit Address/Data Bus. During the first T state (clock cycle) of a machine cycle the low order address is sent out on the Address/Data Bus. These lower 8-bits may be latched externally by the Address Latch Enable signal (ALE). During the rest of the machine cycle the data bus is used for memory or I/O data.

The MSM80C85A provides  $\overline{\text{RD}}$ ,  $\overline{\text{WR}}$ ,  $S_0$ ,  $S_1$  and  $\overline{\text{IO/M}}$  signals for bus control. An Interrupt Acknowledge signal (INTA) is also provided. Hold and all Interrupts are synchronized with the processor's internal clock. The MSM80C85A also provides Serial Input Data (SID) and Serial Output Data (SOD) lines for a simple serial interface.

In addition to these features, the MSM80C85A has three maskable, vector interrupt pins and one nonmaskable TRAP interrupt.

## **INTERRUPT AND SERIAL I/O**

The MSM80C85A has 5 interrupt inputs: INTR, RST 5.5, RST 6.5, RST 7.5, and TRAP, INTR is identical in function to the 8080A INT. Each of the three RESTART inputs, 5.5, 6.5, and 7.5, has a programmable mask. TRAP is also a RESTART interrupt but it is nonmaskable.

The three maskable interrupts cause the internal

execution of RESTART (saving the program counter in the stack and branching to the RESTART address) if the interrupts are enabled and if the interrupt mask is not set. The nonmaskable TRAP causes the internal execution of a RESTART vector independent of the state of the interrupt enable or masks. (See Table 1.)

There are two different types of inputs in the restart interrupts. RST 5.5 and RST 6.5 are high level-sensitive like INTR (and INT on the 8080A) and are recognized with the same timing as INTR. RST 7.5 is rising edge-sensitive.

For RST 7.5, only a pulse is required to set an internal flip-flop which generates the internal interrupt request. The RST 7.5 request flip-flop remains set until the request is serviced. Then it is reset automatically. This flip-flop may also be reset by using the SIM instruction or by issuing a RESET IN to the MSM80C85A. The RST 7.5 internal flip-flop will be set by a pulse on the RST 7.5 pin even when the RST 7.5 interrupt is masked out.

The interrupts are arranged in a fixed priority that determines which interrupt is to be recognized if more than one is pending as follows: TRAP-highest priority, RST 7.5, RST 6.5, RST 5.5, INTR-lowest priority. This priority scheme does not take into account the priority of a routine that was started by a higher priority interrupt. RST 5.5 can interrupt an RST 7.5 routine if the interrupts are re-enabled before the end of the RST 7.5 routine.

The TRAP interrupt is useful for catastrophic events such as power failure or bus error. The TRAP input is recognized just as any other interrupt but has the highest priority. It is not affected by any flag or mask. The TRAP input is both edge and level sensitive. The TRAP input must go high and remain high until it is acknowledged. It will not be recognized again until it goes low, then high again. This avoids any false triggering due to noise or logic glitches. Figure 3 illustrates the TRAP interrupt request circuitry within the MSM80C85A. Note that the servicing of any interrupt (TRAP, RST 7.5, RST 6.5, RST 5.5, INTR) disables all future interrupts (except TRAPs) until an El instruction is executed.

The TRAP interrupt is special in that it disables interrupts, but preserves the previous interrupt enable status. Performing the first RIM instruction following a TRAP interrupt allows you to determine whether interrupts were enabled or disabled prior to the TRAP. All subsequent RIM instructions provide current interrupt enable status. Performing a RIM instruction following INTR or RST 5.5–7.5 will provide current interrupt Enable status, revealing that interrupts are disabled.

The serial I/O system is also controlled by the RIM and SIM instructions. SID is read by RIM, and SIM sets the SOD data.

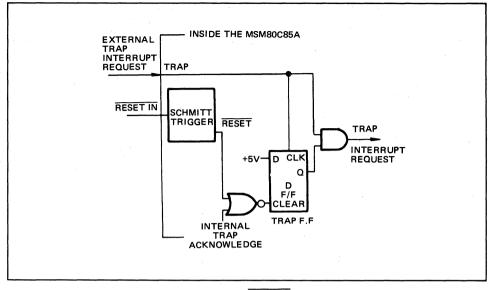


Figure 3 Trap and RESET IN Circuit

## DRIVING THE X<sub>1</sub> and X<sub>2</sub> INPUTS

You may drive the clock inputs of the MSM80C-85A with a crystal, or an external clock source. The driving frequency must be at least 1 MHz, and must be twice the desired internal clock frequency; hence, the MSM80C85A is operated with a 6 MHz cyrstal (for 3 MHz clock). If a crystal is used, it must have the following characteristics:

- Parallel resonance at twice the clock frequency desired
- $C_{L}$  (load capacitance)  $\leq$  30 pF
- $C_S$  (shunt capacitance)  $\leq$  7 pF
- $R_{S}$  (equivalent shunt resistance)  $\leq$  75 ohms

Drive level: 10 mW

Frequency tolerance: ±.005% (suggested)

Note the use of the capacitors between  $X_1$ ,  $X_2$  and ground. These capacitors are required to assure oscillator startup at the correct frequency.

Figure 4 shows the recommended clock driver circuits. Note in B that a pullup resistor is required to assure that the high level voltage of the input is at least 4V.

For driving frequencies up to and including 6 MHz you may supply the driving signal to  $X_1$  and leave  $X_2$  open-circuited (Figure 4B). To prevent self-oscillation of the MSM80C85A, be sure that  $X_2$  is not coupled back to  $X_1$  through the driving circuit.

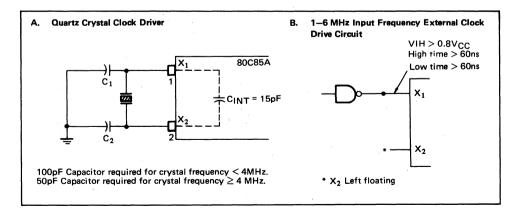


Figure 4 Clock Driver Circuits

## BASIC SYSTEM TIMING

The MSM80C85A has a multiplexed Data Bus. ALE is used as a strobe to sample the lower 8-bits of address on the Data Bus. Figure 5 shows an instruction fetch, memory read and I/O write cycle (as would occur during processing of the OUT instruction). Note that during the I/O write and read cycle that the I/O port address is copied on both the upper and lower half of the address.

There are seven possible types of machine cycles. Which of these seven takes place is defined by the status of the three status lines  $(10/M, S_1, S_0)$  and the three control signals ( $\overline{RD}$ ,  $\overline{WR}$ , and  $\overline{INTA}$ ). (See Table 2.) The status line can be used as advanced controls (for device selection, for example), since they become active at the T<sub>1</sub> state, at the outset of each machine cycle. Control lines  $\overline{RD}$  and  $\overline{WR}$  become active later, at the time when the transfer of data is to take place, so are used as command lines.

A machine cycle normally consists of three T states, with the exception of OPCODE FETCH, which normally has either four or six T states (unless WAIT or HOLD states are forced by the receipt of READY or HOLD inputs). Any T state must be one of ten possible states, shown in Table 3.

Mashing (			Status			Control		
Machine Cycle		10/M	S <sub>1</sub>	S <sub>0</sub>	RD	WR	INTA	
Opcode Fetch	(OF)	0	1	1	0	1	1	
Memory Read	(MR)	0	1	0	0	1	1	
Memory Write	(MW)	0	0	1	1	0	1	
I/O Read	(IOR)	1	1	0	0	1	1	
I/O Write	(IOW)	1	0	1	1	0	1	
Acknowledge of INTR	(INA)	1	1	1	1	1	0	
Bus Idle	(BI): DAD RST, TRAP	0	1	0	1	1	1	
	HALT	1 TS	1 0	1 0	1 TS	1 TS	1 1	

#### Table 2 MSM80C85A Machine Cycle Chart

#### Table 3 MSM80C85A Machine State Chart

Marchine Chate		Status & Buses				Control			
Machine State	S <sub>1</sub> , S <sub>0</sub>	10/M	A <sub>8</sub> -A <sub>15</sub>	AD0-AD7	RD, WR	INTA	ALE		
Т1	х	×	×	x	1	1	1 (1)		
T <sub>2</sub>	х	×	x	X	x	x	0		
TWAIT	x	×	x	x	×	x	0		
T <sub>3</sub>	х	x	x	×	×	x	0		
Т4	1	0 (2)	x	TS	1	1	0		
Τ <sub>5</sub>	1	0 (2)	x	TS	1	1	0		
T <sub>6</sub>	1	0 (2)	x	TS	1	1	0		
TRESET	х	TS	TS	TS	TS	1	0		
THALT	0	TS	тs	TS	TS	1	0		
THOLD	x	тѕ	TS	TS	TS	1	0		

0 = Logic "0"

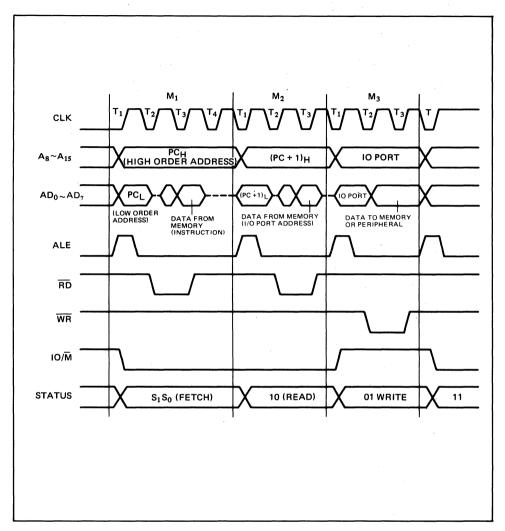
1 = Logic "1"

TS = High Impedance

X = Unspecified

Notes: (1) ALE not generated during 2nd and 3rd machine cycles of DAD instruction.

(2)  $IO/\overline{M} = 1$  during  $T_4 \sim T_6$  of INA machine cycle.







Ambient Temperature under Bias	-40°C to + 85°C
Storage Température	–55°C to + 150°C
Supply Voltage Respect to Ground	-0.3V to + 7.0V
Input Voltage Respect to Ground	-0.3V to V <sub>CC</sub> + 0.3V
Power Dissipation	1.0 Watt (DIP)
	0.7 Watt (FLAT)
	1.0 Watt (PLCC)

Note: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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# **D.C. CHARACTERISTICS**

(T<sub>A</sub> = -40°C to + 85°C; V<sub>CC</sub> = 5V  $\pm$ 10%; unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions	;
Input Low Voltage	VIL	-0.3		+0.8	v		
Input High Voltage	⊻ін	2.2		V <sub>CC</sub> + 0.3	v		
Output Low Voltage	VOL			0.45	v	IOL = 2mA	
	N	2.4			v	I <sub>OH</sub> = -400µA	
Output High Voltage	Vон	4.2			V	I <sub>OH</sub> =40μA	
Input Leak	LI	-10		10	μA	$0V \le V_{IN} \le V_{CC}$	
Output Leak	1LO	-10		10	μA	$0V \le V_{OUT} \le V_{CC}$	
Input Low Level, RESET	VILR	-0.3		+0.8	v		
Input High Level, RESET	VIHR	3.0		V <sub>CC</sub> + 0.3	v		
Hysteresis, RESET	Vнү	0.25			v		
			10	22	mA	$V_{CC} = 4.5V \text{ to } 5.5V$ $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	tCYC = 320ns
Power Supply Current	ICC		10	17	mA	$V_{CC} = 4.75V \text{ to } 5.25V$ $T_A = 0^{\circ}C \text{ to } +85^{\circ}C$	Reset Active CL=0pF
Power Supply Voltage	Vcc	4	5	6	v		

# A.C. CHARACTERISTICS

 $(T_A = -40^{\circ}C \text{ to } 85^{\circ}C; V_{CC} = 5V \pm 10\%)$ 

D	Current	800	285A	Units
Parameter	Symbol	Min.	Max.	Units
CLK Cycle Period	tCYC	320	2000	ns
CLK Low Time	t <sub>1</sub>	80		ns
CLK High Time	t <sub>2</sub>	120		ns
CLK Rise and Fall Time	t <sub>r</sub> , t <sub>f</sub>		30	ns
X <sub>1</sub> Rising to CLK Rising	<sup>t</sup> XKR	30	120	ns
X <sub>1</sub> Rising to CLK Falling	<sup>t</sup> XKF	30	150	ns
$A_{8\sim15}$ Valid to Leading Edge of Control (1)	tAC	270		ns
$A_{0\sim7}$ Valid to Leading Edge of Control	tACL	240		ns
$A_{0\sim 15}$ Valid to Valid Data In	tAD		575	ns
Address Float After Leading Edge of RD (INTA)	tAFR		0	ns
$A_{8\sim 15}$ Valid Before Trailing Edge of ALE <sup>(1)</sup>	tAL	115		ns
$A_{0\sim7}$ Valid Before Trailing Edge of ALE	<sup>†</sup> ALL	90		ns
READY Valid from Address Valid	tARY		220	ns
Address (A <sub>8</sub> -A <sub>15</sub> ) Valid After Control	<sup>t</sup> CA	120		ns
Width of Control Low (RD, WR, INTA)	tcc	400		ns
Trailing Edge of Control to Leading Edge of ALE	tCL	50		ns
Data Valid to Trailing Edge of WR	tDW	420		ns
HLDA to Bus Enable	tHABE		210	ns
Bus Float After HLDA	tHABF		210	ns

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## A.C. CHARACTERISTICS (cont'd)

Parameter	Symbol	800	85A	
Faranieter	Symbol	Min.	Max.	Units
HLDA Valid to Trailing Edge of CLK	<b>tHACK</b>	110		ns
HOLD Hold Time	tHDH	0		ns
HOLD Setup Time to Trailing Edge of CLK	tHDS	170		ns
INTR Hold Time	tinh	0		ns
INTR, RST, and TRAP Setup Time to Falling Edge of CLK	tINS	160		ns
Address Hold Time After ALE	tLA	100		ns
Trailing Edge of ALE to Leading Edge of Control	tLC	130		ns
ALE Low During CLK High	<sup>t</sup> LCK	100		ns
ALE to Valid Data During Read	tLDR		460	ns
ALE to Valid Data During Write	tLDW		200	ns
ALE Width	tLL	140		ns
ALE to READY Stable	<sup>t</sup> LRY		110	ns
Trailing Edge of RD to Re-Enabling of Address	tRAE	150		ns
RD (or INTA) to Valid Data	<sup>t</sup> RD		300	ns
Control Trailing Edge to Leading Edge of Next Control	tRV	400		ns
Data Hold Time After RD INTA (7)	tRDH	0		ns
READY Hold Time	tRYH	0		ns
READY Setup Time to Leading Edge of CLK	tRYS	110	Ι	ns
Data Valid After Trailing Edge of WR	twp	100		ns
LEADING Edge of WR to Data Valid	twDL		.40	ns

Notes: (1) A<sub>8</sub>−A<sub>15</sub> address Specs apply to IO/M
, S<sub>0</sub>, and S<sub>1</sub> except A<sub>8</sub>−A<sub>15</sub> are undefined during T<sub>4</sub>−T<sub>6</sub> of OF cycle whereas IO/M
,S<sub>0</sub>, and S<sub>1</sub> are stable.

(2) Test conditions: t<sub>CYC</sub> = 320ns C<sub>L</sub> = 150pF

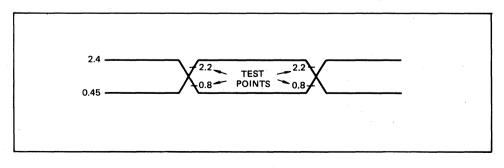
(3) For all output timing where  $C_L = 150pF$  use the following correction factors:

 $25pF \le C_L < 150pF: -0.10ns/pF$ 

 $150pF < C_{L} \le 300pF: +0.30ns/pF$ 

- (4) Output timings are measured with purely capacitive load.
- (5) All timings are measured at output voltage  $V_L = 0.8V$ ,  $V_H = 2.2V$ , and 1.5V with 10ns rise and fall time on inputs.
- (6) To calculate timing specifications at other values of tCYC use Table 7.
- (7) Data hold time is guaranteed under all loading conditions.

## Input Waveform for A.C. Tests:



	MSM80C85A						
<sup>t</sup> AL	-	(1/2)T — 45	MIN				
tLA	-	(1/2)T — 60	MIN				
<sup>t</sup> LL	-	(1/2)T — 20	MIN				
<sup>t</sup> LCK		(1/2)T — 60	MIN				
<sup>t</sup> LC	-	(1/2)T - 30	MIN				
tAD	-	(5/2 + N)T – 225	MAX				
tRD		(3/2 + N)T — 180	MAX				
<sup>t</sup> RAE	-	(1/2)T — 10	MIN				
<sup>t</sup> CA	-	(1/2)T – 40	MIN				
tDW	-	(3/2 + N)T — 60	MIN				
tWD	-	(1/2)T - 60	MIN				
tCC	-	(3/2 + N)T — 80	MIN				
<sup>t</sup> CL	-	(1/2)T — 110	MIN				
tARY	_	(3/2)T — 260	MAX				
<sup>t</sup> HACK	-	(1/2)T — 50	MIN				
tHABF	-	(1/2)T + 50	MAX				
tHABE	-	(1/2)T + 50	MAX				
<sup>t</sup> AC	-	(2/2)T - 50	MIN				
t <sub>1</sub>	-	(1/2)T – 80	MIN				
t <sub>2</sub>	-	(1/2)T – 40	MIN				
<sup>t</sup> RV	-	(3/2)T - 80	MIN				
<sup>t</sup> LDR	-	(2+N)T – 180	MAX				

Table 7	Bus Timing	Specification as a	TCYC	Dependent
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Note: N is equal to the total WAIT states.

T = tCYC

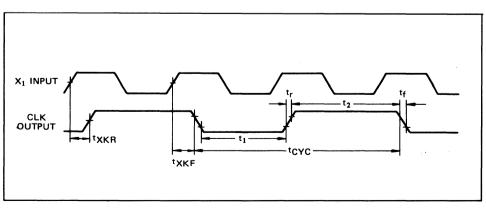
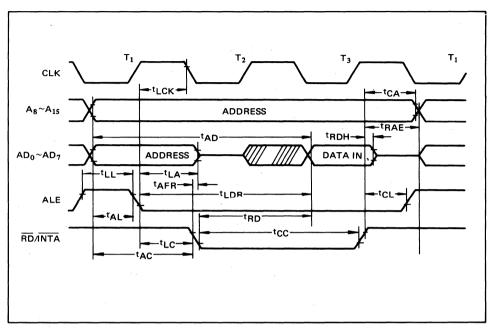


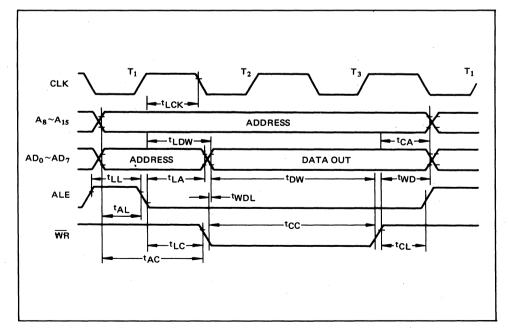
Figure 6 Clock Timing Waveform

# ■ CPU·MSM80C85ARS/GS/JS ■-

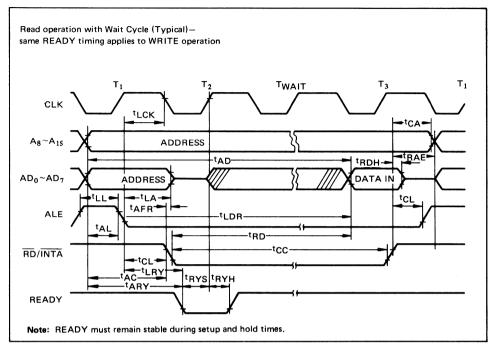
# **READ OPERATION**



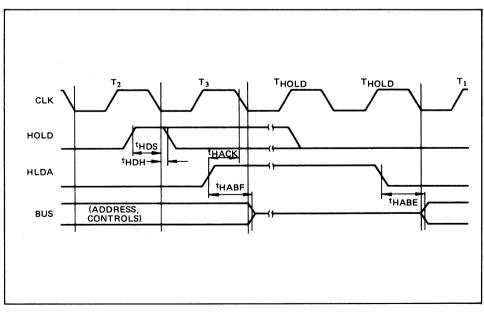
# WRITE OPERATION



44







# HOLD OPERATION

-

Figure 8 MSM80C85A Hold Timing

■ CPU·MSM80C85ARS/GS/JS ■

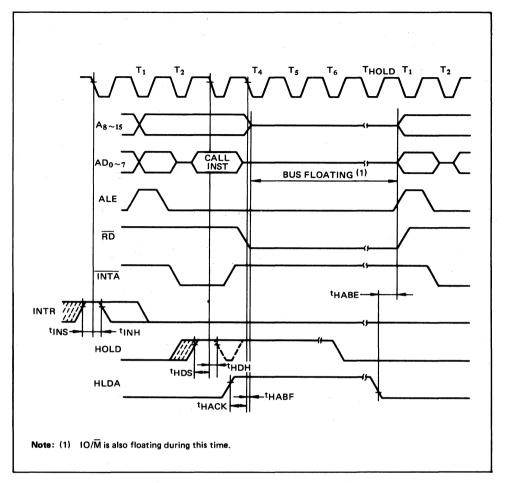


Figure 9 MSM80C85A Interrupt and Hold Timing

	Name in the second seco				uctiu	n Coo	de (1)			Clock (2)
Mnemonic	Description	D <sub>7</sub>	$D_6$	D <sub>5</sub>	D₄	D <sub>3</sub>	$D_2$	D <sub>1</sub>	Do	Cycles
MOVE, LOAD, AND STORE										
MOVr1 r2	Move register to register	0	1	D	D	D	s	s	s	4
MOV M r	Move register to memory	Ō	1	1	1	ō	S	s	s	7
MOVrM	Move memory to register	ŏ	1	Ď	D	Ď	1	1	õ	7
MVIr	Move immediate register	ŏ	ò	D	D	D	1	1	ŏ	7
MVIM	Move immediate memory	ŏ	õ	1	1	ō	1	1	ŏ	10
LXIB	Load immediate register Pair B & C	ō	ŏ	o	ò	ŏ	ò	ò	1	10
	Load immediate register Pair D & E	ŏ	ŏ	ŏ	1	ŏ	ŏ	õ	1	10
	Load immediate register Pair H & L	0	ō	1	ò	ŏ	ŏ	ŏ	1	10
	Load immediate stack pointer	ō	õ	1	1	ŏ	ŏ	ŏ	1	10
STAX B	Store A indirect	o	ŏ	ò	ò	ŏ	ŏ	1	ò	7
STAX D	Store A indirect	0	o	ŏ	1	ō	ō	1	õ	7
LDAX B	Load A indirect	o	ŏ	ŏ	ò	1	ŏ	1	ŏ	7
	Load A indirect	0	0	0	1	1	0	1	0	7
STA	Store A direct	0	0	1	1	0.	ō	1	0	13
LDA	Load A direct	0	0	1	1	1	0	1	0	13
SHLD	Store H & L direct	0	0	1	0	0	0	1	0	13
		0	0	1		1	0	1	0	16
LHLD XCHG	Load H & L direct	1	1	1	0 0	1	0	1	1	4
хсно	Exchange D & E H & L registers				<u> </u>		0			4
STACK OPS										
PUSH B	Push register Pair B & C on stack	1	1	0	0	0	1	0	1	12
PUSH D	Push register Pair D & E on stack	1	1	0	1	0	1	0	1	12
PUSH H	Push register Pair H & L on stack	1	1	1	0	0	1	0	1	12
PUSH PSW	Push A and Flags on stack	1	1	1	1	0	1	0	1	12
POP B	Pop register Pair B & C off stack	1	1	0	0	0	0	0	1	10
POP D	Pop register Pair D & E off stack	1	1	0	1	0	0	0	1	10
POP H	Pop register Pair H & L off stack	1	1	1	0	0	0	0	1	10
POP PSW	Pop A and Flags off stack	1	1	1	1	0	0	0	1	10
XTHL	Exchange top of stack H & L	1	1	1	0	0	0	1	1	16
SPHL	H & L to stack pointer	1	1	1	1	1	0	0	1	6
JUMP										
JMP	Jump unconditional	1	1	0	0	0	0	1	1	10
JC	Jump on carry	1	1	ò	1	1	ŏ	1	ò	7/10
JNC	Jump on no carry	1	1	ŏ	1	ò	ŏ	1	õ	7/10
JZ	Jump on zero	1	1	õ	ò	1	ŏ	1	ŏ	7/10
JNZ	Jump on no zero	1	1	ŏ	ŏ	ò	ŏ	1	ŏ	7/10
JP	Jump on positive	1	1	1	1	ō	ŏ	1	ŏ	7/10
JM	Jump on minus	1	1	1	1	1	ō	1	0	7/10
JPE	Jump on parity even	1	1	1	0	1	0	1	0	7/10
JPO	Jump on parity odd	1	1	1	ŏ	ò	ŏ	1	0	7/10
PCHL	H & L to program counter	1	1	1	ő	1	ŏ	ò	1	6
		<u> </u>								
CALL					-					
CALL	Call unconditional	1	1	0	0	1	1	0	1	18
°CC	Call on carry	1	1	0	1	1	1	0	0	9/18
CNC	Call on no carry	1	1	0	1	0	1	0	0	9/18
CZ	Call on zero	1	1	0	0	1	1	0	0	9/18
CNZ	Call on no zero	1	1	0	0	0	1	0	0	9/18
СР	Call on positive	1	1	1,	1	0	1	0	0	9/18
СМ	Call on minus	1	1	1	1	1	1	0	0	9/18
CPE	Call on parity even	1	1	1	0	1	1	0	0	9/18
СРО	Call on parity odd	1	1	1	0	0	1	0	0	9/18

## Table 8 Instruction Set Summary

6

Maamania	Mnemonic Description			Instr		Clock(2)				
winemonic	Description	D7	$D_6$	D <sub>5</sub>	D4	D <sub>3</sub>	$D_2$	$D_1$	Do	Cycles
DETUDN										
RETURN RET	Batura	1	1	0	0	1	0	0	1	10
RC	Return	1	1	0	1	1	0	0	ò	6/12
RNC	Return on carry	1	1	0	1	0	0	0	0	6/12
RZ	Return on no carry	1	1	0	0	1	0	0	0	6/12
RNZ	Return on zero Return on no zero	1	1	0	0	o	0	0	0	6/12
RP	Return on positive	1	1	1	1	0	0	0	0	6/12
RM	Return on minus	1	1	1	1	1	0	ŏ	0	6/12
RPE	Return on parity even	1	1	1	ò	1	0	ō	õ	6/12
RPO	Return on parity odd	1	1	1	o	ò	ŏ	ō	0	6/12
	neturn on party odd	-					<u> </u>			0/12
RESTART	· · ·									
RST	Restart	1	1	Α	Α	Α	1	1	1	12
INPUT/OUTPU	Γ									
IN	, Input	1	1	0	1	1	0	1	1	10
OUT	Output	1	1	ŏ	1	ò	ŏ	1	1	10
	1	·	· · ·						· · ·	+
	ND DECREMENT									
INR r	Increment register	0	0	D	D	D	1	0	0	4
DCR r	Decrement register	0	0	D	D	D	1	0	1	4
INR M	Increment memory	0	0	1	1	0	1	0	0	10
DCR M	Decrement memory	0	0	1	1	0	1	0	1	10
INX B	Increment B & C registers	0	0	0	0	0	0	1	1	6
INX D	Increment D & E registers	0	0	0	1	0	0	1	1	6
INX H	Increment H & L registers	0	0	1	0	0	0	1	1	6
INX SP	Increment stack pointer	0	0	1	1	0	0	1	1	6
DCX B	Decrement B & C	0	0	0	0	1	0	1	1	6
DCX D	Decrement D & E	0	0	0	1	1	0	1	1	6
DCX H	Decrement H & L	0	0	1	0	1	0	1	1	6
DCX SP	Decrement stack pointer	0	0	1	1	1	0	1	1	6
ADD										
ADD r	Add register to A	1	0	0	0	0	s	s	s	4
ADC r	Add register to A with carry	1	õ	õ	ŏ	1	s	s	s	4
ADD M	Add memory to A	1	ŏ	ŏ	ŏ	ò	1	1	õ	7
ADC M	Add memory to A with carry	1	ŏ	õ	ŏ	1	1	1	ŏ	7
ADI	Add immediate to A	1	1	ŏ	ŏ	ò	1	1	õ	7
ACI	Add immediate to A with carry	1	1	õ	õ	1	1	1	õ	7
DADB	Add B & C to H & L	o	ò	ŏ	ŏ	1	ò	ò	1	10
DADD	Add D & E to H & L	ŏ	ŏ	ŏ	1	1	õ	ŏ	1	10
DADH	Add H & L to H & L	o	õ	1	ò	1	ō	ŏ	1	10
DAD SP	Add stack pointer to H & L	ō	ŏ	1	1	1	ŏ	ō	1	10
		<u> </u>	-			-	-			
SUBTRACT				•		•	~	~	~	
SUB r	Subtract register from A	1	0	0	1	0	S	S	S	4
SBB r	Subtract register from A with borrow	1	0	0	1	1	S	S	S	4
SUB M	Subtract memory from A	1	0	0	1	0	1	1	0	7
SBB M	Subtract memory from A with borrow	1	0	0	1	1	1	1	0	7
SUI	Subtract immediate from A	1	1	0	1	0	1	1	0	7
SBI	Subtract immediate from A with	1	1	0	1	1	1	1	0	/
	borrow									

### Table 8 Instruction Set Summary cont'd

	Description			Clock(2)						
Mnemonic	Description		$D_6$	Ds	D4	D3	$D_2$	$D_1$	$D_0$	Cycles
LOGICAL										
ANA r	And register with A	1	0	1	0	0	S	S	S	4
XRA r	Exclusive Or register with A	1	0	1	0	1	S	S	S	4
ORA r	Or register with A	1	0	1	1	0	S	S	S	4
CMP r	Compare register with A	1	0	1	1	1	S	S	S	4
ANA M	And memory with A	1	0	1	0	0	1	1	0	7
XRA M	Exclusive Or memory with A	1	0	1	0	1	1	1	0	7
ORA M	Or memory with A	1	0	1	1	0	1	1	0	7
CMP M	Compare memory with A	1	0	1	1	1	1	1	0	7
ANI	And immediate with A	1	1	1	0	0	1	1	0	7
XRI	Exclusive Or immediate with A	1	1	1	0	1	1	1	0	7
ORI	Or immediate with A	1	1	1	1	0	1	1	0	7
CPI	Compare immediate with A	1	1	1	1	1	1	1	0	7
ROTATE										
RLC	Rotate A left	0	0	0	0	0	1	1	1	4
RRC	Rotate A right	0	0	0	0	1	1	1	1	4
RAL	Rotate A left through carry	0	0	0	1	0	1	1	1	4
RAR	Rotate A right through carry	0	0	0	1	1	1	1	1	4
SPECIALS	· · · · · · · · · · · · · · · · · · ·									
СМА	Complement A	0	0	1	0	1	1	1	1	4
STC	Set carry	0	0	1	1	0	1	1	1	4
CMC	Complement carry	0	0	1	1	1	1	1	1	4
DAA	Decimal adjust A	0	0	1	0	0	1	1	1	4
CONTROL										
EI	Enable Interrupts	1	1	1	1	1	0	1	1	4
DI	Disable Interrupt	1	1	1	1	0	0	1	1	4
NOP	No-operation	0	0	0	0	0	0	0	0	4
HLT	Halt	0	1	1	1	0	1	1	0	5
RIM	Read Interrupt Mask	0	0	1	0	0	0	0	0	4
SIM	Set Interrupt Mask	0	0	1	1	0	0	0	0	4

#### Table 8 Instruction Set Summary cont'd

Notes: (1) DDD or SSS, B 000, C 001, D 010, E 011, H 100, L 101, Memory 110, A 111,

(2) Two possible cycle times, (6/12) indicate instruction cycles dependent on condition flags.

## Precautions for operation

(1) When the oscillation circuit is to be used, keep the RES input low until the oscillation is sufficiently stabilized after power is turned on.

(2) When power is turned on, the output level (SOD etc.) is irregular before the equipment is reset.

# **OKI semiconductor** MSM80C85A-2RS/GS/JS

**8-BIT CMOS MICROPROCESSOR** 

# **GENERAL DESCRIPTION**

The MSM80C85A-2 is a complete 8-bit parallel central processor implemented in silicon gate C-MOS technology and compatible with MSM80C85A.

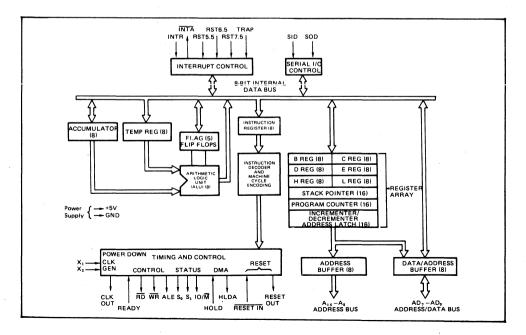
It is designed with higher processing speed (max. 5 MHz) and lower power consumption compared with MSM80C85A and power down mode is provided, thereby offering a high level of system integration.

The MSM80C85A-2 uses a multiplexed address/data bus. The address is split between the 8-bit address bus and the 8-bit data bus. The on-chip address latche of a MSM81C55-5 memory product allows a direct interface with the MSM80C85A-2.

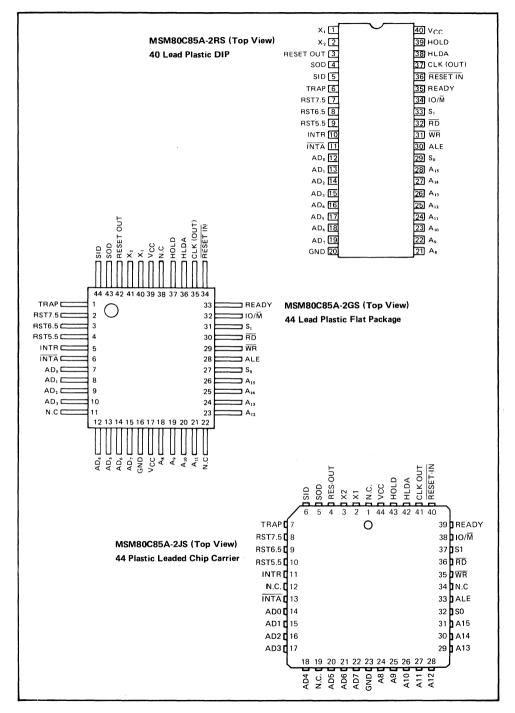
# **FEATURES**

- \* Power down mode (HALT HOLD)
- Low Power Dissipation: 50mW Typ
- · Single +3 to +6 V Power Supply
- -40 to +85° C, Operating Temperature
- Compatible with MSM80C85A
- 0.8µ Instruction Cycle (V<sub>CC</sub> = 5V)
- On-Chip Clock Generator (with External Crystal)
- On-Chip System Controller; Advanced Cycle Status Information Available for Large System Control
- Four Vectored Interrupt Inputs (One is non-maskable) Plus the 8080A-compatible interrupt.
- \* Serial In/Serial Out Port
- Decimal, Binary and Double Precision Arithmetic
- Addressing Capability to 64K Bytes of Memory
- TTL Compatible
- 40 pin Plastic DIP (DIP40-P-600)
- 44 pin PLCC (QFJ44-P-S650)
- 44 pin-V Plastic QFP(QFP44-P-910-VK)

# FUNCTIONAL BLOCK DIAGRAM



# **PIN CONFIGURATION**



# MSM80C85A-2 FUNCTIONAL PIN DEFINITION

The following describes the function of each pin:

Symbol	Function								
A <sub>8</sub> -A <sub>15</sub> (Output, 3-state)	Address Bus: The most significant 8-bits of the memory address or the 8-bits of the I/O address, 3-stated during Hold and Halt modes and during RESET.								
AD <sub>0</sub> —AD <sub>7</sub> (Input/Output) 3-state	Multiplexed Address/Data Bus: Lower 8-bits of the memory address (or I/O address) appear on the bus during the first clock cycle (T state) of a machine cycle. It then becomes the data bus during the second and third clock cycles.								
ALE (Output)	Address Latch Enable: It occurs during the first clock state of a machine cycle and enable the address to get latched into the on-chip latch of peripherals. The falling edge of ALE is set to guarantee setup and hold times for the address information. The falling edge of ALE can also be used to strobe the status information ALE is never 3-stated.								
S₀, S₁, IO/M (Output)	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$								
RD (Output, 3-state)	READ control: A low level on RD indicates the selected memory or I/O device is to be read and that the Data Bus is available for the data transfer, 3-stated during Hold and Halt modes and during RESET.								
WR (Output, 3-state)	WRITE control: A low level on $\overline{WR}$ indicates the data on the Data Bus is to be written into the selected memory or I/O location. Data is set up at the trailing edge of $\overline{WR}$ , 3-stated during Hold and Halt modes and during RESET.								
READY (Input)	If READY is high during a read or write cycle, it indicates that the memory or peripheral is ready to send or receive data. If READY is low, the cpu will wait an integral number of clock cycles for READY to go high before completing the read or write cycle READY must conform to specified setup and hold times.								
HOLD (Input)	HOLD indicates that another master is requesting the use of the address and data buses. The cpu, upon receiving the hold request, will relinquish the use of the bus as soon as the completion of the current bus transfer. Internal processing can continue. The processor can regain the bus only after the HOLD is removed. When the HOLD is acknowledged, the Address, Data, RD, WR, and IO/M lines are 3-stated. And status of power down is controlled by HOLD.								
HLDA (Output)	HOLD ACKNOWLEDGE: Indicates that the cpu has received the HOLD request and that it will relinquish the bus in the next clock cycle. HLDA goes low after the Hold request is removed. The cpu takes the bus one half clock cycle after HLDA goes low.								
INTR (Input)	INTERRUPT REQUEST: Is used as a general purpose interrupt. It is sampled on during the next to the last clock cycle of an instruction and during Hold and Halt states. If it is active, the Program Counter (PC) will be inhibited from incrementing and an INTA will be issued. During this cycle a RESTART or CALL instruction can be inserted to jump to the interrupt service routine. The INTR is enabled and disabled by software. It is disabled by Reset and immediately after an interrupt is accepted. Power down mode is reset by INTR.								
INTA (Output)	INTERRUPT ACKNOWLEDGE: Is used instead of (and has the same timing as) $\overline{\text{RD}}$ during the instruction cycle after an INTR is accepted.								
RST 5.5 RST 6.5 RST 7.5 (Input)	RESTART INTERRUPTS: These three inputs have the same timing as INTR except they cause an internal RESTART to be automatically inserted. The priority of these interrupts is ordered as shown in Table 1. These interrupts have a higher priority than INTR. In addition, they may be individually masked out using the SIM instruction. Power down mode is reset by these interrupts.								
TRAP (Input)	Trap interrupt is a nonmaskable RESTART interrupt. It is recognized at the same timing as INTR or RST 5.5–7.5. It is unaffected by any mask or Interrupt Disable. It has the highest priority of any interrupt. (See Table 1.) Power down mode is reset by input of TRAP.								

Symbol	Function
RESET IN (Input)	Sets the Program Counter to zero and resets the Interrupt Enable and HLDA flip-flops and release power down mode. The data and address buses and the control lines are 3-stated during RESET and because of the asynchronous nature of RESET, the processor's internal registers and flags may be altered by RESET with unpredictable results. RESET IN is a Schmitt-triggered input, allowing connection to an R-C network for power-on RESET delay. The cpu is held in the reset condition as long as RESET IN is applied.
RESET OUT (Output)	Indicated cpu is being reset. Can be used as a system reset. The signal is synchronized to the processor clock and lasts an integral number of clock periods.
X <sub>1</sub> , X <sub>2</sub> (Input)	$X_1$ and $X_2$ are connected to a crystal to drive the internal clock generator. $X_1$ can also be an external clock input from a logic gate. The input frequency is divided by 2 to give the processor's internal operating frequency.
CLK (Output)	Clock Output for use as a system clock. The period of CLK is twice the $X_1$ , $X_2$ input period.
SID (Input)	Serial input data line. The data on this line is loaded into accumulator bit 7 whenever a RIM instruction is executed.
SOD (Output)	Serial output data line. The output SOD is set or reset as specified by the SIM instruction.
V <sub>CC</sub>	+5 volt supply.
GND	Ground Reference.

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#### Table 1 Interrupt Priority, Restart Address, and Sensitivity

Name	Priority	Address Branched To (1) When Interrupt Occurs	Type Trigger
TRAP	1	24H	Rising edge and high level until sampled.
RST 7.5	2	ЗСН	Rising edge (latched).
RST 6.5	3	34H	High level until sampled.
RST 5.5	4 2CH High level		High level until sampled.
INTR	5	(2)	High level until sampled.

Notes: (1) The processor pushes the PC on the stack before branching to the indicated address.

(2) The address branched to depends on the instruction provided to the cpu when the interrupt is acknowledged. CPU·MSM80C85A-2RS/GS/JS =-

## FUNCTIONAL DESCRIPTION

The MSM80C85A-2 is a complete 8-bit parallel central processor. It is designed with silicon gate C-MOS technology and requires a single +5 volt supply. Its basic clock speed is 5MHz, thus improving on the present MSM80C85A's performance with higher system speed and power down mode. Also it is designed to fit into a minimum system of three IC's: The cpu (MSM80C85A-2), and a RAM/IO (MSM81C55-5)

The MSM80C85A-2 has twelve addressable 8-bit register pairs. Six others can be used interchangeably as 8-bit registers or a 16-bit register pairs. The MSM-80C85A-2 register set is as follows:

Mnemonic	Register	Contents
ACC or A	Accumulator	8-bits
PC	Program Counter	16-bit address
BC, DE, HL	General-Purpose	8-bit x 6 or
	Registers; data pointer (HL)	16-bits x 3
SP	Stack Pointer	16-bit address
Flags or F	Flag Register	5 flags (8-bit space)

The MSM80C85A-2 uses a multiplexed Data Bus. The address is split between the higher 8-bit Address Bus and the lower 8-bit Address/Data Bus. During the first T state (clock cycle) of a machine cycle the low order address is sent out on the Address/Data Bus. These lower 8-bits may be latched externally by the Address Latch Enable signal (ALE). During the rest of the machine cycle the data bus is used for memory or I/O data.

The MSM80C85A-2 provides  $\overline{RD}$ ,  $\overline{WR}$ ,  $S_0$ ,  $S_1$  and  $\overline{IO/M}$  signals for bus control. An Interrupt Acknowledge signal ( $\overline{INTA}$ ) is also provided. Hold and all Interrupts are synchronized with the processor's internal clock. The MSM80C85A-2 also provides Serial Input 'Data (SID) and Serial Output Data (SOD) lines for a simple serial interface.

In addition to these features, the MSM80C85A-2 has three maskable, vector interrupt pins, one nonmaskable TRAP interrupt and power down mode with HALT and HOLD.

## INTERRUPT AND SERIAL I/O

The MSM80C85A-2 has 5 interrupt inputs: INTR, RST 5.5, RST 6.5, RST 7.5, and TRAP. INTR is identical in function to the 8080A INT. Each of the three RESTART inputs, 5.5, 6.5, and 7.5, has a programmable mask. TRAP is also a RESTART interrupt but it is nonmaskable.

The three maskable interrupts cause the internal

execution of RESTART (saving the program counter in the stack and branching to the RESTART address) if the interrupts are enabled and if the interrupt mask is not set. The nonmaskable TRAP causes the internal execution of a RESTART vector independent of the state of the interrupt enable or masks. (See Table 1.)

There are two different types of inputs in the restart interrupts. RST 5.5 and RST 6.5 are high level-sensitive like INTR (and INT on the 8080A) and are recognized with the same timing as INTR. RST 7.5 is rising edge-sensitive.

For RST 7.5, only a pulse is required to set an internal flip-flop which generates the internal interrupt request. The RST 7.5 request flip-flop remains set until the request is serviced. Then it is reset automatically. This flip-flop may also be reset by using the SIM instruction or by issuing a RESET IN to the MSM80C85A. The RST 7.5 internal flip-flop will be set by a pulse on the RST 7.5 pin even when the RST 7.5 interrupt is masked out.

The interrupts are arranged in a flixed priority that determines which interrupt is to be recognized if more than one is pending, as follows: TRAP-highest priority, RST 7.5, RST 6.5, RST 5.5, INTR-lowest priority. This priority scheme does not take into account the priority of a routine that was started by a higher priority interrupt. RST 5.5 can interrupt an RST 7.5 routine if the interrupts are re-enabled before the end of the RST 7.5 routine.

The TRAP interrupt is useful for catastrophic events such as power failure or bus error. The TRAP input is recognized just as any other interrupt but has the highest priority. It is not affected by any flag or mask. The TRAP input is both edge and level sensitive. The TRAP input must go high and remain high until it is acknowledged. It will not be recognized again until it goes low, then high again. This avoids any false triggering due to noise or logic glitches. Figure 3 illustrates the TRAP interrupt request circuitry within the MSM80C85A-2. Note that the servicing of any interrupt (TRAP, RST 7.5, RST 6.5, RST 5.5, INTR) disables all future interrupts (except TRAPs) until an El instruction is executed.

The TRAP interrupt is special in that it disables interrupts, but preserves the previous interrupt enable status. Performing the first RIM instruction following a TRAP interrupt allows you to determine whether interrupts were enabled or disabled prior to the TRAP. All subsequent RIM instructions provide current interrupt enable status. Performing a RIM instruction following INTR or RST 5.5–7.5 will provide current lnterrupt Enable status, revealing that Interrupts are disabled.

The serial I/O system is also controlled by the RIM and SIM instructions. SID is read by RIM, and SIM sets the SOD data.

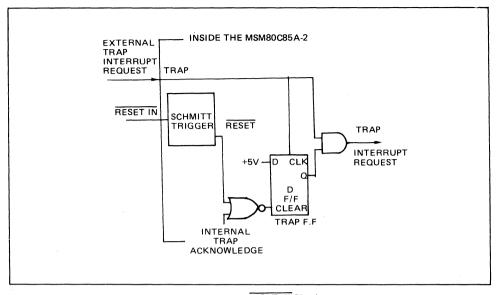


Figure 3 Trap and RESET IN Circuit

## DRIVING THE X<sub>1</sub> and X<sub>2</sub> INPUTS

You may drive the clock inputs of the MSM80C-85A-2 with a crystal, or an external clock source. The driving frequency must be at least 1 MHz, and must be twice the desired internal clock frequency; hence, the MSM80C85A-2 is operated with a 6 MHz crystal (for 3 MHz clock). If a crystal is used, it must have the following characteristics:

Parallel resonance at twice the clock frequency desired

 $C_{L}$  (load capacitance)  $\leq$  30 pF

 $C_{\mbox{S}}$  (shunt capacitance)  $\leq 7~\mbox{pF}$ 

.

 $R_S$  (equivalent shunt resistance)  $\leq$  75 ohms

Drive level : 10 mW

Frequency tolerance: ±.005% (suggested)

Note the use of the capacitors between  $X_1$ ,  $X_2$  and ground. These capacitors are required to assure oscillator startup at the correct frequency.

Figure 4 shows the recommended clock driver circuits. Note in B that a pullup resistor is required to assure that the high level voltage of the input is at least 4V.

For driving frequencies up to and including 6 MHz you may supply the driving signal to  $X_1$  and leave  $X_2$ open-circuited (Figure 4B). To prevent self-oscillation of the MSM80C85A-2, be sure that  $X_2$  is not coupled back to  $X_1$  through the driving circuit.

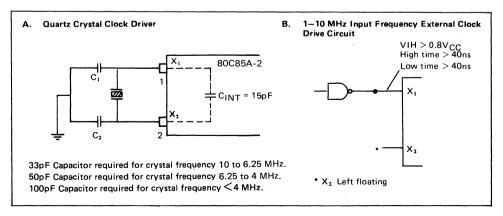


Figure 4 Clock Driver Circuits

## CPU·MSM80C85A-2RS/GS/JS =

# BASIC SYSTEM TIMING

The MSM80C85A-2 has a multiplexed Data Bus. ALE is used as a strobe to sample the lower 8-bits of address on the Data Bus. Figure 5 shows an instruction fetch, memory read and I/O write cycle (as would occur during processing of the OUT instruction). Note that during the I/O write and read cycle that the I/O port address is copied on both the upper and lower half of the address.

There are seven possible types of machine cycles. Which of these seven takes place is defined by the status of the three status lines  $(IO/\overline{M}, S_1, S_0)$  and the

three control signals ( $\overline{RD}$ ,  $\overline{WR}$ , and  $\overline{INTA}$ ). (See Table 2.) The status line can be used as advanced controls (for device selection, for example), since they become active at the T<sub>1</sub> state, at the outset of each machine cycle. Control lines  $\overline{RD}$  and  $\overline{WR}$  become active later, at the time when the transfer of data is to take place, so are used as command lines.

A machine cycle normally consists of three T states, with the exception of OPCODE FETCH, which normally has either four or six T states (unless WAIT or HOLD states are forced by the receipt of READY or HOLD inputs). Any T state must be one of ten possible states, shown in Table 3.

Machine Cycle			Status		Control			
Machine Cy	cie	10/M	S <sub>1</sub>	So	RD	WR	INTA	
Opcode Fetch	(OF)	0	1	1	0	1	1	
Memory Read	(MR)	0	1	0	0	1	1	
Memory Write	(MW)	0	0	1	1	0	1	
I/O Read	(IOR)	1	1	0	0	1	1	
I/O Write	(IOW)	1	0	1	1	0	1	
Acknowledge of INTR	(INA)	1	1	1	1	1	0	
Bus Idle	(BI): DAD ACK. OF	0	1	0	1	1	1	
	RST, TRAP	1	1	1	1	. 1	1	
	HALT	TS	0	0	TS	TS	1	

#### Table 2 MSM80C85A-2 Machine Cycle Chart

#### Table 3 MSM80C85A-2 Machine State Chart

Machine State		Status	& Buses	Control			
Machine State	S1, S0	10/M	A <sub>8</sub> -A <sub>15</sub>	AD <sub>0</sub> -AD <sub>7</sub>	RD, WR	ĪNTĀ	ALE
Τ <sub>1</sub>	х	x	х	×	1	1	1(1)
T <sub>2</sub>	х	x	х	x	x	х	0
TWAIT	х	x	х	×	x	х	0
T <sub>3</sub>	х	x	х	x	x	x	0
T₄	1.	0 (2)	х	TS	1	1	0
T₅	1	0 (2)	х	TS	1	1	0
T <sub>6</sub>	1	0 (2)	х	TS	1	1	0
TRESET	x	TS	тs	TS	TS	1	0
THALT	0	тs	тs	TS	TS	1	0
THOLD	x	TS	TS	TS	TS	1	0

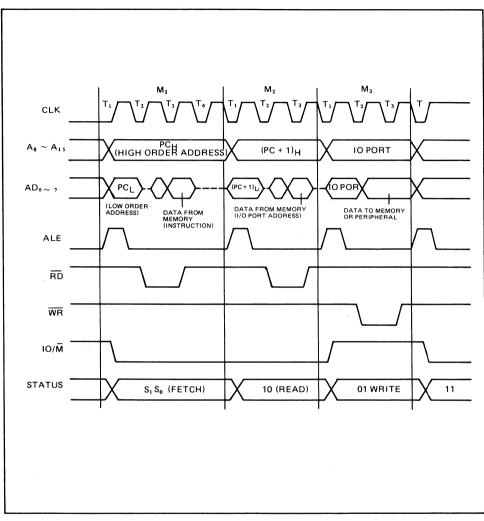
0 = Logic "0"

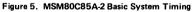
1 = Logic "1"

TS= High Impedance

X = Unspecified

Notes: (1) ALE not generated during 2nd and 3rd machine cycles of DAD instruction. (2)  $IO/\overline{M} = 1$  during  $T_4 \sim T_6$  of INA machine cycle.





F

## CPU·MSM80C85A-2RS/GS/JS =

#### POWER DOWN Mode (a newly added function)

The MSM80C85A-2 is compatible with the MSM80C85A in function and POWER DOWN mode. This reduces power consumption further.

There are two methods available for starting this POWER DOWN mode. One is through software control by using the HALT command and the other is under hardware control by using the pin HOLD. This mode is released by the HOLD, RESET, and interrupt pins (TRAP, RST7.5, RST6.5, RST5.5, or INTR). (See Table 4.)

Since the sequence of HALT, HOLD, RESET, and INTERRUPT is compatible with MSM80C85A, every the POWER DOWN mode can be used with no special attention.

#### Table 4 POWER DOWN Mode Releasing Method

Start by means of HALT command	Released by using pins RESET and INTERRUPT (not by pin HOLD)
Start by means of HOLD pin	Released by using RESET and HOLD pins (not by interrupt pins)

(1) Start by means of HALT command (See Figures 6 and 7.)

The POWER DOWN mode can be started by executing the HALT command.

At this time, the system is put into the HOLD status and therefore the POWER DOWN mode cannot be released even when the HOLD is released later.

In this case, the POWER DOWN mode can be released by means of the RESET or interrupt.

(2) Start by means of HOLD pin (See Figure 8.)

During the execution of commands other than the HALT, the POWER DOWN mode is started when the system is put into HOLD status by means of the HOLD pin.

Since no interrupt works during the execution of the HOLD, the POWER DOWN mode cannot be released by means of interrupt pins.

In this case, the POWER DOWN mode can be released either by means of the RESET pin or by releasing the HOLD status by means of HOLD pin.

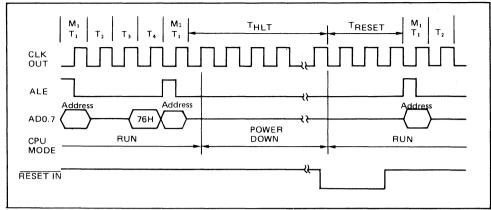
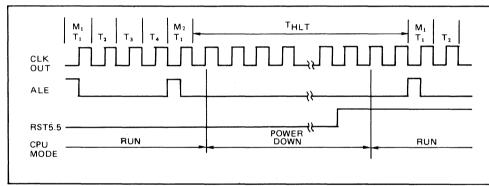


Figure 6. Started by HALT and Released by RESET IN





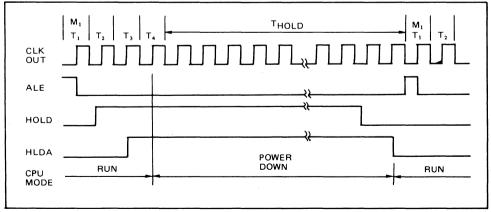


Figure 8. Started and Released by HOLD

#### Limits Parameter Symbol Condition Unit MSM80C85A-2RS MSM80C85A-2GS MSM80C85A-2JS Power Supply Voltage Vcc -0.5 ~ +7 v With respect $v_{\text{IN}}$ Input Voltage $-0.5 \sim V_{CC}$ +0.5 v to GND Output Voltage VOUT v $-0.5 \sim V_{CC}$ +0.5 Tstg $-55 \sim +150$ Storage Temperature °c **Power Dissipation** $Ta = 25^{\circ}C$ PD 0.7 1.0 1.0 w

# ABSOLUTE MAXIMUM RATINGS

# **OPERATING RANGE**

Parameter	Symbol	Limits	Unit
Power Supply Voltage	v <sub>cc</sub>	3 ~ 6	v
Operating Temperature	Тор	-40 ~ +85	°C

# **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Min.	Тур.	Max.	Unit
Power Supply Voltage	Vcc	4.5	5	5.5	v
Operating Temperature	Тор	-40	+25	+85	°C
"L" Input Voltage	VIL	-0.3		+0.8	v
"H" Output Voltage	VIH	2.2		V <sub>CC</sub> + 0.3	v
"L" RESET IN Input Voltage	VILR	-0.3		+0.8	v
"H", RESET IN Input Voltage	VIHR	3.0		V <sub>CC</sub> + 0.3	v

# **D.C. CHARACTERISTICS**

Parameter	Symbol	Cond	Min.	Тур.	Max.	Unit	
"L" Output Voltage	VOL	I <sub>OL</sub> = 2mA				0.45	v
"H" Output Voltage	∨он	l <sub>OH</sub> = -400μA		2.4			v
H Output Voltage	VOH	l <sub>OH</sub> = -40μA		4.2			v
Input Leak Current	LI	$0 \le V_{IN} \le V_{CC}$	$V_{CC} = 4.5V \sim 5.5V$ Ta = -40°C ~ +85°C	-10		10	μΑ
Output Leak Current	1LO	$0 \le V_{OUT} \le V_{CC}$		-10		10	μΑ
Operating Supply		, Tcyc = 200ns CL = 0pF at reset			10	20	mA
Current	'cc	Tcyc = 200ns CL = 0pF at power down mode			3	7	mA

## CPU·MSM80C85A-2RS/GS/JS =

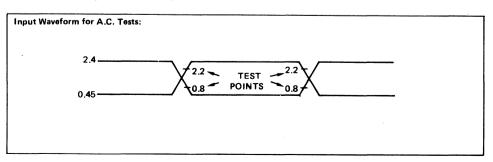
# A.C. CHARACTERISTICS

Parameter	Symbol	Condition	Min.	Max.	Uni
CLK Cycle Period	<sup>t</sup> CYC		200	2000	ns
CLK Low Time	t <sub>1</sub>		40		ns
CLK High Time	· t <sub>2</sub>	-	70		ns
LK Rise and Fall Time	t <sub>r</sub> , t <sub>f</sub>	7		30	ns
X <sub>1</sub> Rising to CLK Rising	<sup>t</sup> XKR	7	25	120	ns
X <sub>1</sub> Rising to CKK Falling	<sup>t</sup> XKF	7	30	150	ns
<sub>8</sub> ∼ <sub>15</sub> Valid to Leading Edge of Control (1)	<sup>t</sup> AC	7	115		ns
$A_0 \sim _7$ Valid to Leading Edge of Control	<sup>t</sup> ACL	1	115		ns
A₀ ∼₁₅ Valid Data In	t <sub>AD</sub>	1		330	ns
Address Float After Leading Edge of RD INTA	<sup>t</sup> AFR	1		0	ns
A <sub>8</sub> ~ <sub>15</sub> Valid Before Trailing Edge of ALE (1)	TAL	1	50		ns
$A_0 \sim_{\gamma}$ Valid Before Trailing Edge of ALE	TALL	1	50		ns
READY Valid from Address Valid	TARY	]		100	ns
Address (A <sub>8</sub> ~ <sub>15</sub> ) Valid After Control	<sup>t</sup> CA	]	60		ns
Width of Control Law (RD, WR, INTA)	tCC	1	230		ns
Trailing Edge of Control to Leading Edge of ALE	<sup>t</sup> CL		25		ns
Data Valid to Trailing Edge of WR	<sup>t</sup> DW		230		ns
HLDA to Bus Enable	<sup>t</sup> HABE	1		150	ns
Bus Float After HLDA	<sup>t</sup> HABF	t <sub>CYC</sub> = 200ns		150	ns
HLDA Valid to Trailing Edge of CLK	<sup>t</sup> HACK	CL = 150pF	40		ns
HOLD Hold Time	<sup>t</sup> HDH		0		ns
HOLD Step Up Time to Trailing Edge of CLK	<sup>t</sup> HDS		120		ns
INTR Hold Time	tINH	1	0		ns
INTR, RST and TRAP Setup Time to Falling Edge of CLK	tINS	1	150		ns
Address Hold Time After ALE	<sup>t</sup> LA	-1	50		ns
Trailing Edge of ALE to Leading Edge of Control	<sup>t</sup> LC	1	60		ns
ALE Low During CLK High	<sup>t</sup> LCK	1	50		ns
ALE to Valid Data During Read	LDR	1		250	ns
ALE to Valid Data During Write	tLDW	1 .		140	ns
ALE Width	tLL	1	80		ns
ALE to READY Stable	<sup>t</sup> LRY	1		30	ns
Trailing Edge of RD to Re-enabling of Address	TRAE	1	90		ns
RD (or INTA) to Valid Data	<sup>t</sup> RD	1		150	ns
Control Trailing Edge to Leading Edge of Next Control	<sup>t</sup> RV	1	220		ns
Data Hold Time After RD INTA (7)	TRDH	1	0		ns
READY Hold Time	<sup>t</sup> RYH	1	0		ns
READY Setup Time to Leading Edge of CLK	TRYS	1	100		ns
Data Valid After Trailing Edge of WR	twp	1	60		ns
LEADING Edge of WR to Data Valid	tWDL	1		20	ns

Notes: (1)  $A_8 \sim A_{15}$  address Specs apply to IO/M,  $S_0$ , and  $S_1$  except  $A_8 \sim A_{15}$  are undefined during  $T_4 \sim T_8$  of OF Agr>A1s address Specs apply to 10//M. So, and S1 except Agr>A1s are underined during 14<sup>-∞</sup>18 or or cycle whereas 10/M. So, and S1 are stable.
 Test conditions: tcyrc = 200ms C1 = 150pF
 For all output timing where C1 = 150pF is the following correction factors: 25pF ≤ C1 < 150pF := 0.10ns/pF 150pF < C1 < 300pF := 0.30ns/pF 150pF < C1 < 300pF := 0.30ns/pF</li>
 Output timings are measured with purely capacitive load.
 All timings are measured at output voltage V1 = 0.8V, VH = 2.2V, and 1.5V with 10ns rise and fall time on invite.

on inputs.

- (6) To calculate timing specifications at other values of  $t_{CYC}$  use Table 7.
- (7) Data hold time is guaranteed under all loading conditions.



# CPU·MSM80C85A-2RS/GS/JS =-

# Table 7 Bus Timing Specification as a $T_{CYC}$ Dependent

	, i a = i		0.00, 0L 100p				
MSM80C85A-2							
tAL	-	(1/2)T — 50	MIN				
<sup>t</sup> LA	-	(1/2)T — 50	MIN				
tLL	_	(1/2)T – 20	MIN				
<sup>t</sup> LCK	-	(1/2)T – 50	MIN				
tLC	-	(1/2)T – 40	MIN				
<sup>t</sup> AD	-	(5/2 + N)T — 170	MAX				
<sup>t</sup> RD		(3/2 + N)T – 150	MAX				
<sup>t</sup> RAE	_	(1/2)T — 10	MIN				
<sup>t</sup> CA	-	(1/2)T – 40	MIN				
tDW	-	(3/2 + N)T — 70	MIN				
twd	-	(1/2)T – 40	MIN				
tCC	-	(3/2 + N)T — 70	MIN				
<sup>t</sup> CL	-	(1/2)T — 75	MIN				
<sup>t</sup> ARY	-	(3/2)T – 200	MAX				
<sup>t</sup> НАСК	-	(1/2)T – 60	MIN				
<sup>t</sup> HABF	_	(1/2)T + 50	MAX				
<sup>t</sup> HABE	-	(1/2)T + 50	MAX				
<sup>t</sup> AC		(2/2)T – 85	MIN				
t <sub>1</sub>	-	(1/2)T – 60	MIN				
t <sub>2</sub>	-	(1/2)T — 30	MIN				
<sup>t</sup> RV	-	(3/2)T - 80	MIN				
<sup>t</sup> LDR	-	(2+N)T - 150	MAX				

 $(Ta = -40^{\circ}C \sim +85^{\circ}C, V_{CC} = 4.5V \sim 5.5V, C_{L} = 150pF)$ 

Note: N is equal to the total WAIT states.

T = tCYC

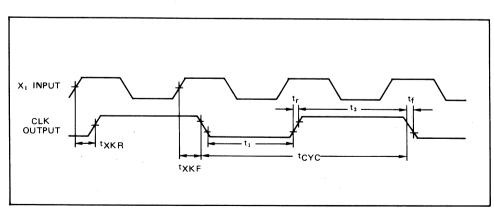
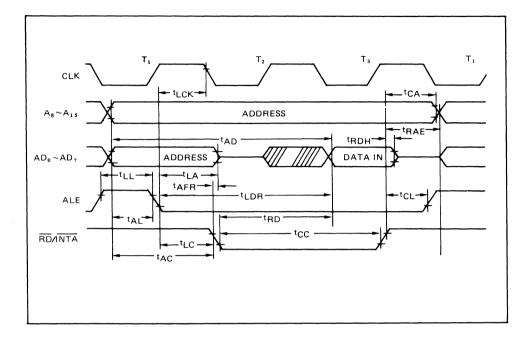
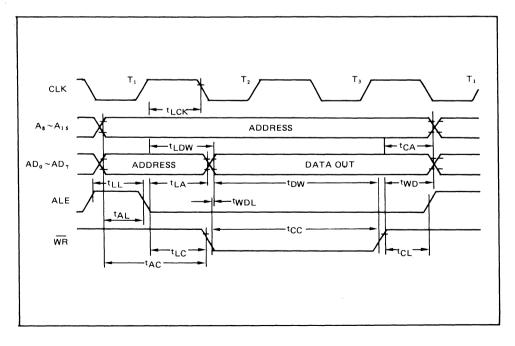


Figure 6 Clock Timing Waveform

# **READ OPERATION**



# WRITE OPERATION



CPU·MSM80C85A-2RS/GS/JS =-

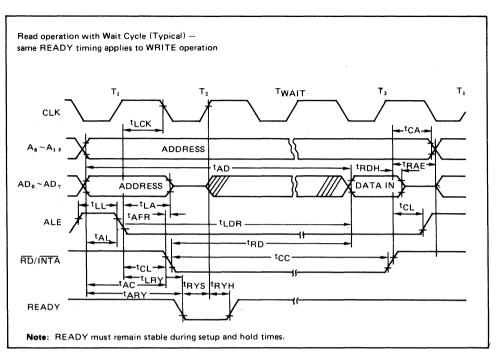
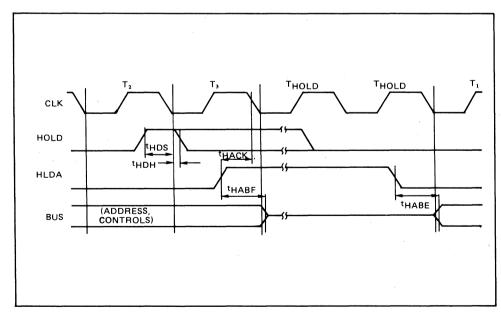


Figure 7 MSM80C85A-2 Bus Timing, With and Without Wait



## HOLD OPERATION



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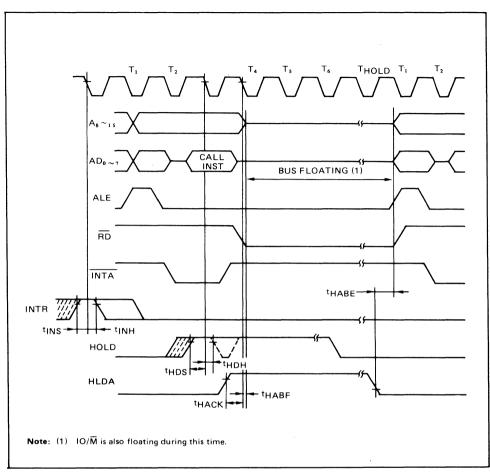


Figure 9 MSM80C85A-2 Interrupt and Hold Timing

# CPU·MSM80C85A-2RS/GS/JS =-

		tion Set Summary Instruction Code (1)								Clock (2)	
Mnemonic	Description	D,	D₅	D₅	D₄	$D_3$	D2	$D_1$	D0	Cycles	
MOVE, LOAD	, AND STORE										
MOVr1 r2	Move register to register	0	1	D	D	D	s	s	s	4	
MOV M r	Move register to memory	0	1	1	1	0	S	s	s	7	
MOV r M	Move memory to register	0	1	D	D	D	1	1	0	7	
MVI r	Move immediate register	0	0	D	D	D	1	1	0	7	
MVIM	Move immediate memory	0	0	1	1	0	1	1	0	10	
LXIB	Load immediate register Pair B & C	0	0	0	0	0	0	0	1	10	
LXID	Load immediate register Pair D & E	0	0	0	1	0	0	0	1	10	
LXIH	Load immediate register Pair H & L	0	0	1	0	0	0	0	1	10	
LXI SP	Load immediate stack pointer	0	0	1	1	0	0	0	1	10	
STAX B	Store A indirect	0	0	0	0	0	0	1	0	7	
STAX D	Store A indirect	0	0	0	1	0	0	1	0	7 .	
LDAX B	Load A indirect	0	0	0	0	1	0	1	0	7	
LDAX D	Load A indirect	0	0	0	1	1	0	1	0	7	
STA	Store A direct	0	0	1	1	0	0	1	0	13	
LDA	Load A direct	0	0	1	1	1	0	1	0	13	
SHLD	Store H & L direct	0	0	1	0	0	Ō	1	0	16	
LHLD	Load H & L direct	0	0	1	Ō	1	0	1	0	16	
XCHG	Exchange D & E H & L registers	1	1	1	0	1	0	1	1	4	
STACK OPS											
PUSH B	Push register Pair B & C on stack	1	1	0	0	0	1	0	1	12	
PUSH D	Push register Pair D & E on stack	1	1	0	1	0	1	0	1	12	
PUSH H	Push register Pair H & L on stack	1	1	1	0	0	1	0	1	12	
PUSH PSW	Push A and Flags on stack	1	1	1	1	0	1	0	1	12	
РОР В	Pop register Pair B & C off stack	1	1	0	0	0	0	0	1	10	
POP D	Pop register Pair D & E off stack	1	1	0	1	Ō	0	0	1	10	
POP H	Pop register Pair H & L off stack	1	1	1	Ó	ō	0	0	1	10	
POP PSW	Pop A and Flags off stack	1	1	1	1	Ō	0	0	1	10	
XTHL	Exchange top of stack H & L	1	1	1	Ó	0	0	1	1	16	
SPHL	H & L to stack pointer	1	1	1	1	1	.0	0	1	6	
JUMP	•										
JMP	Jump unconditional	1	1	0	0	0	0	1	1	10	
JC	Jump on carry	1	1	0	1	1	0	1	0	7/10	
JNC	Jump on no carry	1	1	0	1	0	0	1	0	7/10	
JZ	Jump on zero	1	1	0	0	1	0	1	0	7/10	
JNZ	Jump on no zero	1	1	0	0	0	0	1	0	7/10	
JP	Jump on positive	1	1	1	1	0	0	1	0	7/10	
JM	Jump on minus	1	1	1	1	1	0	1	0	7/10	
JPE	Jump on parity even	1	1	1	0	1	0	1	0	7/10	
JPO	Jump on parity odd	1	1	1	0	0	0	< 1	0	7/10	
PCHL	H & L to program counter	1	1	1	0	1	0	0	1	6	
CALL											
CALL	Call unconditional	1	1	0	0	1	1	0	1	18	
сс	Call on carry	1	1	0	1	1	1	0	0	9/18	
CNC	Call on no carry	1	1	0	1	0	1	0	0	9/18	
cz	Call on zero	1	1	0	0	1	1	0	0	9/18	
CNZ	Call on no zero	1	1	0	0	0	1	0	0	9/18	
СР	Call on positive	1	1	1	1	0	1	0	0	9/18	
СМ	Call on minus	1	1	1	1	1	1	0	0	9/18	
	1. · · · · · · · · · · · · · · · · · · ·	1									
CPE	Call on parity even	1	1	1	0	1	1	0	0	9/18	

#### Table 8 Instruction Set Summary

	Description	Instruction Code(1)								Clock(2)	
Mnemonic		D7	D6	D₅	D₄	D₃	D <sub>2</sub>	D	D₀	Cycles	
RETURN		t -		<b>y</b>			-	·	ĭ		
RET	Return	1	1	0	0	1	0	0	1	10	
RC	Return on carry	1	1	Ō	1	1	ō	ō	0	6/12	
RNC	Return on no carry	1	1	0	1	0	0	Ō	Ő	6/12	
RZ	Return on zero	1	1	0	0	1	ō	ō	Ő	6/12	
RNZ	Return on no zero	1	1	õ	0	0	Ō	õ	Ő	6/12	
RP	Return on positive	1	1	1	1	õ	õ	ŏ	õ	6/12	
RM	Return on minus	1	1	1	1	1	õ	õ	ŏ	6/12	
RPE	Return on parity even	1	1	1	o	1	õ	õ	õ	6/12	
RPO	Return on parity odd	1	1	1	õ	o	ŏ	õ	Ő	6/12	
RESTART	· · · · · · · · · · · · · · · · · · ·										
RST	Restart	1	1	А	А	А	1	1	1	12	
INPUT/OUTPU	ı										
IN	Input	1	1	0	1	1	0	1	1	10	
OUT	Output	1	1	0	1	o	ō	1	1	10	
	1	<u> </u>	•					•	-		
			0	~	-	-		~	~		
INR r	Increment register	0	0	D	D	D	1	0	0	4	
DCR r	Decrement register	0	0	D	D	D	1	0	1	4	
	Increment memory	0	0	1	1	0	1	0	0	10	
DCR M	Decrement memory	0	0	1	1	0	1	0	1	10	
INX B	Increment B & C registers	0	0	0	0	0	0	1	1	6	
INX D	Increment D & E registers	0	0	0	1	0	0	1	1	6	
INX H	Increment H & L registers	0	0	1	0	0	0	1	1	6	
INX SP	Increment stack pointer	0	0	1	1	0	0	1	1	6	
DCX B	Decrement B & C	0	0	0	0	1	0	1	1	6	
DCX D	Decrement D & E	0	0	0	1	1	0	1	1	6	
DCX H	Decrement H & L	0	0	1	0	1	0	1	1	6	
DCX SP	Decrement stack pointer	0	0	1	1	1	0	1	1	6	
ADD											
ADD r	Add register to A	1	0	0	0	0	S	S	S	4	
ADC r	Add register to A with carry	1	0	0	0	1	S	S	S	4	
ADD M	Add memory to A	1	0	0	0	0	1	1	0	7	
ADC M	Add memory to A with carry	1	0	0	0	1	1	1	0	7	
ADI	Add immediate to A	1	1	0	0	0	1	1	0	7	
ACI	Add immediate to A with carry	1	1	0	0	1	1	1	0	7	
DAD B	Add B & C to H & L	0	0	0	0	1	0	0	1	10	
DAD D	Add D & E to H & L	0	0	0	1	1	0	0	1	10	
DAD H	Add H & L to H & L	0	0	1	0	1	0	0	1	10	
DAD SP	Add stack pointer to H & L	0	0	1	1	1	0	0	1	10	
SUBTRACT											
SUB r	Subtract register from A	1	0	0	1	0	S	S	S	4	
SBB r	Subtract register from A with borrow	1	0	0	1	1	S	S	S	4	
SUB M	Subtract memory from A	1	0	0	1	0	1	1	0	7	
SBB M	Subtract memory from A with borrow	1	0	0	1	1	1	1	0	7	
SUI	Subtract immediate from A	1	1	0	1	0	1	1	0	7	
SBI	Subtract immediate from A with	1	1	0	1	1	1	1	0	7	
	borrow										

## Table 8 Instruction Set Summary cont'd

5

Mnemonic	Description			Instr	uctio	n Co	de(1)			Clock(2)
winemonic	Description	D <sub>7</sub>	D6	D,	D₄	D3	$D_2$	D1	D,	Cycles
LOGICAL										7
ANA r	And register with A	1	0	1	0	0	S	S	S	4
XRA r	Exclusive Or register with A	1	0	1	0	1	S	S	s	4
ORA r	Or register with A	1	0	1	1	0	S	S	S	4
CMP r	Compare register with A	1	0	1	1	1	S	S	S	4
ANA M	And memory with A	1	0	1	Ó	0	1	1	0	7
XRA M	Exclusive Or Memory with A	1	0	1	0	1	1	1	0	7
ORA M	Or memory with A	1	0	1	1	0	1	1	0	7
СМР М	Compare memory with A	1	0	1	1	1	1	1	0	7
ANI	And immediate with A	1	1	1	0	0	1	1	0	7
XRI	Exclusive Or immediate with A	1	1	1	0	1	1	1	0	7
ORI	Or immediate with A	1	1	1	1	0	1	1	0	7
CPI	Compare immediate with A	1	1	1	1	1	1	1	0	7
ROTATE										
RLC	Rotate A left	0	0	0	0	0	1	1	1	4
RRC	Rotate A right	0	0	0	0	1	1	1	1	4
RAL	Rotate A left through carry	0	0	0	1	0	1	1	1	4
RAR	Rotate A right through carry	0	0	0	1	1	1	1	1	4
SPECIALS										
СМА	Complement A	0	0	1	0	1	1	1	1	4
STC	Set carry	0	0	1	1	0	1.	1	1	4
CMC	Complement carry	0	0	1	1	1	1	1	1	4
DAA	Decimal adjust A	0	0	1	0	0	1	1	1	4
CONTROL										
EI	Enable Interrupts	1	1	1	1	1	0	1	1	4
DI	Disable Interrupts	1	1	1	1	Ó	0	1	1	4
NOP	No-operation	0	0	Ó	Ó	Ō	Ō	Ó	Ó	4
HLT	Halt (Power down)	Ō	1	1	1	ō	1	1	Ō	5
RIM	Read Interrupt Mask	o	Ō	1	0	0	0 0	0	ō	4
SIM	Set Interrupt Mask	0	õ	1	1	õ	ō	ō	ō	4

#### Table 8 Instruction Set Summary cont'd

Notes: (1) DDD or SSS. B 000. C 001. D 010. E 011. H 100. L 101. Memory 110. A 111.

(2) Two possible cycle times, (6/12) indicate instruction cycles dependent on condition flags.

Precautions for operation

(1) When the oscillation circuit is to be used, keep the RES input low until the oscillation is sufficiently stabilized after power is turned on.

(2) When power is turned on, the SOD output level is irregular before the equipment is reset.



#### NOTE

#### Item: Precautions for operation of MSM80C85A-2

#### 1. Error phenomenon

When the power down mode of the OKI 8-bit microprocessor MSM80C85A-2, which is activated under the conditions indicated below, is released, a malfunction occurs. Although the operation cycle is increased, the operation cycle is increased, the operation sequence is normal. If the HOLD function is not used, no problems are caused.

Condition 1:During the HALT instruction fetch, the HOLD function is activated and an interruption is simultaneously requested. (See Fig.1.)

Conditions 2:During the HALT instruction fetch, the HOLD function is activated and no intterruption is requested. (See Fig.2.) (When the HALT cycle starts after the HOLD function is released)

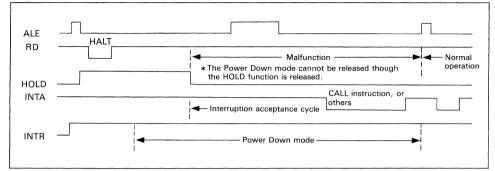


Fig.1 Malfunction timing chart 1

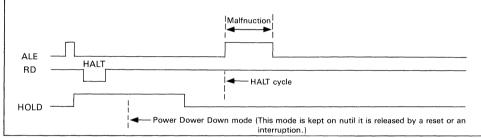


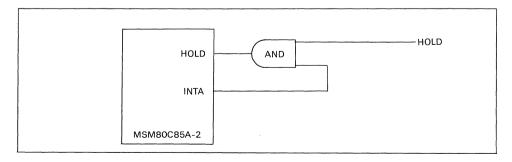
Fig.2 Malfunction timing chart 2

#### 2. Error cause

An error occurs in the Power Down mode release circuit under the above conditions.

#### 3. Precautions for operation

A problem caused by the above malfunction is that the bus conflict with each other because the HOLD function is accepted during the interruption (INTR) acceptance cycle. To prevent the bus from confliction, it is necessary to design so that the HOLD function is not accepted during the interruption (INTR) acceptance cycle. (See Fig.3.)



#### 4. Others

A revised edition of MSM80C85AH which is free of the above error is under development.

# **OKI** semiconductor MSM80C85AHRS/GS/JS

## 8-BIT CMOS MICROPROCESSOR

# GENERAL DESCRIPTION

The MSM80C85AH is a complete 8-bit parallel central processor implemented in silicon gate C-MOS technology and compatible with MSM80C85A.

It is designed with higher processing speed (max, 5 MHz) and lower power consumption compared with MSM80C85A and power down mode is provided, thereby offering a high level of system integration.

The MSM80C85AH uses a multiplexed address/data bus. The address is split between the 8-bit address bus and the 8-bit data bus. The on-chip address latches of a MSM81C55-5 memory product allows a direct interface with the MSM80C85AH

# **FEATURES**

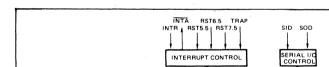
- Power down mode (HALT HOLD)
- Low Power Dissipation: 50mW Typ
- Single +3 to +6 V Power Supply
- -40 to +85°C, Operating Temperature
- Compatible with MSM80C85A
- 0.8µ Instruction Cycle (V<sub>CC</sub> = 5V)
- On-Chip Clock Generator (with External Crystal)

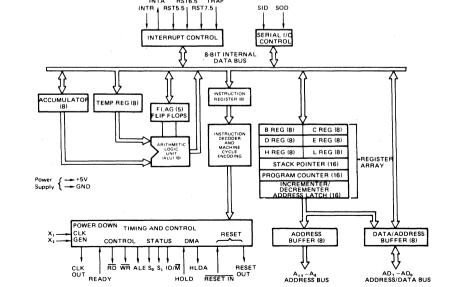
FUNCTIONAL BLOCK DIAGRAM

- ·On-Chip System Controller; Advanced Cycle Status Information Available for Large System Control
- Four Vectored Interrupt Inputs (One is non-maskable) Plus the 8080A-compatible interrupt.

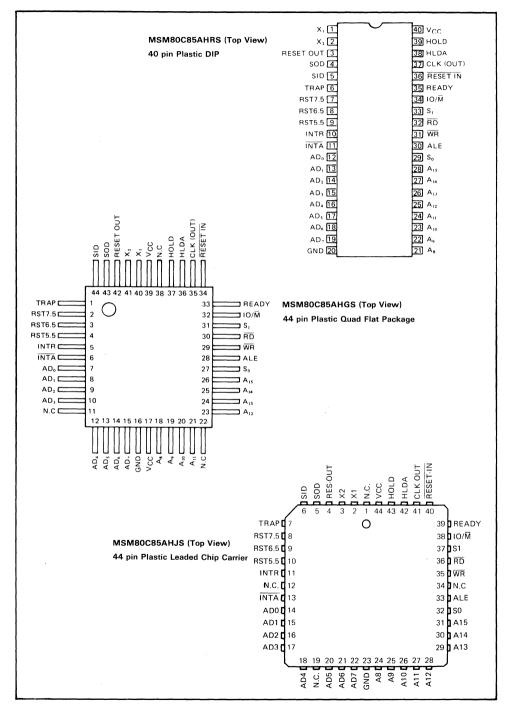
Preliminary

- Serial In/Serial Out Port
- Decimal, Binary and Double Precision Arithmetic
- Addressing Capability to 64K Bytes of Memory
- TTL Compatible
- · 40 pin Plastic DIP (DIP40-P-600)
- 44 pin PLCC (QFJ44-P-S650)
- 44 pin-V Plastic QFP (QFP44-P-910-VK)





# PIN CONFIGURATION



# MSM80C85AH FUNCTIONAL PIN DEFINITION

The following describes the function of each pin:

Symbol	Function						
A <sub>8</sub> – A <sub>15</sub> (Output, 3-state)	Address Bus: The most significant 8-bits of the memory address or the 8-bits of the I/O address, 3-stated during Hold and Halt modes and during RESET.						
AD₀ –AD7 (Input/Output) 3-state	Multiplexed Address/Data Bus: Lower 8-bits of the memory address (or I/O address) appear on the bus during the first clock cycle (T state) of a machine cycle. It then becomes the data bus during the second and third clock cycles.						
ALE (Output)	Address Latch Enable: It occurs during the first clock state of a machine cycle and enables the address to get latched into the on-chip latch of peripherals. The falling edge of ALE is set to guarantee setup and hold times for the address information. The falling edge of ALE can also be used to strobe the status information ALE is never 3-stated.						
S₀ , S₁ , IO/M (Output)	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$						
RD (Output, 3-state)	READ control: A low level on $\overline{\text{RD}}$ indicates the selected memory or I/O device is to be read and that the Data Bus is available for the data transfer, 3-stated during Hold and Halt modes and during RESET.						
WR (Output, 3-state)	WRITE control: A low level on $\overline{\rm WR}$ indicates the data on the Data Bus is to be written into the selected memory or I/O location. Data is set up at the trailing edge of $\overline{\rm WR}$ , 3-stated during Hold and Halt modes and during RESET.						
READY (Input)	If READY is high during a read or write cycle, it indicates that the memory or peripheral is ready to send or receive data. If READY is low, the cpu will wait an integral number of clock cycles for READY to go high before completing the read or write cycle READY must conform to specified setup and hold times.						
HOLD (Input)	HOLD indicates that another master is requesting the use of the address and data buses. The cpu, upon receiving the hold request, will relinquish the use of the bus as soon as the completion of the current bus transfer. Internal processing can continue. The processor can regain the bus only after the HOLD is removed. When the HOLD is acknowledged, the Address, Data, RD, WR, and IO/M lines are 3-stated. And status of power down is controlled by HOLD.						
HLDA (Output)	HOLD ACKNOWLEDGE: Indicates that the cpu has received the HOLD request and that it will relinquish the bus in the next clock cycle. HLDA goes low after the Hold request is removed. The cpu takes the bus one half clock cycle after HLDA goes low.						
INTR (Input)	INTERRUPT REQUEST: Is used as a general purpose interrupt. It is sampled on during the next to the last clock cycle of an instruction and during Hold and Halt states. If it is active, the Program Counter (PC) will be inhibited from incrementing and an INTA will be issued. During this cycle a RESTART or CALL instruction can be inserted to jump to the interrupt service routine. The INTR is enabled and disabled by software. It is disabled by Reset and immediately after an interrupt is accepted. Power down mode is reset by INTR.						
INTA (Output)	INTERRUPT ACKNOWLEDGE: Is used instead of (and has the same timing as) RD during the instruction cycle after an INTR is accepted.						
RST 5.5 RST 6.5 RST 7.5 (Input)	RESTART INTERRUPTS: These three inputs have the same timing as INTR except they cause an internal RESTART to be automatically inserted. The priority of these interrupts is ordered as shown in Table 1. These interrupts have a higher priority than INTR. In addition, they may be individually masked out using the SIM instruction. Power down mode is reset by these interrupts.						
TRAP (Input)	Trap interrupt is a nonmaskable RESTART interrupt. It is recognized at the same timing as INTR or RST 5.5–7.5. It is unaffected by any mask or Interrupt Disable. It has the highest priority of any interrupt. (See Table 1.) Power down mode is reset by input of TRAP.						

Symbol	Function
RESET IN (Input)	Sets the Program Counter to zero and resets the Interrupt Enable and HLDA flip-flops and release power down mode. The data and address buses and the control lines are 3- stated during RESET and because of the asynchronous nature of RESET, the processor's internal registers and flags may be altered by RESET with unpredictable results. RESET IN is a Schmitt-triggered input, allowing connection to an R-C network for power-on RESET delay. The cpu is held in the reset condition as long as RESET IN is applied.
RESET OUT (Output)	Indicated cpu is being reset. Can be used as a system reset. The signal is synchronized to the processor clock and lasts an integral number of clock periods.
X <sub>1</sub> , X <sub>2</sub> (Input)	$X_1$ and $X_2$ are connected to a crystal to drive the internal clock generator. $X_1$ can also be an external clock input from a logic gate. The input frequency is divided by 2 to give the processor's internal operating frequency.
CLK (Output)	Clock Output for use as a system clock. The period of CLK is twice the $X_1$ , $X_2$ input period.
SID (Input)	Serial input data line. The data on this line is loaded into accumulator bit 7 whenever a RIM instruction is executed.
SOD (Output)	Serial output data line. The output SOD is set or reset as specified by the SIM instruction.
Vcc	+5 volt supply.
GND	Ground Reference.

## Table 1 Interrupt Priority, Restart Address, and Sensitivity

Name	Priority	Address Branched To (1) When Interrupt Occurs	Tỳpe Trigger
TRAP	1	24H	Rising edge and high level until sampled.
RST 7.5	2	ЗСН	Rising edge (latched).
RST 6.5	3	34H	High level until sampled.
RST 5.5	4	2CH	High level until sampled.
INTR	5	(2)	High level until sampled.

Notes: (1) The processor pushes the FC on the stack before branching to the indicated address.

(2) The address branched to depends on the instruction provided to the cpu when the interrupt is acknowledged.

## FUNCTIONAL DESCRIPTION

The MSM80C85AH is a complete 8-bit parallel central processor. It is designed with silicon gate C-MOS technology and requires a single +5 volt supply. Its basic clock speed is 5MHz, thus improving on the present MSM80C85A's performance with higher system speed and power down mode. Also it is designed to fit into a minimum system of two IC's: The cpu (MSM80C85AH), and a RAM/IO (MSM81C55-5)

The MSM80C85A-2 has twelve addressable 8-bit register pairs. Six others can be used interchangeably as 8-bit registers or a 16-bit register pairs. The MSM-80C85A-2 register set is as follows:

Mnemonic	Register	Contents
ACC or A	Accumulator	8-bits
PC	Program Counter	16-bit address
BC, DE, HL	General-Purpose	8-bit x 6 or
	Registers;	16-bits x 3
	data pointer (HL)	
SP	Stack Pointer	16-bit address
Flags or F	Flag Register	5 flags (8-bit space)

The MSM80C85AH uses a multiplexed Data Bus. The address is split between the higher 8-bit Address Bus and the lower 8-bit Address/Data Bus. During the first T state (clock cycle) of a machine cycle the low order address is sent out on the Address/Data Bus. These lower 8-bits may be latched externally by the Address Latch Enable signal (ALE). During the rest of the machine cycle the data bus is used for memory or I/O data.

The MSM80C85AH provides  $\overline{RD}$ ,  $\overline{WR}$ ,  $S_0$ ,  $S_1$  and  $IO/\overline{M}$  signals for bus control. An Interrupt Acknowledge signal (INTA) is also provided. Hold and all Interrupts are synchronized with the processor's internal clock. The MSM80C85AH also provides Serial Input Data (SID) and Serial Output Data (SOD) lines for a simple serial interface.

In addition to these features, the MSM80C85AH has three maskable, vector interrupt pins, one nonmaskable TRAP interrupt and power down mode with HALT and HOLD.

## **INTERRUPT AND SERIAL I/O**

The MSM80C85AH has 5 interrupt inputs: INTR, RST 5.5, RST 6.5, RST 7.5, and TRAP. INTR is identical in function to the 8080A INT. Each of the three RESTART inputs, 5.5, 6.5, and 7.5, has a programmable mask. TRAP is also a RESTART interrupt but it is nonmaskable.

The three maskable interrupts cause the internal

execution of RESTART (saving the program counter in the stack and branching to the RESTART address) if the interrupts are enabled and if the interrupt mask is not set. The nonmaskable TRAP causes the internal execution of a RESTART vector independent of the state of the interrupt enable or masks. (See Table 1.)

There are two different types of inputs in the restart interrupts. RST 5.5 and RST 6.5 are high level-sensitive like INTR (and INT on the 8080A) and are recognized with the same timing as INTR. RST 7.5 is rising edge-sensitive.

For RST 7.5, only a pulse is required to set an internal flip-flop which generates the internal interrupt request. The RST 7.5 request flip-flop remains set until the request is serviced. Then it is reset automatically. This flip-flop may also be reset by using the SIM instruction or by issuing a RESET IN to the MSM80C85AH The RST 7.5 internal flip-flop will be set by a pulse on the RST 7.5 pin even when the RST 7.5 interrupt is masked out.

The interrupts are arranged in a flixed priority that determines which interrupt is to be recognized if more than one is pending, as follows: TRAP-highest priority, RST 7.5, RST 6.5, RST 5.5, INTR-lowest priority. This priority scheme does not take into account the priority of a routine that was started by a higher priority interrupt. RST 5.5 can interrupt an RST 7.5 routine if the interrupts are re-enabled before the end of the RST 7.5 routine.

The TRAP interrupt is useful for catastrophic events such as power failure or bus error. The TRAP input is recognized just as any other interrupt but has the highest priority. It is not affected by any flag or mask. The TRAP input is both edge and level sensitive. The TRAP input must go high and remain high until it is acknowledged. It will not be recognized again until it goes low, then high again. This avoids any false triggering due to noise or logic glitches. Figure 3 illustrates the TRAP interrupt request circuitry within the MSM80C85AH Note that the servicing of any interrupt (TRAP, RST 7.5, RST 6.5, RST 5.5, INTR) disables all future interrupts (except TRAPs) until an El instruction is executed.

The TRAP interrupt is special in that it disables interrupts, but preserves the previous interrupt enable status. Performing the first RIM instruction following a TRAP interrupt allows you to determine whether interrupts were enabled or disabled prior to the TRAP. All subsequent RIM instructions provide current interrupt enable status. Performing a RIM instruction following INTR or RST 5.5–7.5 will provide current linterrupt Enable status, revealing that Interrupts are disabled.

The serial I/O system is also controlled by the RIM and SIM instructions. SID is read by RIM, and SIM sets the SOD data.

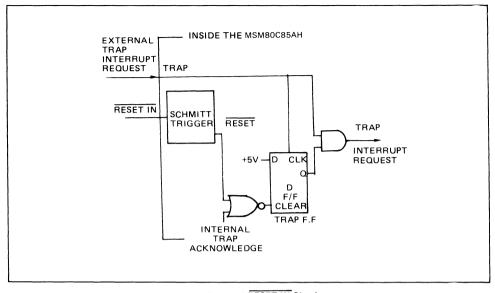


Figure 3 Trap and RESET IN Circuit

# DRIVING THE X<sub>1</sub> and X<sub>2</sub> INPUTS

You may drive the clock inputs of the MSM80C-85A-2 with a crystal, or an external clock source. The driving frequency must be at least 1 MHz, and must be twice the desired internal clock frequency; hence, the MSM80C85AH is operated with a 6 MHz crystal (for 3 MHz clock). If a crystal is used, it must have the following characteristics:

- Parallel resonance at twice the clock frequency desired
- $C_L$  (load capacitance)  $\leq$  30 pF
- $\rm C_S$  (shunt capacitance)  $\leq 7~\rm pF$
- $R_S$  (equivalent shunt resistance)  $\leq$  75 ohms

Drive level : 10 mW

Frequency tolerance: ±.005% (suggested)

Note the use of the capacitors between  $X_1$ ,  $X_2$  and ground. These capacitors are required to assure oscillator startup at the correct frequency.

Figure 4 shows the recommended clock driver circuits. Note in B that a pullup resistor is required to assure that the high level voltage of the input is at least 4V.

For driving frequencies up to and including 6 MHz you may supply the driving signal to  $X_1$  and leave  $X_2$  open-circuited (Figure 4B). To prevent self-oscillation of the MSM80C85AH, be sure that  $X_2$  is not coupled back to  $X_1$  through the driving circuit.

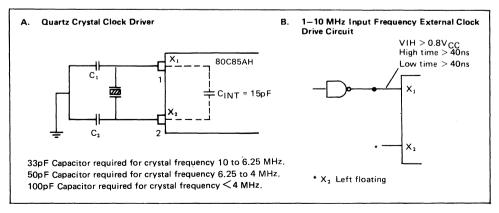


Figure 4 Clock Driver Circuits

## CPU·MSM80C85AHRS/GS/JS =

# BASIC SYSTEM TIMING

The MSM80C85AH has a multiplexed Data Bus. ALE is used as a strobe to sample the lower 8-bits of address on the Data Bus. Figure 5 shows an instruction fetch, memory read and I/O write cycle (as would occur during processing of the OUT instruction). Note that during the I/O write and read cycle that the I/O port address is copied on both the upper and lower half of the address.

There are seven possible types of machine cycles. Which of these seven takes place is defined by the status of the three status lines  $(IO/\overline{M}, S_1, S_0)$  and the

three control signals ( $\overline{RD}$ ,  $\overline{WR}$ , and  $\overline{INTA}$ ). (See Table 2.) The status line can be used as advanced controls (for device selection, for example), since they become active at the T<sub>1</sub> state, at the outset of each machine cycle. Control lines  $\overline{RD}$  and  $\overline{WR}$  become active later, at the time when the transfer of data is to take place, so are used as command lines.

A machine cycle normally consists of three T states, with the exception of OPCODE FETCH, which normally has either four or six T states (unless WAIT or HOLD states are forced by the receipt of  $\overrightarrow{\mathsf{READY}}$  or HOLD inputs). Any T state must be one of ten possible states, shown in Table 3.

Marking			Status		Control           RD         WR           0         1           0         1           1         0           0         1		
Machine Cy	/cie	10/M	S <sub>1</sub>	S <sub>0</sub>	RD	WR	INTA
Opcode Fetch	(OF)	0	1	1	0	1	1
Memory Read	(MR)	0	1	0	0	1	1
Memory Write	(MW)	0	0	1	1	0	1
I/O Read	(IOR)	1	1	0	0	1	1
I/O Write	(IOW)	1	0	1	1	0	1
Acknowledge of INTR	(INA)	1	1	1	1	1	0
Bus idle	(BI): DAD ACK. OF	0	1	0	1	1	1
	RST, TRAP HALT	1 TS	1 0	1	1 TS	1 TS	1

#### Table 2 MSM80C85AH Machine Cycle Chart

#### Table 3 MSM80C85A-2 Machine State Chart

Machine State		Status	s & Buses	····		Control INTA 1 X X X 1 1 1 1 1 1 1 1 1	
Machine State	S1 ,S0	10/M	A <sub>8</sub> -A <sub>15</sub>	AD <sub>0</sub> -AD <sub>7</sub>	RD, WR	INTA	ALE
T <sub>1</sub>	x	x	х	×	1	1	1(1)
T <sub>2</sub>	х	x	X	×	x	х	0 (
TWAIT	х	x	х	×	x	x	0
T <sub>3</sub>	х	x	х	×	x	x	0
T₄	1	0 (2)	х	TS	1	1	0
T₅	1	0 (2)	х	TS	1	1	0
T <sub>6</sub>	1	0 (2)	х	TS	1	1	0
TRESET	x	TS	тs	TS	TS	1	0
THALT	0	TS	тs	TS	тѕ	1	0
THOLD	x	TS	тѕ	TS	TS	1	0

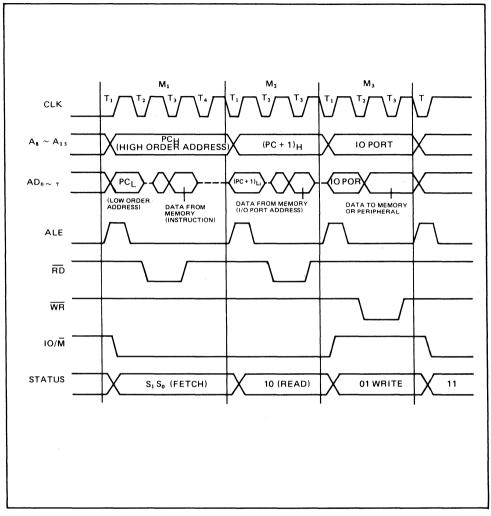
0 = Logic "0"

1 = Logic "1"

TS= High Impedance

X = Unspecified

Notes: (1) ALE not generated during 2nd and 3rd machine cycles of DAD instruction. (2)  $IO/\overline{M} = 1$  during  $T_4 \sim T_6$  of INA machine cycle.





## CPU·MSM80C85AHRS/GS/JS = -

#### POWER DOWN Mode

The MSM80C85AH is compatible with the MSM80C85A in function and POWER DOWN mode. This reduces power consumption further.

There are two methods available for starting this POWER DOWN mode. One is through software control by using the HALT command and the other is under hardware control by using the pin HOLD. This mode is released by the HOLD, RESET, and interrupt pins (TRAP, RST7.5, RST6.5, RST5.5, or INTR). (See Table 4.)

Since the sequence of HALT, HOLD, RESET, and INTERRUPT is compatible with MSM80C85A, every the POWER DOWN mode can be used with no special attention.

Table 4 POWER DOWN Mode Releasing Method

Start by means of HALT command	Released by using pins RESET and INTERRUPT (not by pin HOLD)
Start by means of HOLD pin	Released by using RESET and HOLD pins (not by interrupt pins)

(1) Start by means of HALT command (See Figures 6 and 7.)

> The POWER DOWN mode can be started by executing the HALT command.

> At this time, the system is put into the HOLD status and therefore the POWER DOWN mode cannot be released even when the HOLD is released later.

> In this case, the POWER DOWN mode can be released by means of the RESET or interrupt.

(2) Start by means of HOLD pin (See Figure 8.) During the execution of commands other than the HALT, the POWER DOWN mode is started when the system is put into HOLD status by means of the HOLD pin.

Since no interrupt works during the execution of the HOLD, the POWER DOWN mode cannot be released by means of interrupt pins.

In this case, the POWER DOWN mode can be released either by means of the RESET pin or by releasing the HOLD status by means of HOLD pin.

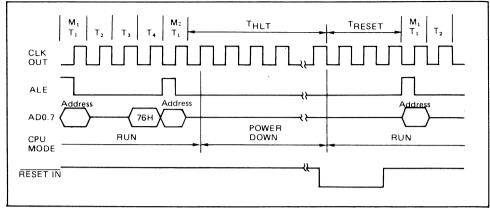


Figure 6. Started by HALT and Released by RESET IN

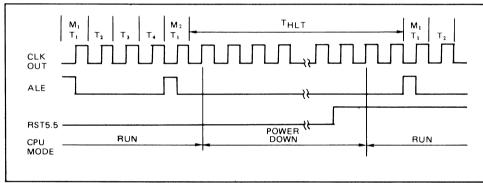


Figure 7. Started by HALT and Released by RST5.5

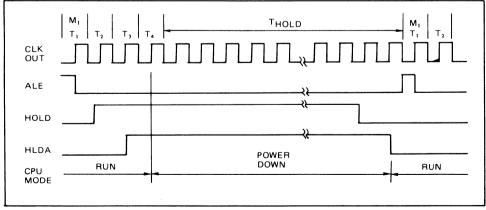


Figure 8. Started and Released by HOLD

# ■ CPU·MSM80C85AHRS/GS/JS ■ -

# ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol		Limits					
	Symbol	Condition	MSM80C85AHRS	MSM80C85AHGS	MSM80C85AHJS	- Unit		
Power Supply Voltage	Vcc			-0.5 ~ +7	······	V		
Input Voltage	VIN	With respect		$-0.5 \sim V_{CC} + 0.5$	999 - Second Control of Control of Second Contro	V		
Output Voltage	Vout	Condition With respect to GND Ta = 25°C	$-0.5 \sim V_{CC} + 0.5$					
Storage Temperature	Tstg		-55~+150					
Power Dissipation	PD	Ta = 25°C	1.0	0.7	1.0	w		

# OPERATING RANGE

Parameter	Symbol	Limits	Unit
Power Supply Voltage	V <sub>CC</sub>	3~6	v
Operating Temperature	Тор	-40 ~ +85	°C

# **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Min.	Тур.	Max.	Unit
Power Supply Voltage	Vcc	4.5	5	5.5	V
Operating Temperature	Тор	-40	+25	+85	°C
"L" Input Voltage	VIL	-0.3		+0.8	v
"H" Output Voltage	VIH	2.2		V <sub>CC</sub> + 0.3	v
,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	VILR	-0.3		+0.8	v
,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	VIHR	3.0		V <sub>CC</sub> +0.3	v

# D.C. CHARACTERISTICS

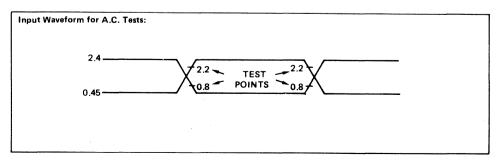
Parameter	Symbol	Conditions			Тур.	Max.	Unit
"L" Output Voltage	VOL	IOL = 2.5mA				0.4	v
"H" Output Voltage	Varia	IOH = -2.5mA		3.0			v
	∨он	IOH = -100µA		VCC -0.4			v
Input Leak Current	ILI	$0 \leq V_{IN} \leq V_{CC}$	$V_{CC} = 4.5V \sim 5.5V$ Ta = -40°C ~ +85°C	-10		10	μA
Output Leak Current	<sup>1</sup> LO	$0 \le V_{OUT} \le V_{CC}$		-10		10	μΑ
Operating Supply Current		Tcyc = 200ns CL = 0pF at reset			10	20	mA
	Icc	Tcyc = 200ns CL = 0pF at power down mode			5	10	mA

# A.C. CHARACTERISTICS

		(Ta = -40° C ~ 8		P	_
Parameter	Symbol	Condition	Min.	Max.	Unit
CLK Cycle Period	tCYC	1	200	2000	ns
CLK Low Time	t1	-	40		ns
CLK High Time	t2	1	70		ns
CLK Rise and Fall Time	t <sub>r</sub> , t <sub>f</sub>	1		30	ns
X <sub>1</sub> Rising to CLK Rising	<sup>t</sup> XKR		25	120	ns
X <sub>1</sub> Rising to CKK Falling	<sup>†</sup> XKF		30	150	ns
$A_8 \sim 15$ Valid to Leading Edge of Control (1)	<sup>t</sup> AC		115		ns
$A_0 \sim \frac{1}{2}$ Valid to Leading Edge of Control	<sup>t</sup> ACL		115		ns
A₀ ∼₁s Valid Data In	<sup>t</sup> AD			350	ns
Address Float After Leading Edge of RD INTA	<sup>t</sup> AFR			0	ns
$A_8 \sim_{15} Valid Before Trailing Edge of ALE (1)$	tAL		50		ns
$A_0 \sim_7 Valid Before Trailing Edge of ALE$	tALL		50		ns
READY Valid from Address Valid	<sup>t</sup> ARY			100	ns
Address (A8~15) Valid After Control	<sup>t</sup> CA		60		ns
Width of Control Law (RD, WR, INTA)	<sup>†</sup> CC	]	230		ns
Trailing Edge of Control to Leading Edge of ALE	<sup>t</sup> CL		25		ns
Data Valid to Trailing Edge of WR	tDW		230		ns
HLDA to Bus Enable	<sup>t</sup> HABE	1		150	ns
Bus Float After HLDA	<sup>t</sup> HABF	t <sub>CYC</sub> = 200ns		150	ns
HLDA Valid to Trailing Edge of CLK	тнаск	CL = 150pF	40		ns
HOLD Hold Time	tHDH	1	0		ns
HOLD Step Up Time to Trailing Edge of CLK	tHDS	1	120		ns
INTR Hold Time	tinh	1	0		ns
INTR, RST and TRAP Setup Time to Falling Edge of CLK	tINS		150		ns
Address Hold Time After ALE	<sup>t</sup> LA		50		ns
Trailing Edge of ALE to Leading Edge of Control	*LC	1	60		ns
ALE Low During CLK High	<sup>t</sup> LCK	-	50		ns
ALE to Valid Data During Read	<sup>t</sup> LDR	1		270	ns
ALE to Valid Data During Write	tLDW	1		140	ns
ALE Width	tLL	1	80		ns
ALE to READY Stable	<sup>t</sup> LRY	1		30	ns
Trailing Edge of RD to Re-enabling of Address	TRAE	1	90		ns
RD (or INTA) to Valid Data	tRD	1		150	ns
Control Trailing Edge to Leading Edge of Next Control	<sup>t</sup> BV	1	220		ns
Data Hold Time After RD INTA (7)	<sup>t</sup> RDH	1	0		ns
READY Hold Time	<sup>t</sup> BYH	1	0		ns
READY Setup Time to Leading Edge of CLK	TRYS	1	100	-	ns
Data Valid After Trailing Edge of WR	twp	1	60		ns
LEADING Edge of WR to Data Valid	tWDL	-		20	ns

Notes: (1) A<sub>8</sub>~A<sub>15</sub> address Specs apply to IO/M, S<sub>0</sub>, and S<sub>1</sub> except A<sub>8</sub>~A<sub>15</sub> are undefined during T<sub>4</sub>~T<sub>8</sub> of OF cycle whereas IO/M, S<sub>0</sub>, and S<sub>1</sub> are stable.
 (2) Test conditions: (cycle 200ns C<sub>L</sub> = 150pF
 (3) For all output timing where C<sub>L</sub> = 150pF use the following correction factors: 25pF ≤ C<sub>L</sub> < 150pF: -0.10ns/pF 150pF < C<sub>L</sub> ≤ 150pF: +0.30ns/pF
 (4) Output timings are measured with purely capacitive load.
 (5) All timones are measured with purely capacitive load.

- (5) All timings are measured at output voltage V<sub>L</sub> = 0.8V, V<sub>H</sub> = 2.2V, and 1.5V with 10ns rise and fall time on inputs.
- on inputs.
  (6) To calculate timing specifications at other values of t<sub>CYC</sub> use Table 7.
  (7) Data hold time is guaranteed under all loading conditions.



## Table 7 Bus Timing Specification as a TCYC Dependent

		-40 C + 485 C, VCC - 4.5V	
		MSM80C85A-2	· · ·
<sup>t</sup> AL		(1/2)T — 50	MIN
<sup>t</sup> LA	-	(1/2)⊤ – 50	MIN
<sup>t</sup> LL	-	(1/2)⊤ – 20	MIN
<sup>t</sup> LCK		(1/2)T — 50	MIN
tLC.		(1/2)T — 40	MIN
<sup>t</sup> AD	_	(5/2 + N)T — 150	MAX
<sup>t</sup> RD	-	(3/2 + N)T — 150	MAX
<sup>t</sup> RAE	_	(1/2)T — 10	MIN
<sup>t</sup> CA	_	(1/2)T — 40	MIN
<sup>t</sup> DW	-	(3/2 + N)T — 70	MIN
tWD	-	(1/2)T - 40	MIN
tCC	-	(3/2 + N)T - 70	MI,N
<sup>t</sup> CL	-	(1/2)T — 75	MIN
<sup>t</sup> ARY	-	(3/2)T – 200	MAX
<sup>t</sup> HACK	-	(1/2)T — 60	MIN
<sup>t</sup> HABF	-	(1/2)T + 50	MAX
<sup>t</sup> HABE	-	(1/2)T + 50	MAX
<sup>t</sup> AC		(2/2)T - 85	MIN
tı		(1/2)⊤ – 60	MIN
t <sub>2</sub>	-	(1/2)⊤ — 30	MIN
<sup>t</sup> RV		(3/2)T - 80	MIN
tLDR	-	(2+N)T — 130	МАХ

 $(Ta = -40^{\circ}C \sim +85^{\circ}C, V_{CC} = 4.5V \sim 5.5V, C_{L} = 150pF)$ 

Note: N is equal to the total WAIT states.

T = tCYC

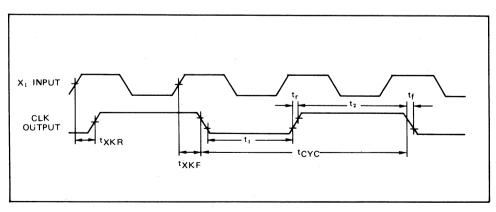
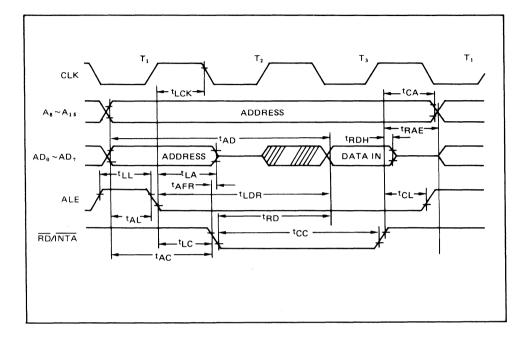
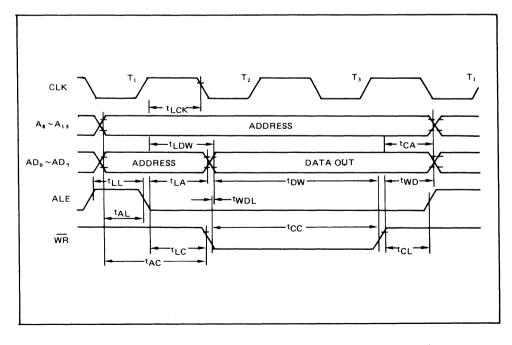


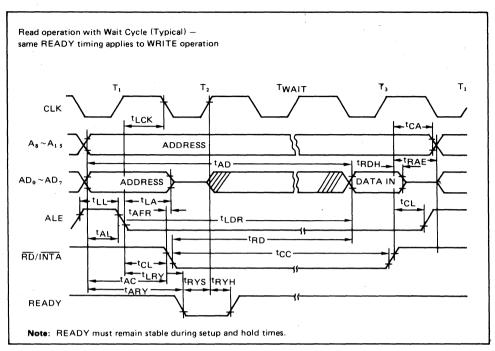
Figure 6 Clock Timing Waveform

# READ OPERATION

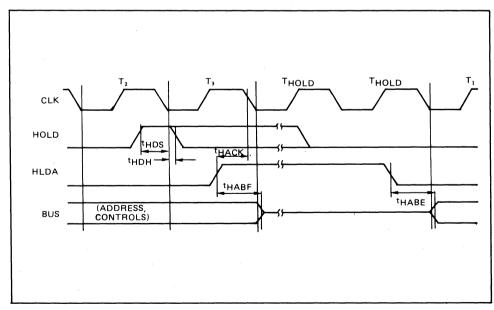


# WRITE OPERATION









# HOLD OPERATION



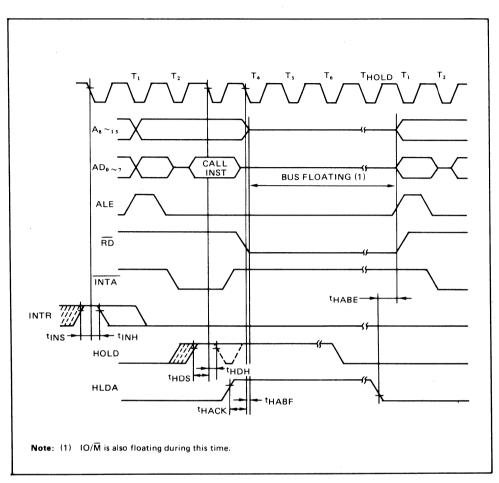


Figure 9 MSM80C85AH Interrupt and Hold Timing

## ■ CPU·MSM80C85AHRS/GS/JS ■

	Table 8 Instruc	1				n Co	de (1	)		
Mnemonic	Description	D <sub>7</sub>	D,	D <sub>5</sub>	D₄	D3		, D1	D,	Clock (2) Cycles
MOVE, LOAD		104			04	03	02	51	00	
MOVE, LOAD	Move register to register	0	1	D	D	D	s	s	s	4
MOV M r	Move register to register	ŏ	1	1	1	ō	s	s	s	7
MOVrM	Move memory to register	o	1	D	D	D	1	1	0	7
MVIr	Move immediate register	0	ò	D	D	D	1	1	0	7
MVIM	Move immediate register	0	o	1	1	0	1	1	0	10
LXIB		0	0	ò	o	0	0	ò	1	10
	Load immediate register Pair B & C	0	0	0	1	0	0	0	1	
	Load immediate register Pair D & E Load immediate register Pair H & L	-	-	-		-	-	-		10
	-	0	0	1	0	0	0	0	1	10
	Load immediate stack pointer	1	0	1	1	0	0	0	-1	10
STAX B	Store A indirect	0	0	0	0	0	0	1	0	7
STAX D	Store A indirect	0	0	0	1	0	0	1	0	7
LDAX B	Load A indirect	0	0	0	0	1	0	1	0	7
LDAX D	Load A indirect	0	0	0	1.	1	0	1	0	7
STA	Store A direct	0	0	1	1	0	0	1	0	13
LDA	Load A direct	0	0	1	1	1	0	1	0	13
SHLD	Store H & L direct	0	0	1	0	0	0	1	0	16
LHLD	Load H & L direct	0	0	1	0	1	0	1	0	16
XCHG	Exchange D & E H & L registers	1	1	1	0	1	0	1	1	4
STACK OPS										
PUSH B	Push register Pair B & C on stack	1	1	0	0	0	1	0	1	12
PUSH D	Push register Pair D & E on stack	1	1	0	1	0	1	0	1	12
PUSH H	Push register Pair H & L on stack	1	1	1,	0	0	1	0	1	12
PUSH PSW	Push A and Flags on stack	1	1	1	1	0	1	0	1	12
POP B	Pop register Pair B & C off stack	1	1	0	0	0	0	0	1	10
POP D	Pop register Pair D & E off stack	1	1	.0	1	0	0	0	1	10
РОР Н	Pop register Pair H & L off stack	1	1	1	0	0	0	0	1	10
POP PSW	Pop A and Flags off stack	1	1	1	1	0	0	0	1	10
XTHL	Exchange top of stack H & L	1	1	1	0	0	0	1	1	16
SPHL	H & L to stack pointer	1	1	1	1	Ť	Ō	0	1	6
JUMP										
JMP	Jump unconditional	1	1	0	0	0	0	1	1	10
JC	Jump on carry	1	1	0	1	1	ō	1	0	7/10
JNC	Jump on no carry	1	1	õ	1	ò	ŏ	1	ŏ	7/10
JZ	Jump on zero	1	1	õ	ò	1	ō	1.	ŏ	7/10
JNZ	Jump on no zero	1	1	õ	ō	ò	ō	1	õ	7/10
JP	Jump on positive	1	1	1	1	ŏ	ō	1	o	7/10
JM	Jump on minus	1	1	1	1	1	ō	1.	0	7/10
JPE	Jump on parity even	1	1	1	ò	1	o	1	0	7/10
JPO	Jump on parity odd	1	1	1	0	0	0	1	0	7/10
PCHL	H & L to program counter	1	1	1	0	1	0	0	1	6
CALL		<u> </u>						-		~
CALL	Call unconditional	1	1	0	0	1	1	0	1	18
CC	Call on carry	1	1	0	1	1	1	0	ó	9/18
CNC	Call on no carry	1	1	0	1	0	1	0	0	9/18 9/18
CZ	Call on ro carry Call on zero	1	1						_	
CNZ				0	0	1	1	0	0	9/18
	Call on no zero	1	1	0	0	0	1	0	0	9/18
CP	Call on positive	1	1	1	1	0	1	0	0	9/18
CM	Call on minus	1	1	1	1	1	1	0	0	9/18
CPE	Call on parity even	1	1	1	0	1	1	0	0	9/18
CPO	Call on parity odd	1	1	1	0	0	1	0	0	9/18

## Table 8 Instruction Set Summary

Mnemonic	Description			Instr	ructio	n Co	de(1)			Clock(2)
	Description	D7	D6	D₅	D₄	D3	D <sub>2</sub>	$D_1$	D₀	Cycles
RETURN										
RET	Return	1	1	0	0	1	0	0	1	10
RC	Return on carry	1	1	0	1	1	0	0	0	6/12
RNC	Return on no carry	1	1	0	1	0	0	0	0	6/12
RZ	Return on zero	1	1	0	0	1	0	0	0	6/12
RNZ	Return on no zero	1	1	0	0	0	0	0	0	6/12
RP	Return on positive	1	1	1	1	0	0	0	0	6/12
RM	Return on minus	1	1	1	1	1	0	0	0	6/12
RPE	Return on parity even	1	1	1	0	1	Ó	0	0	6/12
RPO	Return on parity odd	1	1	1	0	0	0	0	0	6/12
RESTART										
RST	Restart	1	1	А	А	А	1	1	1	12
INPUT/OUTPU	т									
IN	Input	1	1	0	1	1	0	1	1	10
OUT	Output	1	1	0	1	0	0	1	1	10
INCREMENT	AND DECREMENT									
INR r	Increment register	0	0	D	D	D	1	0	0	4
DCR r	Decrement register	0	0	D	D	D	1	0	1	4
INR M	Increment memory	0	0	1	1	0	1	0	0	10
DCR M	Decrement memory	0	0	1	1	0	1	0	1	10
INX B	Increment B & C registers	0	0	0	0	0	0	1	1	6
INX D	Increment D & E registers	0	0	0	1	0	0	1	1	6
INX H	Increment H & L registers	0	0	1	0	0	0	1	1	6
INX SP	Increment stack pointer	0	0	1	1	0	0	1	1	6
DCX B	Decrement B & C	0	0	0	0	1	0	1	1	6
DCX D	Decrement D & E	0	0	0	1	1	0	1	1	6
рсх н	Decrement H & L	0	0	1	0	1	0	1	1	6
DCX SP	Decrement stack pointer	0	0	1	1	1	0	1	1	6
ADD										
ADD r	Add register to A	1	0	0	0	0	S	s	S	4
ADC r	Add register to A with carry	1	0	0	0	1	s	s	s	4
ADD M	Add memory to A	1	0	0	0	0	1	1	0	7
ADC M	Add memory to A with carry	1	0	0	0	1	1	1	0	ว้
ADI	Add immediate to A	1	1	0	0	0	1	1	0	7
ACI	Add immediate to A with carry	1	1	ō	Ő	1	1	1	õ	7
DAD B	Add B & C to H & L	0	0 0	õ	Ő	1	0	o	1	10
DADD	Add D & E to H & L	ō	õ	õ	1	1	õ	ŏ	1	10
DADH	Add H & L to H & L	o	ŏ	1	0	1	ŏ	ō	1	10
DAD SP	Add stack pointer to H & L	0	0	1	1	1	0	õ	1	10
SUBTRACT										
SUB r	Subtract register from A	1	0	0	1	0	s	s	s	4
SBB r	Subtract register from A with borrow	1	0	0	1	1	S	s	S	4
SUB M	Subtract memory from A	1	0	õ	1	o o	1	1	õ	7
SBB M	Subtract memory from A with borrow	1	õ	õ	1	1	1	1	õ	7
SUI	Subtract immediate from A	1	1	õ	1	o	1	1	õ	, 7
SBI	Subtract immediate from A with	1	1	õ	1	1	1	1	ō	7
	borrow									

## Table 8 Instruction Set Summary cont'd

## ■ CPU·MSM80C85AHRS/GS/JS ■ -

Mnemonic	Deve factor			Instr	uctio	Instruction Code(1)							
winemonic	Description	D <sub>7</sub>	D <sub>6</sub>	D₅	D₄	D3	D <sub>2</sub>	D1	D,	Clock(2) Cycles			
LOGICAL													
ANA r	And register with A	1	0	1	0	0	S	S	S	4			
XRA r	Exclusive Or register with A	1	0	1	0	1	S	S	S	4			
ORA r	Or register with A	1	0	1	1	0	s	S	S	4			
CMP r	Compare register with A	1	0	1	1	1	S	S	S	4			
ANA M	And memory with A	1	0	1	0	0	1	1	0	7			
XRA M	Exclusive Or Memory with A	1	0	1	0	1	1	1	0	7			
ORA M	Or memory with A	1	0	1	1	0	1	1	0	7			
СМР М	Compare memory with A	1	0	1	1	1	1	1	0	7			
ANI	And immediate with A	1	1	1	0	0	1	1	0	7			
XRI	Exclusive Or immediate with A	1	1	1	0	1	1	1	0	7			
ORI	Or immediate with A	1	1	1	1	0	1	1	0	7			
CPI	Compare immediate with A	1	1	1	1	1	1	1	0	7			
ROTATE													
RLC	Rotate A left	0	0	0	0	0	1	1	1	4			
RRC	Rotate A right	0	0	Ō	Ō	1	1	1	1	4			
RAL	Rotate A left through carry	Ō	Ō	Ō	1	Ó	1	1	1	4			
RAR	Rotate A right through carry	0	0	Ō	1	1	1	1	1	4			
SPECIALS													
СМА	Complement A	0	0	1	0	1	1	1	1	4			
STC	Set carry	0	0	1	1	0	1	1	1	4			
CMC	Complement carry	0	Ō	1	1	1	1	1	1	4			
DAA	Decimal adjust A	0	0	1	0	Ó	1	1	1	4			
CONTROL													
EI	Enable Interrupts	1	1	1	1	1	0	1	1	4			
DI	Disable Interrupts	1	1	1	1	ò	ō	1	1	4			
NOP	No-operation	0	Ó	0 0	Ó	ō	ō	ò	o	4			
HLT	Halt (Power down)	0	1	1	1	õ	1	1	ō	5			
RIM	Read Interrupt Mask	0	o o	1	0	õ	o.	o	ŏ	4			
SIM	Set Interrupt Mask	0	õ	1	1	õ	õ	õ	ŏ	4			

### Table 8 Instruction Set Summary cont'd

Notes: (1) DDD or SSS. B 000. C 001. D 010. E 011. H 100. L 101. Memory 110. A 111.

(2) Two possible cycle times, (6/12) indicate instruction cycles dependent on condition flags.

Precautions for operation

- (1) When the oscillation circuit is to be used, keep the RES input low until the oscillation is sufficiently stabilized after power is turned on.
- (2) When power is turned on, the output level (SOD etc.) is irregular before the equipment is reset.

# **OKI** semiconductor MSM80C86ARS/GS/JS MSM80C86A-2RS/GS/JS

**16-BIT CMOS MICROPROCESSOR** 

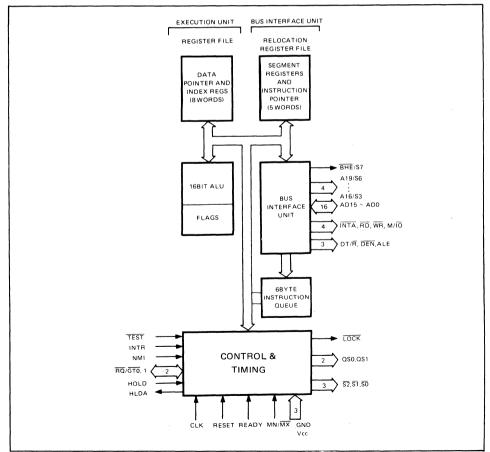
# **GENERAL DESCRIPTION**

The MSM80C86A/MSM80C86A-2 are complete 16-bit CPUs implemented in Silicon Gate CMOS technology. They are designed with same processing speed as the NMOS 8086/8086-2 but have considerably less power consumption. They are directly compatible with MSM80C88A/MSM80C88A-2 software and MSM80C85A/MSM80C85A-2 hardware and peripherals.

## FEATURES

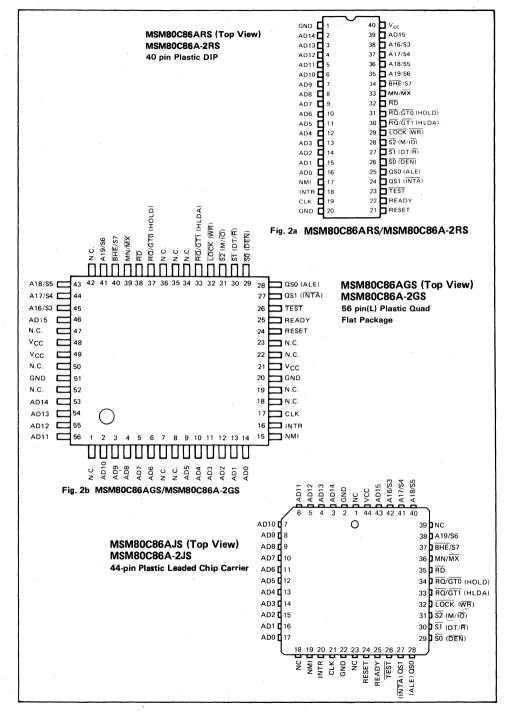
- 1 Mbyte Direct Addressable Memory Space
- Internal 14 Word by 16-bit Register Set
- 24 Operand Addressing Modes
- Bit, Byte, Word and String Operations
- 8 and 16-bit Signed and Unsigned Arithmetic Operation
- From DC to 5 MHz Clock Rate (MSM80C86A)
- From DC to 8 MHz Clock Rate (MSM80C86A-2)
- Low Power Dissipation 10 mA/MHz
- Bus Hold Circuitry Eliminates Pull-Up Resistors
- •40 pin Plastic DIP (DIP40-P-600)
- 44 pin PLCC(QFJ44-P-S650)
- 56 pin(L)-V Plastic QFP (QFP56-P-910-VK)

# CIRCUIT CONFIGURATION



J

## **PIN CONFIGURATION**



Parameter			MSM80C86AGS MSM80C86A-2GS	MSM80C86AJS MSM80C86A-2JS	Unit	Conditions		
Power Supply Voltage	Vcc		V					
Input Voltage	VIN		V	With respect				
Output Voltage	VOUT		-0.5 $\sim$ V <sub>CC</sub> +0.5					
Storage Temperature	Tstg		°C	-				
Power Dissipation	PD	1.0	w	Ta = 25° C				

# ABSOLUTE MAXIMUM RATINGS

## **OPERATING RANGE**

Parameter	Symbol	Lir	Limits					
Falaneter	Symbol	MSM80C86A	MSM80C86A-2	Unit				
Power Supply Voltage	Vcc	3 ~ 6	4.75 ~ 5.25	v				
Operating Temperature	Тор	-40 ~ +85	0 ~ +70	°c				

# RECOMMENDED OPERATING CONDITIONS

Paramotor	Combal	м	SM80C8	6A	MS	Unit		
Parameter	Symbol	MIN	ТҮР	MAX	MIN	TYP	MAX	Unit
Power Supply Voltage	V <sub>CC</sub>	4.5	5.0	5.5	4.75	5.0	5.25	v
Operating Temperature	TOP	-40	+25	+85	0	+25	+70	°C
"L" Input Voltage	VIL	-0.5		+0.8	-0.5		+0.8	V
"H" Input Voltage	(*1) V1H	V <sub>CC</sub> -0.8		V <sub>CC</sub> +0.5	V <sub>CC</sub> -0.8		V <sub>CC</sub> +0.5	v
	(*2)	2.0		V <sub>CC</sub> +0.5	2.0		V <sub>CC</sub> +0.5	V

\*1 Only CLK, \*2 Except CLK.

## DC CHARACTERISTICS

(MSM80C86A: V<sub>CC</sub> = 4.5V to 5.5V, Ta =  $-40^{\circ}$  to +85°C) (MSM80C86A-2: V<sub>CC</sub> = 4.75 to 5.25V, Ta =  $0^{\circ}$ C to +70°C)

Parameter	Symbol	MIN	TYP	MAX	Unit	Conditions
"L" Output Voltage	Vol			0.4	v	IOL = 2.5 mA
"H" Output Voltage	Voн	3.0			v	IOH = -2.5 mA
in Output voltage	VOH .	Vcc-0.4		1	, v	IOH = – 100 μA
Input Leak Current	· ILI ·	-1.0		+1.0	μA	0 < VI < V <sub>CC</sub>
Output Leak Current	ILO	-10		+10	μA	V <sub>O</sub> = V <sub>CC</sub> or GND
Input Leakage Current (Bus Hold Low)	IBHL	50		400	μA	V <sub>IN</sub> = 0.8V *3
Input Leakage Current (Bus Hold High)	Івнн	-50		-400	μΑ	VIN = 3.0V *4
Bus Hold Low Overdrive	IBHLO			600	μA	*5
Bus Hold High Overdrive	<sup>I</sup> внно			-600	μA	*6
Operating Power Supply Current	ICC .			10	mA/MHz	V <sub>IL</sub> = GND V <sub>IH</sub> = V <sub>CC</sub>
Standby Power Supply Current	Iccs			500	μΑ	V <sub>CC</sub> = 5.5V Outputs Unloaded V <sub>IN</sub> = V <sub>CC</sub> or GND
Input Capacitance	Cin		-	10	pF	*7
Output Capacitance	Cout			15	pF	*7
I/O Capacitance	CI/O			20	pF	*7

\*3 Test condition is to lower V  $_{\mbox{IN}}$  to GND and then raise V  $_{\mbox{IN}}$  to 0.8V on pins  $\,$  2–16, and 35–39

\*4 Test condition is to raise VIN to VCC and then lower VIN to 3.0V on pins 2-16, 26-32, and 34-39.

\*5 An external driver must source at least IBHLO to switch this node from LOW to HIGH.

\*6 An external driver must sink at least IBHHO to switch this node from HIGH to LOW.

\*7 Test Conditions: a) Freq = 1 MHz.

b) Ummeasured Pins at GND.

c) VIN at 5.0V or GND.

# A.C. CHARACTERISTICS

(MSM80C86A:  $V_{CC}$  = 4.5V to 5.5V, Ta = -40° C to +85° C) (MSM80C86A-2:  $V_{CC}$  = 4.75V to 5.25V, Ta = 0° C to 70° C)

## Minimum Mode System

Timing Requirements

Parameter	Symbol	MSM80	DC86A	MSM800	286A-2	Unit
Parameter	Symbol	Min.	Max.	Min.	Max.	Unit
CLK Cycle Period	TCLCL	200	DC	125	DC	ns
CLK Low Time	TCLCH	118		68		ns
CLK High Time	TCHCL	69		44		ns
CLK Rise Time (From 1.0V to 3.5V)	TCH1CH2		10		10	ns
CLK Fall Time (From 3.5V to 1.0V)	TCL2CL1		10		10	ns
Data in Setup Time	TDVCL	30		20		ns
Data in Hold Time	TCLDX	10		10		ns
RDY <sup>'</sup> Setup Time into MSM 82C84A (See Notes 1, 2)	TR1VCL	35		35		ns
RDY Hold Time into MSM 82C84A (See Notes 1, 2)	TCLR1X	0		0		ns
READY Setup Time into MSM80C86A	TRYHCH	118		68		ns
READY Hold Time into MSM80C86A-2	TCHRYX	30		20		ns
READY inactive to CLK (See Note 3)	TRYLCL	-8		-8		ns
HOLD Setup Time	тнусн	35		20		ns
INTR, NMI, TEST Setup Time (See Note 2)	тімусн	30		15		ns
Input Rise Time (Except CLK) (From 0.8V to 2.0V)	TILIH		15		15	ns
Input Fall Time (Except CLK) (From 2.0V to 0.8V)	TIHIL		15		15	ns

### Timing Responses

D	Sumbal	MSM80	DC86A	MSM80	C86A-2	Unit
Parameter	Symbol	Min.	Max.	Min.	Max.	
Address Valid Delay	TCLAV	10	110	10	60	ns
Address Hold Time	TCLAX	10		10		ns
Address Float Delay	TCLAZ	TCLAX	80	TCLAX	50	ns
ALE Width	TLHLL	TCLCH-20		TCLCH-10		ns
ALE Active Delay	TCLLH		80		50	ns
ALE Inactive Delay	TCHLL		85		55	ns
Address Hold Time to ALE Inactive	TLLAX	TCHCL-10		TCHCL-10		ns
Data Valid Delay	TCLDV	10	110	10	60	ns
Data Hold Time	тснох	10		10		ns
Data Hold Time after WR	TWHDX	TCLCH-30		TCLCH-30		ns
Control Active Delay 1	тсусту	10	110	10	70	ns
Control Active Delay 2	тснсти	10	110	10	60	ns
Control Inactive Delay	тсустх	10	110	10	70	ns
Address Float to RD Active	TAZRL	0		0		ns
RD Active Delay	TCLRL	10	165	10	100	ns

F

## CPU·MSM80C86ARS/GS/JS MSM80C86A-2RS/GS/JS

Parameter	Symbol	MSM80	C86A	MSM800	86A-2	Unit
Falainetei	Symbol	Min.	Max.	Min.	Max.	Onit
RD Inactive Delay	TCLRH	. 10	150	10	80	ns
RD Inactive to Next Address Active	TRHAV	TCLCL-45	•	TCLCL-40		ns
HLDA Valid Delay	TCLHAV	10	160	10	100	ns
RD Width	TRLRH	2TCLCL-75		2TCLCL-50		ns
WR Width	TWLWH	2TCLCL-60		2TCLCL-40		ns
Address Valid to ALE Low	TAVAL	TCLCH-60		TCLCH-40		ns
Output Rise Time (From 0.8V to 2.0V)	TOLOH		15		15	ns
Output Fall Time (From 2.0V to 0.8V)	TOHOL		15		15	ns

Notes: 1. Signal at MSM 82C84A or MSM 82C88 are shown for reference only.

2. Setup requirement for asynchronous signal only to guarantee recognition at next CLK.

3. Applies only to T2 state. (8 ns into T3)

## Maximum Mode System (Using MSM 82C88 Bus Controller) Timing Requirements

<b>P</b>		MSM8			MSM80C86A-2	
Parameter	Symbol	Min.			Min. Max.	
CLK Cycle Period	TCLCL	200	DC	125	DC	ns
CLK Low Time	TCLCH	118		68		ns
CLK High Time	TCHCL	69		44		ns
CLK Rise Time (From 1.0V to 3.5V)	TCH1CH2		10		10	ns
CLK Fall Time (From 3.5V to 1.0V)	TCL2CL1		10		10	ns
Data in Setup Time	TDVCL	30		20		ns
Data in Hold Time	TCLDX	10		10		ns
RDY Setup Time into MSM 82C84A (See Notes 1, 2)	TR1VCL	35		35		ns
RDY Hold Time into MSM 82C84A (See Notes 1, 2)	TCLR1X	0		0		ns
READY Setup Time into MSM 80C86A	TRYHCH	118		68		ns
READY Hold Time into MSM 80C86A	TCHRYX	30		20		ns
READY inactive to CLK (See Note 3)	TRYLCL	-8		-8		ns
Set up Time for Recognition (NMI, INTR, TEST) (See Note 2)	TINVCH	30		15		ns
RQ/GT Setup Time	TGVCH	30		15		ns
RQ Hold Time into MSM 80C86A	тснбх	40		30		ns
Input Rise Time (Except CLK) (From 0.8V to 2.0V)	TILIH		15		15	ns
Input Fall Time (Except CLK) (From 2.0 to 0.8V)	TIHIL		15		15	ns

## Timing Responses

De remente r	Cumbal	MSM80	MSM80C86A MSM80C86A-2		C86A-2	Unit	
Parameter	Symbol	Min.	Max.	Min.	Max.		
Command Active Delay (See Note 1)	TCLML	5	45	5	35	ns	
Command Inactive Delay (See Note 1)	TCLMH	5	45	5	45	ns	
READY Active to Status Passive (See Note 4)	TRYHSH		110		65	ns	
Status Active Delay	тснѕу	10	110	10	60	ns	
Status Inactive Delay	TCLSH	10	130	10	70	ns	
Address Valid Delay	TCLAV	10	110	10	60	ns	
Address Hold Time	TCLAX	10		10		ns	
Address Float Delay	TCLAZ	TCLAX	80	TCLAX	50	ns	
Status Valid to ALE High (See Note 1)	TSVLH		35		25	ns	
Status Valid to MCE High (See Note 1)	тѕумсн		35		30	ns	
CLK low to ALE Valid (See Note 1)	TCLLH		35		25	ns	
CLK Low to MCE High (See Note 1)	TCLMCH		35		25	ns	
ALE Inactive Delay (See Note 1)	TCHLL	4	35	4	25	ns	
Data Valid Delay	TCLDV	10	110	10	60	ns	
Data Hold Time	TCHDX	10		10		ns	

# ■ CPU·MSM80C86ARS/GS/JS MSM80C86A-2RS/GS/JS

Deserved	Symbol	MSM800	MSM80C86A MSM80C86A-2		C86A-2	Unit	
Parameter	Symbol	Min.	Max.	Min.	Max.	Unit	
Control Active Delay (See Note 1)	TCVNV	5	45	5	45	ns	
Control Inactive Delay (See Note 1)	TCVNX	5	45	5	45	ns	
Address Float to RD Active	TAZRL	0		0		ns	
RD Active Delay	TCLRL	10	165	10	100	ns	
RD Inactive Delay	TCLRH	. 10	150	10	80	ns	
RD Inactive to Next Address Active	TRHAV	TCLCL-45		TCLCL-40		ns	
Direction Control Active Delay (See Note 1)	TCHDTL		50		50	ns	
Direction Control Inactive Delay (See Note 1)	тснотн		35		30	ns	
GT Active Delay	TCLGL	0	85	0	50	ns	
GT Inactive Delay	TCLGH	0	85	0	50	ns	
RD Width	TRLRH	2TCLCL-75		2TCLCL-50		ns	
Output Rise Time (From 0.8V to 2.0V)	TOLOH		15		15	ns	
Output Fall Time (From 2.0V to 0.8V)	TOHOL		15		15	ns	

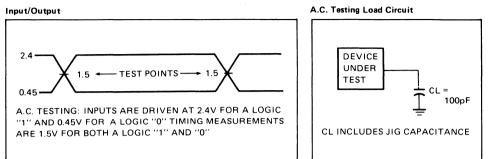
Notes: 1. Signal at MSM 82C84A or MSM 82C88 are shown for reference only.

2. Setup requirement for asynchronous signal only to guarantee recognition at next CLK.

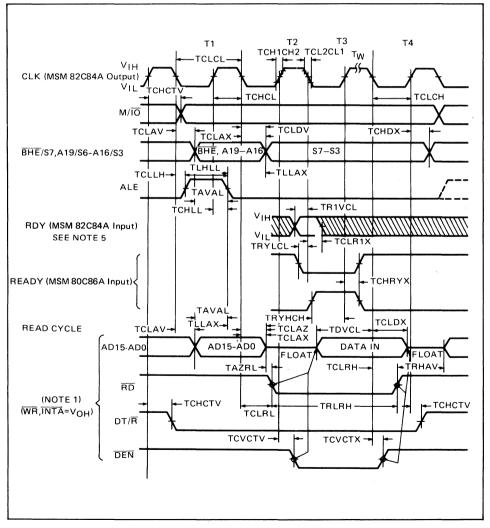
3. Applies only to T2 state (8 ns into T3)

4. Applies only to T3 and wait states.

# TIMING CHART



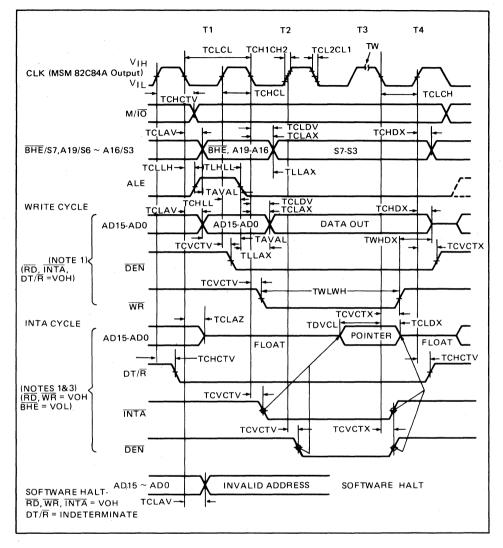
#### Minimum Mode

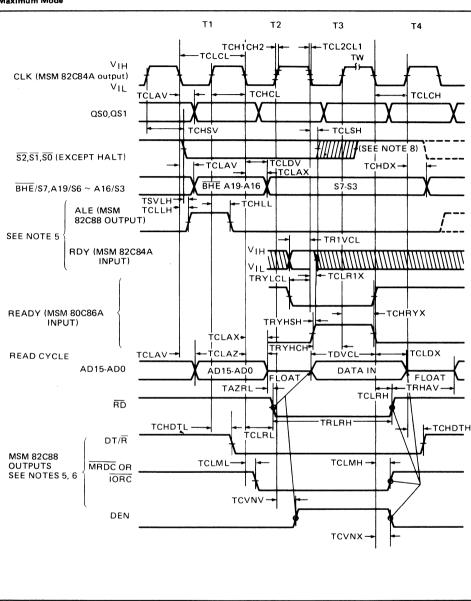


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## ■ CPU·MSM80C86ARS/GS/JS MSM80C86A-2RS/GS/JS ■--

Minimum Mode (Continued)

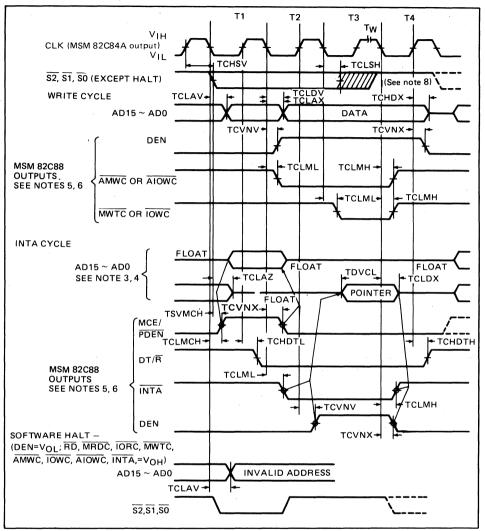




Maximum Mode

## CPU MSM80C86ARS/GS/JS MSM80C86A-2RS/GS/JS

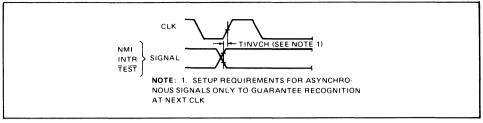
Maximum Mode (Continued)



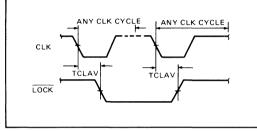
Notes: 1. All signals switch between VOH and VOL unless otherwise specified.

- 2. RDY is sampled near the end of T2,T3,TW to determine if TW machines states are to be inserted.
- 3. Cascade address is valid between first and second INTA cycle.
- 4 Two INTA cycles run back-to-back. The MSM 80C86A LOCAL ADDR/DATA BUS is floating during both INTA cycles. Control for pointer address is shown for second INTA cycle.
- 5. Signals at MSM 82C84A or MSM 82C88 are shown for reference only.
- The issuance of the MSM 82C88 command and control signals (MRDC, MWTC, AMWC, IORC, IOWC, AIOWC, INTA and DEN) lags the active high MSM 82C88 CEN.
- 7. All timing measurements are made at 1.5V unless otherwise noted.
- 8. Status inactive in state just prior to T4.

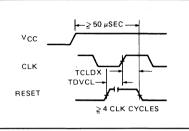
Asynchronous Signal Recognition



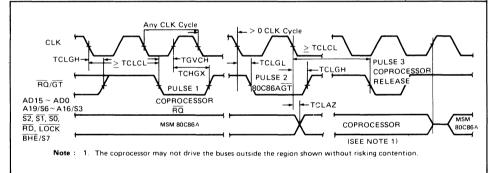
#### Bus Lock Signal Timing (Maximum Mode Only)

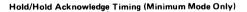


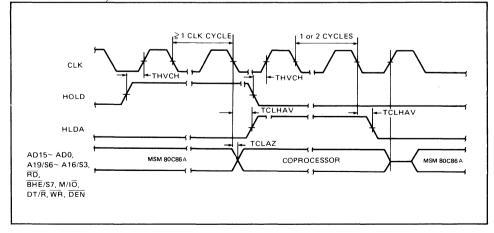




## Request/Grant Sequence Timing (Maximum Mode Only)







# 5

## **PIN DESCRIPTION**

#### AD0 - AD15

ADDRESS DATA BUS: Input/Output

These lines are the multiplexed address and data bus.

These are the address bus at the T1 cycle and the data bus at the T2, T3, TW and T4 cycles.

At the T1 cycle, AD0 low indicates Data Bus Low (D0 - D7) Enable. These lines are high impedance during interrupt acknowledge and hold acknowledge.

### A16/S3. A17/S4, A18/S5, A19/S6

ADDRESS/STATUS: Output

Tses are the four most significant addresses, at the T1 cycle. Accessing I/O port address, these are low at T1 cycles. These lines are Status lines at T2, T3, TW and T4 cycles. S3 and S4 are encoded as shown.

S3	S4	Characteristics		
c	0	Alternate Data		
1	Ó	Stack		
0	1	Code or None		
1	1	Data		

These lines are high impedance during hold acknowledge.

#### BHE/S7

BUS HIGH ENABLE/STATUS: Output

This line indicates Data Bus High Enable (BHE) at the T1 cycle.

This line indicates Data Bus High Enable (BHE) at the T1 cycles.

This line is status line at T2, T3, TW and T4 cycles.

## RD

READ: Output

This line indicates that CPU is in the memory or I/O read cycle.

This line is the read strobe signal when CPU read data from memory or I/O device.

This line is active low.

This line is high impedance during hold acknowledge.

### READY

#### **READY: Input**

This line indicates to the CPU that the addressed memory or I/O device is ready to read or write.

This line is active high.

If the setup and hold time is out of specification, illegal operation will occur.

#### INTR

INTERRUPT REQUEST: Input

This line is the level triggered interrupt request signal which is sampled during the last clock cycle of instruction and string manipulation.

It can be internally masked by software.

This signal is active high and internally synchronized.

#### TEST

#### **TEST:** Input

This line is examined by the WAIT instruction. When TEST is high, the CPU enters idle cycle. When TEST is low, the CPU exits the idle cycle.

#### NMI

NON MASKABLE INTERRUPT: Input

This line causes a type 2 interrupt.

NMI is not maskable.

This signal is internally synchronized and needs 2 clock cycles of pulse width.

#### RESET

RESET: Input

This signal causes the CPU to initialize immediately.

This signal is active high and must be at least four clock cycles.

## CLK

#### CLOCK: Input

This signal provides the basic timing for the internal circuit.

#### MN/MX

MINIMUM/MAXIMUM: Input

This signal selects the CPU's operating mode.

. When  $V_{\mbox{CC}}$  is connected, the CPU operates in Minimum mode.

Whin GND is connected, the CPU orerates Maximum mode.

#### Vcc

 $V_{CC}$ : +3 - +6V supplied.

#### GND

GROUND

The following pin function descriptions are maximum mode only.

Other pin functions are already described.

#### SO, S1, S2

STATUS: Output

These lines indicate bus status and they are used by the MSM82C88 Bus Controller to generate all memory and I/O access control signals.

These lines are high impedance during hold acknowledge.

These status lines are encoded as shown.

## CPU·MSM80C86ARS/GS/JS MSM80C86A-2RS/GS/JS

<u>52</u>	S1	<b>SO</b>	Characteristics
0 (LOW)	0	0	Interrupt acknowledge
0	0	1	Read I/O Port
0	1	0	Write I/O Port
0	1	1	Halt
1 (HIGH)	0	0	Code Access
1	0	1	Read Memory
1	1	0	Write Memory
1	1	1	Passive

#### RQ/GT0 RQ/GT1

REQUEST/GRANT: Input/Output

These lines are used for Bus Request from other devices and Bus GRANT to other deivces.

These lines are bidirectional and active low.

### LOCK

LOCK: Output

This line is active low.

When this line is low, other devices can not gain control of the bus.

This line is high impedance during hold acknowledge.

#### QS0/QS1

QUEUE STATUS: Output

These lines are Queue Status, and indicate internal instrucion queue status.

<sup>′</sup> QS1	QS0	Characteristics
0 (LOW)	0	No Operation
0	1	First Byte of Op Code from Queue
1 (HIGH)	0	Empty the Queue
1	1	Subsequent Byte from Queue

The following pin function descriptions are minimum mode only. Other pin functions are already described.

## M/IO

STATUS: Output

This line selects memory address space or I/O address space.

When this line is high, the CPU selects memory address space and when it is low, the CPU selects I/O address space.

This line is high impedance during hold acknow-ledge.

# WR

WRITE: Output

This line indicates that the CPU is in the memory or I/O write cycle.

This line is a write strobe signal when the CPU writes data to memory or I/O device.

This line is active low.

This line is high impedance during hold acknow-ledge.

#### INTA

INTERRUPT ACKNOWLEDGE: Output

This line is a read strobe signal for the interrupt acknowledge cycle.

This line is active low.

#### ALE

ADDRESS LATCH ENABLE: Output

This line is used for latching the address into the MSM82C12 address latch, It is a possitive pulse and its trailing edge is used to strobe the address, This line is never floated.

DT/R

DATA TRANSMIT/RECEIVE: Output

This line is used to control the output enable of the bus transceiver.

When this line is high, the CPU transmits data, and when it is low, the CPU receives data.

This line is high impedance during hold acknow-ledge.

#### DEN

DATA ENABLE: Output

This line is used to control the output enable of the bus transceiver.

This line is active low. This line is high impedance during hold acknowledge.

#### HOLD

HOLD REQUEST: Input

This line is used for Bus Request from other devices.

This line is active high.

#### HLDA

HOLD ACKNOWLEDGE: Output

This line is used for Bus Grant to other devices. This line is active high.

# FUNCTIONAL DESCRIPTION

# STATIC OPERATION

All MSM80C86A circuitry is of static design. Internal registers, counters and latches are static and require no refresh as with dynamic circuit design. This eliminates the minimum operating frequency restriction placed on other microprocessors. The MSM80C86A can operate from DC to the appropriate upper frequency limit. The processor clock may be stopped in either state (high/low) and held there indefinitely. This type of operation is especially useful for system debug or power critical applications.

The MSM80C86A can be single stepped using only the CPU clock. This state can be maintained as long as is necessary. Sigle step clock operation allows simple interface circuitry to provice critical information for bringing up your system.

Static design also allows very low frequency operation (down to DC). In a power critical situation, this can provide extremely low power operation since MSM80C86A power dissipation is directly related to operating frequency. As the system frequency is reduced, so is the operating power until, ultimately, at a DC input frequency, MSM80C86A power requirement is the standby current (500  $\mu$ A maximum).

#### **GENERAL OPERATION**

The internal function of the MSM80C86 consists of a Bus Interface Unit (BIU) and an Execution Unit (EU). These units operate mutually but perform as separate processors.

BIU performs instruction fetch and queueing, operand fetch, DATA read and write address relocation and basic bus control. Instruction pre-fetch is performed while waiting for decording and execution of instructions. Thus, the CPU's performance is increased. Up to 6-bytes of instruction stream can be queued.

The EU receives pre-fetched instructions from the BIU queue, decodes and executes the instructions, and provides the un-relocated operand address to BIU.

#### MEMORY ORGANIZATION

The MSM80C86A has a 20-bit address to memory. Each address has an 8-bit data width. Memory is organized 00000H to FFFFH and is logicaly divided into four segments: code, data, extra data and stack segment. Each segment contains up to 64 Kbytes and locates on a 16-byte boundary. (Fig. 3a)

All memory references are made relative to the segment register which functions in accordance with a select rule. Word operands can be located on even or odd address boundary.

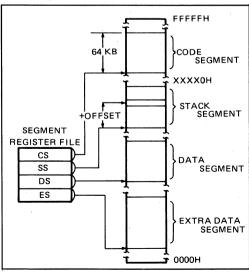
The BIU automatically performs the proper number of memory accesses. Memory consists of an even address and an odd address. Byte data of even address is transfered on the D0 – D7 and byte data of odd address is transfered on the D8 – D15.

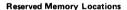
The CPU prevides two enable signals  $\overline{BHE}$  and A0 to access either an odd address, even address or both:

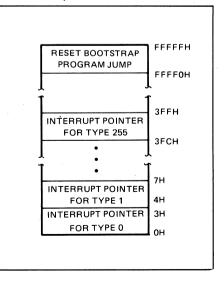
Memory location FFFOH is the start address after reset, and 00000H through 003FFH are reserved as an interrupt pointer, where there are 256 types of interrupt pointers.

Each interrupt type has a 4-byte pointer element consisting of a 16-bit segment address and a 16-bit offset address.

#### **Memory Organization**







# CPU·MSM80C86ARS/GS/JS MSM80C86A-2RS/GS/JS

Memory Reference Need	Segment Register Used	Segment Selection Rule
Instructions	CODE (CS)	Automatic with all instruction prefetch.
Stack	STACK (SS)	All stack pushes and pops. Memory references relative to BP base register except data references.
Local Data	DATA (DS)	Data references when relative to stack destination of str- ing operation, or explicitly overridden.
External (Global) Data	EXTRA (ES)	Destination of string operations: Explicitly selected us- ing a segment overriden.

#### MINIMUM AND MAXIMUM MODES

The MSM80C86A has two system modes: minimum and maximum. When using maximum mode, it is easy to organize a multi-CPU system with a 82C88 Bus Controller which generate the bus control signal.

When using minimum mode, it is easy to organize a simple system by generating bus control signal by itself.

 $MN\overline{/MX}$  is the mode select pin. Definition of 24-31 pin changes depend on the  $MN\overline{/MX}$  pin.

#### **BUS OPERATION**

The MSM80C86A has a time multiplexed address and data bus. If a non-multiplexed bus is desired for a system, it is only to add the address latch.

A CPU bus cycle consists of at least four clock cycles: T1, T2 T3 and T4. (Fig. 4)

The address output occurs during T1 and data transfer occurs during T3 and T4. T2 is used for changing the direction of the bus at the read operation. When the device which is accessed by the CPU is not ready for The data transfer and the CPU "NOT READY", TW cycles are inserted between T3 and T4.

When a bus cycle is not needed, T1 cycles are inserted between the bus cycles for internal execution. During the T1 cycle, the ALE signal is output from the CPU or the MSM82C88 depending on MN/MX. At the trailing edge of ALE, a valid address may be latched.

Status bits  $\overline{S0}$ ,  $\overline{S1}$  and  $\overline{S2}$  are used in the maximum mode by the bus controller to recognize the type of bus operation according to the following table.

S2	<u>S1</u>	SO	Characteristics
0 (LOW)	0	0	Interrupt acknowledge
0	0	1	Read I/O
0	1	0	Write I/O
0	1	1	Halt
1 (HIGH)	0	0	Instruction Fetch
1	0	1	Read Data from Memory
1	1	0	Write Data to Memory
1	1	1	Passive (no bus cycle)

Status bits S3 through S7 are multiplexed with A16  $\sim$  A19, and BHE: therefore, they are valid during T2 through T4.

S3 and S4 indicate which segment register was selected on the bus cycle, according to the following table.

S4	S3	Characteristics
0 (LOW)	0	Alternate Data (Extra segment)
0	1	Stack
1 (HIGH)	0	Code or None
1	1	Data

S5 indicates interrupt enable Flag.

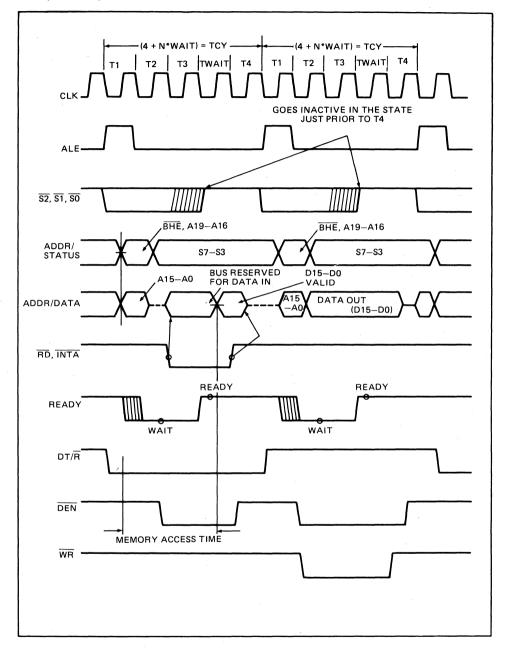
#### I/O ADDRESSING

The MSM80C86A has 64 Kbyte of I/O or as 32 Kwords I/O. When the CPU accesses an I/O device, addresses A0  $\sim$  A15 are in the same format as a memory address, and A16  $\sim$  A19 are low.

The I/O ports addresses are same as memory, so it is necessary to be careful when using 8-bit peripherals.

# CPU·MSM80C86ARS/GS/JS MSM80C86A-2RS/GS/JS

**Basic System Timing** 



5

# EXTERNAL INTERFACE

#### RESET

CPU Initalization is executed by the RESET pin. The MSM80C86A's RESET High signal is required for greater than 4 clock cycles.

The Rising edge of RESET terminates present operation immediately. The Falling edge of RESET triggers an internal reset sequence for approximately 10 clock cycles. Afer the internal reset sequence is finished normal operation occurs from absolute location FFFFOH.

#### INTERRUPT OPERATIONS

Interrupt Acknowledge Sequence

Interrupt operation is classified as software or hardware, and hardware interrupt is classified as nonmaskable or maskable.

An interrupt causes a new program location defined on the interrupt pointer table, according to the interrupt type. Absolute locations 00000H through 003FFH are reserved for the interrupt pointer table. The interrupt pointer table consists of 256-elements. Each element is 4 bytes in size and corresponds to an 8 bit type number which is sent from an interrupt interrupt request device during the interrupt acknow-ledge cycle.

#### NON-MASKABLE INTERRUPT (NMI)

The MSM80C86A has a Non-maskable Interrupt (NMI) which is of higher priority than the maskable interrupt request (INTR).

The NMI request pulse width needs a minimum of 2 clock cycles. The NMI will be serviced at the end of the current instruction or between string manipulations.

#### MASKABLE INTERRUPT (INTR)

The MSM80C86A provides another interrupt request (INTR) which can be masked by software. INTR is level triggered, so it must be held until the interrupt request is acknowledged.

INTR will be serviced at the end of the aurrent instruction or between string manipulations.

# | T1 | T2 | T3 | T4 |T| | T2 | T3 | T4 | ALE IOCK INTA AD0-AD15 FLOAT TYPE VECTOR

#### INTERRUPT ACKNOWLEDGE

During the interrupt acknowledge sequence, further interrupts are disabled. The interrupt enable bit is reset by any interrupt, after which the Flag register is automatically pushed onto the stack. During the acknowledge sequence, the CPU emits the lock signal from T2 of the first bus cycle to T2 of the second bus cycle. At second bus cyclees, byte is fetched from the external device as a vector which identified the type of interrupt. This vector is multiplied by four and used as a interrupt pointer address. (INTR only)

The Interrupt Return (IRET) instruction includes a Flag pop operation which returns the original interrupt enable bit when it restores the Flag.

#### HALT

When a Halt instruction is executed, the CPU enters the Halt state. An interrupt request or RESET will force the MSM80C86A out of the Halt state.

#### SYSTEM TIMING - MINIMUM MODE

A bus cycle begins T1 with an ALE signal. The trailing edge of ALE is used to latch the address. From T1 to T4 the M/IO signal indicates a memory or I/O operation. From T2 to T4, the address data bus changes the address bus to data bus.

The read  $(\overline{RD})$ , write  $(\overline{WR})$  and interrupt acknowledge  $(\overline{INTA})$  signals causes the addressed device to enable data bus. These signal becomes active at the beginning of T2 and inactive at the beginning of T4.

#### SYSTEM TIMING - MAXIMUM MODE

At maximum mode, the MSM82C88 Bus Controller is added to system. The CPU sends status information to the Bus Controller. Bus timing signals are generated by Bus Controller. Bus timing is almost the same as in the minimum mode.

# **BUS HOLD CIRCUITRY**

To avoid high current conditions caused by floating inputs to CMOS devices and to eliminate the need for pull-up/down resistors, "bus-hold" circuitry has been used on MSM80C86A pins 2–16, 26–32, and 34– 39 (Figures 6a, 6b). These circuits will maintain the last valid logic state if no driving source is present (i.e. an unconnected pin or a driving source which goes to a high impedance state). To overdrive the "bus hold" circuits, an external driver must be capable of supplying approximately 600  $\mu$ A minimum sink or source current at valid input voltage levels. Since this "bus hold" circuitry is active and not a "resistive" type element, the associated power supply current is negligible and power dissipation is significantly reduced when compared to the use of passive pull-up resistors.

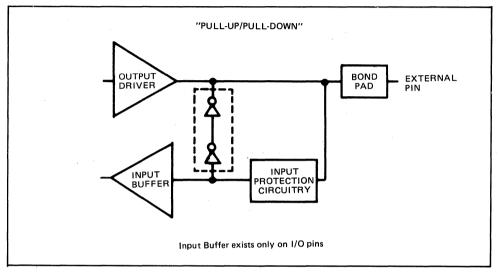


Figure 6a. Bus hold circuitry pin 2-16, 35-39.

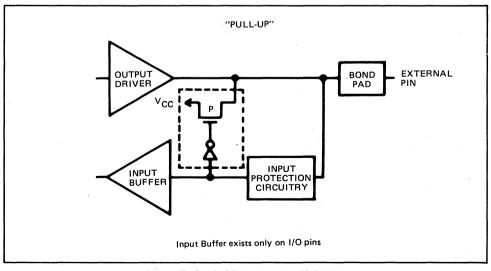


Figure 6b. Bus hold circuitry pin 26-32, 34

# DATA TRANSFER

MOV = Move:	7	6	5	4	3	2	1	0	76	5	4	3	2	1 0	7	6	5	i 4	3	2	1	0	7	6	5	4	3	2	1 0
Register/memory to/from register	1	0	0	0	1	0	d	w	mod		reg		r	/m															
Immediate to register/memory	1	1	0				1	w	mod	0	0	0	r	/m				data	э						c	lata	if	w =	< <b>1</b> -
Immediate to register	1	0	1	1	w	1	reg			c	data	•						da	ta i	fw	<b>i</b> = 1								
Memory to accumulator	1	0	1	0	0	0	0	w		а	ddr	-lov	v				â	addr	-hig	h									
Accumulator to memory	1	0	1	0	0	0	1	w		а	ddr	-lov	v				ł	addr	-hig	h									
Register/memory to segment register	1	0	0	0	1	1	1	0	mod	0	re	g	r	/m															
Segment register to register/memory	1	0	0	0	1	1	0	0	mod	0	re	g	r	'/m															
PUSH = Push:																													
Register/memory	1	1	1	1	1	1	1	1	mod	1	1	0	r	/m															
Register	0	1	0	1	0	1	reg																						
Segment register	0	0	0	re	g	1	1	0																					
POP = Pop:																													
Register/memory	1	0	0	0	1	1	1	1	mod	0	0	0	r	/m															
Register	0	1	0	1	1	1	reg																						
Segment register	0	0	0	re	g	1	1	1																					
XCHG = Exchange:																													
Register/memory with register	1	0	0	0	0	1	1	w	mod		reg		r	/m															
Register with accumulator	1	0	0	1	0	1	reg				-																		
IN = Input from:																					-								
Fixed port	1	1	1	0	0	1	0	w			рс	ort																	
Variable port	1						0	1																					
OUT = Output to:																													
Fixed port	1	1	1	0	0	1	1	w			pc	ort																	
Variable port	1	1	1	0	1	1	1	w																					
XLAT = Translate byte to AL	1	1	0	1	0	1	1	1																					
LEA = Load EA to register	1	0	0	0	1	1	0	1	mod		reg		r	/m									ł						
LDS = Load pointer to DS	1	1	0	0	0	1	0	1	mod		reg			/m															
LES = Load pointer to ES	1	1	0		0		0		mod		reg		r	'/m															
LAHF = Load AH with flags	1	0	0		1		1																						
SAHF = Store AH into flags	1		0				1																						
PUSHF = Push flags	1						0																						
POPF = Pop flags	1	0	0	1	1	1	0	1																					

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# ARITHMETIC

0	~												1
0	~												4
	0	0 (	0	0	0	d	w	mod		req	r/m		
1	0	0 0	0	0	0	s	w	mod	0	0 0	r/m	data	data if s:w = 01
0	0	0 (	D	0	1	0	w			data		data if w = 1	
-	-	-	-	-		-							
0	0	0	1	0	0	d	w	mod		rea	r/m		
1	0	0 0	Ó	0	0	s	w	mod	0			data	data if s:w = 01
0	-						1		-				
Č	Ũ	°.	•	Ŭ	•	°.				uutu			
1	1	1	1	1	1	1	w	mod	0	0 0	r/m		
0	1	0 (	С	0	re	eg							
0	0	1	1	0	1	ĭ	1						
-	٠.			-		<u></u>							
0	0	1 (	C	1	0	d	w	mod		reg	r/m		
1	0	0 0	) c	0	0	s	w	mod	1	0 1	r/m	data	data if s:w = 01
0	0	1 (	C	1	1	0	w			data		data if w = 1	
0	0	0	1	1	0	d	w	mod		reg	r/m		
1	0	0 (	<b>)</b>	0	0	s	w	mod	0	1 1	r/m	data	data if s:w = 01
0	0	o '	1	1	1	0	w			data		data if w = 1	
1	1	1 .	1	1	1	1	w	mod	0	0 1	r/m	• · · · ·	
0	1	0 (	)	1	r	eg							
1	1	1 .		0	1	1	w	mod	0	1 1	r/m		
0	0	1 .	1	1	0	d	w	mod		reg	r/m		
1	0	0 (	)	0	0	s	w	mod	1	1 1	r/m	data	data if s:w = 01
0	0	1 '	1	1	1	0	w			data		data if w = 1	
0	0	1 .	1	1	1	1	1						-
		$\begin{array}{c} 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 $		$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	0       0       0       1       0       0       0       0       0       0       1       0       0       0       1       0       0       0       1       0       1       0       0       0       1       0       1       0       1       0       1       0       1	0       0       1       0       0       d       w         0       0       0       0       0       s       w         0       0       1       0       1       0       1       w         1       1       1       1       1       1       1       w         0       0       1       0       0       reg       w         0       0       1       0       1       1       1       1         0       0       1       0       1       1       1       1       1         0       0       1       0       1       0       1       1       1         0       0       1       0       1       1       0       w       w         0       0       1       1       1       0       w	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$

IMUL = Integer multiply (signed)       1       1       1       1       1       1       1       1       1       1       1       1       1       1       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       0       1       0       1       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       0       1       0       1       0       1       0       1       0       1       0       1       0       0       1       0	DAS = Decimal adjust for subtract	0	0	1	0	1	1	1	1								
AAM = ASCII adjust for multiply       1       1       0       1       0       0       0       0       1       1       0         DIV = Divide (unsigned)       1       1       1       1       1       1       1       1       0       1       1       0       0       0       1       0       1       0       0       0       1       0       1       0       0       1       0       1       0       0       1       0	MUL = Multiply (unsigned)	1	1	1	1	0	1	1	w	mc	d	1	0	0		r/m	
DIV = Divide (unsigned)       1       1       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1       1       0       1 <td>IMUL = Integer multiply (signed)</td> <td>1</td> <td>1</td> <td>1</td> <td>1</td> <td>0</td> <td>1</td> <td>1</td> <td>w</td> <td>mc</td> <td>bd</td> <td>1</td> <td>0</td> <td>1</td> <td></td> <td>r/m</td> <td></td>	IMUL = Integer multiply (signed)	1	1	1	1	0	1	1	w	mc	bd	1	0	1		r/m	
DIV = Integer divide (signed)       1 <t< td=""><td>AAM = ASCII adjust for multiply</td><td>1</td><td>1</td><td>0</td><td>1</td><td>0</td><td>1</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>1</td><td>0</td><td>1</td><td>0</td></t<>	AAM = ASCII adjust for multiply	1	1	0	1	0	1	0	0	0	0	0	0	1	0	1	0
AAD = ASCII adjust for divide 1 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 0 0 0 1 0 1 0	DIV = Divide (unsigned)	1	-1	1	1	0	1	1	w	mc	d	1	1	0		r/m	
CBW = Convert byte to word 1 0 0 1 1 0 0 0	IDIV = Integer divide (signed)	1	1	1	1	0	1	1	w	mc	bd	1	1	1		r/m	
	AAD = ASCII adjust for divide	1	1	0	1	0	1	0	1	0	0	0	0	1	0	1	0
CWD = Convert word to double word         1         0         1         1         0         1	CBW = Convert byte to word	1	0	0	1	1	0	0	0								
	CWD = Convert word to double word	1	0	0	1	1	0	0	1								

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	1

# LOGIC

				_											
NOT = Invert	1	1	1	1	0	1	1	w	mod	0	1	0	r/m		
SHL/SAL = Shift logical/arithmetic left	1	1	0	1	0	0	v	w	mod	1	0	0	r/m		
SHR = Shift logical right	1	1	0	1	0	0	v	w	mod	1	0	1	r/m		
SAR = Shift arithmetic right	1	1	0	1	0	0	v	w		1		1	r/m		
ROL = Rotate left	1	1	0	1	0	0	v	w	mod	0	0	0	r/m		
ROR = Rotate right	1	1	0	1	0	0	v	w	mod	0	0	1	r/m		
RCL = Rotate left through carry	1	1	0	1	0	0	v	w	mod	0	1	0	r/m		
RCR = Rotate right through carry	1	1	0	1	0	0	v	w	mod	0	1	1	r/m		
AND = And:															
Reg./memory and register to either	0	0	1	0	0	0	d	w	mod			reg	r/m		
Immediate to register/memory	1	0	0	0	0	0	0	w	mod	1	0	Ō	r/m	data	data if w = 1
Immediate to accumulator	0	0	1	0	0	1	0	w			d	ata		data if w = 1	
TEST = And function to flags, no result:														~	
Register/memory and register	1	0	0	0	0	1	0	w	mod			reg	r/m		
Immediate data and register/memory	1	1	1	1	0	1	1	w	mod	0		ŏ	r/m	data	data if w = 1
Immediate data and accumulator	1	0	1	0	1	0	0	w			d	ata		data if w = 1	
OR = Or:															
Reg./memory and register to either	0	0	0	0	1	0	d	w	mod			reg	r/m		
Immediate to register/memory	1	0	0	0	0	0	0	w	mod	0			r/m	data	data if w = 1
Immediate to accumulator	0	0										ata		data if w = 1	
XOR = Exclusive or:															
Reg./memory and register to either	0	0	1	1	0	0	d	w	mod			reg	r/m		
Immediate to register/memory	1		0						mod	1		Ő	r/m	data	data if w = 1
Immediate to accumulator	0	0	1									ata		data if w = 1	
TRING MANIPULATION														I	
REP = Repeat	1	1	1	1	-	0		z							
	1 1	0	1	0		1		w							
MOVS = Move byte/word														1	
MOVS = Move byte/word CMPS = Compare byte/word	1	0	1			1		w							
	1	0	1 1			1 1		w							
CMPS = Compare byte/word	1 1 1	0 0 0	1 1		1 1	1 1	1 0	w w							

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CJMP = Conditional JMP			
JE/JZ = Jump on equal/zero	0 1 1 1 0 1 0 0	disp	
JZ/JNGE = Jump on less/not greater or equal	0 1 1 1 1 1 0 0	disp	
JLE/JNG = Jump on less or equal/not greater	0 1 1 1 1 1 0	disp	
JB/JNAE = Jump on below/not above or equal	0 1 1 1 0 0 1 0	disp	
JBE/JNA = Jump on below or equal/not above	0 1 1 1 0 1 1 0	disp	
JP/JPE = Jump on parity/parity even	0 1 1 1 1 0 1 0	disp	
JO = Jump on over flow	0 1 1 1 0 0 0 0	disp	
JS = Jump on sign	0 1 1 1 1 0 0 0	disp	
JNE/JNZ = Jump on not equal/not zero	0 1 1 1 0 1 0 1	disp	
JNL/JGE = Jump on not less/greater or equal	0 1 1 1 1 1 0 1	disp	
JNLE/JG = Jump on not less or equal/greater	0 1 1 1 1 1 1 1	disp	
JNB/JAE = Jump on not below/above or equal	0 1 1 1 0 0 1 1	disp	
JNBE/JA = Jump on not below or equal/above	0 1 1 1 0 1 1 1	disp	
JNP/JPO = Jump on not parity/parity odd	0 1 1 1 1 0 1 1	disp	
JNO = Jump on not overflow	0 1 1 1 0 0 0 1	disp	
JNS = Jump an not sign	0 1 1 1 1 0 0 1	disp	
LOOP = Loop CX times	1 1 1 0 0 0 1 0	disp	
LOOPZ/LOOPE = Loop while zero/equal	1 1 1 0 0 0 0 1	disp	
LOOPNZ/LOOPNE = Loop while not zero/equal	1 1 1 0 0 0 0 0	disp	
JCXZ = Jump on CX zero	1 1 1 0 0 0 1 1	disp	
INT = Interrupt:			
Type specified	1 1 0 0 1 1 0 1	type	
Туре 3	1 1 0 0 1 1 0 0		
INTO = Interrupt on overflow	1 1 0 0 1 1 1 0		
IRET = Interrupt return	1 1 0 0 1 1 1 1		
		1	1

# PROCESSOR CONTROL

CLC = Clear carry	1 1 1 1 1 0 0 0
CMC = Complement carry	
STC = Set carry	
CLD = Clear direction	
STD = Set direction	
CLI = Clear interrupt	
STI = Set interrupt	
HLT = Halt	
WAIT = Wait	
ESC = Escape (to external device)	1 1 0 1 1 x x x mod x x x r/m
LOCK = Bus lock prefix	1 1 1 1 0 0 0 0



CALL = Call:	7	6	5	4	3	2	1	0	76	5	4	1 :	3 2	2	1 0	7	6	5	5.	4	3	2	1	0	7	•	3	5	4	3	2	1	0
Direct within segment	1	1	1	0	1	0	0	0			dis	sp-l	ow						di	sp-l	higł	h											
Indirect within segment	1	1	1	1	1	1	1	1	mod	0	1	. (	0	ı	r/m																		
Direct intersegment	1	0	0	1	1	0	1	0		(	offs	set-	low	1					off	set	-hig	gh											
											seg	ġ-lo	w						se	}g-⊦	high	۱											
Indirect intersegment	1	1	1	1	1	1	1	1	mod	0	1		1	ľ	r/m																		
JMP = Unconditional Jump:																																	
Direct within segment	1	1	1	0	1	0	0	1			dis	ip-l	ow						di	sp-l	higł	h											
Direct within segment-short	1	1	1	0	1	0	1	1			c	dis	р																				
Indirect within segment	1	1	1	1	1	1	1	1	mod	1	0	) (	D	1	r/m																		
Direct intersegment	1	1	1	0	1	0	1	0		(	offs	set-	low	1					off	set	-hig	gh											
											se	eg-l	ow						se	}g-h	high	۱											
Indirect intersegment	1	1	1	1	1	1	1	1	mod	1	0	) '	1	r	r/m																		
RET = Return from CALL:																																	
Within segment	1	1	0	0	0	0	1	1																									
Within seg. adding immediate to SP	1	1	0	0	0	0	1	0			dat	ta-l	ow						da	ita-'	higl	h											
Intersegment	1	1	0	0	1	0	1	1																									
Intersegment adding immediate to SP	1	1	0	0	1	0	1	0			dat	ta-I	ow						da	ita-'	higl	h											

CPU·MSM80C86ARS/GS/JS MSM80C86A-2RS/GS/JS

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# CONTROL TRANSFER

#### Footnotes:

AL = 8-bit accumulator AX = 18-bit accumulator CX = Count register DS = Data segment ES = Extra segment Above/below refers to unsigned value Greater = more positive Less = less positive (more negative) signed value If d = 1 then "to" reg: If d = 0 then "from" reg. If w = 1 then word instruction: If w = 0 then byte instruction If mod = 11 then r/m is treated as a REG field If mod = 00 then DISP = 0\*, disp-low and disp-high are absent If mod = 01 then DISP = disp-low sign-extended to 16-bits, disp-high is absent If mod = 10 then DISP = disp-high: disp-low If r/m = 000 then EA = (BX) + (SI) + DISP If r/m = 001 then EA = (BX) + (DI) + DISP

If r/m = 010 then EA = (BP) + (SI) + DISP If r/m = 011 then EA = (BP) + (DI) + DISP If r/m = 100 then EA = (BI) + DISP If r/m = 101 then EA = (DI) + DISP If r/m = 110 then EA = (BP) + DISP\* If r/m = 111 then EA = (BX) + DISP DISP follows 2nd byte of instruction (before data if required) \* except if mod = 00 and r/m = 110 then EA-disp-high: disp-low

```
If s:w = 01 then 16 bits of immediate data form the operand
If s:w = 11 then an immediate data byte is sign extended to form the 16-bit operand
If v = 0 then "count" = 1: If v = 1 then "count" in (CL)
x = don't care
```

z is used for string primitives for comparison with ZF FLAG

#### SEGMENT OVERRIDE PREFIX

001 reg 110

REG is assigned according to the following table:

16-Bit	(w = 1)	8-Bit	(w = 0)	Segment
000	AX	000	AL	00 ES
001	сх	001	CL	01 CS
010	DX	010	DL	10 SS
011	BX	011	BL	11 DS
100	SP	100	AH	
101	BP	101	СН	
110	SI	110	DH	
111	DI	111	вн	

Instructions which reference the flag register file as a 16-bit object use the symbol FLAGS to represent the file:

FLAGS = x:x:x:(OF):(DF):(IF):(TF):(SF):(ZF):X:(AF):X:(PF):X:(CF)

# **OKI** semiconductor

# MSM80C86A-10RS/GS/JS

# **16-BIT CMOS MICROPROCESSOR**

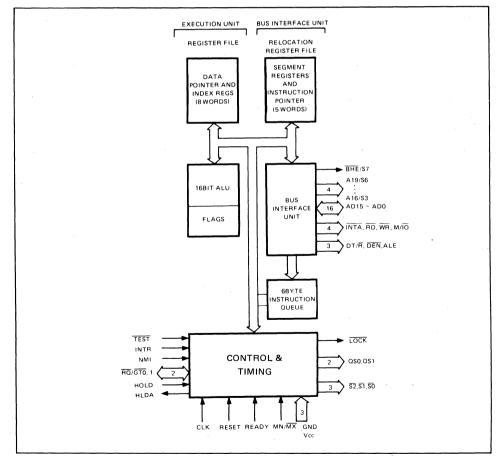
# **GENERAL DESCRIPTION**

The MSM80C86A-10 are complete 16-bit CPUs implemented in Silicon Gate CMOS technology. They are designed with same processing speed as the NMOS 8086-1 but have considerably less power consumption. They are directly compatible with MSM80C88A-10 software and MSM80C85A/MSM80C85A-2 hardware and peripherals.

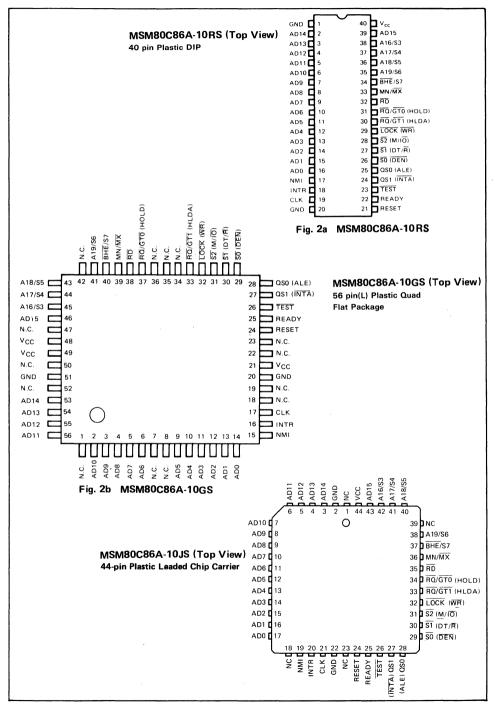
#### FEATURES

- 1 Mbyte Direct Addressable Memory Space
- Internal 14 Word by 16-bit Register Set
- 24 Operand Addressing Modes
- Bit, Byte, Word and String Operations
- 8 and 16-bit Signed and Unsigned Arithmetic Operation
- From DC to 10 MHz Clock Rate
- Low Power Dissipation 10 mA/MHz
- Bus Hold Circuitry Eliminates Pull-Up Resistors
- •40 pin Plastic DIP (DIP40-P-600)
- •44 pin PLCC (QFJ44-P-S650)
- •56 pin(L)-V Plastic QFP (QFP56-P-910-VK)

# CIRCUIT CONFIGURATION



# **PIN CONFIGURATION**



# CPU·MSM80C86A-10RS/GS/JS

#### Limits Symbol Unit Conditions Parameter MSM80C86A-MSM80C86A-MSM80C86A-10RS 10GS 10JS Vcc -0.5 ~ +7 Power Supply Voltage v With respect ٧ Input Voltage VIN –0.5 $\sim$ V<sub>CC</sub> +0.5 to GND Output Voltage -0.5 $\sim$ V<sub>CC</sub> +0.5 v Vouт -65 ~ +150 °C Storage Temperature Tstg \_ w Ta = 25° C 1.0 0.7 **Power Dissipation** PD

# ABSOLUTE MAXIMUM RATINGS

# **OPERATING RANGE**

Parameter	Symbol	Limits	Unit
rarameter	Symbol	MSM80C86A-10	Unit
Power Supply Voltage	Vcc	4.75 ~ 5.25	v
Operating Temperature	Т <sub>ОР</sub>	0 ~ +70	°C

# **RECOMMENDED OPERATING CONDITIONS**

D	Gumbal	MS			
Parameter	Symbol	MIN	TYP	MAX	Unit
Power Supply Voltage	Power Supply Voltage V <sub>CC</sub>		5.0	5.25	V
Operating Temperature	Тор	0	+25	+70	°C
"L" Input Voltage	VIL	-0.5		+0.8	V
"H" Input Voltage	(*1) VIH	V <sub>CC</sub> -0.8		V <sub>CC</sub> +0.5	v
	(*2)	2.0		V <sub>CC</sub> +0.5	V

\*1 Only CLK, \*2 Except CLK.

# DC CHARACTERISTICS

Parameter	Symbol	MIN	ТҮР	MAX	Unit	Conditions
"L" Output Voltage	VOL			0.4	V	IOL = 2.5 mA
"H" Output Voltage	VOH	3.0			v	IOH = -2.5 mA
	⊻ОН	Vcc-0.4			Ň	IOH = - 100 μA
Input Leak Current	ILI I	-1.0		+1.0	μA	0 < V <sub>IN</sub> < V <sub>CC</sub>
Output Leak Current	ILO	-10		+10	μA	V <sub>O</sub> = V <sub>CC</sub> or GND
Input Leakage Current (Bus Hold Low)	IBHL	50		400 µA		V <sub>IN</sub> = 0.8V *3
Input Leakage Current (Bus Hold High)	Івнн	-50		-400	μΑ	VIN = 3.0V *4
Bus Hold Low Overdrive	IBHLO			600	μA	*5
Bus Hold High Overdrive	<sup>і</sup> внно			-600	μA	*6
Operating Power Supply Current	<sup>I</sup> CC			10	mA/MHz	V <sub>IL</sub> = GND V <sub>IH</sub> = V <sub>CC</sub>
Standby Power Supply Current	ICCS			500	μΑ	V <sub>CC</sub> = 5.5V Outputs Unloaded V <sub>IN</sub> = V <sub>CC</sub> or GND
Input Capacitance	Cin			10	рF	*7
Output Capacitance	Cout			15	pF	*7
I/O Capacitance	CI/O			20	pF	*7

(MSM80C86A-10:  $V_{CC}$  = 4.75 to 5.25V, Ta = 0°C to +70°C)

\*3 Test condition is to lower VIN to GND and then raise VIN to 0.8V on pins 2-16, and 35-39

\*4 Test condition is to raise V<sub>IN</sub> to V<sub>CC</sub> and then lower V<sub>IN</sub> to 3.0V on pins 2–16, 26–32, and 34–39.

\*5 An external driver must source at least IBHLO to switch this node from LOW to HIGH.

\*6 An external driver must sink at least IBHHO to switch this node from HIGH to LOW.

\*7 Test Conditions: a) Freq = 1 MHz.

b) Ummeasured Pins at GND.

c) VIN at 5.0V or GND.

# A.C. CHARACTERISTICS

(MSM80C86A-10: V<sub>CC</sub> = 4.75V to 5.25V, Ta = 0°C to 70°C) Minimum Mode System

**Timing Requirements** 

Parameter	Symbol	MSM800	Unit	
Farameter	Symbol	Min.	Max.	Unit
CLK Cycle Period	TCLCL	100	DC	ns
CLK Low Time	TCLCH	46		ns
CLK High Time	TCHCL	44		ns
CLK Rise Time (From 1.0V to 3.5V)	тсн1сн2		10	ns
CLK Fall Time (From 3.5V to 1.0V)	TCL2CL1		10	ns
Data in Setup Time	TDVCL	20		ns
Data in Hold Time	TCLDX	10		ns
RDY Setup Time into MSM 82C84A (See Notes 1, 2)	TR1VCL	35		ns
RDY Hold Time into MSM 82C84A (See Notes 1, 2)	TCLR1X	0		ns
READY Setup Time into MSM80C86A	TRYHCH	33		· ns
READY Hold Time into MSM80C86A	TCHRYX	20		ns
READY inactive to CLK (See Note 3)	TRYLCL	-8		ns
HOLD Setup Time	тнусн	20		ns
INTR, NMI, TEST Setup Time (See Note 2)	тімусн	15		ns
Input Rise Time (Except CLK) (From 0.8V to 2.0V)	TILIH		15	ns
Input Fall Time (Except CLK) (From 2.0V to 0.8V)	TIHIL		15	ns

#### Timing Responses

Parameter	Symbol	MSM800	MSM80C86A-10		
Parameter	Symbol	Min.	Max.	Unit	
Address Valid Delay	TCLAV	10	60	ns	
Address Hold Time	TCLAX	10		ns	
Address Float Delay	TCLAZ	TCLAX	50	ns	
ALE Width	TLHLL	TCLCH-10		ns	
ALE Active Delay	TCLLH		40	ns	
ALE Inactive Delay	TCHLL		45	ns	
Address Hold Time to ALE Inactive	TLLAX	TCHCL-10		ns	
Data Valid Delay	TCLDV	10	60	ns	
Data Hold Time	TCHDX	10		ns	
Data Hold Time after WR	TWHDX	TCLCH-25		ns	
Control Active Delay 1	тсусту	10	55	ns	
Control Active Delay 2	тснсти	10	50	ns	
Control Inactive Delay	тсустх	10	55	ns	
Address Float to RD Active	TAZRL	0		ns	
RD Active Delay	TCLRL	10	70	ns	

Parameter	Symbol	MSM80C	Unit	
Farameter	Symbol	Min.	Max.	Unit
RD Inactive Delay	TCLRH	10	60	ns
<b>RD</b> Inactive to Next Address Active	TRHAV	TCLCL-35		ns
HLDA Valid Delay	TCLHAV	10	60	ns
RD Width	TRLRH	2TCLCL-40		ns
WR Width	TWLWH	2TCLCL-35		ns
Address Valid to ALE Low	TAVAL	TCLCH-35		ns
Output Rise Time (From 0.8V to 2.0V)	TOLOH		15	ns
Output Fall Time (From 2.0V to 0.8V)	TOHOL		15	ns

Notes: 1. Signal at MSM 82C84A or MSM 82C88 are shown for reference only.

2. Setup requirement for asynchronous signal only to guarantee recognition at next CLK.

3. Applies only to T2 state. (8 ns into T3)

Maximum Mode System (Using MSM 82C88 Bus Controller) Timing Requirements

Parameter	Cumbel	MSM80	C86A-10	Unit
Parameter	Symbol	Min.	Max.	Unit
CLK Cycle Period	TCLCL	100	DC	ns
CLK Low Time	TCLCH	46		ns
CLK High Time	TCHCL	44		ns
CLK Rise Time (From 1.0V to 3.5V)	TCH1CH2		10	ns
CLK Fall Time (From 3.5V to 1.0V)	TCL2CL1		10	ns
Data in Setup Time	TDVCL	20		ns
Data in Hold Time	TCLDX	10		ns
RDY Setup Time into MSM 82C84A (See Notes 1, 2)	TR1VCL	35		ns
RDY Hold Time into MSM 82C84A (See Notes 1, 2)	TCLR1X	0		ns
READY Setup Time into MSM 80C86A	TRYHCH	33		ns
READY Hold Time into MSM 80C86A	TCHRYX	20		ns
READY inactive to CLK (See Note 3)	TRYLCL	-8		ns
Set up Time for Recognition (NMI, INTR, TEST) (See Note 2)	тілусн	15		ns
RQ/GT Setup Time	TGVCH	15		ns
RQ Hold Time into MSM 80C86A	TCHGX	20		ns
Input Rise Time (Except CLK) (From 0.8V to 2.0V)	TILIH		15	ns
Input Fall Time (Except CLK) (From 2.0 to 0.8V)	TIHIL		15	ns

# Timing Responses

Parameter	Sumbol	MSM800	Unit	
Parameter	Symbol	Min.	Max.	Omt
Command Active Delay (See Note 1)	TCLML	5	35	ns
Command Inactive Delay (See Note 1)	TCLMH	5	45	ns
READY Active to Status Passive (See Note 4)	TRYHSH		45	ns
Status Active Delay	TCHSV	10	45	ns
Status Inactive Delay	TCLSH	10	60	ns
Address Valid Delay	TCLAV	10	60	ns
Address Hold Time	TCLAX	10		ns
Address Float Delay	TCLAZ	TCLAX	50	ns
Status Valid to ALE High (See Note 1)	TSVLH		25	ns
Status Valid to MCE High (See Note 1)	тѕумсн		30	ns
CLK low to ALE Valid (See Note 1)	TCLLH		25	ns
CLK Low to MCE High (See Note 1)	TCLMCH		25	ns
ALE Inactive Delay (See Note 1)	TCHLL	4	25	ns
Data Valid Delay	TCLDV	10	60	ns
Data Hold Time	тснох	10		ns

2	C	MSM800	MSM80C86A-10		
Parameter	Symbol	Min.	Max.	Unit	
Control Active Delay (See Note 1)	TCVNV	5	45	ns	
Control Inactive Delay (See Note 1)	TCVNX	5	45	ns	
Address Float to RD Active	TAZRL	0		ns	
RD Active Delay	TCLRL	10	70	ns	
RD Inactive Delay	TCLRH	10	60	ns	
RD Inactive to Next Address Active	TRHAV	TCLCL-35		ns	
Direction Control Active Delay (See Note 1)	TCHDTL		50	ns	
Direction Control Inactive Delay (See Note 1)	тснотн		30	ns	
GT Active Delay (See Note 5)	TCLGL	0	38	ns	
GT Inactive Delay	TCLGH	0	45	ns	
RD Width	TRLRH	2TCLCL-40		ns	
Output Rise Time (From 0.8V to 2.0V)	TOLOH		15	ns	
Output Fall Time (From 2.0V to 0.8V)	TOHOL		15	ns	

Notes: 1. Signal at MSM 82C84A or MSM 82C88 are shown for reference only.

Setup requirement for asynchronous signal only to guarantee recognition at next CLK.
 Applies only to T2 state (8 ns into T3)

4. Applies only to T3 and wait states.

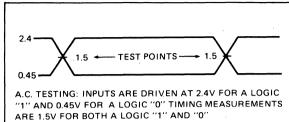
5.  $C_L = 40 pF (\overline{RQ}/\overline{GT}_0, \overline{RQ}/\overline{GT}_1)$ 

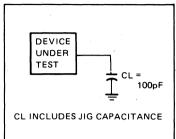
# ■ CPU·MSM80C86A-10RS/GS/JS ■

# TIMING CHART

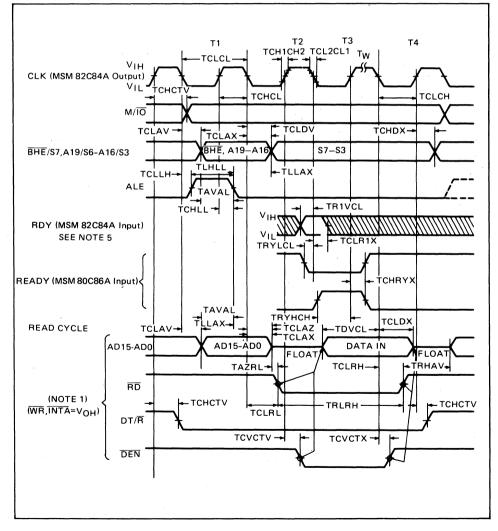
## Input/Output





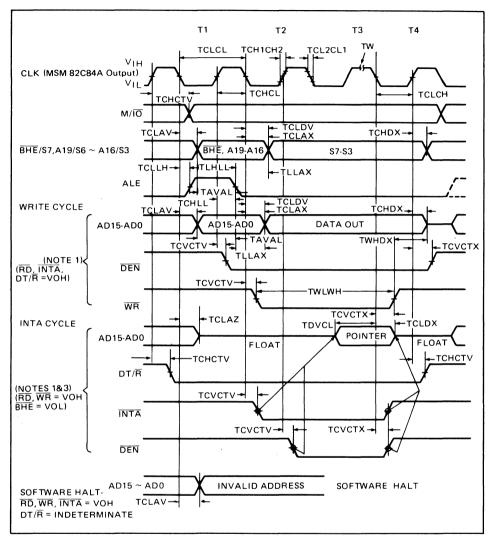


#### Minimum Mode



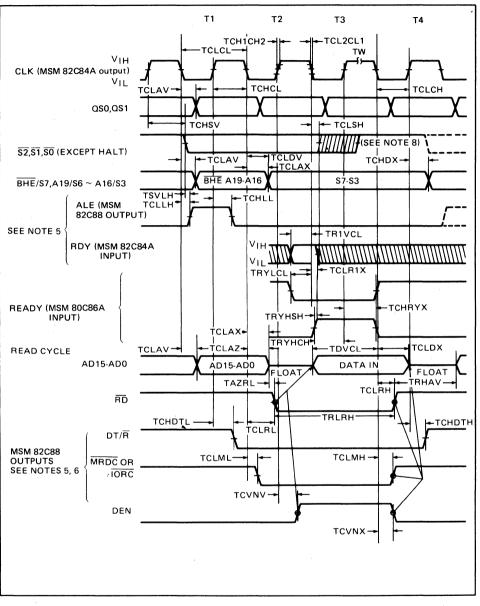
124

#### Minimum Mode (Continued)



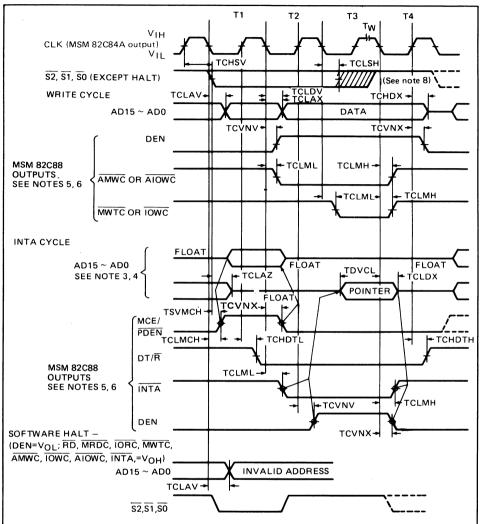
■ CPU·MSM80C86A-10RS /GS/JS ■

Maximum Mode



5

Maximum Mode (Continued)

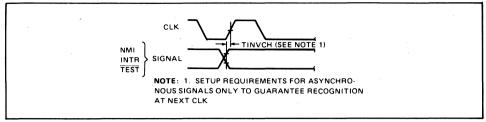


Notes: 1. All signals switch between VOH and VOL unless otherwise specified.

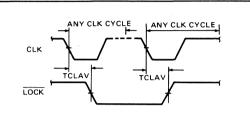
- 2. RDY is sampled near the end of T2,T3,TW to determine if TW machines states are to be inserted.
- 3. Cascade address is valid between first and second INTA cycle.
- Two INTA cycles run back-to-back. The MSM 80C86A LOCAL ADDR/DATA BUS is floating during both INTA cycles. Control for pointer address is shown for second INTA cycle.
- 5. Signals at MSM 82C84A or MSM 82C88 are shown for reference only.
- 6. The issuance of the MSM 82C88 command and control signals (MRDC, MWTC, AMWC, IORC, IOWC, AIOWC, INTA and DEN) lags the active high MSM 82C88 CEN.
- 7. All timing measurements are made at 1.5V unless otherwise noted.
- 8. Status inactive in state just prior to T4.

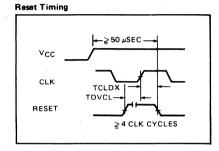
# CPU-MSM80C86A-10RS/GS/JS



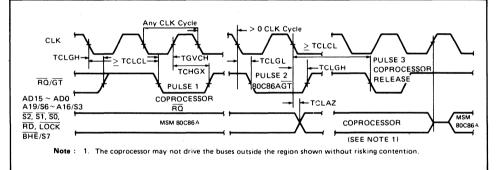


Bus Lock Signal Timing (Maximum Mode Only)

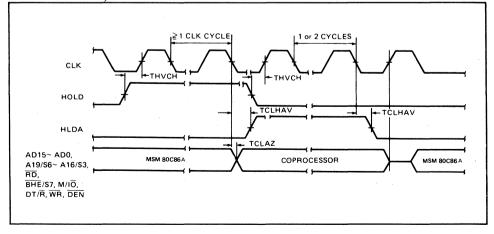




Request/Grant Sequence Timing (Maximum Mode Only)



#### Hold/Hold Acknowledge Timing (Minimum Mode Only)



# PIN DESCRIPTION

#### AD0 - AD15

ADDRESS DATA BUS: Input/Output

These lines are the multiplexed address and data bus.

These are the address bus at the T1 cycle and the data bus at the T2, T3, TW and T4 cycles.

At the T1 cycle, AD0 low indicates Data Bus Low (D0 - D7) Enable. These lines are high impedance during interrupt acknowledge and hold acknowledge.

#### A16/S3. A17/S4, A18/S5, A19/S6

#### ADDRESS/STATUS: Output

Tses are the four most significant addresses, at the T1 cycle. Accessing I/O port address, these are low at T1 cycles. These lines are Status lines at T2, T3, TW and T4 cycles. S3 and S4 are encoded as shown.

S3	S4	Characteristics
0	0	Alternate Data
1	0	Stack
0	1	Code or None
1	1	Data

These lines are high impedance during hold acknowledge.

#### BHE/S7

**BUS HIGH ENABLE/STATUS: Output** 

This line indicates Data Bus High Enable (BHE) at the T1 cycle.

This line indicates Data Bus High Enable (BHE) at the T1 cycles.

This line is status line at T2, T3, TW and T4 cycles.

#### RD

#### **READ: Output**

This line indicates that CPU is in the memory or I/O read cycle.

This line is the read strobe signal when CPU read data from memory or I/O device.

This line is active low.

This line is high impedance during hold acknow-ledge.

#### READY

#### **READY: Input**

This line indicates to the CPU that the addressed memory or I/O device is ready to read or write.

This line is active high.

If the setup and hold time is out of specification, illegal operation will occur.

#### INTR

#### INTERRUPT REQUEST: Input

This line is the level triggered interrupt request signal which is sampled during the last clock cycle of instruction and string manipulation.

It can be internally masked by software.

This signal is active high and internally synchronized.

#### TEST

#### **TEST:** Input

This line is examined by the WAIT instruction. When  $\overline{\text{TEST}}$  is high, the CPU enters idle cycle. When  $\overline{\text{TEST}}$  is low, the CPU exits the idle cycle.

#### NMI

NON MASKABLE INTERRUPT: Input

This line causes a type 2 interrupt.

NMI is not maskable.

This signal is internally synchronized and needs 2 clock cycles of pulse width.

#### RESET

**RESET:** Input

This signal causes the CPU to initialize immediately.

This signal is active high and must be at least four clock cycles.

#### CLK

CLOCK: Input

This signal provides the basic timing for the internal circuit.

#### MN/MX

MINIMUM/MAXIMUM: Input

This signal selects the CPU's operating mode.

When  $V_{\mbox{CC}}$  is connected, the CPU operates in Minimum mode.

Whin GND is connected, the CPU orerates Maximum mode.

#### Vcc

V<sub>CC</sub>: +5V supplied.

#### GND

GROUND

The following pin function descriptions are maximum mode only.

Other pin functions are already described.

#### S0, S1, S2

STATUS: Output

These lines indicate bus status and they are used by the MSM82C88 Bus Controller to generate all memory and I/O access control signals.

These lines are high impedance during hold acknowledge.

These status lines are encoded as shown.

<u>S2</u>	S1	SO	Characteristics
0 (LOW)	0	ò	Interrupt acknowledge
0	0	1	- Read I/O Port
0	1	0	Write I/O Port
0	1	- 1	Halt
1 (HIGH)	0	0	Code Access
1	0	1	Read Memory
1	1	0	Write Memory
<sup>-</sup> 1	1	1	Passive

#### RQ/GT0 RQ/GT1

REQUEST/GRANT: Input/Output

These lines are used for Bus Request from other devices and Bus GRANT to other deivces.

These lines are bidirectional and active low.

#### LOCK

LOCK: Output

This line is active low.

When this line is low, other devices can not gain control of the bus.

This line is high impedance during hold acknow-ledge.

#### QS0/QS1

QUEUE STATUS: Output

These lines are Queue Status, and indicate internal instrucion queue status.

QS1	QS0	Characteristics
0 (LOW)	0	No Operation
0	1	First Byte of Op Code from Queue
1 (HIGH)	0	Empty the Queue
1	1	Subsequent Byte from Queue

The following pin function descriptions are minimum mode only. Other pin functions are already described.

#### M/IO

STATUS: Output

This line selects memory address space or I/O address space.

When this line is high, the CPU selects memory address space and when it is low, the CPU selects I/O address space.

This line is high impedance during hold acknowledge.

# WR

#### WRITE: Output

This line indicates that the CPU is in the memory or I/O write cycle.

This line is a write strobe signal when the CPU writes data to memory or I/O device.

This line is active low.

This line is high impedance during hold acknowledge.

#### INTA

INTERRUPT ACKNOWLEDGE: Output

This line is a read strobe signal for the interrupt acknowledge cycle.

This line is active low.

#### ALE

ADDRESS LATCH ENABLE: Output

This line is used for latching the address into the MSM82C12 address latch, It is a possitive pulse and its trailing edge is used to strobe the address, This line is never floated.

#### DT/R

DATA TRANSMIT/RECEIVE: Output

This line is used to control the output enable of the bus transceiver.

When this line is high, the CPU transmits data, and when it is low, the CPU receives data.

This line is high impedance during hold acknowledge.

#### DEN

DATA ENABLE: Output

This line is used to control the output enable of the bus transceiver.

This line is active low. This line is high impedance during hold acknowledge.

#### HOLD

HOLD REQUEST: Input

This line is used for Bus Request from other devices.

This line is active high.

#### HLDA

HOLD ACKNOWLEDGE: Output

This line is used for Bus Grant to other devices. This line is active high.

# FUNCTIONAL DESCRIPTION

#### STATIC OPERATION

All MSM80C86A circuitry is of static design. Internal registers, counters and latches are static and require no refresh as with dynamic circuit design. This eliminates the minimum operating frequency restriction placed on other microprocessors. The MSM80C86A can operate from DC to the appropriate upper frequency limit. The processor clock may be stopped in either state (high/low) and held there indefinitely. This type of operation is especially useful for system debug or power critical applications.

The MSM80C86A can be single stepped using only the CPU clock. This state can be maintained as long as is necessary. Sigle step clock operation allows simple interface circuitry to provice critical information for bringing up your system.

Static design also allows very low frequency operation (down to DC). In a power critical situation, this can provide extremely low power operation since MSM80C86A power dissipation is directly related to operating frequency. As the system frequency is reduced, so is the operating power until, ultimately, at a DC input frequency, MSM80C86A power requirement is the standby current (500  $\mu$ A maximum).

#### GENERAL OPERATION

The internal function of the MSM80C86A consists of a Bus Interface Unit (BIU) and an Execution Unit (EU). These units operate mutually but perform as separate processors.

BIU performs instruction fetch and queueing, operand fetch, DATA read and write address relocation and basic bus control. Instruction pre-fetch is performed while waiting for decording and execution of instructions. Thus, the CPU's performance is increased. Up to 6-bytes of instruction stream can be queued.

The EU receives pre-fetched instructions from the BIU queue, decodes and executes the instructions, and provides the un-relocated operand address to BIU.

#### MEMORY ORGANIZATION

The MSM80C86A has a 20-bit address to memory. Each address has an 8-bit data width. Memory is organized 00000H to FFFFH and is logically divided into four segments: code, data, extra data and stack segment. Each segment contains up to 64 Kbytes and locates on a 16-byte boundary. (Fig. 3a)

All memory references are made relative to the segment register which functions in accordance with a select rule. Word operands can be located on even or odd address boundary.

The BIU automatically performs the proper number of memory accesses. Memory consists of an even address and an odd address. Byte data of even address is transfered on the D0 – D7 and byte data of odd address is transfered on the D8 – D15.

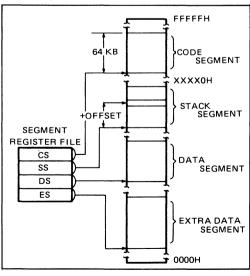
The CPU prevides two enable signals  $\overline{BHE}$  and A0 to access either an odd address, even address or both:

Memory location FFFFOH is the start address after reset, and 00000H through 003FFH are reserved as an interrupt pointer, where there are 256 types of interrupt pointers.

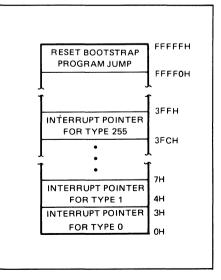
Each interrupt type has a 4-byte pointer element consisting of a 16-bit segment address and a 16-bit offset address.

5

Memory Organization



#### **Reserved Memory Locations**



CPU·MSM80C86A-10RS /GS/JS =

Memory Reference Need	Segment Register Used	Segment Selection Rule
Instructions	CODE (CS)	Automatic with all instruction prefetch.
Stack	STACK (SS)	All stack pushes and pops. Memory references relative to BP base register except data references.
Local Data	DATA (DS)	Data references when relative to stack destination of str- ing operation, or explicitly overridden.
External (Global) Data	EXTRA (ES)	Destination of string operations: Explicitly selected us- ing a segment overriden.

#### MINIMUM AND MAXIMUM MODES

The MSM80C86A has two system modes: minimum and maximum. When using maximum mode, it is easy to organize a multi-CPU system with a 82C88 Bus Controller which generate the bus control signal.

When using minimum mode, it is easy to organize a simple system by generating bus control signal by itself.

 $MN/\overline{MX}$  is the mode select pin. Definition of 24-31 pin changes depend on the  $MN/\overline{MX}$  pin.

#### **BUS OPERATION**

The MSM80C86A has a time multiplexed address and data bus. If a non-multiplexed bus is desired for a system, it is only to add the address latch.

A CPU bus cycle consists of at least four clock cycles: T1, T2 T3 and T4. (Fig. 4)

The address output occurs during T1 and data transfer occurs during T3 and T4. T2 is used for changing the direction of the bus at the read operation. When the device which is accessed by the CPU is not ready for The data transfer and the CPU "NOT READY", TW cycles are inserted between T3 and T4.

When a bus cycle is not needed, T1 cycles are inserted between the bus cycles for internal execution. During the T1 cycle, the ALE signal is output from the CPU or the MSM82C88 depending on  $MN/\overline{MX}$ . At the trailing edge of ALE, a valid address may be latched.

Status bits  $\overline{S0}$ ,  $\overline{S1}$  and  $\overline{S2}$  are used in the maximum mode by the bus controller to recognize the type of bus operation according to the following table.

<u>52</u>	S1	SO	Characteristics
0 (LOW)	0	0	Interrupt acknowledge
0	0	1	Read I/O
0	1	0	Write I/O
0	1	1	Halt
1 (HIGH)	0	0	Instruction Fetch
1	0	1	Read Data from Memory
1	1	0	Write Data to Memory
1	1	1	Passive (no bus cycle)

Status bits S3 through S7 are multiplexed with A16  $\sim$  A19, and BHE: therefore, they are valid during T2 through T4.

S3 and S4 indicate which segment register was selected on the bus cycle, according to the following table.

S4	S3	Characteristics
0 (LOW)	0	Alternate Data (Extra segment)
0	1	Stack
1 (HIGH)	0	Code or None
1	1	Data

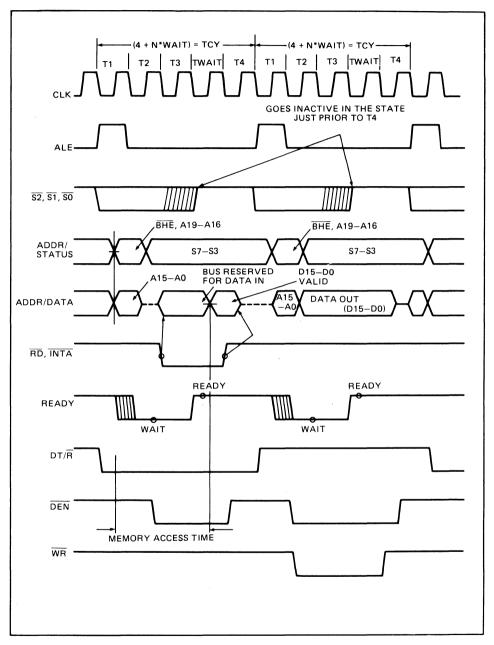
S5 indicates interrupt enable Flag.

#### I/O ADDRESSING

The MSM80C86A has 64 Kbyte of I/O or as 32 Kwords I/O. When the CPU accesses an I/O device, addresses A0  $\sim$  A15 are in the same format as a memory address, and A16  $\sim$  A19 are low.

The I/O ports addresses are same as memory, so it is necessary to be careful when using 8-bit peripherals.

Basic System Timing



#### CPU·MSM80C86A-10RS/GS/JS =

# **EXTERNAL INTERFACE**

#### RESET

CPU Initialization is executed by the RESET pin. The MSM80C86A's RESET High signal is required for greater than 4 clock cycles.

The Rising edge of RESET terminates present operation immediately. The Falling edge of RESET triggers an internal reset sequence for approximately 10 clock cycles. Afer the internal reset sequence is finished normal operation occurs from absolute location FFFFOH.

#### INTERRUPT OPERATIONS

Interrupt operation is classified as software or hardware, and hardware interrupt is classified as nonmaskable or maskable.

An interrupt causes a new program location defined on the interrupt pointer table, according to the interrupt type. Absolute locations 00000H through 003FFH are reserved for the interrupt pointer table. The interrupt pointer table consists of 256-elements. Each element is 4 bytes in size and corresponds to an

#### Interrupt Acknowledge Sequence

8 bit type number which is sent from an interrupt interrupt request device during the interrupt acknowledge cycle.

#### NON-MASKABLE INTERRUPT (NMI)

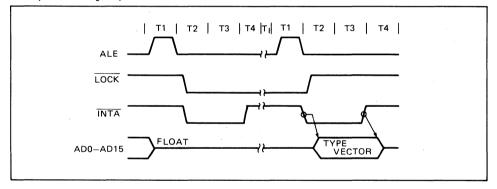
The MSM80C86A has a Non-maskable Interrupt (NMI) which is of higher priority than the maskable interrupt request (INTR).

The NMI request pulse width needs a minimum of 2 clock cycles. The NMI will be serviced at the end of the current instruction or between string manipulations.

#### MASKABLE INTERRUPT (INTR)

The MSM80C86A provides another interrupt request (INTR) which can be masked by software. INTR is level triggered, so it must be held until the interrupt request is acknowledged.

INTR will be serviced at the end of the aurrent instruction or between string manipulations.



#### INTERRUPT ACKNOWLEDGE

During the interrupt acknowledge sequence, further interrupts are disabled. The interrupt enable bit is reset by any interrupt, after which the Flag register is automatically pushed onto the stack. During the acknowledge sequence, the CPU emits the lock signal from T2 of the first bus cycle to T2 of the second bus cycle. At second bus cyclees, byte is fetched from the external device as a vector which identified the type of interrupt. This vector is multiplied by four and used as a interrupt pointer address. (INTR only)

The Interrupt Return (IRET) instruction includes a Flag pop operation which returns the original interrupt enable bit when it restores the Flag.

#### HALT

When a Halt instruction is executed, the CPU enters the Halt state. An interrupt request or RESET will force the MSM80C86A out of the Halt state.

#### SYSTEM TIMING - MINIMUM MODE

A bus cycle begins T1 with an ALE signal. The trailing edge of ALE is used to latch the address. From T1 to T4 the  $M/\overline{10}$  signal indicates a memory or I/O operation. From T2 to T4, the address data bus changes the address bus to data bus.

The read  $(\overline{RD})$ , write  $(\overline{WR})$  and interrupt acknowledge  $(\overline{INTA})$  signals causes the addressed device to enable data bus. These signal becomes active at the beginning of T2 and inactive at the beginning of T4.

#### SYSTEM TIMING - MAXIMUM MODE

At maximum mode, the MSM82C88 Bus Controller is added to system. The CPU sends status information to the Bus Controller. Bus timing signals are generated by Bus Controller. Bus timing is almost the same as in the minimum mode.

CPU·MSM80C86A-10RS /GS/JS

# **BUS HOLD CIRCUITRY**

To avoid high current conditions caused by floating inputs to CMOS devices and to eliminate the need for pull-up/down resistors, "bus-hold" circuitry has been used on MSM80C86A pins 2-16, 26-32, and 34-39 (Figures 6a, 6b). These circuits will maintain the last valid logic state if no driving source is present (i.e. an unconnected pin or a driving source which goes to a high impedance state). To overdrive the "bus hold" circuits, an external driver must be capable of supplying approximately  $600 \ \mu$ A minimum sink or source current at valid input voltage levels. Since this "bus hold" circuitry is active and not a "resistive" type element, the associated power supply current is negligible and power dissipation is significantly reduced when compared to the use of passive pull-up resistors.

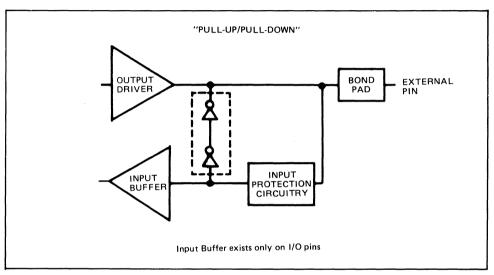


Figure 6a. Bus hold circuitry pin 2-16, 35-39.

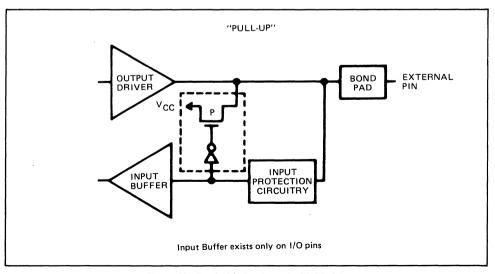


Figure 6b. Bus hold circuitry pin 26-32, 34

# DATA TRANSFER

MOV = Move:		7	-				2 1		· •	76	5		3	2 1		7	6	5	4	3	2	! 1	0	7	6	5	4	3	2	1	0
Register/memory to/from register	1	•	-		-		0 0			mod	re	-	_	r/m	1																
Immediate to register/memory		1	-	-			1 1		wr	mod	0		0	r/n	ו			0	data		_						data	a if	w	= 1	
Immediate to register		1 (		•		w	re	•			da											v ≈	1								
Memory to accumulator	1	1	2				0 (		w			dr-lo								hig											
Accumulator to memory		1	C		-	-	-		w			dr-le						а	đđr	-hig	jh										
Register/memory to segment register		-	-	-			1 1		-		0			r/m																	
Segment register to register/memory		1	5	0	0	1	1 (	) (	0 1	mod	0	reg		r/n	ו																
PUSH = Push:																															
Register/memory		1	1	1	1	1	1. 1	· ۱	1 1	mod	1	1	0	r/m	וו																
Register		0	1 (	0	1 (	0	re	g																							
Segment register		0	<b>)</b> (	0	reg		1 1	1 (	0																						
POP = Pop:																															
Register/memory		1	) (	0	0	1	1 1	۱ ·	1   1	mod	0	0	0	r/n	וו																
Register		0	1 (	0	1	1	re	g																							
Segment register		0	<b>)</b> (	0	reg		1 1	ī ·	1																						
					J									٠																	
XCHG = Exchange:																															
Register/memory with register		1 (	<b>)</b> (	0	0	0	1 1	۱ ۱	wr	mod	re	eg		r/n	ו ו																
Register with accumulator		1	)	0	1 (	0	re	g																							
IN = Input from:																															
Fixed port		1	1	1	0	0	1 (	) \	w		F	port	:																		
Variable port		1	1				1 (	) \	N		•																				
OUT = Output to:																															
		1		1	<u> </u>	<b>^</b> .					_																				
Fixed port						-					ţ	port	L																		
Variable port		1	•		-	-			w 1																						f
XLAT = Translate byte to AL	1	1 1 (		•		0								- /										1							1
LEA = Load EA to register		•	-	-	0				· ·	mod	re	-		r/m r/m																	
LDS = Load pointer to DS	1	1		-		-		) ' \		mod mod	re	-		r/m r/m																	
LES = Load pointer to ES	1	1.			0	0		) (		1100	re	:y		r/n	•																
LAHF = Load AH with flags	1	1.	-	0	1	1			· ·															1							
SAHF = Store AH into flags		1 (		-					-																						
PUSHF = Push flags		1			1			) (	·																						
POPF = Pop flags			, (	U	1	1	1 (		']																						

# ARITHMETIC

ADD = Add:														
Reg./memory with register to either	0	0	0	0	0	0	d	w	mod		req	r/m		
Immediate to register/memory	1	0	0	0	0	0		w		0	0 0		data	data if s:w = 01
Immediate to accumulator	0	0	0	Ō				w			data		data if w = 1	
ADC = Add with carry:										÷				
Reg./memory with register to either	0	0	0	1	0	0	d	w	mod		reg	r/m		
Immediate to register/memory	1	0	0	0	0	0	s	w	mod	0			data	data if s:w = 01
Immediate to accumulator	0	0	0	1	0	1	0	w			data		data if w = 1	
INC = Increment:														
Register/memory	1	1	1	1	1	1	1	w	mod	0	0 0	r/m		
Register	0	1	0	0	0	r	eg							
AAA = ASCII adjust for add	0	0	1	1	0	1	1	1						
DAA = Decimal adjust for add	0	0	1	0	0	1	1	1						
SUB = subtract:														
Reg./memory and register to either	0	0	1	0	1	0	d	w	mod		reg	r/m		
Immediate from register/memory	1	0	0	0	0	0	s	w	mod	1	0 1	r/m	data	data if s:w = 01
Immediate from accumulator	0	0	1	0	1	1	0	w			data		data if w = 1	
SBB = Subtract with borrow:														
Reg./memory and register to either	0	0	0	1	1	0	d	w	mod		reg	r/m		
Immediate from register/memory	1	0	0	0	0	0	s	w	mod	0	1 1	r/m	data	data if s:w = 01
Immediate from accumulator	0	0	0	1	1	1	0	w			data		data if w = 1	
DEC = Decrement:														
Register/memory						1	1	w	mod	0	01	r/m		
Register	0	1	0	0	1	I	reg							
NEG = Change sign	1	1	1	1	0	1	1	w	mod	0	11	r/m		
CMP = Compare:														
•	^	^	1	1	1	^	d		mad			- 1		
Register/memory and register Immediate with register/memory			0						mod mod	1	reg	r/m r/m	data	
Immediate with register/memory	•	-	1	-			s O	1	mod		data	r/m	data data if w = 1	data if s:w = 01
AAS = ASCII adjust for subtract	-	-	1								uata			
	0	0	1	•	1	•	•	1						



DAS = Decimal adjust for subtract	
MUL = Multiply (unsigned)	1 1 1 1 0 1 1 w mod 1 0 0 r/m
IMUL = Integer multiply (signed)	1 1 1 1 0 1 1 w mod 1 0 1 r/m
AAM = ASCII adjust for multiply	1 1 0 1 0 1 0 0 0 0 0 1 0 1 0
DIV = Divide (unsigned)	1 1 1 1 0 1 1 w mod 1 1 0 r/m
IDIV = Integer divide (signed)	1 1 1 1 0 1 1 w mod 1 1 1 r/m
AAD = ASCII adjust for divide	1 1 0 1 0 1 0 1 0 0 0 0 1 0 1 0
CBW = Convert byte to word	
CWD = Convert word to double word	

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# LOGIC

							_	_		_				
NOT = Invert	1	1	1	1	0	1	1	w	mod	0	1 0	r/m		
SHL/SAL = Shift logical/arithmetic left	1	1	0	1	0	0	v	w	mod	1	0 0	r/m		
SHR = Shift logical right	1	1	0	1	0	0	v	w	mod	1	01	r/m		
SAR = Shift arithmetic right	1	1	0	1	0	0	v	w	mod	1	1 1	r/m		
ROL = Rotate left	1	1	0	1	0	0	v	w	mod	0	0 0	r/m		
ROR = Rotate right	1	1	0	1	0	0	v	w	mod	0	01	r/m		
RCL = Rotate left through carry	1	1	0	1	0	0	v	w	mod	0	10	r/m		
RCR = Rotate right through carry	1	1	0	1	0	0	v	w	mod	0	1 1	r/m		
AND = And:														
Reg./memory and register to either	0	0	) 1	0	0	0	d	w	mod		reg	r/m		
Immediate to register/memory	1	0	) 0	0	0	0	0	w	mod	1	0 0	r/m	data	data if w = 1
Immediate to accumulator	0	0	) 1	0	0	1	0	w			data		data if w = 1	
TEST = And function to flags, no result:														
Register/memory and register	1	0	0	0	0	1	0	w	mod		reg	r/m		
Immediate data and register/memory	1	1	1	1	0	1	1	w	mod	0	0 0	r/m	data	data if w = 1
Immediate data and accumulator	1	0	) 1	0	1	0	0	w			data		data if w = 1	
OR = Or:														
Reg./memory and register to either	0	0	0	0	1	0	d	w	mod		reg	r/m		
Immediate to register/memory	1	0	0	0	0	0			mod	0		r/m	data	data if w = 1
Immediate to accumulator	0	0	0	0	1	1	0	w			data		data if w = 1	
XOR = Exclusive or:														
Reg./memory and register to either	0	0	1	1	0	0	d	w	mod		reg	r/m		
Immediate to register/memory	1	0	0	0	0	0	0	w	mod	1	1 0	r/m	data	data if w = 1
Immediate to accumulator	0	0	) 1	1	0	1	0	w			data		data if w = 1	
TRING MANIPULATION														4
REP = Repeat	1	1	1	1	0	0	1							
MOVS = Move byte/word	1	0	1	0	0	1	0	w						

REP = Repeat	1 1 1 1 0 0 1 z	
MOVS = Move byte/word	1 0 1 0 0 1 0 w	
CMPS = Compare byte/word	1 0 1 0 0 1 1 w	
SCAS = Scan byte/word	1010111w	
LODS = Load byte/word to AL/AX	1010110w	
STOS = Store byte/word from AL/AX	1 0 1 0 1 0 1 w	

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C	•	L	

## L

0	1	1	1	0	1	0	0	)	disp						
0	1	1	1	1	1	0	0		disp						
0	1	1	1	1	1	1	0	)	disp						
0	1	1	1	0	0	1	0		disp						
0	1	1	1	0	1	1	0	)	disp						
0	1	1	1	1	0	1	0		disp	-					
0	1	1	1	0	0	0	0		disp						
0	1	1	1	1	0	0	0		disp						
0	1	1	1	0	1	0	1		disp						
0	1	1	1	1	1	0	1		disp			~			
0	1	1	1	1	1	1	1		disp						
0	1	1	1	0	0	1	1		disp						
0	1	1	1	0	1	1	1		disp						
0	1	1	1	1	0	1	1		disp						
0	1	1	1	0	0	0	1		disp						
0	1	1	1	1	0	0	1		disp	1. Sec. 1. Sec					
1	1	1	0	0	0	1	0		disp		]				
1	1	1	0	0	0	0	1		disp						
1	1	1	0	0	0	0	0		disp						
1	1	1	0	0	0	1	1		disp						
1	1	0	0	1	1	0	1		type						
1	1	0	0	1	1	0	0								
1	1	0	0	1	1	1	0			2					
1	1	0	0	1	1	1	1				1			-	
		0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$ \begin{smallmatrix} 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 0 & 1 & 1 & 1 \\ 1 & 1 & 1 & 0 \\ 1 & 1 & 1 & 0 \\ 1 & 1 & 1 & 0 \\ 1 & 1 & 0 & 0 \\ 1 & 0 & 0 \\ 1$	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	0       1       1       1       1       0       0       disp         0       1       1       1       1       1       0       disp         0       1       1       1       0       0       0       disp         0       1       1       1       0       0       0       disp         0       1       1       1       0       1       0       disp         0       1       1       1       1       1       disp         0       1       1       1       1       1       disp         0       1       1       0       1       1       disp         0       1       1       0       0       1       disp         1       1	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	0       1       1       1       1       0       0         0       1       1       1       1       0       0       disp         0       1       1       1       1       0       disp         0       1       1       1       0       0       disp         0       1       1       1       0       1       0       disp         0       1       1       1       0       1       0       disp         0       1       1       1       0       0       0       disp         0       1       1       1       0       0       0       disp         0       1       1       1       0       1       disp         0       1       1       1       1       1       disp         1       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   1       1       0       0       1       disp         1       1       0	0       1       1       1       1       0       0         0       1       1       1       1       0       0       disp         0       1       1       1       0       0       disp         0       1       1       1       0       1       0       disp         0       1       1       0       1       0       disp         0       1       1       0       1       0       disp         0       1       1       0       0       0       disp         0       1       1       0       0       0       disp         0       1       1       1       0       1       disp         0       1       1       1       1       1       disp         1       1       0       0       1       disp         1       1       0       0       1

CPU-MSM80C86A-10RS/GS/JS

## PROCESSOR CONTROL

CLC = Clear carry	1 1 1 1 1 0 0 0
CMC = Complement carry	
STC = Set carry	1 1 1 1 0 0 1
CLD = Clear direction	1 1 1 1 1 0 0
STD = Set direction	
CLI = Clear interrupt	
STI = Set interrupt	
HLT = Halt	
WAIT = Wait	
ESC = Escape (to external device)	1 1 0 1 1 x x x mod x x x r/m
LOCK = Bus lock prefix	

## CONTROL TRANSFER

CALL = Call:	7	6	5	4	3	2	1	0	76	5	4	3	2	1	0	7	6	5	5	4	3	2	1	0	7	6	5	4	1 3	2	: 1	1 (
Direct within segment	1	1	1	0	1	0	0	0		d	lisp-	lov	N						di	sp-l	higl	h										
Indirect within segment	1	1	1	1	1	1	1	1	mod	0	1	0		r/m	۱ I																	
Direct intersegment	1	0	0	1	1	0	1	0		of	fset	t-lo	w						off	set	-hig	gh										
										s	seg-l	low	,						se	eg-h	nigh	۱										
Indirect intersegment	1	1	1	1	1	1	1	1	mod	0	1	1		r/m	n																	
JMP = Unconditional Jump:																																
Direct within segment	1	1	1	0	1	0	0	1		d	lisp-	lov	N						di	sp-l	higl	h										
Direct within segment-short	1	1	1	0	1	0	1	1			dis	sp																				
Indirect within segment	1	1	1	1	1	1	1	1	mod	1	0	0		r/m	.																	
Direct intersegment	1	1	1	0	1	0	1	0		of	fset	t-lo	w						off	set	-hig	gh										
											seg	-lov	N						se	eg-t	nigh	ı										
Indirect intersegment	1	1	1	1	1	1	1	1	mod	1	0	1		r/m	ו																	
RET = Return from CALL:																																
Within segment	1	1	0	0	0	0	1	1																								
Within seg. adding immediate to SP	1	1	0	0	0	0	1	0		d	ata-	lov	N						da	ita-	hig	h										
Intersegment	1	1	0	0	1	0	1.	1																								
Intersegment adding immediate to SP	1	1	0	0	1	0	1	0		d	ata-	lov	N						da	ita-	hig	h										
			_																													

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#### Footnotes:

AL = 8-bit accumulator AX = 18-bit accumulator CX = Count register DS = Data segment ES = Extra segment Above/below refers to unsigned value Greater = more positive Less = less positive (more negative) signed value If d = 1 then "to" reg: If d = 0 then "from" reg. If w = 1 then word instruction: If w = 0 then byte instruction

If mod = 11 then r/m is treated as a REG field If mod = 00 then DISP = 0\*, disp-low and disp-high are absent If mod = 01 then DISP = disp-low sign-extended to 16-bits, disp-high is absent If mod = 10 then DISP = disp-high: disp-low

```
If r/m = 000 then EA = (BX) + (SI) + DISP

If r/m = 001 then EA = (BX) + (DI) + DISP

If r/m = 010 then EA = (BP) + (SI) + DISP

If r/m = 011 then EA = (BP) + (DI) + DISP

If r/m = 100 then EA = (SI) + DISP

If r/m = 101 then EA = (DI) + DISP

If r/m = 110 then EA = (BP) + DISP

If r/m = 111 then EA = (BX) + DISP

DISP follows 2nd byte of instruction (before data if required)

* except if mod = 00 and r/m = 110 then EA-disp-high: disp-low
```

```
If s:w = 01 then 16 bits of immediate data form the operand
If s:w = 11 then an immediate data byte is sign extended to form the 16-bit operand
If v = 0 then "count" = 1: If v = 1 then "count" in (CL)
x = don't care
```

z is used for string primitives for comparison with ZF FLAG

SEGMENT OVERRIDE PREFIX

001 reg 110

REG is assigned according to the following table:

16-Bit	(w = 1)	8-Bit	(w = 0)	Segment
000	AX	000	AL	00 ES
001	СХ	001	CL	01 CS
010	DX	010	DL	10 SS
011	BX	011	BL	11 DS
100	SP	100	AH	
101	BP	101	СН	
110	SI	110	DH	
111	DI	111	BH	

Instructions which reference the flag register file as a 16-bit object use the symbol FLAGS to represent the file:

FLAGS = x:x:x:(OF):(DF):(IF):(TF):(SF):(ZF):X:(AF):X:(PF):X:(CF)

# **OKI** semiconductor MSM80C88ARS/GS/JS MSM80C88A-2RS/GS/JS

8-BIT CMOS MICROPROCESSOR

## **GENERAL DESCRIPTION**

The MSM80C88A/MSM80C88A-2 are internal 16-bit CPUs with 8-bit interface implemented in Silicon Gate CMOS technology. They are designed with the same processing speed as the NMOS 8088/8088-2, but with considerably less power consumption.

The processor has attributes of both 8 and 16-bit microprocessor. It is directly compatible with MSM80C86A/MSM80C86A-2 software and MSM80C85A/MSM80C85A-2 hardware and peripherals.

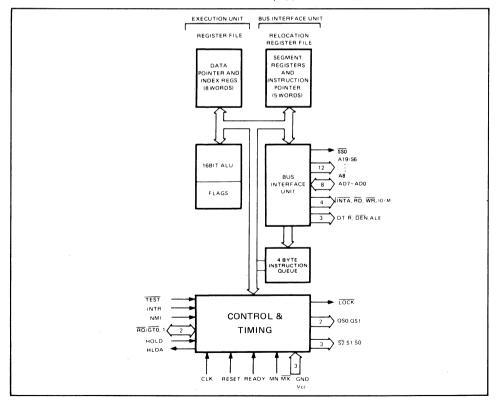
## FEATURES

- 8-Bit Data Bus Interface
- 16-Bit Internal Architecture
- 1 Mbyte Direct Addressable Memory Space

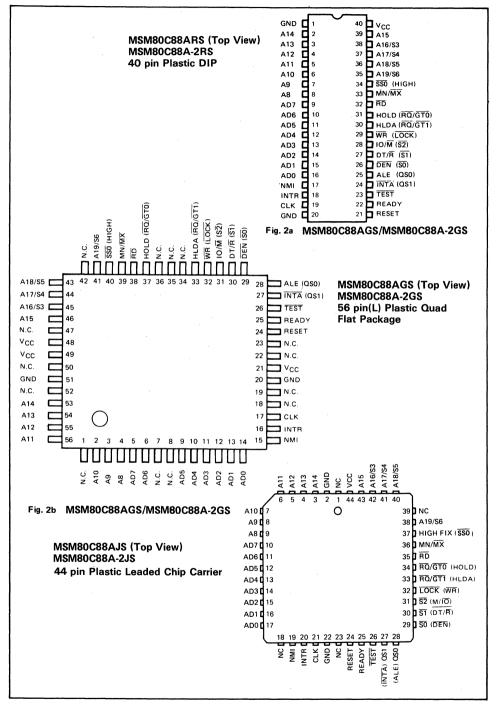
FUNCTIONAL BLOCK DIAGRAM

- Software Compatible with MSM80C86A
- Internal 14 Word by 16-bit Register Set
- 24 Operand Addressing Modes

- Bit, Byte, Word and String Operations
- 8 and 16-bit Signed and Unsigned Arithmetic Operation
- From DC to 5 MHz Clock Rate (MSM80C88A)
- From DC to 8 MHz Clock Rate (MSM 80C88A-2)
- Low Power Dissipation (10 mA/MHz)
- Bus Hold Circuitry Eliminates Pull-Up Resistors
- •40 pin Plastic DIP (DIP40-P-600)
- •44pin PLCC (QFJ44-P-S650)
- 56 pin(L)-V Plastic QFP (QFP56-P-910-VK)



## **PIN CONFIGURATION**



		Armoo				
Parameter	Symbol	MSM80C88ARS MSM80C88A-2RS	MSM80C88AGS MSM80C88A-2GS	MSM80C88AJS MSM80C88A-2JS	Unit	Conditions
Power Supply Voltage	Vcc		-0.5 ~ +7		v	
Input Voltage	VIN		-0.5 $\sim$ V <sub>CC</sub> +0.5		v	With respect
Output Voltage	Vout		-0.5 $\sim$ V <sub>CC</sub> +0.5		v	
Storage Temperature	Tstg		-65 ~ +150		°c	-
Power Dissipation	PD	1.0	0	.7	w	Ta = 25° C

## ABSOLUTE MAXIMUM RATINGS

## **OPERATING RANGE**

Parameter	Sumbal	Lir	Limits						
Faranielei	Symbol	MSM80C88A	MSM80C88A-2	Unit					
Power Supply Voltage	V <sub>CC</sub>	3 ~ 6	4.75 ~ 5.25	v					
Operating Temperature	T <sub>OP</sub>	-40 ~ +85	0 ~ +70	°C					

## **RECOMMENDED OPERATING CONDITIONS**

<b>D</b>	0	м	SM80C8	8A	M	SM80C8	8A-2	
Parameter	Symbol	MIN	ТҮР	MAX	MIN	TYP	MAX	Unit
Power Supply Voltage	V <sub>CC</sub>	4.5	5.0	5.5	4.75	5.0	5.25	V
Operating Temperature	ТОР	-40	+25	+85	0	+25	+70	°C
"L" Input Voltage	VIL	-0.5		+0.8	-0.5		+0.8	V
"H" Input Voltage	ViH <sup>(*1)</sup>	V <sub>CC</sub> -0.8		V <sub>CC</sub> +0.5	V <sub>CC</sub> -0.8		V <sub>CC</sub> +0.5	V
in input voltage	(*2)	2.0		V <sub>CC</sub> +0.5	2.0		V <sub>CC</sub> +0.5	V

\*1 Only CLK, \*2 Except CLK.

## DC CHARACTERISTICS

## $(\text{MSM80C86A: V}_{CC} = 4.5 \text{V to } 5.5 \text{V}, \text{ Ta} = -40^{\circ} \text{ to } +85^{\circ} \text{C} ) \\ (\text{MSM80C88A-2: V}_{CC} = 4.75 \text{ to } 5.25 \text{V}, \text{ Ta} = 0^{\circ} \text{C to } +70^{\circ} \text{C} ) \\ \end{cases}$

Parameter	Symbol	MIN	ТҮР	мах	Unit	Conditions
"L" Output Voltage	VOL			0.4	V	IOL = 2.5 mA
	N -	3.0				IOH = -2.5 mA
"H" Output Voltage	VOH	VCC-0.4			V	I <sub>OH</sub> = -100μA
Input Leak Current	ILI	-1.0		+1.0	μA	0 < V1 < VCC
Output Leak Current	ILO	-10		+10	μA	V <sub>O</sub> = V <sub>CC</sub> or GND
Input Leakage Current (Bus Hold Low)	IBHL	50		400	μA	VIN = 0.8V *3
Input Leakage Current (Bus Hold High)	<sup>I</sup> ВНН	-50		-400	μA	V <sub>IN</sub> = 3.0V *4
Bus Hold Low Overdrive	IBHLO			600	μA	*5
Bus Hold High Overdrive	Івнно			-600	μA	*6
Operating Power Supply Current	lcc			10	mA/MHz	V <sub>IL</sub> =GND V <sub>IH</sub> =VCC
StandbySupply Current	ICCS			500	μΑ	V <sub>IN</sub> =V <sub>CC</sub> or GND Outputs Unloaded CLK=GND or <sup>V</sup> CC
Input Capacitance	C <sub>in</sub>			10	pF	*7
Output Capacitance	Cout			15	рF	*7
I/O Capacitance	CI/O			20	pF	*7

\*3. Test conditions is to lower  $V_{\mbox{IN}}$  to GND and then raise  $V_{\mbox{IN}}$  to 0.8V on pins 2–16 and 35–39.

\*4. Test condition is to raise VIN to VCC and then lower VIN to 3.0V on pins 2-16, 26-32, and 34-39.

\*5. An external driver must source at least IBHLO to switch this node from LOW to HIGH.

\*6. An external driver must sink at least IBHHO to switch this node from HIGH to LOW.

\*7. Test Conditions: a) Freq = 1 MHz.

b) Ummeasured Pins at GND.

c) VIN at 5.0V or GND.

## A.C. CHARACTERISTICS

 $\begin{array}{l} (\text{MSM80C88A: V}_{\text{CC}} = 4.5 \text{V to } 5.5 \text{V}, \mbox{ Ta} = -40^{\circ} \mbox{C to } +85^{\circ} \mbox{C}) \\ (\text{MSM80C88A-2: V}_{\text{CC}} = 4.75 \text{V to } 5.25 \text{V}, \mbox{ Ta} = 0^{\circ} \mbox{C to } 70^{\circ} \mbox{C}) \end{array}$ 

## Minimum Mode System

## Timing Requirements

Parameter	Symbol	MSM80	C88A	MSM80	C88A-2	Unit
Farameter	Symbol	Min.	Max.	Min.	Max.	Unit
CLK Cycle Period	TCLCL	200	DC	125	DC	ns
CLK Low Time	TCLCH	118		68		ns
CLK High Time	TCHCL	69		44		ns
CLK Rise Time (From 1.0V to 3.5V)	тсн1сн2	·	10		10	ns
CLK Fall Time (From 3.5V to 1.0V)	TCL2CL1		10		10	ns
Data in Setup Time	TDVCL	30		20		ns
Data in Hold Time	TCLDX	10		10		ns
RDY Setup Time into MSM 82C84A (See Notes 1, 2)	TR1VCL	35		35		ns
RDY Hold Time into MSM 82C84A (See Notes 1, 2)	TCLR1X	0		0		ns
READY Setup Time into MSM 80C88A	твүнсн	118		68		ns
READY Hold Time into MSM 80C88A	TCHRYX	30		20		ns
READY inactive to CLK (See Note 3)	TRYLCL	-8		-8		ns
HOLD Setup Time	тнусн	35		20		ns
INTR, NMI, TEST Setup Time (See Note 2)	TINVCH	30		15		ns
Input Rise Time (Except CLK) (From 0.8V to 2.0V)	TILIH		15		15	ns
Input Fall Time (Except CLK) (From 2.0V to 0.8V)	тініс		15		15	ns

#### **Timing Responses**

Parameter	Symbol	MSM80	0C88A	MSM80	C88A-2	Unit
Parameter	Symbol	Min.	Max.	Min.	Max.	Omt
Address Valid Delay	TCLAV	10	110	10	60	ns
Address Hold Time	TCLAX	10		<b>10</b> -		ns
Address Float Delay	TCLAZ	TCLAX	80	TCLAX	50	ns
ALE Width	TLHLL	TCLCH-20		TCLCH-10		ns
ALE Active Delay	TCLLH		80		50	ns
ALE Inactive Delay	TCHLL		85		55	ns
Address Hold Time to ALE Inactive	TLLAX	TCHCL-10		TCHCL-10		ns
Data Valid Delay	TCLDV	10	110	10	60	ns
Data Hold Time	тснох	10		10		ns
Data Hold Time after WR	тwнdx	TCLCH-30		TCLCH-30		ns
Control Active Delay 1	тсусту	10	110	10	70	ns
Control Active Delay 2	тснсти	10	110	10	60	ns
Control Inactive Delay	тсустх	10	110	10	70	ns
Address Float to RD Active	TAZRL	0		0		ns
RD Acrive Delay	TCLRL	10	165	10	100	ns

## ■ CPU·MSM80C88ARS/GS/JS MSM80C88A-2RS/GS/JS ■-

D	Symbol	MSM80	C88A	MSM80C	88A-2	Unit
Parameter	Symbol	Min.	Max.	Min.	Max.	Unit
RD Inactive Delay	TCLRH	10	150	10	80	ns
RD Inactive to Next Address Active	TRHAV	TCLCL-45		TCLCL-40		ns
HLDA Valid Delay	TCLHAV	10	160	10	100	ns
RD Width	TRLRH	2TCLCL-75		2TCLCL-50		ns
WR Width	TWLWH	2TCLCL-60		2TCLCL-40		ns
Address Valid to ALE Low	TAVAL	TCLCH-60		TCLCH-40		ns
Output Rise Time (From 0.8V to 2.0)	TOLOH		15		15	ns
Output Fall Time (From 2.0V to 0.8V)	TOHOL		15		15	ns

Notes: 1. Signals at MSM82C84A shown for reference only.

2. Setup requirement for asynchronous signal only to guarantee recognition at next CLK.

3. Applies only to T2 state. (8 ns into T3)

#### Maximum Mode System (Using MSM 82C88 Bus Controller) Timing Requirements

	Quarter	MSM80	C88A	MSM80C	88A-2	Unit
Parameter	Symbol	Min.	Max.	Min.	Max.	Unit
CLK Cycle Period	TCLCL	200	DC	125	DC	ns
CLK Low Time	TCLCH	118		68		ns
CLK High Time	TCHCL	69		44		ns
CLK Rise Time (From 1.0V to 3.5V)	TCH1CH2		10		10	ns
CLK Fall Time (From 3.5V to 1.0V)	TCL2CL1		10		10	ns
Data in Setup Time	TDVCL	30		20		ns
Data in Hold Time	TCLDX	10		10		ns
RDY Setup Time into MSM 82C84A (See Notes 1, 2)	TR1VCL	35		35		ns
RDY Hold Time into MSM 82C84A (See Notes 1, 2)	TCLR1X	0		0		ns
READY Setup Time into MSM 80C88A	TRYHCH	118		68		ns
READY Hold Time into MSM 80C88A	TCHRYX	30		20		ns
READY inactive to CLK (See Note 3)	TRYLCL	-8		-8		ns
Set up Time for Recognition (NMI, INTR, TEST) (See Note 2)	тілусн	30		15		n's
RQ/GT Setup Time	TGVCH	30		15		ns
RQ Hold Time into MSM 80C88A	тснбх	40		30		ns
Input Rise Time (Except CLK) (From 0.8V to 2.0V)	TILIH		15	-	15	ns
Input Fall Time (Except CLK) (From 2.0V to 0.8V)	TIHIL	1	15		15	ns

#### Timing Responses

Parameter	Symbol	MSM80	C88A	MSM80C	88A-2	- Unit
Parameter	Symbol	Min.	Max.	Min.	Max.	
Command Active Delay (See Note 1)	TCLML	5	45	5	35	ns
Command Inactive Delay (See Note 1)	TCLMH	5	45	5	45	ns
READY Active to Status Passive (See Note 4)	TRYHSH		110		65	ns
Status Active Delay	TCHSV	10	110	10	60	ns
Status Inactive Delay	TCLSH	10	130	10	70	ns
Address Valid Delay	TCLAV	10	110	10	60	ns
Address Hold Time	TCLAX	10		10		ns
Address Float Delay	TCLAZ	TCLAX	80	TCLAX	50	ns
Status Valid to ALE High (See Note 1)	TSVLH		35		25	ns
Status Valid to MCE High (See Note 1)	тѕ∨мсн		35		30	ns
CLK low to ALE Valid (See Note 1)	TCLLH		35		25	ns
CLK Low to MCE High (See Note 1)	TCLMCH		35		25	ns
ALE Inactive Delay (See Note 1)	TCHLL	4	35	4	25	ns
Data Valid Delay	TCLDV	10	110	10	60	ns
Data Hold Time	тснох	10		10		ns
Control Active Delay (See Note 1)	TCVNV	5	45	5	45	ns
Control Inactive Delay (See Note 1)	TCVNX	5	45	5	45	ns
Address Float to RD Active	TAZRL	0		0		ns
RD Active Delay	TCLRL	10	165	10	100	ns
RD Inactive Delay	TCLRH	10	150	10	80	ns
RD Inactive to Next Address Active	TRHAV	TCLCL-45		TCLCL-40		ns
Direction Control Active Delay (See Note 1)	TCHDTL		50		50	ns
Direction Control Inactive Delay (See Note 1)	тснотн		35		30	ns
GT Active Delay	TCLGL	0	85	0	50	ns
GT Inactive Delay	TCLGH	0	85	0	50	ns
RD Width	TRLRH	2TCLCL-75		2TCLCL-50		ns
Output Rise Time (From 0.8V to 2.0V)	TOLOH		15		15	ns
Output Fall Time (From 2.0V to 0.8V)	TOHOL		15		15	ns

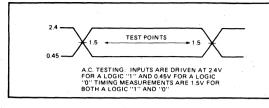
Notes: 1. Signals at MSM 82C84A or MSM 82C88 are shown for reference only.

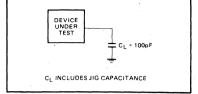
2. Setup requirement for asynchronous signal only to guarantee recognition at next CLK.

3. Applies only to T2 state (8 ns into T3)

4. Applies only to T3 and wait states.

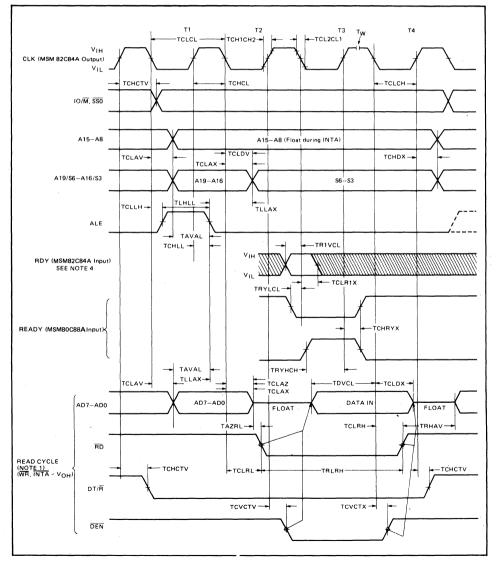
## A.C. TESTING INPUT, OUTPUT WAVEFORM A.C. TESTING LOAD CIRCUIT



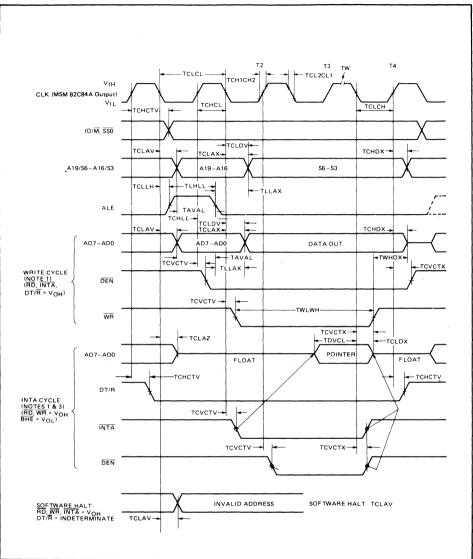


## TIMING CHART

Minimum Mode



Minimum Mode (Continued)

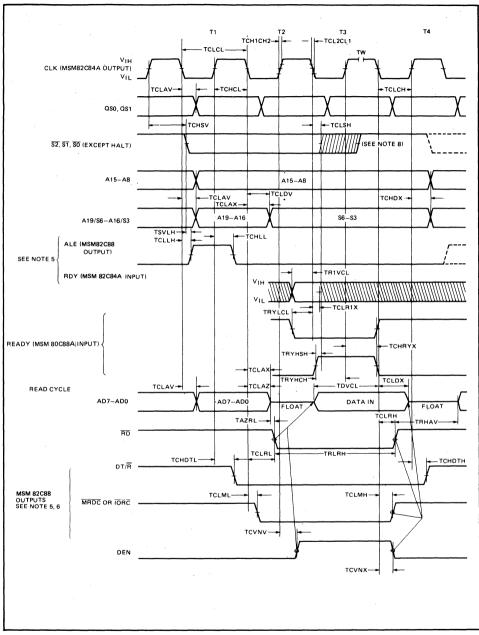


#### NOTES:

- 1. All signals switch between VOH and VOL unless otherwise specified.
- 2. RDY is sampled near the end of T2, T3, TW to determine if TW machines states are to be inserted.
- 3 Two INTA cycles run back-to-back. The MSM80C88A LOCAL ADDR/DATA BUS is floating during both INTA cycles. Control signals shown for second INTA cycle.
- 4. Signals at MSM 82C84A shown for reference only.
- 5. All timing measurements are made at 1.5V unless otherwise noted.

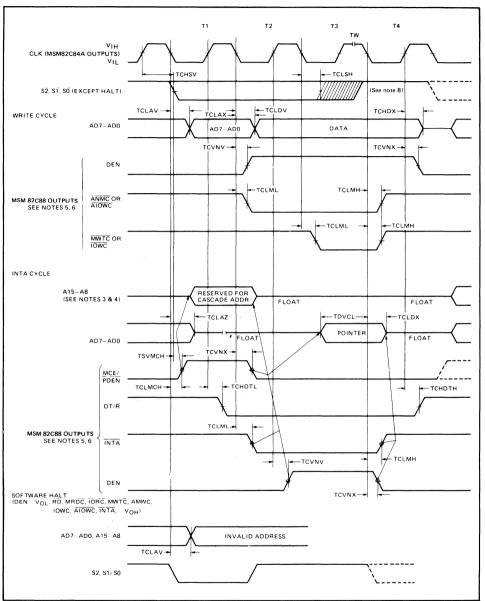
■ CPU·MSM80C88ARS/GS/JS MSM80C88A-2RS/GS/JS ■-





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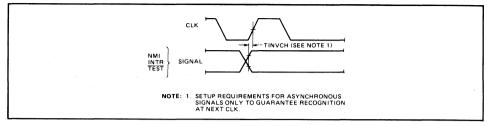
#### Maximum Mode (Continued)



#### NOTES:

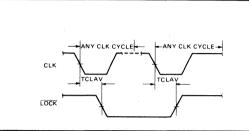
- 1. All signals switch between VOH and VOL unless otherwise specified.
- 2. RDY is sampled near the end of T2, T3, TW to determine if TW machines states are to be inserted.
- 3. Cascade address is valid between first and second INTA cycle.
- Two INTA cycles run back-to-back. The MSM 80C88A LOCAL ADDR/DATA BUS is floating during both INTA cycles Control for pointer address is shown for second INTA cycle.
- 5. Signal at MSM 82C84A and MSM82C88 shown for reference only.
- 6 The issuance of the MSM 82C88 command and control signals IMRDC, MWTC, AMWC, IORC, IOWC, AIOWC, INTA and DEN) lags the active high MSM 82C88 CEN.
- 7. All timing measurements are made at 1.5V unless otherwise noted.
- 8. Status inactive in state just prior to T4.

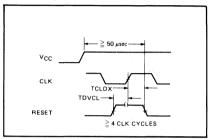
Asynchronous Signal Recognition



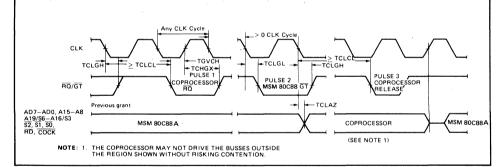


**Reset Timing** 

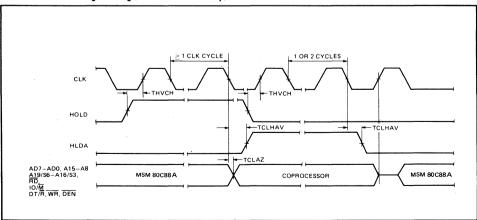




#### Request/Grant Sequence Timing (Maximum Mode Only)



Hold/Hold Acknowledge Timing (Minimum Mode Only)



## PIN DESCRIPTION

#### AD0-AD7

ADDRESS DATA BUS: Input/Output

These lines are the multiplexed address and data

These are the address bus at T1 cycle and the data bus at T2, T3, TW and T4 cycle.

T2, T3, TW and T4 cycle.

These lines are high impedance during interrupt acknowledge and hold acknowledge.

#### A8-A15

ADDRESS BUS: Output

These lines are the address bus bits 8 thru 15 at all cycles.

These lines do not have to be latched by an ALE signal.

These lines are high impedance during interrupt acknowledge and hold acknowledge.

#### A16/S3, A17/S4, A18/S5, A19/S6

ADDRESS/STATUS: Output

These are the four most significant address as at the T1, cycle.

Accessing I/O port address, these are low at T1 Cycles.

These lines are Status lines at the T2, T3, TW and T4 Cycle.

S5 indicate interrupt enable Flag.

S3 and S4 are encoded as shown.

S3	S4	Characteristics
0	0	Alternate Data
1	0	Stack
0	1	Code or None
1	1	Data

These lines are high impedance during hold acknowledge.

#### RD

**READ:** Output

This lines indicates that the CPU is in a memory or I/O read cycle.

This line is the read strobe signal when the CPU reads data from a memory or I/O device.

This line is active low.

This line is high impedance during hold acknowledge.

#### READY

READY: Input

This line indicates to the CPU that an addressed memory or I/O device is ready to read or write. This line is active high.

IF the setup and hold time are outof specification, an illegal operation will occur.

#### INTR

INTERRUPT REQUEST: Input

This line is a level triggered interrupt request signal which is sampled during the last clock cycle of instruction and string manipulations.

It can be internally masked by software.

This signal is active high and internally synchronized.

#### TEST

#### TEST: Input

This line is examined by a "WAIT" instruction. When TEST is high, the CPU enters an idle cycle. When TEST is low, the CPU exits an idle cycle.

#### NMI

NON MASKABLE INTERRUPT: Input This line causes a type 2 interrupt, NMI is not maskable.

This signal is internally synchronized and needs a 2 clock cycle pulse width.

#### RESET

#### **RESET:** Input

This signal causes the CPU to initialize immediately. This signal is active high and must be at least four clock cycles.

#### CLK

## CLOCK: Input

This signal provide the basic timing for an internal circuit.

#### MN/MX

MINIMUM/MAXIMUM: Input

This signal selects the CPU's operate mode.

When  $V_{CC}$  is connected, the CPU operates in minimum mode.

When GND is connected, the CPU operates in maximum mode.

#### Vcc

 $V_{CC}$  +3 - +6 V supplied.

#### GND

GROUND

The following pin function descriptions are for maximum mode only.

Other pin functions are already described.

#### <u>50, 51, 52</u>

#### STATUS: Output

These lines indicate bus status and they are used by the MSM82C88 Bus Controller to generate all memory and I/O access control signals.

These lines are high impedance during hold acknowledge.

These status lines are encoded as shown.

<u>52</u>	<u>51</u>	<del>S0</del>	Characteristics
0 (LOW)	0	0	Interrupt acknowledge
0	0	1	Read I/O Port
0	1	0	Write I/O Port
0	1	1	Halt
1 (HIGH)	0	0	Code Access
1	0	1	Read Memory
1	1	0	Write Memory
1	1	1	Passive

## RQ/GTO

RQ/GT1

REQUEST/GRANT: Input/Output

These lines are used for Bus Request from other devices and Bus GRANT to other devices. These lines are bidirectional and active low.

#### LOCK

LOCK: Output

This line is active low.

When this line is low, other devices can not gain control of the bus.

This line is high impedance during hold acknowledge.

#### QSO/QS1

QUEUE STATUS: Output

These are Queue Status Lines that indicate internal instruction queue status.

QS1	QSO	Characteristics
0 (LOW)	0	No Operation
0	1	First Byte of Op Code from Queue
1 (HIGH)	0	Empty the Queue
1	1	Subsequent Byte from Queue

The following pin function descriptions are minimum mode only. Other pin functions are already described.

#### 10/M

STATUS: Output

This line selects memory address space or I/O address space.

When this line is low, the CPU selects memory address space and when it is high, the CPU selects I/O address space.

This line is high impedance during hold acknowledge.

#### WR

#### WRITE: Output

This line indicates that the CPU is in a memory or I/O write cycle.

This line is a write strobe signal when the CPU writes data to memory or an I/O device.

This line is active low.

This line is high impedance during hold acknowledge.

#### INTA

INTERRUPT ACKNOWLEDGE: Output

This line is a read strobe signal for the interrupt accknowledge cycle.

This line is active low.

#### ALE

ADDRESS LATCH ENABLE: Output

This line is used for latching an address into the MSM82C12 address latch it is a positive pulse and the trailing edge is used to strobe the address. This line in never floated.

## DT/R

DATA TRANSMIT/RECEIVE: Output

This line is used to control the direction of the bus transceiver.

When this line is high, the CPU transmits data, and when it is low, the CPU receive data.

This line is high impedance during hold acknowledge.

#### DEN

DATA ENABLE: Output

This line is used to control the output enable of the bus transceiver.

This line is active low. This line is high impedance during hold acknowledge.

#### HOLD

HOLD REQUEST: Input

This line is used for a Bus Request from an other device.

This line is active high.

#### HLDA

HOLD ACKNOWLEDGE: Output

This line is used for a Bus Grant to an other device.

This line is active high.

#### SSO

STATUS: Output

This line is logically equivalent to  $\overline{\text{SO}}$  in the maximum mode.

#### STATIC OPERATION

All MSM80C88A circuitry is of static design. Internal registers, counters and latches are static and require no refresh as with dynamic circuit design. This eliminates the minimum operating frequency restriction placed on other microprocessors. The MSM80C88A can operate from DC to the appropriate upper frequency limit. The processor clock may be stopped in either state (high/low) and held there indefinitely. This type of operation is especially useful for system debug or power critical applications.

The MSM80C88A can be signal stepped using only the CPU clock. This state can be maintained as long as is necessary. Single step clock operation allows simple interface circuitry to provide critical information for bringing up your system.

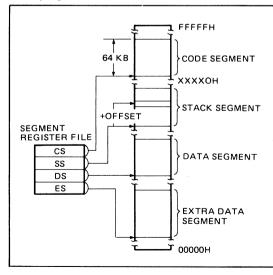
Static design also allows very low frequency operation (down to DC). In a power critical situation, this can provide extremely low power operation since 80C88A power dissipation is directly related to operating frequency. As the system frequency is reduced, so is the operating power until, ultimately, at a DC input frequency, the MSM80C88A power requirement is the standby current (500 µA maximum).

## FUNCTIONAL DESCRIPTION

#### GENERAL OPERATION

The internal function of the MSM80C88A consist of a Bus Interface Unit (BIU) and an Execution Unit (EU). These units operate mutually but perform as separate processors.

#### Memory Organization



The BIU performs instruction fetch and queueing, operand fetch, DATA read and write address relocation and basic bus control. By performing instruction prefetch while waiting for decoding and execution of instruction, the CPU's performance is increased. Up to 4-bytes fo instruction stream can be queued.

EU receives pre-fetched instructions from the BIU queue, decodes and executes instructions and provides an un-relocated operand address to the BIU.

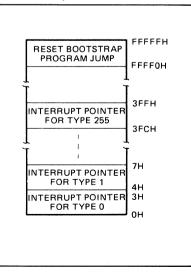
#### MEMORY ORGANIZATION

The MSM80C88A has a 20-bit address to memory. Each address has 8-bit data width. Memory is organized 00000H to FFFFH and is logically divided into four segments: code, data, extra data and stack segment. Each segment contains up to 64 Kbytes and locates on a 16-byte boundary. (Fig. 3a)

All memory references are made relative to a segment register according to a select rule. Memory location FFFF0H is the start address after reset, and 00000H through 003FFH are reserved as an interrupt pointer. There are 256 types of interrupt pointer;

Each interrupt type has a 4-byte pointer element consisting of a 16-bit segment address and a 16-bit offset address.

#### Reserved Memory Locations



## CPU·MSM80C88ARS/GS/JS MSM80C88A-2RS/GS/JS

Memory Reference Need	Segment Register Used	Segment Selection Rule								
Instructions	CODE (CS)	Automatic with all instruction prefetch.								
Stack	STACK (SS)	All stack pushes and pops. Memory references relative to BP base register except data references.								
Local Data	DATA (DS)	Data references when relative to stack, destination of string operation, or explicitly overridden.								
External (Global) Data	EXTRA (ES)	Destination of string operations: Explicitly selected using a segment override.								

#### MINIMUM AND MAXIMUM MODES

The MSM80C88A has two system modes: minimum and maximum. When using the maximum mode, it is easy to organize a multiple-CPU system with the MSM 82C88 Bus Controller which generates the bus control signal.

When using the minimum mode, it is easy to organize a simple system by generating the bus control signal itself.  $MN/\overline{MX}$  is the mode select pin. Definition of 24-31, 34 pin changes depends on the MN/MX pin.

#### **BUS OPERATION**

The MSM80C88A has a time multiplexed address and data bus. If a non-multiplexed bus is desired for the system, it is only needed to add the address latch.

A CPU bus cycle consists of at least four clock cycles: T1, T2, T3 and T4. (Fig. 4)

The address output occurs during T1, and data transfer occurs during T3 and T4. T2 is used for changing the direction of the bus during read operation. When the device which is accessed by the CPU is not ready to data transfer and send to the CPU "NOT READY" is indicated TW cycles are inserted between T3 and T4.

When a bus cycle is not needed, T1 cycles are inserted between the bus cycles for internal execution. At the T1 cycle an ALE signal is output from the CPU or the MSM82C88 depending in MN/MX, at the trailing edge of an ALE, a valid address may be latched. Status bits S0, S1 and S2 are uased, in maximum mode, by the bus controller to recognize the type of bus operation according to the following table.

<u>S2</u>	<u>5</u> 1	SŌ	Characteristics
0 (LOW)	0	0	Interrupt acknowledge
0	0	1	Read I/O
0	1	0	Write I/O
0	1	1	Halt
1 (HIGH)	0	0	Instruction Fetch
1	0	1	Read Data from Memory
1	1	0	Write Data to Memory
1	1	1	Passive (no bus cycle)

Status bit S3 through S6 are multiplexed with A16-A19, and therefore they are valid during T2 through T4. S3 and S4 indicate which segment register was selected on the bus cycle, according to the following table.

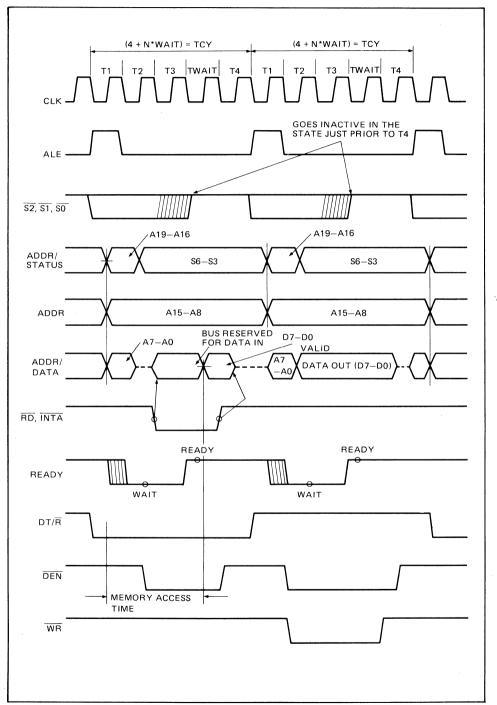
S4	S3	Characteristics
0 (LOW)	0	Alternate Data (Extra Segment)
0	1	Stack
1 (HIGH)	0	Code or None
1	1	Data

S5 indicates interrupt enable Flag.

#### I/O ADDRESSING

The MSM80C88A has a 64 Kbyte I/O. When the CPU accesses an I/O device, address A0-A15 are in same format as a memory access, and A16-A19 are low. I/O ports address are same as four memory.

Basic System Timing



## EXTERNAL INTERFACE

#### RESET

CPU initialization is executed by the RESET pin. The MSM80C88A's RESET High signal is required for greater than 4 clock cycles.

The rising edge of RESET terminates the present operation immediately. The falling edge of RESET triggers an internal reset requence for approximately 10 clock cycles. After internal reset sequence is finished. normal operation begins from absolute location FFFOH.

#### INTERRUPT OPERATIONS

The interrupt operation is classified as software or hardware, and hardware interrupt is classified as nonmarkable or maskable.

An interrupt causes a new program location which is defined by the interrupt pointer table, according to the interrupt type. Absolute location 00000H through 003FFH is reserved for the interrupt pointer table. The interrupt pointer table consists of 256-elements, Each element is 4 bytes in size and corresponds to an 8-bit type number which is sent from an interrupt request device during the interrupt acknowledge cycle.

#### NON-MASKABLE INTERRUPT (NMI)

The MSM80C88A has a non-maskable Interrupt (NM1) which is of higher priority than a maskable interrupt request (INTR).

An NM1 request pulse width needs minimum of 2 clock cycles. The NM1 will be serviced at the end of the current instruction or between string manipulations. MASKABLE INTERRUPT (INTR)

The MSM80C88A provides another interrupt request (INTR) which can be masked by software. INTR is level triggered, so it must be held until interrupt request is acknowledged.

The INTR will be serviced at the end of the current instruction or between string manipulations.

#### Interrupt Acknowledge Sequence

#### INTERRUPT ACKNOWLEDGE

During the interrupt acknowledge sequence, further interrupts are disabled. The interrupt enable bit is reset by any interrupt, after which the Flag register is automatically pushed onto the stack. During an acknowledge sequence, the CPU emits the lock signal from T2 of first bus cycle to T2 of second bus cycle. At the second bus cycle, a byte is fetched from the external device as a vector which identifies the type of interrupt. This vector is multiplied by four and used as an interrupt pointer address (INTR only).

The Interrupt Return (IRET) instruction includes a Flag pop operation which returns the original interrupt enable bit when it restores the Flag.

#### ΗΔΙ Τ

When a Halt instruction is executed, the CPU enter Halt state. An interrupt request or RESET will force the MSM80C88A out of the Halt state.

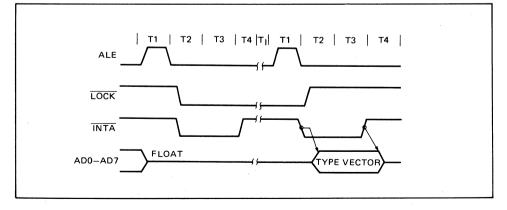
#### SYSTEM TIMING-MINIMUM MODE

A bus cycle begins at T1 with an ALE signal. The trailing edge of ALE is used to latch the address. From T1 to T4 the  $IO/\overline{M}$  signal indicates a memory or I/O operation. From T2 to T4, the address data bus changes the address bus to the data bus.

The read (RD), write (WR), and interrupt acknowledge (INTA) signals caused the addressed device to enable the data bus. These signals become active at the beginning of T2 and inactive at the beginning of T4.

#### SYSTEM TIMING-MAXIMUM MODE

In maximum mode, the MSM82C88 Bus Controller is added to system. The CPU sends status information to the Bus Controller. Bus timing signals are generated by the Bus Controller. Bus timing is almost the same as in minimum mode



## **BUS HOLD CIRCUITRY**

To avoid high current conditions caused by floating inputs to CMOS devices, and to eliminate the need for pull-up/down resistors, "bus-hold" circuitry has been used on 80C86 pins 2–16, 26–32, and 34–39 (Figures 6a, 6b). These circuits will maintain the last valid logic state if no driving source is present (i.e. an unconnected pin or a driving source which goes to a high impedance state). To overdrive the "bus hold" circuits, an external driver must be capable of supplying approximately 400  $\mu$ A minimum sink or source current at valid input voltage levels. Since this "bus hold" circuitry is active and not a "resistive" type element, the associated power supply current is negligible and power dissipation is significantly reduced when compared to the use of passive pull-up resistors.

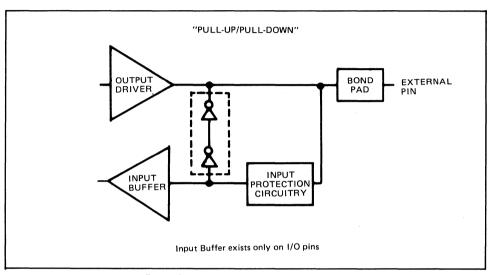


Figure 6a. Bus hold circuitry pin 2-16, 35-39.

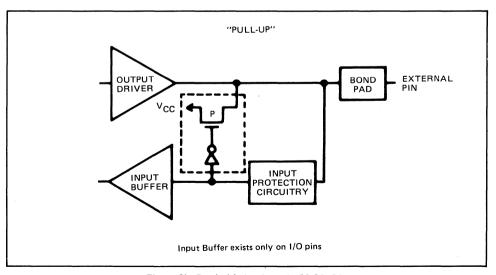


Figure 6b. Bus hold circuitry pin 26-32, 34



MOV = Move:		7	6	5	4	3	2	1	0	76	5	5 4	3	2	1	0	7	6	5	; 4	4	3	2	1	0	7	6	5	4	3	2	1
Register/memory to/from register		1	0	0	0	1	0	d	w	mod		reg			r/m	l.										I						
Immediate to register/memory		1	1	0	0	0	1	1	w	mod	0	0 (	0		r/m					da	ta					1			data	if	w	= 1
Immediate to register		1	0	1	1	w	1	reg				data	Э							d	lata	if	w	= 1		I						
Memory to accumulator	· ·	1	0	1	0	0	0	0	w		a	addr	-lov	v						add	ir-h	igh				1						
Accumulator to memory		1	0	1	0	0	0	1	w		ć	addr	-lov	v						add	lr-h	igh										
Register/memory to segment register		1	0	0	0	1	1	1	0	mod	0	) re	g		r/m	1										1						
Segment register to register/memory		1	0	0	0	1	1	0	0	mod	0	) re	g		r/m											I						
PUSH = Push:																										I						
Register/memory		1	1	1	1	1	1	1	1	mod	1	1	0		r/m	1										1						
Register		0	1	0	1	0	į	reg																								
Segment register		0	0	0	reç	)	1	1	0																							
POP = Pop:																										1						
Register/memory		1	0	0	0	`1	1	1	1	mod	0	0	0		r/m	1																
Register		0	1	0	1	1		reg																								
Segment register		0	Ò	0	reg	J	1	1	1																							

XCHG = Exchange: Register/memory with register

Register with accumulator

IN = Input from: Fixed port

Variable port OUT = Output to:

PUSHF = Push flags

POPF = Pop flags

Fixed port Variable port XLAT = Translate byte to AL LEA = Load EA to register LDS = Load pointer to DS LES = Load pointer to ES LAHF = Load AH with flags SAHF = Store AH into flags

1 0 0 0 0 1 1 w mod reg 1 0 0 1 0 reg

1 1 0 1 mod

1 0 0 mod

mod

1 0 1

1 1 1 0 0 1 0 w

1 1 1 0 1 1 0 w

1 1 1 0 0 1 1 w

1 1 1 0 1 1 1 w

0

10011100 10011101

0 1 1 1 1 1

0 1 1 1 1 0

0 1 0 1 1 1

0 0 0

0 0

1

1

1

1

1 0 0 0

1

1

1

0

1 0

r/m

port

port

reg

reg

reg

r/m

r/m

r/m

## ARITHMETIC

								-							· · · · · · · · · · · · · · · · · · ·
ADD = Add:															
Reg./memory with register to either	0	0	0	0	•	0	d	w	mod			eg	r/m		
Immediate to register/memory	1	0		-		0		w	mod	0	0	-	r/m	data	data if s:w = 01
Immediate to accumulator	0	0	0	0	0	1	0	w			dat	а		data if w = 1	
ADC = Add with carry:															
Reg./memory with register to either	0	0	0	1	0	0	d	w	mod		r	eg	r/m		
Immediate to register/memory	1	0	0	0	0	0	s	w	mod	0	1	0	r/m	data	data if s:w = 01
Immediate to accumulator	0	0	0	1	0	1	0	w			dat	а		data if w = 1	
INC = Increment:															
Register/memory	1	1	1	1	1	1	1	w	mod	0	0	0	r/m		
Register	0	1	0	0	0	r	eg								
AAA = ASCII adjust for add	0		1	1	0	1	1	1							
DAA = Decimal adjust for add	0	0	1	0	0	1	1	1							
SUB = subtract:															
Reg./memory and register to either	0	0	1	0	1	0	d	w	mod		r	eg	r/m		
Immediate from register/memory	1	0	0	0	0	0	s	w	mod	1	0	1	r/m	data	data if s:w = 01
Immediate from accumulator	0	0	1	0	1	1	0	w			dat	а		data if w = 1	
SBB = Subtract with borrow:															
Reg./memory and register to either	0	0	0	1	1	0	d	w	mod		r	eg	r/m		
Immediate from register/memory	1	0	0	0	0	0	s	w	mod	0	1	1	r/m	data	data if s:w = 01
Immediate from accumulator	0	0	0	1	1	1	0	w			dat	а		data if w = 1	
DEC = Decrement:															
Register/memory	1	1	1	1	1	1	1	w	mod	0	0	1	r/m		
Register	0	1	0	0	1		reg	1							
NEG = Change sign	1	1	1	1	0	1	1	w	mod	0	1	1	r/m		
CMP = Compare:															
Register/memory and register	0	0	1	1	1	0	d	w	mod		r	eg	r/m		
Immediate with register/memory	1	0	0	0	0	0	s	w	mod	1	1	1	r/m	data	data if s:w = 01
Immediate with accumulator	0	0	1	1	1	1	0	w			data	3		data if w = 1	
AAS = ASCII adjust for subtract	0	0	1	1	1	1	1	1							

■ CPU·MSM80C88ARS/GS/JS MSM80C88A-2RS/GS/JS■

٦

A C C C C C C C C C C C C C C C C C C C	DAS = Decimal adjust for subtract	0 0 1 0 1 1 1	-		
	MUL = Multiply (unsigned)	1 1 1 1 1 0 1 1	100	,E	
	IMUL = Integer multiply (signed)	1 1 1 1 0 1 1	w mod 1 0 1 r	m,	
	AAM = ASCII adjust for multiply	1 1 0 1 0 1 0	0 0 0 0 0 1 0	1 0	
	DIV = Divide (unsigned)	1 1 1 1 1 0 1 1	w mod 1 1 0	-/m	
	IDIV = Integer divide (signed)	1 1 1 1 0 1 1	w mod 1 1 1	-/u	
CBW = Convert byte to word 1 0 0 1 1 0 0 0 1 2 0 0 1 2 0 0 1 1 0 0 0 1 0	AAD = ASCII adjust for divide	1 1 0 1 0 1 0	10000	1 0	
	CBW = Convert byte to word	1.001100	0		×
	CWD = Convert word to double word	1001100			

5

r

LOGIC

NOT = Invert		1	1	1 1	C	1	1	w	mod	0	1 0	r/m		
SHL/SAL = Shift logical/arithmetic left		1	1	01	C	0	v	w	mod	1	0 0	r/m		
SHR = Shift logical right		1	1	01	C	0	v	w	mod	1	01	r/m		
SAR = Shift arithmetic right		1	1	01	C	0	v	w	mod	1	1 1	r/m		
ROL = Rotate left		1	1	01	C	0	v	w	mod	0	0 0	r/m		
ROR = Rotate right		1	1	01	C	0	v	w	mod	0	01	r/m		
RCL = Rotate left through carry		1	1	01	C	0	v	w	mod	0	10	r/m		
RCR = Rotate right through carry		1	1	0 1	C	0	v	w	mod	0	1 1	r/m		
AND = And:														
Reg./memory and register to either		0	0	1 0	) (	0	d	w	mod		reg	r/m		
Immediate to register/memory		1	0	0 0	) (	0	0	w	mod	1	οŏ	r/m	data	data if w = 1
Immediate to accumulator	(	0	0	1 0	) (	1	0	w			data		data if w = 1	
TEST = And function to flags, no result:														
Register/memory and register		1	0	0 0	) C	1	0	w	mod		reg	r/m		
Immediate data and register/memory		1	1	1 1	C	1	1	w		0	-	r/m	data	data if w = 1
Immediate data and accumulator				1 0							data		data if w = 1	
OR = Or:														
Reg./memory and register to either		0	0	0 0	) 1	0	d	w	mod		reg	r/m		
Immediate to register/memory		1		0 0					mod	0	0 1	r/m	data	data if w = 1
Immediate to accumulator	(	0	0	0 0	) 1	1	0	w			data	-	data if w = 1	
XOR = Exclusive or:														
Reg./memory and register to either		0	0	1 1	0	0	d	w	mod		reg	r/m		
Immediate to register/memory	· ·	1	0	0 0	0	0	0	w	mod	1	1 0	r/m	data	data if w = 1
Immediate to accumulator	(	0	0	1 1	0	1	0	w			data		data if w = 1	
STRING MANIPULATION											<u>.</u>			I
REP = Repeat		1	1	1 1	0	0							<u> </u>	
MOVS = Move byte/word		1	0	10	0	1	0	w						
CMPS = Compare byte/word		-	0	10			1	w						
SCAS = Scan byte/word				1 0				w						
		1	^	1 0	. 1	1	~							

1010110w

1010101w

LODS = Load byte/word to AL/AX

STOS = Store byte/word from AL/AX

2	5	J	L	

CJMP = Conditional JMP											-
JE/JZ = Jump on equal/zero	0	1	1	1	0	1	0	0	disp		×
JZ/JNGE = Jump on less/not greater or equal	0	1	1	1	1	1	0	0	disp	s	
JLE/JNG = Jump on less or equal/not greater	0	1	1	1	1	1	1	0	disp		
JB/JNAE = Jump on below/not above or equal	0	1	1	1	0	0	1	0	disp		· · · · · · · · · · · · · · · · · · ·
JBE/JNA = Jump on below or equal/not above	0	1	1	1	0	1	1	0	disp		
JP/JPE = Jump on parity/parity even	0	1	1	1	1	0	1	0	disp		
JO = Jump on over flow	0	1	1	1	0	0	0	0	disp		
JS = Jump on sign	0	1	1	1	1	0	0	0	disp		
JNE/JNZ = Jump ຄn not equal/not zero	0	1	1	1	0	1	0	1	disp		
JNL/JGE = Jump on not less/greater or equal	0	1	1	1	1	1	0	1	disp		
JNLE/JG = Jump on not less or equal/greater	0	1	1	1	1	1	1	1	disp		
JNB/JAE = Jump on not below/above or equal	0	1	1	1	0	0	1	1	disp		
JNBE/JA = Jump on not below or equal/above	0	1	1	1	0	1	1	1	disp		
JNP/JPO = Jump on not parity/parity odd	0	1	1	1	1	0	1	1	disp		
JNO = Jump on not overflow	0	1	1	1	0	0	0	1	disp		
JNS = Jump on not sign	0	1	1	1	1	0	0	1	disp		
LOOP = Loop CX times	1	1	1	0	0	0	1	0	disp		and the second
LOOPZ/LOOPE = Loop while zero/equal	1	1	1	0	0	0	0	1	disp		
LOOPNZ/LOOPNE = Loop while not zero/equal	1	1	1	0	0	0	0	0	disp		
JCXZ = Jump on CX zero	1	1	1	0	0	0	1	1	disp		
INT = Interrupt:											
Type specified	1	1	0	0	1	1	0	1	type		
Туре З	1	1	0	0	1	1	0	0			
INTO = Interrupt on overflow	1	1	0	0	1	1	1	0			
IRET = Interrupt return	1	1	0	0	1	1	1	1			

## PROCESSOR CONTROL

CLC = Clear carry	1	1	1	1	1	0	0	0								
CMC = Complement carry	1	1	1	1	0	1	0	1								
STC = Set carry	1	1	1	1	1	0	0	1								
CLD = Clear direction	1	1	1	1	1	1	0	0								
STD = Set direction	1	1	1	1	1	1	0	1								
CLI = Clear interrupt	1	1	1	1	1	0	1	0								
STI = Set interrupt	1	1	1	1	1	0	1	1								
HLT = Halt	1	1	1	1	0	1	0	0								
WAIT = Wait	1	0	0	1	1	0	1	1								
ESC = Escape (to external device)	1	1	0	1	1	х	х	x	mod	x	x	×	r/m			
LOCK = Bus lock prefix	1	1	1	1	0	0	0	0								

## CONTROL TRANSFER

CALL = Call:	7	6	5	4	3	2	1	0	76	5	4	3	2	2	1 (	)	76	; ;	5	4	3	2	1	0	7	6	5 5	5	4	3	2	1	0
Direct within segment	1	1	1	0	1	0	0	0			dis	p-lo	w						d	isp-	hig	h											
Indirect within segment	1	1	1	1	1	1	1	1	mod	0	1	0		r	/m																		
Direct intersegment	1	0	0	1	1	0	1	0		c	offs	et-l	ow	/					of	fset	-hi	gh											
											seg	g-loi	w						s	eg-	higl	n											
Indirect intersegment	1	1	1	1	1	1	1	1	mod	0	1	1		r	/m																		
JMP = Unconditional Jump:																																	
Direct within segment	1	1	1	0	1	0	0	1			dis	p-lo	w						d	isp-	hig	h											
Direct within segment-short	1	1	1	0	1	0	1	1			С	lisp																					
Indirect within segment	1	1	1	1	1	1	1	1	mod	1	0	0		r	/m																		
Direct intersegment	1	1	1	0	1	0	1	0		c	offs	et-l	ow	1					of	fset	-hi	gh											
											se	g-lo	w						s	eg-l	higł	n											
Indirect intersegment	1	1	1	1	1	1	1	1	mod	1	0	1		r	/m																		
RET = Return from CALL:																																	
Within segment	1	1	0	0	0	0	1	1																									
Within seg. adding immediate to SP	1	1	0	0	0	0	1	0			dat	a-lo	w						d	ata	hig	h											
Intersegment	1	1	0	0	1	0	1	1																									
Intersegment adding immediate to SP	1	1	0	0	1	0	1	0			dat	a-lo	w						d	ata	hig	h											



Footnotes:

AL = 8-bit accumulator AX = 18-bit accumulator CX = Count register DS = Data segment ES = Extra segment Above/below refers to unsigned value Greater = more positive Less = less positive (more negative) signed value If d = 1 then "to" reg. If d = 0 then "from" reg. If w = 1 then word instruction: If w = 0 then byte instruction

If mod = 11 then r/m is treated as a REG field If mod = 00 then DISP = 0\*, disp-low and disp-high are absent If mod = 01 then DISP = disp-low sign-extended to 16-bits, disp-high is absent If mod = 10 then DISP = disp-high: disp-low

```
If r/m = 000 then EA = (BX) + (SI) + DISP

If r/m = 001 then EA = (BX) + (DI) + DISP

If r/m = 010 then EA = (BP) + (SI) + DISP

If r/m = 011 then EA = (BP) + (DI) + DISP

If r/m = 100 then EA = (SI) + DISP

If r/m = 101 then EA = (DI) + DISP

If r/m = 110 then EA = (BP) + DISP*

If r/m = 111 then EA = (BX) + DISP

DISP follows 2nd byte of instruction (before data if required)

* except if mod = 00 and r/m = 110 then EA-disp-high: disp-low
```

If s:w = 01 then 16 bits of immediate data form the operand If s:w = 11 then an immediate data byte is sign extended to form the 16-bit operand If v = 0 then "count" = 1: If v = 1 then "count" in (CL) x = don't care

z is used for string primitives for comparison with ZF FLAG

SEGMENT OVERRIDE PREFIX

001 reg 110

REG is assigned according to the following table:

16-Bit	(w = 1)	8-Bit	(w = 0)	Segment
000	AX	000	AL	00 ES
001	СХ	001	CL	01 CS
010	DX	010	DL	10 SS
011	вх	011	BL	11 DS
100	SP	100	AH	
101	BP	101	СН	
110	SI	110	DH	
111	DI	111	вн	

Instructions which reference the flag register file as a 16-bit object use the symbol FLAGS to represent the file:

FLAGS = x:x:x:(OF):(DF):(IF):(TF):(SF):(ZF):X:(AF):X:(PF):X:(CF)

# **OKI** semiconductor

# MSM80C88A-10RS/GS/JS

## **8-BIT CMOS MICROPROCESSOR**

## **GENERAL DESCRIPTION**

The MSM80C88A-10 are internal 16-bit CPUs with 8-bit interface implemented in Silicon Gate CMOS technology. They are designed with the same processing speed as the NMOS8088-1, but with considerably less power consumption.

The processor has attributes of both 8 and 16-bit microprocessor. It is directly compatible with MSM80C86A-10 software and MSM80C85A/MSM80C85A-2 hardware and peripherals.

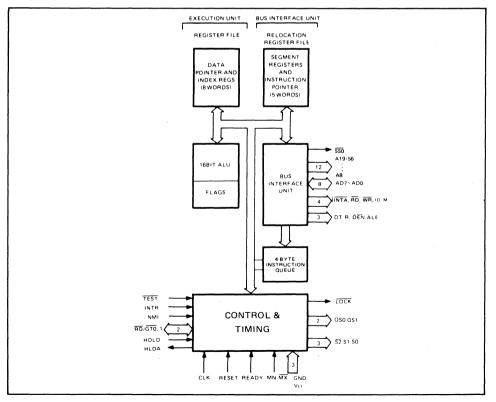
## FEATURES

- 8-Bit Data Bus Interface
- 16-Bit Internal Architecture
- 1 Mbyte Direct Addressable Memory Space
- Software Compatible with MSM80C86A
- Internal 14 Word by 16-bit Register Set

FUNCTIONAL BLOCK DIAGRAM

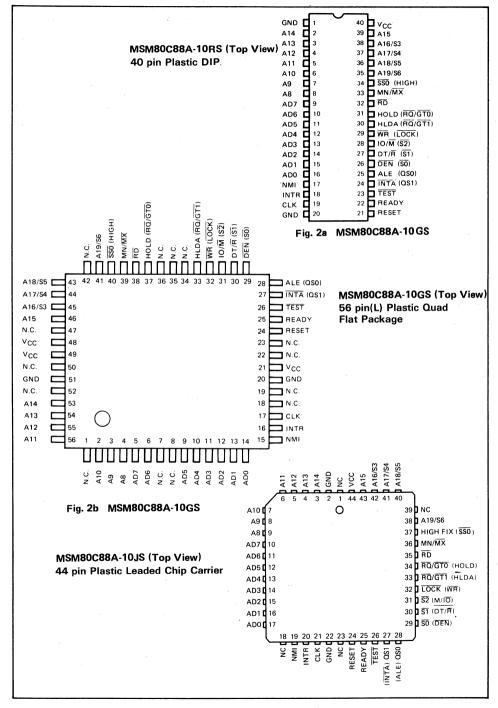
• 24 Operand Addressing Modes

- Bit, Byte, Word and String Operations
- 8 and 16-bit Signed and Unsigned Arithmetic Operation
- From DC to 10 MHz Clock Rate
- Low Power Dissipation (10 mA/MHz)
- Bus Hold Circuitry Eliminates Pull-Up Resistors
- •40 pin Plastic DIP (DIP40-P-600)
- •44 pin PLCC (QFJ44-P-S650)
- 56 pin(L)-V Plastic QFP (QFP56-P-910-VK)



#### CPU·MSM80C88A-10RS/GS/JS =

## PIN CONFIGURATION



## ABSOLUTE MAXIMUM RATINGS

			Limits					
Parameter	Symbol	MSM80C88A- 10RS	MSM80C88A 10GS	MSM80C88A- 10JS	Unit	Conditions		
Power Supply Voltage	Vcc		-0.5 ~ +7		v	With respect		
Input Voltage	VIN		-0.5 ~ V <sub>CC</sub> +0.5					
Output Voltage	VOUT		-0.5 $\sim$ V <sub>CC</sub> +0.5		V	to GND		
Storage Temperature	Tstg		°C	-				
Power Dissipation	PD	1.0	w	Ta = 25°C				

## OPERATING RANGE

Parameter	Symbol	Limits	Unit
rarameter	Symbol	MSM80C88A-10	
Power Supply Voltage	Vcc	4.75 ~ 5.25	v
Operating Temperature	ТОР	0 ~ +70	°C

## **RECOMMENDED OPERATING CONDITIONS**

Deservator	Sumbal	MSM80C88A-10			
Parameter	Symbol	MIN	TYP	MAX	Unit
Power Supply Voltage	V <sub>CC</sub>	4.75	5.0	5.25	V
Operating Temperature	ТОР	0	+25	+70	°C
"L" Input Voltage	VIL	-0.5		+0.8	V
"H" Input Voltage	VIH <sup>(*1)</sup>	V <sub>CC</sub> -0.8		V <sub>CC</sub> +0.5	V
in input voltage	(*2)	2.0		V <sub>CC</sub> +0.5	V

\*1 Only CLK, \*2 Except CLK

## DC CHARACTERISTICS

(MSM80C88A-10:  $V_{CC}$  = 4.75 to 5.25V, Ta = 0°C to +70°C)

Parameter	Symbol	MIN	ТҮР	MAX	Unit	Conditions
"L" Output Voltage	VOL			0.4	V	IOL = 2.5 mA
"H" Output Voltage	Vou	3.0	· ·		v	IOH = −2.5 mA
H Output Voltage	VOH	VCC-0.4			V	IOH = -100µA
Input Leak Current	ا_ا	-1.0		+1.0	μA	0 < VIN < VCC
Output Leak Current	ILO .	-10		+10	μA	V <sub>O</sub> = V <sub>CC</sub> or GND
Input Leakage Current (Bus Hold Low)	IBHL	50		400	μΑ	VIN = 0.8V *3
Input Leakage Current (Bus Hold High)	<sup>I</sup> ВНН	-50		-400	μΑ	V <sub>IN</sub> = 3.0V *4
Bus Hold Low Overdrive	IBHLO			600	μA	*5
Bus Hold High Overdrive	Івнно			-600	μA	*6
Operating Power Supply Current	ICC			10	mA/MHz	V <sub>IL</sub> =GND V <sub>IH</sub> =VCC
StandbySupply Current	ICCS			500	μΑ	V <sub>IN</sub> =V <sub>CC</sub> or GND Outputs Unloaded CLK=GND or V <sub>CC</sub>
Input Capacitance	C <sub>in</sub>			10	pF	*7
Output Capacitance	Cout			15	pF	*7
I/O Capacitance	CI/O			20	pF	*7

\*3. Test conditions is to lower V<sub>IN</sub> to GND and then raise V<sub>IN</sub> to 0.8V on pins 2–16 and 35–39.

\*4. Test condition is to raise VIN to VCC and then lower VIN to 3.0V on pins 2-16, 26-32, and 34-39.

\*5. An external driver must source at least IBHLO to switch this node from LOW to HIGH.

\*6. An external driver must sink at least IBHHO to switch this node from HIGH to LOW.

\*7. Test Conditions: a) Freq = 1 MHz.

b) Ummeasured Pins at GND.

c) VIN at 5.0V or GND.

## A.C. CHARACTERISTICS

(MSM80C88A-10:  $V_{CC} = 4.75V$  to 5.25V, Ta = 0°C to 70°C)

## Minimum Mode System

## Timing Requirements

		MSM80	C88A-10	
Parameter	Symbol	Min.	Max.	Unit
CLK Cycle Period	TCLCL	100	DC	ns
CLK Low Time	TCLCH	46		ns
CLK High Time	TCHCL	44		ns
CLK Rise Time (From 1.0V to 3.5V)	TCH1CH2		10	ns
CLK Fall Time (From 3.5V to 1.0V)	TCL2CL1		10	ns
Data in Setup Time	TDVCL	20		ns
Data in Hold Time	TCLDX	10		ns
RDY Setup Time into MSM 82C84A (See Notes 1, 2)	TR1VCL	35		ns
RDY Hold Time into MSM 82C84A (See Notes 1, 2)	TCLR1X	о		ns
READY Setup Time into MSM 80C88A	TRYHCH	33		ns
READY Hold Time into MSM 80C88A	TCHRYX	20		ns
READY inactive to CLK (See Note 3)	TRYLCL	-8		ns
HOLD Setup Time	тнусн	20		ns
INTR, NMI, TEST Setup Time (See Note 2)	тім∨сн	15		ns
Input Rise Time (Except CLK) (From 0.8V to 2.0V)	TILIH		15	ns
Input Fall Time (Except CLK) (From 2.0V to 0.8V)	TIHIL		15	ns

#### Timing Responses

Parameter	Symbol	MSM80	C88A-10	Unit
Farameter	Symbol	Min.	Max.	Unit
Address Valid Delay	TCLAV	10	60	ns
Address Hold Time	TCLAX	10		ns
Address Float Delay	TCLAZ	TCLAX	50	ns
ALE Width	TLHLL	TCLCH-10		ns
ALE Active Delay	TCLLH		40	ns
ALE Inactive Delay	TCHLL		45	ns
Address Hold Time to ALE Inacitive	TLLAX	TCHCL-10		ns
Data Valid Delay	TCLDV	10	60	ns
Data Hold Time	тснох	10		ns
Data Hold Time after WR	тwнdx	TCLCH-25		ns
Control Active Delay 1	тсусту	10	55	ns
Control Active Delay 2	тснсту	10	50	ns
Control Inactive Delay	тсустх	10	55	ns
Address Float to RD Active	TAZRL	0		ns
RD Acrive Delay	TCLRL	10	70	ns

## CPU·MSM80C88A-10RS/GS/JS =

Parameter	Sumbol	MSM80C	88A-10	Unit
Farameter	Symbol	Min.	Max.	Onit
RD Inactive Delay	TCLRH	10	60	ns
RD Inactive to Next Address Active	TRHAV	TCLCL-35		ns
HLDA Valid Delay	TCLHAV	10	60	ns
RD Width	TRLRH	2TCLCL-40		ns
WR Width	TWLWH	2TCLCL-35		ns
Address Valid to ALE Low	TAVAL	TCLCH-35		ns
Output Rise Time (From 0.8V to 2.0)	TOLOH		15	ns
Output Fall Time (From 2.0V to 0.8V)	TOHOL		15	ns

Notes: 1. Signals at MSM82C84A shown for reference only.

- 2. Setup requirement for asynchronous signal only to guarantee recognition at next CLK.
- 3. Applies only to T2 state. (8 ns into T3)

#### Maximum Mode System (Using MSM 82C88 Bus Controller) Timing Requirements

Parameter	Symbol	MSM80C88A-10		
		Min.	Max.	Unit
CLK Cycle Period	TCLCL	100	DC	ns
CLK Low Time	TCLCH	46		ns
CLK High Time	TCHCL	44		ns
CLK Rise Time (From 1.0V to 3.5V)	тсн1сн2		10	ns
CLK Fall Time (From 3.5V to 1.0V)	TCL2CL1		10	ns
Data in Setup Time	TDVCL	20		ns
Data in Hold Time	TCLDX	10		ns
RDY Setup Time into MSM 82C84A (See Notes 1, 2)	TR1VCL	35		ns
RDY Hold Time into MSM 82C84A (See Notes 1, 2)	TCLR1X	0		ns
READY Setup Time into MSM 80C88A	TRYHCH	33		ns
READY Hold Time into MSM 80C88A	TCHRYX	20		ns
READY inactive to CLK (See Note 3)	TRYLCL	-8		ns
Set up Time for Recognition (NMI, INTR, TEST) (See Note 2)	тілусн	15		nis
RQ/GT Setup Time	TGVCH	15		ns
RO Hold Time into MSM 80C88A	TCHGX	20		ns
Input Rise Time (Except CLK) (From 0.8V to 2.0V)	TILIH		15	ns
Input Fall Time (Except CLK) (From 2.0V to 0.8V)	TIHIL		15	ns

#### Timing Responses

Parameter	Symbol	MSM80C88A-10		
		Min.	Max.	Unit
Command Active Delay (See Note 1)	TCLML	5	35	ns
Command Inactive Delay (See Note 1)	TCLMH	5	45	ns
READY Active to Status Passive (See Note 4)	TRYHSH		45	ns
Status Active Delay	TCHSV	10	45	ns
Status Inactive Delay	TCLSH	10	60	ns
Address Valid Delay	TCLAV	10	60	ns
Address Hold Time	TCLAX	10		ns
Address Float Delay	TCLAZ	TCLAX	50	ns
Status Valid to ALE High (See Note 1)	TSVLH		25	ns
Status Valid to MCE High (See Note 1)	TSVMCH		30	ns
CLK low to ALE Valid (See Note 1)	TCLLH		25	ns
CLK Low to MCE High (See Note 1)	TCLMCH		25	ns
ALE Inactive Delay (See Note 1)	TCHLL	4	25	ns
Data Valid Delay	TCLDV	10	60	ns
Data Hold Time	тснох	10		ns
Control Active Delay (See Note 1)	TCVNV	5	45	ns
Control Inactive Delay (See Note 1)	TCVNX	5	45	ns
Address Float to RD Active	TAZRL	0		ns
RD Active Delay	TCLRL	10	70	ns
RD Inactive Delay	TCLRH	10	60	ns
RD Inactive to Next Address Active	TRHAV	TCLCL-35		ns
Direction Control Active Delay (See Note 1)	TCHDTL		50	ns
Direction Control Inactive Delay (See Note 1)	тснотн		30	ns
GT Active Delay (See Note 5)	TCLGL	0	38	ns
GT Inactive Delay	TCLGH	0	45	ns
RD Width	TRLRH	2TCLCL-40		ns
Output Rise Time (From 0.8V to 2.0V)	TOLOH		15	ns
Output Fall Time (From 2.0V to 0.8V)	TOHOL		15	ns

Notes: 1. Signals at MSM 82C84A or MSM 82C88 are shown for reference only.

2. Setup requirement for asynchronous signal only to guarantee recognition at next CLK.

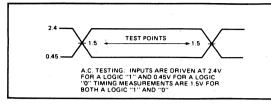
3. Applies only to T2 state (8 ns into T3)

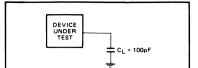
4. Applies only to T3 and wait states.

5.  $C_L = 40 pF (\overline{RQ}/\overline{GT}_0, \overline{RQ}/\overline{GT}_1)$ 

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### A.C. TESTING INPUT, OUTPUT WAVEFORM



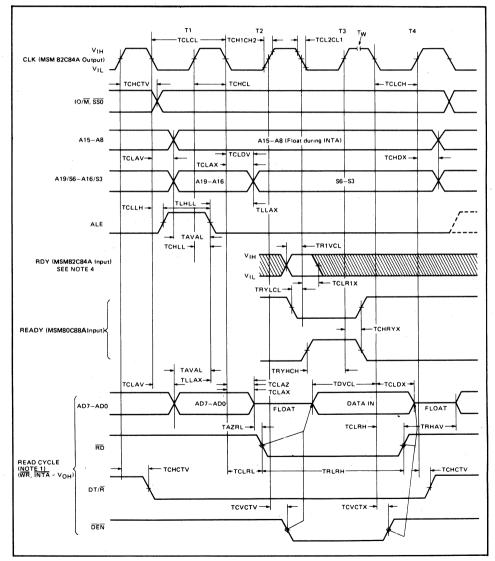


CI INCLUDES JIG CAPACITANCE

A.C. TESTING LOAD CIRCUIT

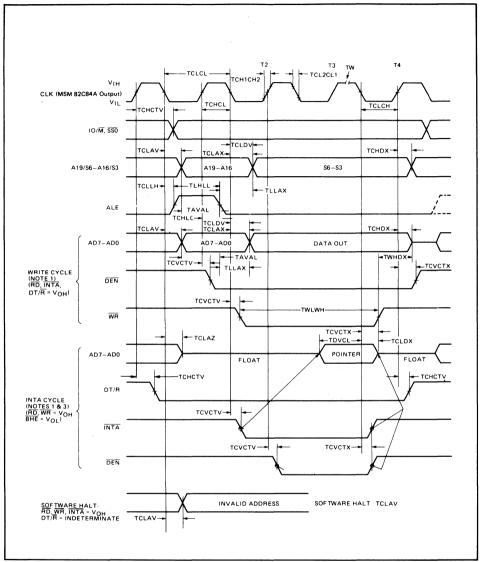
### TIMING CHART

Minimum Mode



5

### Minimum Mode (Continued)

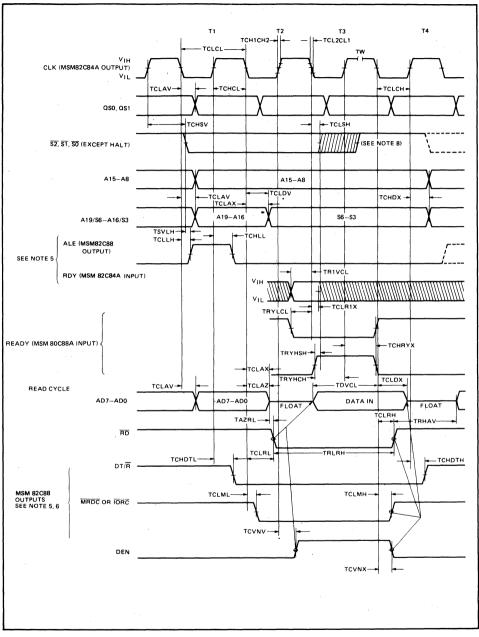


### NOTES:

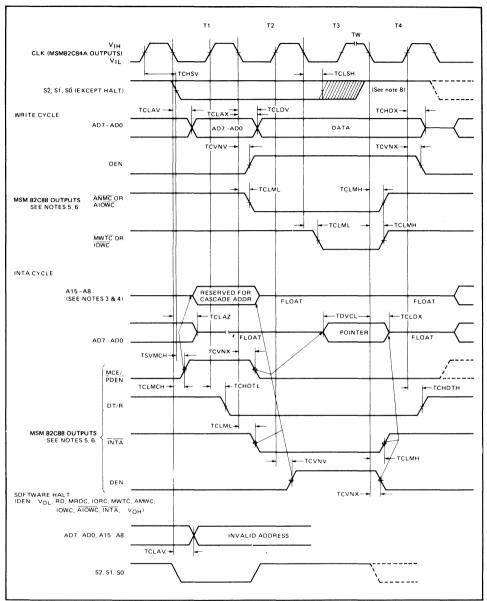
- 1. All signals switch between  $V_{\mbox{OH}}$  and  $V_{\mbox{OL}}$  unless otherwise specified.
- 2. RDY is sampled near the end of T2, T3, TW to determine if TW machines states are to be inserted.
- 3 Two INTA cycles run back-to-back. The MSM80C88A LOCAL ADDR/DATA BUS is floating during both INTA cycles. Control signals shown for second INTA cycle.
- 4. Signals at MSM 82C84A shown for reference only.
- 5. All timing measurements are made at 1.5V unless otherwise noted.

■ CPU·MSM80C88A-10RS/GS/JS ■





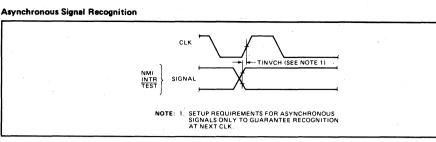
### Maximum Mode (Continued)

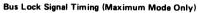


### NOTES:

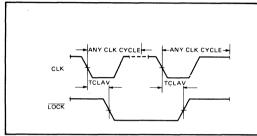
- 1. All signals switch between  $V_{\mbox{OH}}$  and  $V_{\mbox{OL}}$  unless otherwise specified
- 2 RDY is sampled near the end of T2, T3, TW to determine if TW machines states are to be inserted.
- 3 Cascade address is valid between first and second INTA cycle.
- Two INTA cycles run back-to-back. The MSM 80C88A LOCAL ADDR/DATA BUS is floating during both INTA cycles Control for pointer address is shown for second INTA cycle.
- 5. Signal at MSM 82C84A and MSM82C88 shown for reference only.
- 6. The issuance of the MSM 82C88 command and control signals [MRDC, MWTC, AMWC, IORC, IOWC, AIOWC, INTA and DEN) lags the active high MSM 82C88 CEN.
- 7 All timing measurements are made at 1.5V unless otherwise noted
- 8 Status inactive in state just prior to T4

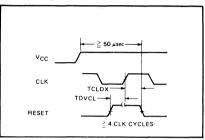
### CPU·MSM80C88A-10RS/GS/JS =



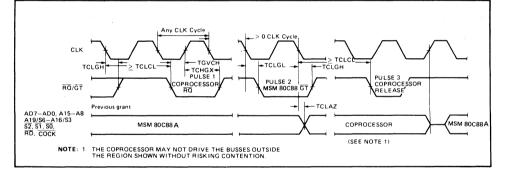




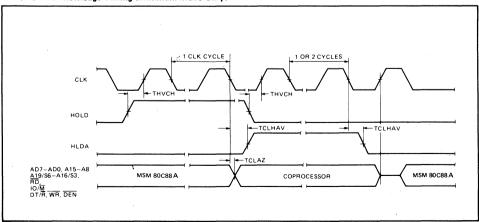




### Request/Grant Sequence Timing (Maximum Mode Only)







### CPU-MSM80C88A-10RS/GS/JS

### PIN DESCRIPTION

### AD0-AD7

ADDRESS DATA BUS: Input/Output

These lines are the multiplexed address and data hus

These are the address bus at T1 cycle and the data bus at T2, T3, TW and T4 cycle.

T2, T3, TW and T4 cycle.

These lines are high impedance during interrupt acknowledge and hold acknowledge.

### A8-A15

ADDRESS BUS: Output

These lines are the address bus bits 8 thru 15 at all cycles.

These lines do not have to be latched by an ALE signal.

These lines are high impedance during interrupt acknowledge and hold acknowledge.

### A16/S3, A17/S4, A18/S5, A19/S6

ADDRESS/STATUS: Output

These are the four most significant address as at the T1, cycle.

Accessing I/O port address, these are low at T1 Cycles.

These lines are Status lines at the T2, T3, TW and T4 Cycle.

S5 indicate interrupt enable Flag.

S3 and S4 are encoded as shown.

S3	S4	Characteristics
0	0	Alternate Data
1	0	Stack
0	1	Code or None
1	1	Data

These lines are high impedance during hold acknowledge.

### RD

**READ:** Output

This lines indicates that the CPU is in a memory or I/O read cycle.

This line is the read strobe signal when the CPU reads data from a memory or I/O device.

This line is active low.

This line is high impedance during hold acknowledge.

### READY

**READY:** Input

This line indicates to the CPU that an addressed memory or I/O device is ready to read or write. This line is active high.

IF the setup and hold time are outof specification, an illegal operation will occur.

### INTR

INTERRUPT REQUEST: Input

This line is a level triggered interrupt request signal which is sampled during the last clock cycle of instruction and string manipulations.

It can be internally masked by software.

This signal is active high and internally synchronized.

### TEST

### TEST: Input

This line is examined by a "WAIT" instruction. When  $\overline{\text{TEST}}$  is high, the CPU enters an idle cycle. When  $\overline{\text{TEST}}$  is low, the CPU exits an idle cycle.

### NMI

NON MASKABLE INTERRUPT: Input This line causes a type 2 interrupt. NMI is not maskable. This signal is internally synchronized and needs a 2 clock cycle pulse width.

### RESET

### RESET: Input

This signal causes the CPU to initialize immediately. This signal is active high and must be at least four clock cycles.

### CLK

### CLOCK: Input

This signal provide the basic timing for an internal circuit.

### MN/MX

MINIMUM/MAXIMUM: Input

This signal selects the CPU's operate mode.

When  $V_{CC}$  is connected, the CPU operates in minimum mode.

When GND is connected, the CPU operates in maximum mode.

### Vcc

V<sub>CC</sub> +5V supplied.

### GND

GROUND

The following pin function descriptions are for maximum mode only.

Other pin functions are already described.

### <u>50, 51, 52</u>

### STATUS: Output

These lines indicate bus status and they are used by the MSM82C88 Bus Controller to generate all memory and I/O access control signals.

These lines are high impedance during hold acknowledge.

These status lines are encoded as shown.

S2	<u>81</u>	SO	Characteristics
0 (LOW)	0	0	Interrupt acknowledge
0	0	1	Read I/O Port
0	1	0	Write I/O Port
0	1	1	Halt
1 (HIGH)	0	0	Code Access
1	0	1	Read Memory
1	1	0	Write Memory
1	1	1	Passive

### RQ/GTO

RQ/GT1

REQUEST/GRANT: Input/Output

These lines are used for Bus Request from other devices and Bus GRANT to other devices. These lines are bidirectional and active low.

### LOCK

LOCK: Output

This line is active low.

When this line is low, other devices can not gain control of the bus.

This line is high impedance during hold acknowledge.

### QS0/QS1

QUEUE STATUS: Output

These are Queue Status Lines that indicate internal instruction queue status.

QS1	QSO	Characteristics
0 (LOW)	0	No Operation
0	1	First Byte of Op Code from Queue
1 (HIGH)	0	Empty the Queue
1	1	Subsequent Byte from Queue

The following pin function descriptions are minimum mode only. Other pin functions are already described.

### 10/M

STATUS: Output

This line selects memory address space or I/O address space.

When this line is low, the CPU selects memory address space and when it is high, the CPU selects I/O address space.

This line is high impedance during hold acknowledge.

### WR

WRITE: Output This line indicates that the CPU is in a memory or

I/O write cycle. This line is a write strobe signal when the CPU writes data to memory or an I/O device.

This line is active low.

This line is high impedance during hold acknowledge.

### INTA

INTERRUPT ACKNOWLEDGE: Output

This line is a read strobe signal for the interrupt accknowledge cycle.

This line is active low.

### ALE

ADDRESS LATCH ENABLE: Output

This line is used for latching an address into the MSM82C12 address latch it is a positive pulse and the trailing edge is used to strobe the address. This line in never floated.

### DT/R

DATA TRANSMIT/RECEIVE: Output

This line is used to control the direction of the bus transceiver.

When this line is high, the CPU transmits data, and when it is low, the CPU receive data.

This line is high impedance during hold acknowledge.

### DEN

DATA ENABLE: Output

This line is used to control the output enable of the bus transceiver.

This line is active low. This line is high impedance during hold acknowledge.

### HOLD

HOLD REQUEST: Input

This line is used for a Bus Request from an other device.

This line is active high.

### HLDA

HOLD ACKNOWLEDGE: Output

This line is used for a Bus Grant to an other device.

This line is active high.

### SS0

STATUS: Output This line is logically equivalent to  $\overline{\text{SO}}$  in the maximum mode.

- CPU·MSM80C88A-10RS/GS/JS

### STATIC OPERATION

All MSM80C88A circuitry is of static design. Internal registers, counters and latches are static and require no refresh as with dynamic circuit design. This eliminates the minimum operating frequency restriction placed on other microprocessors. The MSM80C88A can operate from DC to the appropriate upper frequency limit. The processor clock may be stopped in either state (high/low) and held there indefinitely. This type of operation is especially useful for system debug or power critical applications.

The MSM80C88A can be signal stepped using only the CPU clock. This state can be maintained as long as is necessary. Single step clock operation allows simple interface circuitry to provide critical information for bringing up your system.

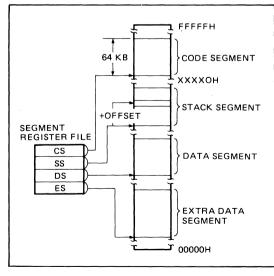
Static design also allows very low frequency operation (down to DC). In a power critical situation, this can provide extremely low power operation since 80C88A power dissipation is directly related to operating frequency. As the system frequency is reduced, so is the operating power until, ultimately, at a DC input frequency, the MSM80C88A power requirement is the standby current (500 µA maximum).

### FUNCTIONAL DESCRIPTION

### GENERAL OPERATION

The internal function of the MSM80C88A consist of a Bus Interface Unit (BIU) and an Execution Unit (EU). These units operate mutually but perform as separate processors.

### Memory Organization



The BIU performs instruction fetch and queueing, operand fetch, DATA read and write address relocation and basic bus control. By performing instruction prefetch while waiting for decoding and execution of instruction, the CPU's performance is increased. Up to 4-bytes fo instruction stream can be queued.

EU receives pre-fetched instructions from the BIU queue, decodes and executes instructions and provides an un-relocated operand address to the BIU.

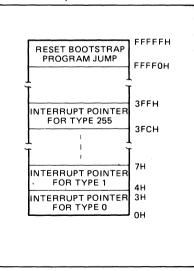
### MEMORY ORGANIZATION

The MSM80C88A has a 20-bit address to memory. Each address has 8-bit data width. Memory is organized 00000H to FFFFH and is logically divided into four segments: code, data, extra data and stack segment. Each segment contains up to 64 Kbytes and locates on a 16-byte boundary. (Fig. 3a)

All memory references are made relative to a segment register according to a select rule. Memory location FFFF0H is the start address after reset, and 00000H through 003FFH are reserved as an interrupt pointer. There are 256 types of interrupt pointer;

Each interrupt type has a 4-byte pointer element consisting of a 16-bit segment address and a 16-bit offset address.

### **Reserved Memory Locations**



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CPU·MSM80C88A-10RS/GS/JS

Memory Reference Need	Segment Register Used	Segment Selection Rule
Instructions	CODE (CS)	Automatic with all instruction prefetch.
Stack	STACK (SS)	All stack pushes and pops. Memory references relative to BP base register except data references.
Local Data	DATA (DS)	Data references when relative to stack, destination of string operation, or explicitly overridden.
External (Global) Data	EXTRA (ES)	Destination of string operations: Explicitly selected using a segment override.

### MINIMUM AND MAXIMUM MODES

The MSM80C88A has two system modes: minimum and maximum. When using the maximum mode, it is easy to organize a multiple-CPU system with the MSM 82C88 Bus Controller which generates the bus control signal.

When using the minimum mode, it is easy to organize a simple system by generating the bus control signal itself.  $MN/\overline{MX}$  is the mode select pin. Definition of 24-31, 34 pin changes depends on the MN/MX pin.

### BUS OPERATION

The MSM80C88A has a time multiplexed address and data bus. If a non-multiplexed bus is desired for the system, it is only needed to add the address latch.

A CPU bus cycle consists of at least four clock cycles: T1, T2, T3 and T4. (Fig. 4)

The address output occurs during T1, and data transfer occurs during T3 and T4. T2 is used for changing the direction of the bus during read operation. When the device which is accessed by the CPU is not ready to data transfer and send to the CPU "NOT READY" is indicated TW cycles are inserted between T3 and T4.

When a bus cycle is not needed, T1 cycles are inserted between the bus cycles for internal execution. At the T1 cycle an ALE signal is output from the CPU or the MSM82C88 depending in MN/MX. at the trailing edge of an ALE, a valid address may be latched. Status bits S0, S1 and S2 are uased, in maximum mode, by the bus controller to recognize the type of bus operation according to the following table.

S2	<u>5</u> 1	SO	Characteristics
0 (LOW)	0	0	Interrupt acknowledge
0	0	1	Read I/O
0	1	0	Write I/O
0	1	1	Halt
1 (HIGH)	0	0	Instruction Fetch
1	0	1	Read Data from Memory
1	1	0	Write Data to Memory
1	1	1	Passive (no bus cycle)

Status bit S3 through S6 are multiplexed with A16-A19, and therefore they are valid during T2 through T4. S3 and S4 indicate which segment register was selected on the bus cycle, according to the following table.

S4	S3	Characteristics
0 (LOW)	0	Alternate Data (Extra Segment)
0	1	Stack
1 (HIGH)	0	Code or None
1	1	Data

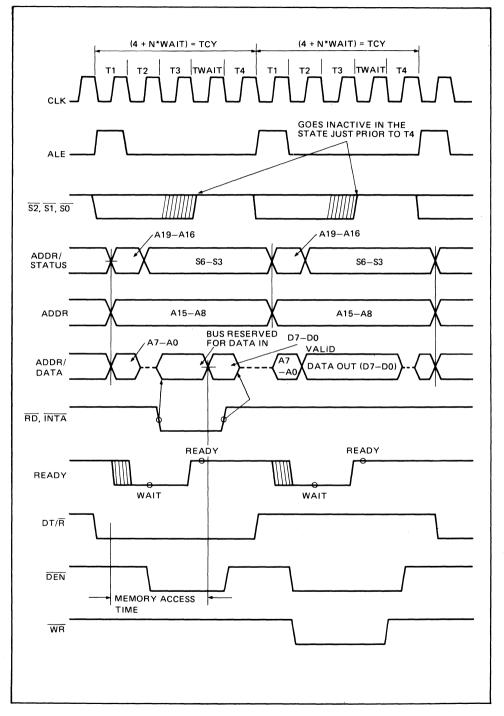
S5 indicates interrupt enable Flag.

### I/O ADDRESSING

The MSM80C88A has a 64 Kbyte I/O. When the CPU accesses an I/O device, address A0-A15 are in same format as a memory access, and A16-A19 are low.

I/O ports address are same as four memory.

### **Basic System Timing**



5

# 5

### EXTERNAL INTERFACE

### RESET

CPU initialization is executed by the RESET pin. The MSM80C88A's RESET High signal is required for greater than 4 clock cycles.

The rising edge of RESET terminates the present operation immediately. The falling edge of RESET triggers an internal reset requence for approximately 10 clock cycles. After internal reset sequence is finished, normal operation begins from absolute location FFFF0H.

### INTERRUPT OPERATIONS

The interrupt operation is classified as software or hardware, and hardware interrupt is classified as nonmarkable or maskable.

An interrupt causes a new program location which is defined by the interrupt pointer table, according to the interrupt type. Absolute location 00000H through 003FFH is reserved for the interrupt pointer table. The interrupt pointer table consists of 256-elements. Each element is 4 bytes in size and corresponds to an 8-bit type number which is sent from an interrupt request device during the interrupt acknowledge cycle.

### NON-MASKABLE INTERRUPT (NMI)

The MSM80C88A has a non-maskable Interrupt (NM1) which is of higher priority than a maskable interrupt request (INTR).

An NM1 request pulse width needs minimum of 2 clock cycles. The NM1 will be serviced at the end of the current instruction or between string manipulations.

### MASKABLE INTERRUPT (INTR)

The MSM80C88A provides another interrupt request (INTR) which can be masked by software. INTR is level triggered, so it must be held until interrupt request is acknowledged.

The INTR will be serviced at the end of the current instruction or between string manipulations.

### Interrupt Acknowledge Sequence

### INTERRUPT ACKNOWLEDGE

During the interrupt acknowledge sequence, further interrupts are disabled. The interrupt enable bit is reset by any interrupt, after which the Flag register is automatically pushed onto the stack. During an acknowledge sequence, the CPU emits the lock signal from T2 of first bus cycle to T2 of second bus cycle. At the second bus cycle, a byte is fetched from the external device as a vector which identifies the type of interrupt. This vector is multiplied by four and used as an interrupt pointer address (INTR only).

The Interrupt Return (IRET) instruction includes a Flag pop operation which returns the original interrupt enable bit when it restores the Flag.

### HALT

When a Halt instruction is executed, the CPU enter Halt state. An interrupt request or RESET will force the MSM80C88A out of the Halt state.

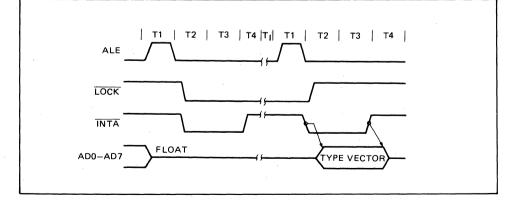
### SYSTEM TIMING-MINIMUM MODE

A bus cycle begins at T1 with an ALE signal. The trailing edge of ALE is used to latch the address. From T1 to T4 the  $IO/\overline{M}$  signal indicates a memory or I/O operation. From T2 to T4, the address data bus changes the address bus to the data bus.

The read  $(\overline{RD})$ , write  $(\overline{WR})$ , and interrupt acknowledge  $(\overline{INTA})$  signals caused the addressed device to enable the data bus. These signals become active at the beginning of T2 and inactive at the beginning of T4.

### SYSTEM TIMING-MAXIMUM MODE

In maximum mode, the MSM82C88 Bus Controller is added to system. The CPU sends status information to the Bus Controller. Bus timing signals are generated by the Bus Controller. Bus timing is almost the same as in minimum mode.



### **BUS HOLD CIRCUITRY**

To avoid high current conditions caused by floating inputs to CMOS devices, and to eliminate the need for pull-up/down resistors, "bus-hold" circuitry has been used on 80C86 pins 2–16, 26–32, and 34–39 (Figures 6a, 6b). These circuits will maintain the last valid logic state if no driving source is present (i.e. an unconnected pin or a driving source which goes to a high impedance state). To overdrive the "bus hold" circuits, an external driver must be capable of supplying approximately 400  $\mu$ A minimum sink or source current at valid input voltage levels. Since this "bus hold" circuitry is active and not a "resistive" type element, the associated power supply current is negligible and power dissipation is significantly reduced when compared to the use of passive pull-up resistors.

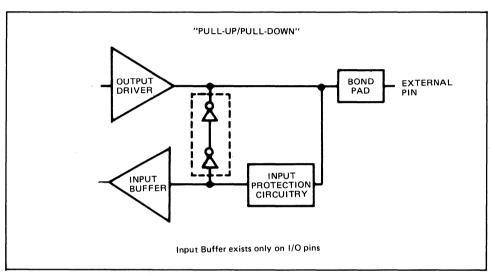


Figure 6a. Bus hold circuitry pin 2-16, 35-39.

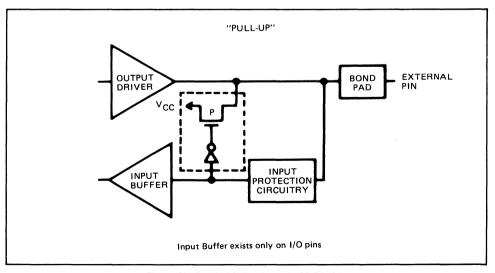


Figure 6b. Bus hold circuitry pin 26-32, 34

## DATA TRANSFER

MOV = Move:	7	6	5	4	3			0	76	5	4	3	2 1	0	7	6	5	4	3	2	1	0	76	6	5 4	3	2	1	0
Register/memory to/from register	1	0	0	0	1		d	w			eg	_	r/m																
Immediate to register/memory	1	1	0	0	0	1	1	w	mod		0	0	r/m					lata							da	ta if	w	= 1	
Immediate to register	1	0	1	1	w		reg				ata								a if		= 1								
Memory to accumulator	1	0	1	0	0	0					dr-l								high										
Accumulator to memory	1	0	1	0	0	0	1	w			dr-l						ac	ldr-	higł	n									
Register/memory to segment register	1	0	0	0		1		0	mod		reg		r/m																
Segment register to register/memory	1	0	0	0	1.	1	0	0	mod	0	reg		r/m																
PUSH = Push:																													
Register/memory		1	1			1	1	1	mod	1	1	0	r/m														,		
Register	0	1	0	1	0		reg																						
Segment register	0	0	0	re	g	1	1	0																					
POP = Pop:																													
Register/memory	1	0	0	0	1	1	1	1	mod	0	0	0	r/m																
Register	0	1	0	1	1		reg																						
Segment register	0	0	0	re	g	1	1	1																					
XCHG = Exchange:																													
Register/memory with register	1	0	0	0	0	1	1	w	mod	r	eg		r/m																č
Register with accumulator	1	0	0	1	0		reg																						
IN = Input from:																													
Fixed port	1	1	1	0	0	1	0	w			por	t																	
Variable port	1	1	1	0	1	1	0	w																					
OUT = Output to:																													
Fixed port	1	1	1	0	0	1	1	w			por	t																	
Variable port	1	1	1	0	1	1	1	w																					
XLAT = Translate byte to AL	1	1	0	1	0	1	1	1																					
LEA = Load EA to register	1	0	0	0	1	1	0	1	mod	I	eg		r/m																
LDS = Load pointer to DS	1	1	0	0	0	1	0	1	mod	. 1	eg		r/m																
LES = Load pointer to ES	1	1	0	0	0	1	0	0	mod	ı	eg		r/m																
LAHF = Load AH with flags	1	0	0	1	1	1	1	1																					
SAHF = Store AH into flags	1	0	0	1	1	1	1	0																					
PUSHF = Push flags	1	0	0	1	1	1	0	0																					1
POPF = Pop flags	1	0	0	1	1	1	0	1																					

■ CPU-MSM80C88A-10RS/GS/JS

## ARITHMETIC

ADD = Add:	Τ				_					_					
Reg./memory with register to either Immediate to register/memory Immediate to accumulator	0 1 0	0 0 0	0 0 0	0 0 0	0 0 0	0 0 1	s	* * *		0		reg O ata	r/m r/m	data data if w = 1	data if s:w = 01
ADC = Add with carry:															
Reg./memory with register to either Immediate to register/memory Immediate to accumulator	0 1 0	0 0 0			0 0 0	0	s			0		reg O ata	r/m r/m	data data if w = 1	data if s:w = 01
INC = Increment:															
Register/memory Register AAA = ASCII adjust for add DAA = Decimal adjust for add	1 0 0 0		0 1	0 1		י 1	reg 1	1	mod	0	0	0	r/m		
SUB = subtract:															
Reg./memory and register to either Immediate from register/memory Immediate from accumulator	0 1 0	0		0	1 0 1	0	s	w	mod mod	1	0	reg 1 Ita	r/m r/m	data data if w = 1	data if s:w = 01
SBB = Subtract with borrow:															
Reg./memory and register to either Immediate from register/memory Immediate from accumulator	0 1 0	0	0	0	1 0 1	0	s	w	mod mod	0	1	reg 1 ta	r/m r/m	data data if w = 1	data if s:w = 01
DEC = Decrement:															
Register/memory Register NEG = Change sign	0	1	0	0	1		reg		mod mod				r/m r/m		
CMP = Compare:															
Register/memory and register Immediate with accumulator AAS = ASCII adjust for subtract	0 1 0 0	0 0		1		0 1	s O	w w	mod mod			reg 1 ta	r/m r/m	data data if w = 1	data if s:w = 01



■ CPU-MSM80C88A-10RS/GS/JS ■

DAS = Decimal adjust for subtract	
MUL = Multiply (unsigned)	1 1 1 1 0 1 1 w mod 1 0 0 r/m
[MUL = Integer multiply (signed)	1 1 1 1 0 1 1 w mod 1 0 1 r/m
AAM = ASCII adjust for multiply	1 1 0 1 0 1 0 0 0 0 0 1 0 1 0
DIV = Divide (unsigned)	1 1 1 1 0 1 1 w mod 1 1 0 r/m
IDIV = Integer divide (signed)	1 1 1 1 0 1 1 w mod 1 1 1 r/m
AAD = ASCII adjust for divide	1 1 0 1 0 1 0 1 0 0 0 0 1 0 1 0
CBW = Convert byte to word	
CWD = Convert word to double word	

CPU-MSM80C88A-10RS/GS/JS

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## LOGIC

	 1	1	1	1	~	1	1			~	- 1		- 1		
NOT = Invert SHL/SAL = Shift logical/arithmetic left		1							mod mod				r/m r/m		
SHL/SAL = Shift logical/arithmetic left SHR = Shift logical right	1		0						mod mod				r/m		
SAR = Shift arithmetic right	1		-						mod				r/m		
ROL = Rotate left	1		-						mod				r/m		
ROR = Rotate right	1								mod				r/m		
RCL = Rotate left through carry	1		0						mod				r/m		
RCR = Rotate right through carry	1								mod				r/m		
AND = And:															
Reg./memory and register to either	0	0	1	0	0	0	d	w	mod			reg	r/m		
Immediate to register/memory	1	0	0	0	0	0	0	w	mod	1	0	) Ő	r/m	data	data if w = 1
Immediate to accumulator	0	0	1	0	0	1	0	w			C	data		data if w = 1	
TEST = And function to flags, no result:															
Register/memory and register	1	0	0	0	0	1	0	w	mod			reg	r/m		
Immediate data and register/memory	1	1	1	1	0	1	1	w	mod	0	0	) Ō	r/m	data	data if w = 1
Immediate data and accumulator	1	0	1	0	1	0	0	w			c	data		data if w = 1	
OR = Or:															
Reg./memory and register to either	0	0	0	0	1	0	d	w	mod			reg	r/m		
Immediate to register/memory	1	0							mod	0	0	) 1	r/m	data	data if w = 1
Immediate to accumulator	0	0			1							data		data if w = 1	
XOR = Exclusive or:															
Reg./memory and register to either	0	0	1	1	0	0	d	w	mod			reg	r/m		
Immediate to register/memory	1	0	0	0	0	0	0	w	mod	1	1	ŏ	r/m	data	data if w = 1
Immediate to accumulator	0	0	1	1	0	1	0	w			c	data		data if w = 1	
REP = Repeat	 1	1	1	1	0	0	1	z							
MOVS = Move byte/word	1	0	1	0	0	1	0	w							
CMPS = Compare byte/word	1	0	1	0	0	1	1	w							
SCAS = Scan byte/word	1	0	1	0	1	1	1	w							
	1	0		^	1	4	^		1				1		

LODS = Load byte/word to AL/AX

STOS = Store byte/word from AL/AX



1 0 1 0 1 1 0 w

1010101w



### CJMP = Conditional JMP 0 1 1 1 0 1 0 0 disp JE/JZ = Jump on equal/zero 0 disp JZ/JNGE = Jump on less/not greater or equal 1 1 0 0 1 1 0 1 1 1 1 1 1 0 disp JLE/JNG = Jump on less or equal/not greater JB/JNAE = Jump on below/not above or equal 0 0 0 1 0 disp 1 1 1 disp JBE/JNA = Jump on below or equal/not above 0 1 1 1 0 1 1 0 JP/JPE = Jump on parity/parity even 0 1 1 1 0 1 0 disp 1 JO = Jump on over flow 0 1 1 1 0 0 0 0 disp JS = Jump on sign 0 1 1 1 0 0 0 disp 1 JNE/JNZ = Jump on not equal/not zero 10101 disp 0 1 1 JNL/JGE = Jump on not less/greater or equal 0 1 1 1 1 0 1 disp 1 JNLE/JG = Jump on not less or equal/greater 0 1 disp 1 1 1 1 1 JNB/JAE = Jump on not below/above or equal 0 1 10011 disp 1 JNBE/JA = Jump on not below or equal/above 0 1 0 1 1 1 disp 1 1 JNP/JPO = Jump on not parity/parity odd 0 disp 1 1 1 1011 JNO = Jump on not overflow 0 0 1 disp 1 0 0 JNS = Jump on not sign 0 1 1 0 0 1 disp 1 1 LOOP = Loop CX times disp 1 0 0 0 1 0 LOOPZ/LOOPE = Loop while zero/equal 0 0 0 0 1 disp 1 1 LOOPNZ/LOOPNE = Loop while not zero/equal 0 0 0 0 0 disp 1 1 1 JCXZ = Jump on CX zero 1 1 1 0 0 0 1 1 disp INT = Interrupt: 0 1 1 0 1 Type specified 1 1 0 type 0.01100 Type 3 1 1 0 0 1 1 1 0 INTO = Interrupt on overflow 1 1 1 1 0 0 1 1 1 1 IRET = Interrupt return

CPU-MSM80C88A-10RS/GS/JS

### PROCESSOR CONTROL

CLC = Clear carry	1	1	1	1	1	0	0	0		
CMC = Complement carry	1	1	1	1	0	1	0	1		
STC = Set carry	1	1	1	1	1	0	0	1		
CLD = Clear direction	1	1	1	1	1	1	0	0		
STD = Set direction	1	1	1	1	1	1	0	1		
CLI = Clear interrupt	1	1	1	1	1	0	1	0		
STI = Set interrupt	1	1	1	1	1	0	1	1		
HLT = Halt	1	1	1	1	0	1	0	0		
WAIT = Wait	1	0	0	1	1	0	1	1		
ESC = Escape (to external device)	1	1	0	1	1	x	x	x	mod x x x r/m	
LOCK = Bus lock prefix	1	1	1	1	0	0	0	0		

## CONTROL TRANSFER

CALL = Call:	7	6	5	4	3	2	1	0	76	5	4	. 3	3	2	1 (	)	7 (	6	5	4	3	2	1	C	v[7	, (	6	5	4	3	2	1	0
Direct within segment	1	1	1	0	1	0	0	0			dis	p-le	ow						¢	disp	-hi	gh											1
Indirect within segment	1	1	1	1	1	1	1	1	mod	0	1	C	)		r/m																		
Direct intersegment	1	0	0	1	1	0	1	0			offs	et-	lov	v					o	ffse	t-h	igh											
											seg	g-lo	w							seg	-hig	gh											
Indirect intersegment	1	1	1	1	1	1	1	1	mod	0	1	1	I		r/m																		
JMP = Unconditional Jump:																																	
Direct within segment	1	1	1	0	1	0	0	1			dis	p-le	ow						c	disp	-hi	gh											
Direct within segment-short	1	1	1	0	1	0	1	1			c	disp	5																				
Indirect within segment	1	1	1	1	1	1	1	1	mod	1	0	0	)	i	r/m																		
Direct intersegment	1	1	1	0	1	0	1	0		c	offs	et-	lov	v					o	ffse	t-h	igh					-						
											se	eg-l	ow							seg	-hig	jh											1
Indirect intersegment	1	1	1	1	1	1	1	1	mod	1	0	1		1	r/m																		
RET = Return from CALL:																																	
Within segment	1	1	0	0	0	0	1	1																									
Within seg. adding immediate to SP	1	1	0	0	0	0	1	0			dat	a-le	ow						c	data	a-hi	gh											
Intersegment	1	1	0	0	1	0	1	1														-											1
Intersegment adding immediate to SP	1	1	0	Ð	1	0	1	0			dat	a-le	ow						c	data	a-hi	gh											ļ



### CPU·MSM80C88A-10RS/GS/JS =

Footnotes:

AL = 8-bit accumulator AX = 18-bit accumulator CX = Count register DS = Data segment ES = Extra segment Above/below refers to unsigned value Greater = more positive Less = less positive (more negative) signed value If d = 1 then "to" reg: If d = 0 then "from" reg. If w = 1 then word instruction: If w = 0 then byte instruction

If mod = 11 then r/m is treated as a REG field If mod = 00 then DISP = 0\*, disp-low and disp-high are absent If mod = 01 then DISP = disp-low sign-extended to 16-bits, disp-high is absent If mod = 10 then DISP = disp-high: disp-low

```
If r/m = 000 then EA = (BX) + (SI) + DISP

If r/m = 001 then EA = (BX) + (DI) + DISP

If r/m = 010 then EA = (BP) + (SI) + DISP

If r/m = 011 then EA = (BP) + (DI) + DISP

If r/m = 100 then EA = (SI) + DISP

If r/m = 101 then EA = (DI) + DISP

If r/m = 110 then EA = (BZ) + DISP*

If r/m = 111 then EA = (BX) + DISP

DISP follows 2nd byte of instruction (before data if required)
```

\* except if mod = 00 and r/m = 110 then EA-disp-high: disp-low

If s:w = 01 then 16 bits of immediate data form the operand If s:w = 11 then an immediate data byte is sign extended to form the 16-bit operand If v = 0 then "count" = 1: If v = 1 then "count" in (CL) x = don't care

z is used for string primitives for comparison with ZF FLAG

SEGMENT OVERRIDE PREFIX

001 reg 110

REG is assigned according to the following table:

16-Bit	(w = 1)	8-Bit	(w = 0)	Segment
000	AX	000	AL	00 ES
001	СХ	001	CL	01 CS
010	DX	010	DL	10 SS
011	BX	011	BL	11 DS
100	SP	100	АН	
101	BP	101	СН	
110	SI	110	DH	
111	DI	111	вн	

Instructions which reference the flag register file as a 16-bit object use the symbol FLAGS to represent the file:

FLAGS = x:x:x:x:(OF):(DF):(IF):(TF):(SF):(ZF):X:(AF):X:(PF):X:(CF)

# 1/0

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# **OKI** semiconductor MSM81C55RS/GS/JS MSM81C55-5RS/GS/JS

2048 BIT CMOS STATIC RAM WITH I/O PORTS AND TIMER

### GENERAL DESCRIPTION

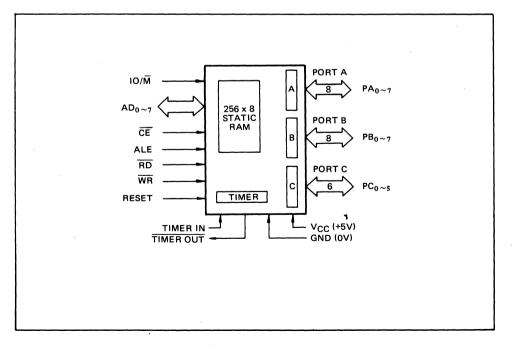
The MSM81C55/81C55-5 have 2k bits of static RAM (256 byte) with parallel I/O ports and a timer. It uses silicon gate CMOS technology and consumes a standby current of 100 micro ampere, maximum, while the chip is not selected. Featuring a maximum access time of 400 ns, the MSM81C55/81C55-5 can be used in an 80C85A/80C85A-2 system without using wait states. The parallel I/O consists of two 8-bit ports and one 6-bit port (both general purpose). The MSM81C55/81C55-5 also contains a 14-bit programmable counter/timer which may be used for sequence-wave generation or terminal count-pulsing.

### FEATURES

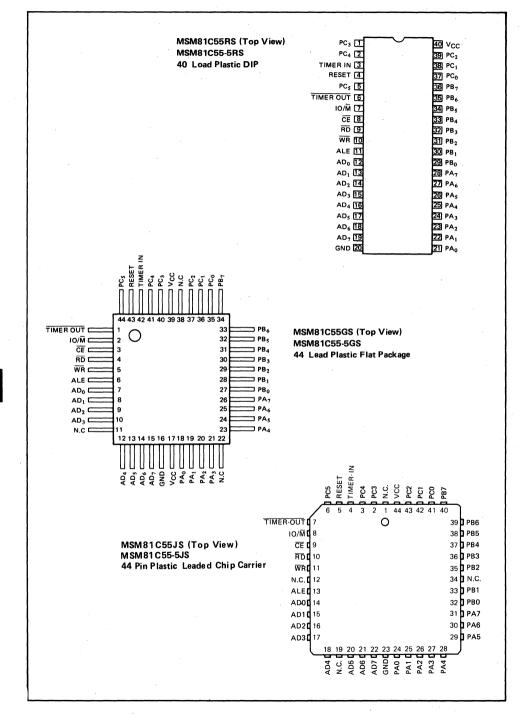
- High speed and low power achieved with silicon gate CMOS technology.
- 256 words x 8 bits RAM
- Single power supply, 3 to 6V
- Completely static operation
- On-chip address latch
- 8-bit programmable I/O ports (port A and B)
- TTL Compatible

### FUNCTIONAL BLOCK DIAGRAM

- RAM data hold characteristic at 2V
- 6-bit programmable I/O port (port C)
- 14-bit programmable binary counter/timer
- Multiplexed address/data bus
- Direct interface with MSM80C85A
- Direct interface with MSM80C85A-2 (MSM81C55-5)
- •40 pin Plastic DIP (DIP40-P-600)
- •44 pin PLCC (QFJ44-P-S650)
- •44 pin Plastic QFP(QFP44-P-910-K)
- 44 pin-V Plastic QFP(QFP44-P-910-VK)



### PIN CONFIGURATION



# ABSOLUTE MAXIMUM RATINGS

			Limits				
Parameter	Symbol	Conditions	MSM81C55RS MSM81C55-5RS	MSM81C55GS MSM81C55-5GS	MSM81C55JS MSM81C55-5JS	Unit	
Supply Voltage	Vcc			-0.5 to +7		V	
Input Voltage	VIN		-0.5 to V <sub>CC</sub> + 0.5				
Output Voltage	Vout	Referenced to GND	–0.5 to V <sub>CC</sub> + 0.5				
Storage Temperature	T <sub>stg</sub>			-55 to + 150		°C	
Power Dissipation	PD	Ta = 25°C	1.0	0.7	1.0	w	

### OPERATING CONDITION

Parameter	Symbol	Limits	Unit
Supply Voltage	Vcc	3 to 6	v
Operating Temperature	тор	-40 to +85	°C

### **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage (81C55)	Vcc	4.5	5	5.5	v
Operating Temperature (81C55)	тор	-40	+25	+85	°c
"L" Level Input	VIL	-0.3		+0.8	v
"H" Level Input	∨ін	2.2		V <sub>CC</sub> + 0.3	v
Supply Voltage (81C55-5)	Vcc	4.75	5	5.25	v
Operating Temperature (81C55-5)	т <sub>ор</sub>	-40	+25	+70	°c

### DC CHARACTERISTICS

Parameter	Symbol	Condit	Conditions			Max.	Unit
"L" Level Output Voltage	VOL	IOL = 2mA				0.45	v
"H" Level Output Voltage	New	IOH =400μA		2.4			v
	∨он	IOH = -40μA	V <sub>CC</sub> = 4.5V to 5.5V	4.2			v
Input Leak Current	1LI	$0 \le V_{IN} \le V_{CC}$		-10		10	μA
Output Leak Current	ILO	0 ≤ V <sub>OUT</sub> ≤ V <sub>CC</sub>	$Ta = -40^{\circ}C$ to	-10		10	μA
Standby Current	lccs	ĈĒ ≧ V <sub>CC</sub> –0.2V V <sub>IH</sub> <u>≧</u> V <sub>CC</sub> –0.2V V <sub>IL</sub> ≤ 0.2V	85°C		0.1	100	μA
Mean Operating Current	ιсс	Memory cycle time: 1µs				5	mA

### AC CHARACTERISTICS

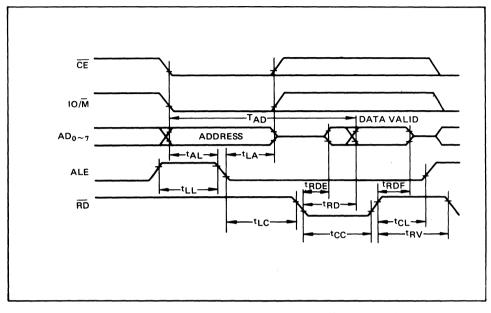
 $(V_{CC} = 4.5 \text{ to } 5.5V, Ta = -40 \text{ to } +80^{\circ}\text{C}) \text{ MSM81C55H}$  $(V_{CC} = 4.75 \text{ to } 5.25V, Ta = -40 \text{ to } +70^{\circ}\text{C}) \text{ MSM81C55-5}$ 

		MSME	31C55	MSM8	1C55-5		T .
Parameter	Symbol	Min.	Max.	Min.	Max.	Unit	Remarks
Address/latch Set-up Time	tAL	50		37		ns	
Latch/address Holt Time	tLA	30		30		ns	
Latch/read (write) Delay Time	tLC	100		40		ns	
Read/output Delay Time	tRD		170		140	ns	
Address/output Delay Time	tAD		400		330	ns	
Latch Width	tLL	100		70		ns	
Read/data Bus Floating Time	<sup>t</sup> RDF	0	100	0	80	ns	
Read (write)/latch Delay Time	tCL	20		20		ns	
Read (write) Width	tCC	250		200		ns	
Data In/write Set-up Time	tDW	150		100		ns	
Write/data-in Holt Time	tWD	0		25		ns	
Recovery Time	tRV	300		200		ns	
Write/port Output Delay Time	tWP		400		300	ns	
Port Input/read Set-up Time	tPR	70		50		ns	Load capaci-
Read/port Input Hold Time	tRP	50		10		ns	tance: 150pF
Strobe/buffer Full Delay Time	tSBF		400		300	ns	
Strobe Width	tss	200		150		ns	
Strobe/buffer Empty Delay Time	tRBE		400		300	ns	
Strobe/interrupt-on Delay Time	tsi		400		300	ns	
Read/interrupt-off Delay Time	tRDI		400		300	ns	
Port Input/strobe Set-up Time	tPSS	50		20		ņs	
Strobe/port-input Hold Time	<sup>t</sup> PHS	120		100		ns	
Strobe/buffer-empty Delty Time	tSBE		400		300	ns	
Write/buffer-full Delay Time	tWBF		400		300	ns	
Write/interrupt-off Delay Time	twi		400		300	ns	
Time Output Delay Time Low	<sup>t</sup> TL		400		300	ns	
Time Output Delay Time High	ţтн		400		300	ns	
Read/data Buse Enable Delay Time	tRDE	10		10		ns	ж.
Timer Cycle Time	tCYC	320		320		ns	
Timer Input Rise and Fall Times	t <sub>r</sub> , t <sub>f</sub>		80		80	ns	
Timer Input Low Level Time	t <sub>1</sub>	80		40		ns	
Timer Input High Level Time	t <sub>2</sub>	120		70		ns	
WRITE to TIMER-IN for writes which start counting	۲WT	200		200		ns	
TIMER-IN to WRITE for wites which start counting	۲W	0		0		ns	

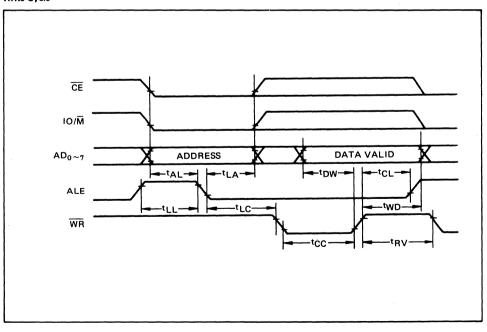
Note: Timing are measured with  $V_L$  = 0.8V and  $V_H$  = 2.2V for both input and output.

## TIMING

Read Cycle



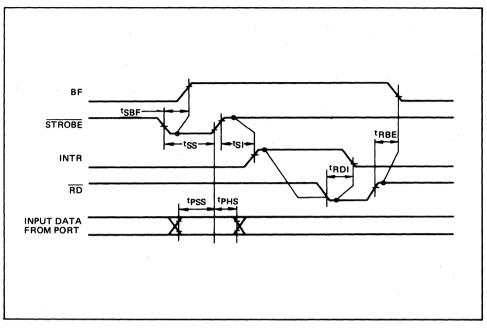
Write Cycle

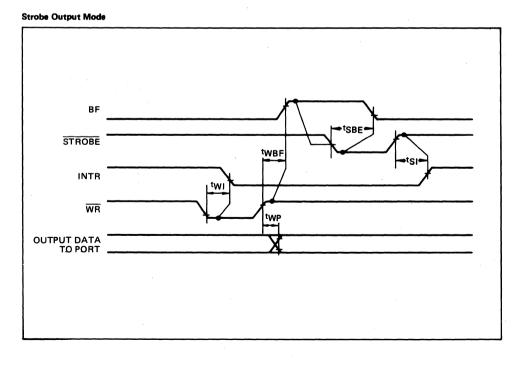


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■ I/O·MSM81C55RS/GS/JS MSM81C55-5RS/GS/JS ■-

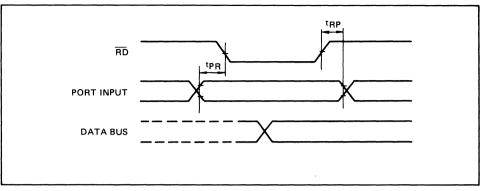
```
Strobe Input Mode
```



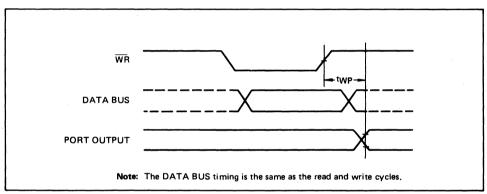


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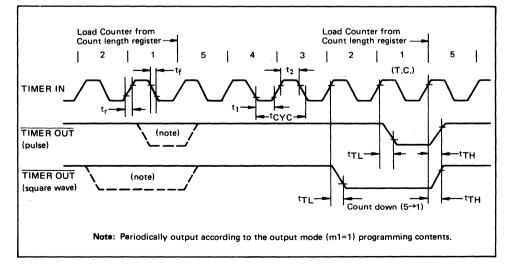




### **Basic Output Mode**

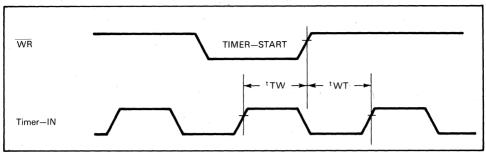


**Timer Waveforms 1** 



■ I/O·MSM81C55RS/GS/JS MSM81C55-5RS/GS/JS ■-



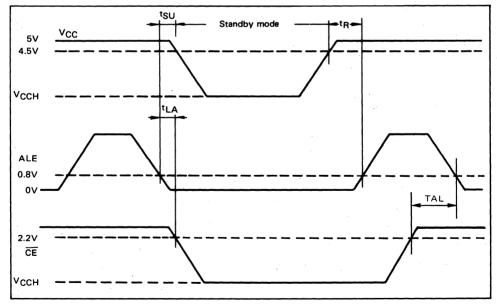


### RAM DATA HOLD CHARACTERISTICS AT LOW SUPPLY VOLTAGE

l*•	Sumbol	One dising	Specification			
Item	Symbol	Condition Min.		Typ.	Max.	Unit
Data Holding Supply Voltage	VCCH	V <sub>IN</sub> = 0V or V <sub>CC</sub> , ALE = 0V	2.0	-	-	V
Data Holding Supply Current	ГССН	V <sub>CC</sub> = V <sub>CCH</sub> , ALE = 0 V <sub>IN</sub> = 0V or V <sub>CC</sub>	-	0.05	20	μ
Set-up Time	ts∪		30	-	-	ns
Hold Time	tR		20	- '	-	ns

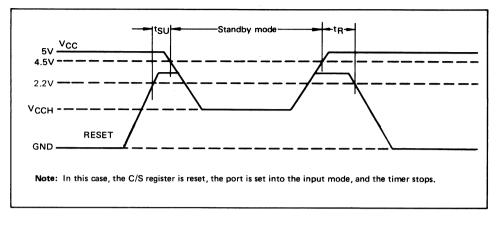
Two ways to place device in standby mode:

(1) Method using CE





### (2) Method using RESET



### PIN FUNCTIONS

Symbol	Function						
RESET	A high level input to this pin resets the chip, places all three I/O ports in the input mode, resets all output latches and stops timer.						
ALE	Negative going edge of the ALE (Address Latch Enable) input latches $AD_{0\sim7}$ , IO/ $\overline{M}$ , and CE signals into the respective latches.						
AD <sub>0∼7</sub>	Three-state, bi-directional address/data bus. Eight-bit address information on this bus is read into the internal address latch at the negative going edge of the ALE. Eight bits of data can be read from or written to the chip using this bus depending on the state of the WRITE or READ input.						
CE	When the CE input is high, both read and write operations to the chip are disabled.						
10/ <del>M</del>	A high level input to this pin selects the internal I/O functions, and a low level selects th memory.						
RD	If this pin is low, data from either the memory or ports is read onto the $AD_{0\sim7}$ lines depending on the state of the IO/M line.						
WR	If this pin is low, data on lines $AD_{0\sim7}$ is written into either the memory or into the select port depending on the state of the IO/M line.						
PA <sub>0~7</sub> (PB <sub>0~7</sub> )	General-purpose I/O pins. Input/output directions can be determined by programming the command/status (C/S) register.						
PC <sub>0∼5</sub>	Three pins are usable either as general-purpose I/O pins or control pins for the PA and PB ports. When used as control pins, they are assigned to the following functions:         PC0:       A INTR (port A interrupt)         PC1:       A BF (port A full)         PC2:       A STB (port A strobe)         PC3:       B INTR (port B interrupt)         PC4:       B BF (port B buffer full)         PC5:       B STB (port B strobe)						
TIMER IN	Input to the counter/timer						
TIMER OUT	Timer output. When the present count is reached during timer operation, this pin provides a square-wave or pulse output depending on the programmed control status.						
V <sub>CC</sub>	3—6V power supply						
GND	GND						

I/O·MSM81C55RS/GS/JS MSM81C55-5RS/GS/JS =-

### **OPERATION**

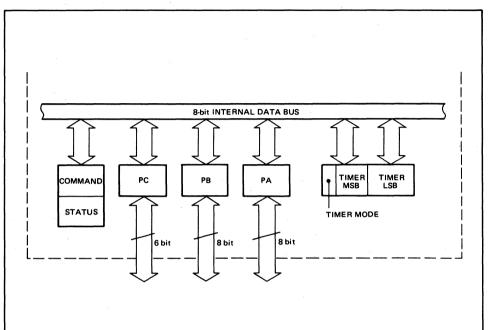
### Description

The MSM81C55 has three functions as described below.

• 2K bit static RAM (256 words x 8 bits)

- Two 8-bit I/O ports (PA and PB) and a 6-bit I/O port (PC)
- 14-bit timer counter

The internal register is shown in the figure below, and the I/O addresses are described in the table below.

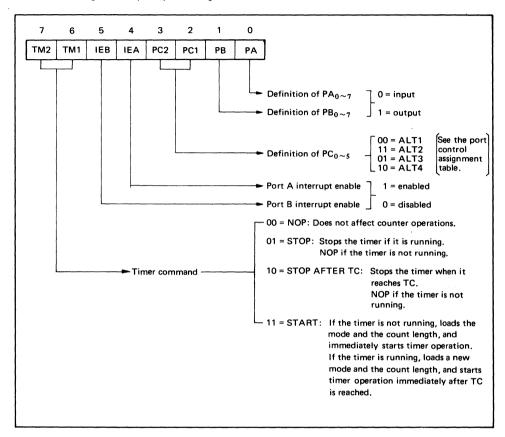


	i	
١.	-	

			1/0 A	ddress				Selecting Register		
A7	A6	A5	A4	A3	A2	A1	A0	Selecting Register		
×	x	×	×	x	0	0	0	Internal command/status register		
×	×	×	×	×	0	0	1	Universal I/O port A (PA)		
×	×	×	×	×	0	1	0	Universal I/O port B (PB)		
×	×	x	×	×	0	1	1	I/O port C (PC)		
*	×	×	×	×	1	0	0	Timer count lower position 8 bits (LSB)		
×	×	×	×	×	1	0	1	Timer count upper position 6 bits and timer mode 2 bits (MSB)		

x: Don't care.

(1) Programming the Command/Status (C/S) Register The contents of the command register can be written during an I/O cycle by addressing it with an I/O address of xxxxx000. Bit assignments for the register are shown below:



### Port Control Assignment Table

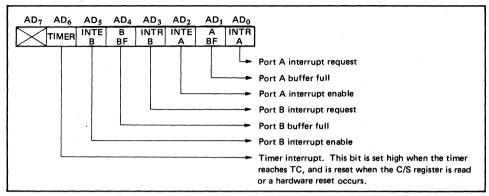
Pin	ALT1	ALT2	ALT3	ALT4
PC <sub>0</sub>	Input port	Output port	A INTR	A INTR
PC1	Input port	Output port	A BF	ABF
PC <sub>2</sub>	Input port	Output port	A STB	A STB
PC3	Input port	Output port	Output port	B INTR
PC4	Input port	Output port	Output port	BBF
PC5	Input port	Output port	Output port	B STB

### I/O·MSM81C55RS/GS/JS MSM81C55-5RS/GS/JS =

### (2) Reading the C/S Register

The I/O and timer status can be accessed by reading the contents of the Status register located

at I/O address xxxxx000. The status word format is shown below:



### (3) PA and PB Registers

These registers may be used as either input or output ports depending on the programmed contents of the C/S register. They may also be used either in the basic mode or in the strobe mode. I/O address of the PA register: xxxxx001

I/O address of the PB register: xxxxx010

### (4) PC Register

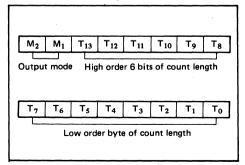
The PC register may be used as an input port, output port or control register depending on the programmed contents of the C/S register. The I/O address of the PC register is xxxxx011.

### (5) Timer

The timer is a 14-bit down counter which counts TIMER IN pulses.

The low order byte of the timer register has an I/O address of xxxxx100, and the high order byte of the register has an I/O address of xxxxx101.

The count length register (CLR) may be preset with two bytes of data. Bits 0 through 13 are assigned to the count length and bits 14 and 15 specify the timer output mode. A read operation of the CLR reads the contents of the counter and the pertinent output mode. The initial value range which can initially be loaded into the counter is 2 through 3FFF hex. Bit assignments to the timer counter and possible output modes are shown in the following.



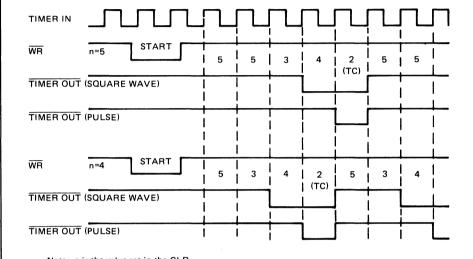
- $M_2 M_1$
- 0 0 Outputs a low-level signal in the latter half (Note 1) of a count period.
- 0 1 Outputs a low-level signal in the latter half of a count period, automatically loads the programmed count length, and restarts counting when the TC value is reached.
- Outputs a pulse when the TC value is reached.
- Outputs a pulse each time the preset TC value is reached, automatically loads the programmed count length, and restarts from the beginning.
- Note 1: When counting an asymmetrical value such as (9), a high level is output during the first period of five, and a low level is output during the second period of four.
- Note 2: If an internal counter of the MSM81C-55RS/GS receives a reset signal, count operation stops but the counter is not set to a specific initial value or output mode. When restarting count operation after reset, the START command must be executed again through the C/S register.

Note that while the counter is counting, you may load a new count and mode into the CLR. Before the new count and mode will be used by the counter, you must issue a START command to the counter.

Please note the timer circuit on the 81C55 is designed to be a square-wave timer, not a event counter. To achieve this, it counts down by twos twice in completing one cycle. Thus, its registers do not contain values directly representing the number of TIMER IN pulse received. After the timer has started counting down, the values residing in the count registers can be used to calculate the actual number of TIMER IN pulse required to complete the timer cycle if desired. To obtain the remaining count, perform the following operations in order:

- 1. STOP the counter
- Read in the 16 bit value from the count registers.
- 3. Reset the upper two mode bits
- 4. Reset the carry and rotate right one position all 16 bits through carry
- If carry is set, add ½ of the full original count (½ full count-1 if full count is odd).
- Note:

If you started with an odd count and you read the count registers before the third count pulse occurs, you will not be able to recognize whether one or two counts have occurred. Regardless of this, the 81C55 always counts out the right number of pulses in generating the TIMER OUT waveforms.



Note: n is the value set in the CLR. Figures in the diagram refer to counter value.

### (6) Standby Mode (see page 7)

The MSM81C55 is placed in standby mode when the high level at the CE input is latched during the negative going edge of ALE. All input ports and the timer input should be pulled up or down to either V<sub>CC</sub> or GND potential.

When using battery back-up, all ports should be set low or in input port mode. The timer output should be set low. Otherwise, a buffer should be added to the timer output and the battery should be connected to the power supply pins of the buffer.

By setting the reset input to a high level, the standby mode can be selected. In this case, the command register is reset, so the ports automatically set to the input mode and the timer stops.

# **OKI** semiconductor MSM81C55HRS/GS/JS

2048 BIT CMOS STATIC RAM WITH I/O PORTS AND TIMER

### GENERAL DESCRIPTION

The MSM81C55/H have 2k bits of static RAM (256 byte) with parallel I/O ports and a timer. It uses silicon gate CMOS technology and consumes a standby current of 100 micro ampere, maximum, while the chip is not selected. Featuring a maximum access time of 400 ns, the MSM81C55/H can be used in an 80C85A/80C85A-2 system without using wait states. The parallel I/O consists of two 8-bit ports and one 6-bit port (both general purpose). The MSM81C55/H also contains a 14-bit programmable counter/timer which may be used for sequencewave generation or terminal count-pulsing.

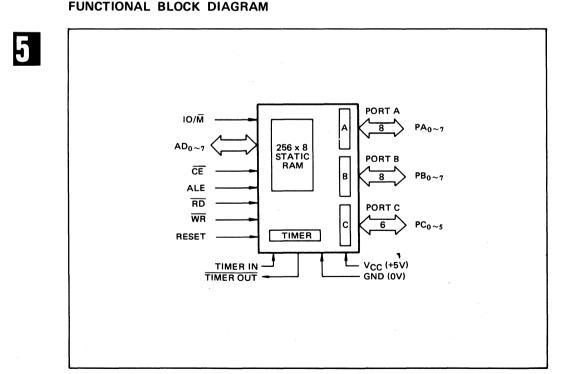
### FEATURES

- High speed and low power achieved with silicon gate CMOS technology.
- 256 words x 8 bits RAM
- Single power supply, 3 to 6V
- Completely static operation
- On-chip address latch
- 8-bit programmable I/O ports (port A and B)
- TTL Compatible

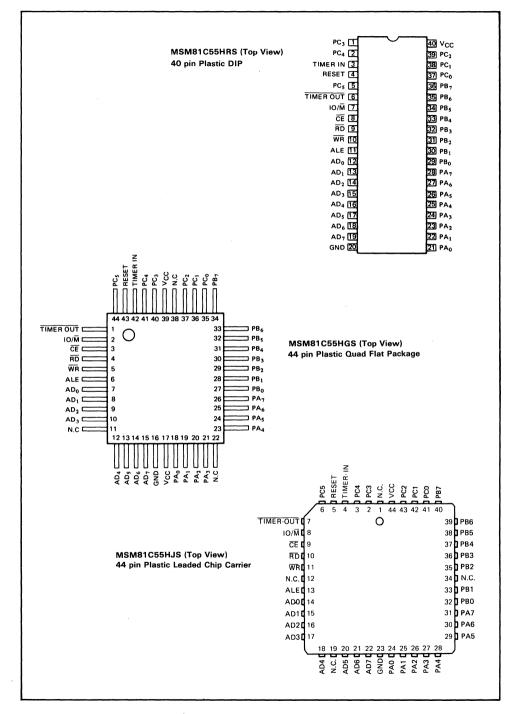
- RAM data hold characteristic at 2V
- 6-bit programmable I/O port (port C)
- 14-bit programmable binary counter/timer
- Multiplexed address/data bus
- Direct interface with MSM80C85AH (MSM81C55H)

Prolininary

- Direct interfau nith MSM80C51F (16MHZ)
- •40 pin Plastic DIP (DIP40-P-600)
- •44 pin PLCC (QFJ44-P-S650)
- •44 pin-V Plastic QFP (QFP44-P-910-VK)



### PIN CONFIGURATION



5

# ABSOLUTE MAXIMUM RATINGS

			Limits				
Parameter	Symbol	Conditions	MSM81C55HS	MSM81C55HGS	MSM81C55HJS	Unit	
Supply Voltage	Vcc		-0.5 to +7				
Input Voltage	VIN		-0.5 to V <sub>CC</sub> + 0.5				
Output Voltage	Vout	Referenced to GND	$-0.5$ to V co $\pm 0.5$				
Storage Temperature	T <sub>stg</sub>		-55 to + 150				
Power Dissipation	PD	Ta = 25°C	1.0	0.7	1.0	w	

# **OPERATING CONDITION**

Parameter	Symbol	Limits	Unit
Supply Voltage	V <sub>CC</sub>	3 to 6	V
Operating Temperature	ТОР	-40 to +85	°C

# **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Min.	Тур.	Max.	Unit	
Supply Voltage	Vcc	4.5	5	5.5	V	
Operating Temperature	ТОР	-40	+25	+85	°C	
"L" Level Input	VIL	-0.3		+0.8	v	
"H" Level Input	VIH	2.2		V <sub>CC</sub> + 0.3	v	

#### **DC CHARACTERISTICS**

Parameter	Symbol	Condit	ons	Min.	Тур.	Max.	Unit
"L" Level Output Voltage	VOL	IOL = 2.5mA				0.4	v
"H" Level Output Voltage		<b>IOH =</b> -2.5mA		3.0			v
	∨он	<b>I</b> OH =100µА	-	VCC -0.4			v
Input Leak Current	ι <sub>LI</sub>	$0 \le V_{IN} \le V_{CC}$	V <sub>CC</sub> = 4.5V to	-10		10	μA
Output Leak Current	IL0	$0 \le V_{OUT} \le V_{CC}$	$Ta = -40^{\circ}C$ to	-10		10	μA
Standby Current	lccs	$  \vec{CE} \geqq V_{CC} - 0.2V \\ V_{IH} \geqq V_{CC} - 0.2V \\ V_{IL} \le 0.2V $	85°C	-	0.1	50	μA
Mean Operating Current	<sup>I</sup> cc	Tcyc=200nS				10	mA į

# AC CHARACTERISTICS

 $(V_{CC} = 4.5 \text{ to } 5.5 \text{V}, \text{ Ta} = -40 \text{ to } +80^{\circ} \text{C}) \text{ MSM81C55H}$ 

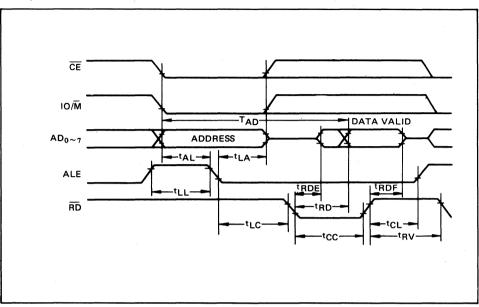
	· · ·	MSM8	1C55H		
Parameter	Symbol	Min.	Max.	Unit	Remarks
Address/latch Set-up Time	<sup>t</sup> AL	28		ns	
Latch/address Holt Time	tLA	27		ns	]
Latch/read (write) Delay Time	<sup>t</sup> LC	40		ns	
Read/output Delay Time	tRD		140	ns	
Address/output Delay Time	tAD	1	330	ns	
Latch Width	tLL	58		ns	
Read/data Bus Floating Time	tRDF	10	80	ns	
Read (write)/latch Delay Time	tCL	20		ns	
Read (write) Width	tCC	200		ns	
Data In/write Set-up Time	tDW	100		ns	
Write/data-in Holt Time	tWD	12		ns	
Recovery Time	tRV	200		ns	
Write/port Output Delay Time	tWP		300	ns	
Port Input/read Set-up Time	tPR	50		ns	Load capaci-
Read/port Input Hold Time	tRP	10		ns	tance: 150pF
Strobe/buffer Full Delay Time	tSBF		300	ns	
Strobe Width	tss	150		ns	
Strobe/buffer Empty Delay Time	<sup>t</sup> RBE		300	ns	
Strobe/interrupt-on Delay Time	tSI	8	300	ns	
Read/interrupt-off Delay Time	tRDI		300	ns	
Port Input/strobe Set-up Time	tPSS	20		ns	
Strobe/port-input Hold Time	<sup>t</sup> PHS	100		ns	
Strobe/buffer-empty Delty Time	tSBE	I	300	ns	
Write/buffer-full Delay Time	tWBF	1	300	ns	× .
Write/interrupt-off Delay Time	tWI		300	ns	
Time Output Delay Time Low	<sup>t</sup> TL		300	ns	
Time Output Delay Time High	tтн		300	ns	
Read/data Buse Enable Delay Time	<sup>t</sup> RDE	10		ns	
Timer Cycle Time	<sup>t</sup> CYC	200		ns	
Timer Input Rise and Fall Times	t <sub>r</sub> , t <sub>f</sub>		80	ns	
Timer Input Low Level Time	t <sub>1</sub>	40		ns	
Timer Input High Level Time	t <sub>2</sub>	70		ns	Į
WRITE to TIMER-IN for writes which start counting	tWT	100		ns	
TIMER-IN to WRITE for wites which start counting	<sup>t</sup> TW	0		ns	

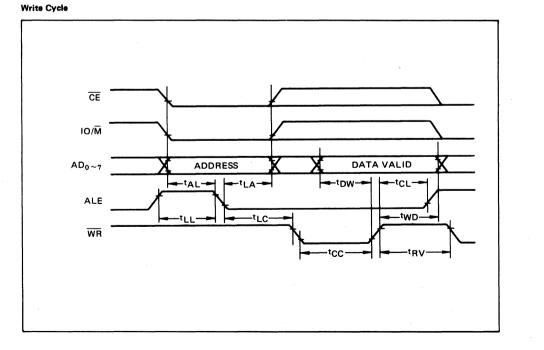
Note: Timing are measured with V  $_L$  = 0.8V and V  $_H$  = 2.2V for both input and output.

# ■ I/O·MSM81C55HRS/GS/JS ■-

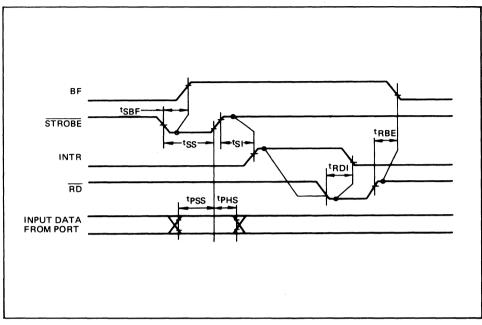
#### TIMING

Read Cycle

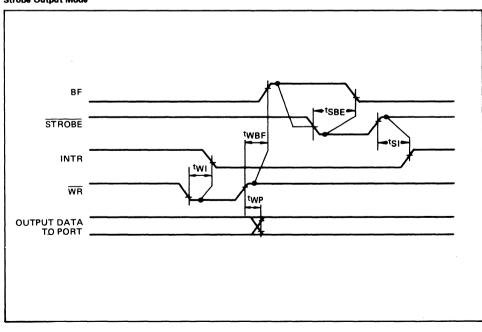




#### Strobe Input Mode

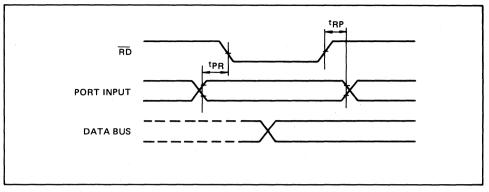


Strobe Output Mode

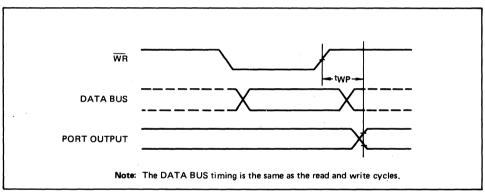


■ I/O·MSM81C55HRS/GS/JS ■ -



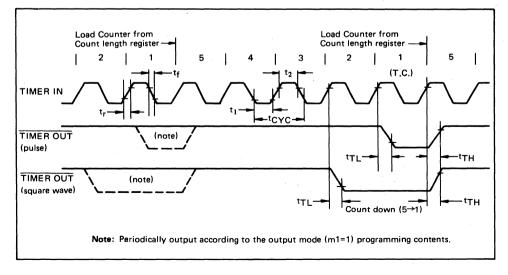




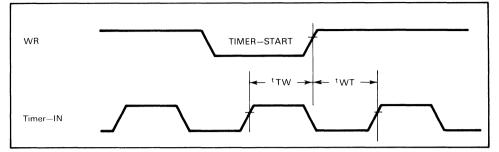




Timer Waveforms 1



#### Timer Waveforms 2

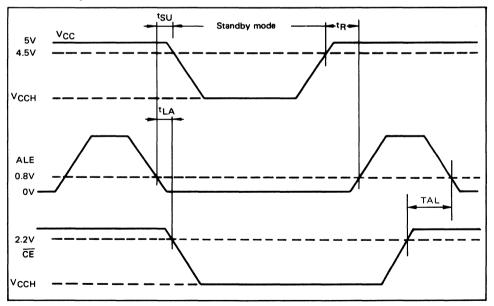


# RAM DATA HOLD CHARACTERISTICS AT LOW SUPPLY VOLTAGE

ltem	Symbol	Condition	Specification			Unit
item	Symbol	Condition	Min.	Тур.	Max.	Unit
Data Holding Supply Voltage	Vссн	V <sub>IN</sub> = 0V or V <sub>CC</sub> , ALE = 0V	2.0	-	-	v
Data Holding Supply Current	ICCH	V <sub>CC</sub> = V <sub>CCH</sub> , ALE = 0 V <sub>IN</sub> = 0V or V <sub>CC</sub>	-	0.05	20	μ
Set-up Time	ts∪		30	-	-	ns
Hold Time	<sup>t</sup> R		20		-	ns

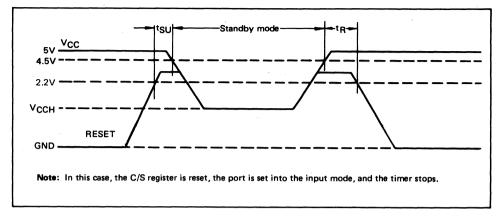
Two ways to place device in standby mode:

(1) Method using CE



#### ■ I/O·MSM81C55HRS/GS/JS ■ -

#### (2) Method using RESET



### **PIN FUNCTIONS**

Symbol	Function						
RESET	A high level input to this pin resets the chip, places all three I/O ports in the input mode, resets all output latches and stops timer.						
ALE	Negative going edge of the ALE (Address Latch Enable) input latches $AD_{0} \sim 7$ , $IO/\overline{M}$ , and CE signals into the respective latches.						
AD <sub>0~7</sub>	Three-state, bi-directional address/data bus. Eight-bit address information on this bus is read into the internal address latch at the negative going edge of the ALE. Eight bits of data can be read from or written to the chip using this bus depending on the state of the WRITE or READ input.						
CE	When the CE input is high, both read and write operations to the chip are disabled.						
ю/м	A high level input to this pin selects the internal I/O functions, and a low level selects the memory.						
RD	If this pin is low, data from either the memory or ports is read onto the $AD_{0\sim7}$ lines depending on the state of the IO/M line.						
WR	If this pin is low, data on lines $AD_{0\sim7}$ is written into either the memory or into the selected port depending on the state of the IO/M line.						
PA <sub>0~7</sub> (PB <sub>0~7</sub> )	General-purpose I/O pins. Input/output directions can be determined by programming the command/status (C/S) register.						
PC <sub>0∼5</sub>	Three pins are usable either as general-purpose I/O pins or control pins for the PA and PB ports. When used as control pins, they are assigned to the following functions:         PC0:       A INTR (port A interrupt)         PC1:       A BF (port A full)         PC2:       A STB (port A strobe)         PC3:       B INTR (port B interrupt)         PC4:       B BF (port B buffer full)         PC5:       B STB (port B strobe)						
TIMER IN	Input to the counter/timer						
TIMER OUT	Timer output. When the present count is reached during timer operation, this pin provides a square-wave or pulse output depending on the programmed control status.						
V <sub>CC</sub>	3-6V power supply						
GND	GND						

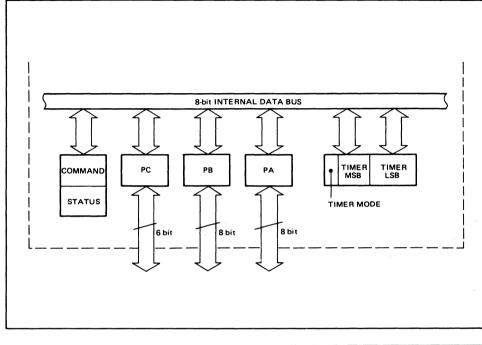
# OPERATION

#### Description

The MSM81C55H has three functions as described below.

• 2K bit static RAM (256 words x 8 bits)

- Two 8-bit I/O ports (PA and PB) and a 6-bit I/O port (PC)
- 14-bit timer counter
  - The internal register is shown in the figure below,
  - d the I/O addresses are described in the table below.

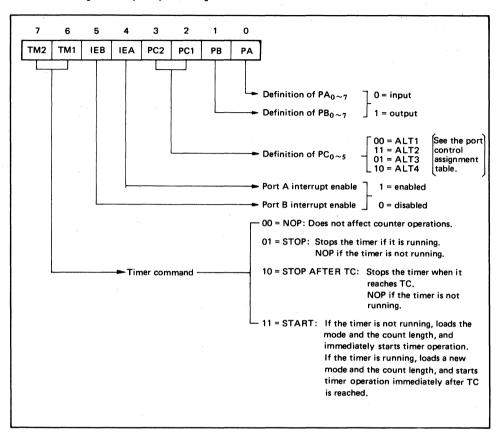


			1/0 A	ddress				Colordina Desirator		
A7	A6	A5	A4	A3	A2	A1	A0	Selecting Register		
×	×	×	×	×	0	0	0	Internal command/status register		
×	×	×	×	×	0	0	1	Universal I/O port A (PA)		
×	×	×	×	×	0	1	0	Universal I/O port B (PB)		
×	×	×	×	×	0	1	1	I/O port C (PC)		
*	×	×	×	×	1	0	0	Timer count lower position 8 bits (LSB)		
×	×	×	×	×	1	0	1	Timer count upper position 6 bits and timer mode 2 bits (MSB)		

x: Don't care.

#### I/O·MSM81C55HRS/GS/JS =

(1) Programming the Command/Status (C/S) Register The contents of the command register can be written during an I/O cycle by addressing it with an I/O address of xxxxx000. Bit assignments for the register are shown below:



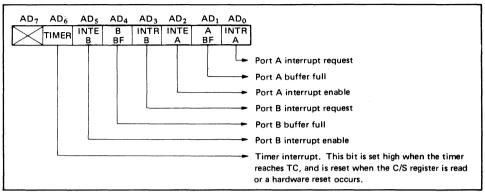
#### Port Control Assignment Table

Pin	ALT1	ALT2	ALT3	ALT4
PC <sub>0</sub>	Input port	Output port	A INTR	A INTR
PC1	Input port	Output port	A BF	ABF
PC <sub>2</sub>	Input port	Output port	A STB	A STB
PC3	Input port	Output port	Output port	B INTR
PC4	Input port	Output port	Output port	BBF
PC5	Input port	Output port	Output port	B STB

at I/O address xxxxx000. The status word format

#### (2) Reading the C/S Register

The I/O and timer status can be accessed by reading the contents of the Status register located



#### (3) PA and PB Registers

These registers may be used as either input or output ports depending on the programmed contents of the C/S register. They may also be used either in the basic mode or in the strobe mode. I/O address of the PA register: xxxxx001 I/O address of the PB register: xxxxx010

(4) PC Register

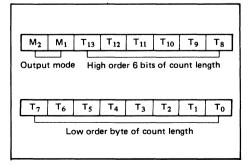
The PC register may be used as an input port, output port or control register depending on the programmed contents of the C/S register. The I/O address of the PC register is xxxxx011.

#### (5) Timer

The timer is a 14-bit down counter which counts TIMER IN pulses.

The low order byte of the timer register has an I/O address of xxxxx100, and the high order byte of the register has an I/O address of xxxxx101.

The count length register (CLR) may be preset with two bytes of data. Bits 0 through 13 are assigned to the count length and bits 14 and 15 specify the timer output mode. A read operation of the CLR reads the contents of the counter and the pertinent output mode. The initial value range which can initially be loaded into the counter is 2 through 3FFF hex. Bit assignments to the timer counter and possible output modes are shown in the following.



 $M_2 M_1$ 

is shown below:

- 0 0 Outputs a low-level signal in the latter half (Note 1) of a count period.
- 0 1 Outputs a low-level signal in the latter half of a count period, automatically loads the programmed count length, and restarts counting when the TC value is reached.
- 1 0 Outputs a pulse when the TC value is reached.
- Outputs a pulse each time the preset TC value is reached, automatically loads the programmed count length, and restarts from the beginning.
- Note 1: When counting an asymmetrical value such as (9), a high level is output during the first period of five, and a low level is output during the second period of four.
- Note 2: If an internal counter of the MSM81C-55RS/GS receives a reset signal, count operation stops but the counter is not set to a specific initial value or output mode. When restarting count operation after reset, the START command must be executed again through the C/S register.

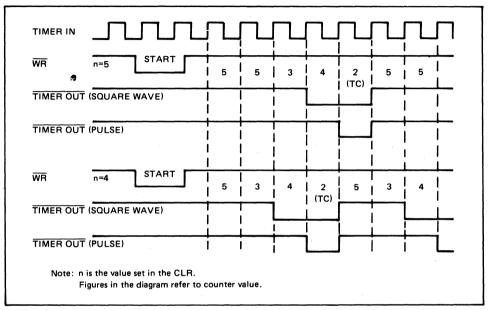
Note that while the counter is counting, you may load a new count and mode into the CLR. Before the new count and mode will be used by the counter, you must issue a START command to the counter.

Please note the timer circuit on the 81C55 is designed to be a square-wave timer, not a event counter. To achieve this, it counts down by twos twice in completing one cycle. Thus, its registers do not contain values directly representing the number of TIMER IN pulse received. After the timer has started counting down, the values residing in the count registers can be used to calculate the actual number of TIMER IN pulse required to complete the timer cycle if desired. To obtain the remaining count, perform the following operations in order:

#### ■ I/O·MSM81C55HRS/GS/JS ■

- 1. STOP the counter
- 2. Read in the 16 bit value from the count registers.
- 3. Reset the upper two mode bits
- 4. Reset the carry and rotate right one position all 16 bits through carry
- If carry is set, add ½ of the full original count (½ full count-1 if full count is odd).
- Note:

If you started with an odd count and you read the count registers before the third count pulse occurs, you will not be able to recognize whether one or two counts have occurred. Regardless of this, the 81C55 always counts out the right number of pulses in generating the TIMER OUT waveforms.



#### (6) Standby Mode (see page 7)

The MSM81C55 is placed in standby mode when the high level at the CE input is latched during the negative going edge of ALE. All input ports and the timer input should be pulled up or down to either V<sub>CC</sub> or GND potential.

When using battery back-up, all ports should be set low or in input port mode. The timer output should be set low. Otherwise, a buffer should be added to the timer output and the battery should be connected to the power supply pins of the buffer.

By setting the reset input to a high level, the standby mode can be selected. In this case, the command register is reset, so the ports automatically set to the input mode and the timer stops.

# **OKI semiconductor** MSM82C12RS/GS

**8-BIT INPUT/OUTPUT PORT** 

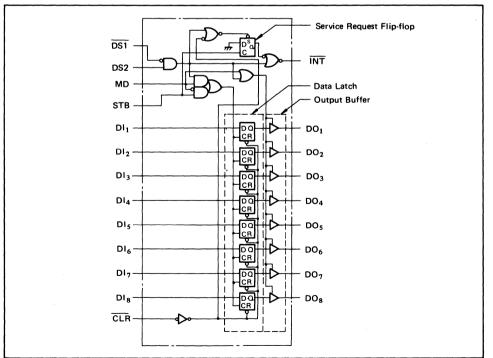
# **GENERAL DESCRIPTION**

The MSM82C12 is an 8 bit input output port employing 3  $\mu$  silicon gate CMOS technology. It insures low operating power. This device incorporates a service request flip-flop for generation and control of interrupts for a CPU, in addition to an 8-bit latch circuit having a three-state output buffer.

It is effective when used as an address latch device to separate the time division bus line outputs in systems employing the MSM80C85A CPU or similar processors using multiplexed address/data bus line.

# **FEATURES**

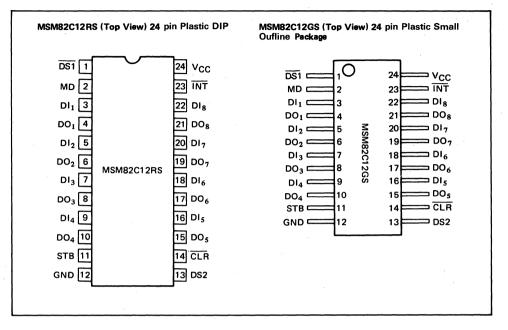
- Operated on low power consumption due to silicon gate CMOS.
- 3 V ~ 6 V single power supply
- Full static operation
- Parallel 8-bit data register and buffer
- Provided with an interrupt generating function through the adoption of a service request flip-flop
- Equipped with a clear terminal which operates asynchronously
- TTL compatible
- Functionally compatible with the 8212
- •24 pin Plastic DIP (DIP24-P-600)
- •24 pin Plastic SOP (SOP24-P-430-K)
- •24 pin-V Plastic SOP (SOP24-P-430-VK)



# CIRCUIT CONFIGURATION

#### I/O·MSM82C12RS/GS =

# **PIN CONFIGURATION**



#### PIN DESCRIPTION

Pin Name	ltem	Input/Output	Function				
DI1~DI8 Data input		Input	These pins are 8-bit data inputs. The data input is connected to the input D pins of the 8-bit data latch circuit built inot the device.				
DO1~DO8	Data output	Output	These pins are 8-bit data outputs. Each bit is composed of 3- state output buffers. These buffers can be made into enable or disable (high imped- ance status).				
MD	Mode input	Input	This pin is a clock input for the data latch. It is also used to reset the internal service request flip-flop at the same time.				
STB	Strobe input	Input	This pin is a clock input for the data latch. It is also used to reset the internal service request flip-flop at the same time.				
DS1, DS2	Device select input	Input	The AND of these two input functions make the status control of output buffers or becomes a clock input to the data latch. It also functions to perform set/reset of the internal service request flip-flop.				
CLR	Clear input	Input	This pin clears the internal data latch in low level. It also sets the internal service request flip-flop at this time. The clear is operated asynchronously to the clock.				
INT	Interrupt output	Output	This pin is the ouput of the internal service request flip-flop, but is inverted to ouptut it in low level operation.				
v <sub>cc</sub>			+5V power supply				
GND			GND				

### FUNCTIONAL DESCRIPTION

# Output Buffer Status Control and Data Latch Clock Input

When the input MD is at high level, the ouptut buffer is enabled and the device select input (DS1.DS2) becomes the clock input to the data latch. When the input MD is in low level, the status of the output buffer is determined by the device select input (DS1.DS2) (the output buffer is enabled when (DS1.DS2) is in high level). At this time, the input STB becomes the clock input to the data latch.

MD	(DS1 · DS2)	STB	$DO_1 \sim DO_8$
0	0	0	High impedance status
0	0	1	High impedance status
1	o	0	Data latch
1	0	1	Data latch
0	1	0	Data latch
0	1	1	Data in
1	1	0	Data in
1	1	1	Data in

#### Service Request Flip-flop

The service request flip-flop is used to generate and control the interrupt for the CPU when the MSM82C12 is used as an input/output port in a microcomputer system. The flip-flop is set asynchronously by input CLR. When the flip-flop is set, the system is in noninterrupt status.

CLR	(DS1 · DS2)	STB	٥	INT
0	0	0	1	1
o	1	0	1	0
1	1		1	0
1	1	ο	1	0
1	0	0	1	1
1	0	7_	0	0

#### Clear

When the clear input becomes low level, the internal data latch is cleared irrespective of the clock and becomes low level.

#### ABSOLUTE MAXIMUM RATINGS

Parameter	Cumbel	Conditions	Lin	l la la	
	Symbol Conditions		MSM82C12RS MSM82C12GS		Unit
Supply Voltage	Vcc	With	-0.5 to +	-7	v
Input Voltage	VIN	respect	0.5 to V <sub>CC</sub> +0.5		
Output Voltage	Vout	to GND	-0.5 to V <sub>CC</sub> +0.5		v
Storage Temperature	Tstg		-55 to +150		°C
Power Dissipation	PD	Ta = 25°C	0.9	0.7	w

# OPERATING RANGE

Parameter	Symbol	Limits	Unit
Supply Voltage	Vcc	3 to 6	v
Operating Temperature	TOP	-40 to +85	°C

# RECOMMENDED OPERATING CONDITION

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage	Vcc	4.5	5	5.5	v
Operating Temperature	TOP	-40	+25	+85	°C
"L" Input Voltage	VIL	-0.3		+0.8	v
"H" Input Voltage	VIH	2.2		V <sub>CC</sub> +0.3	v

# DC CHARACTERISTICS

Parameter	Symbol	Cond	itions	Min.	Typ.	Max.	Unit
"L" Output Voltage	VOL	I <sub>OL</sub> = 4mA				0.4	V
"H" Output Voltage	Voн	I <sub>OH</sub> =4mA	V <sub>CC</sub> = -4.5V to 5.5V Ta = -40°C to +85°C	3.7			V
Input Leak Current	ILI.	0≦VIN≦VCC		-10		10	μA
Output Leak Current	IL0	0≦Vout≦Vcc		-10		10	μA
Supply Current (Standby)	Frees	V <sub>IH</sub> <u>≥</u> V <sub>CC</sub> - 0.2V V <sub>IL</sub> <u>≤</u> 0.2V			0.1	100	μA
Average Supply Current (active)	<sup>I</sup> CC	f = 1 MHz				1	mA

#### AC CHARACTERISTICS

 $(V_{CC} = 4.5 \sim 5.5V, Ta = -40^{\circ}C + 85^{\circ}C)$ 

Parameter	Symbol	Min.	Тур.	Max.	Unit	Remarks	
Pulse Width	tPW	30			ns		
Data to Output Delay	<sup>t</sup> PD		20	45	ns	]	
Write Enable to Output Delay	tWE		31	60	ns		
Data Set Up Time	tSET	15			ns		
Data Hold Time	tH	30			ns	Load 30pF	
Clear to Output Delay	tC		19	40	ns	7	
Reset to Output Delay	tR		21	45	ns	].	
Set to Output Delay	ts		25	45	ns		
Output Enable Time	tE		52	90	ns	Load 20pF +	
Output Disable Time	tD		30	55	ns	1 kΩ	

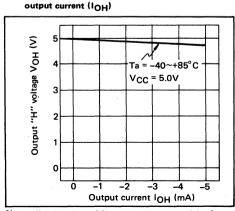
Note: TYP is measured where  $V_{CC} = 5 V$  and Ta =  $25^{\circ}$ C.

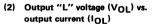
Timing is measured where VL = VH = 1.5V in both input and output.

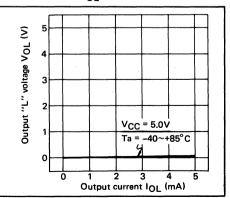
t\_E and t\_D are measured at V\_OL + 0.5V or V\_OH – 0.5V when the two are made into high impedance status.

# **OUTPUT CHARACTERISTICS** (DC Characteristics Reference Value)

(1) Output "H" voltage ( $V_{OH}$ ) vs.



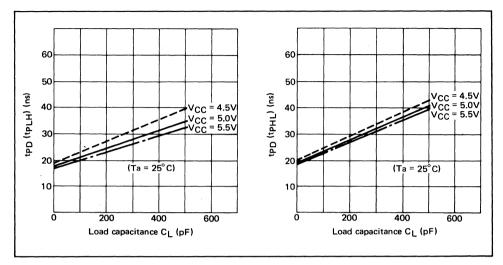




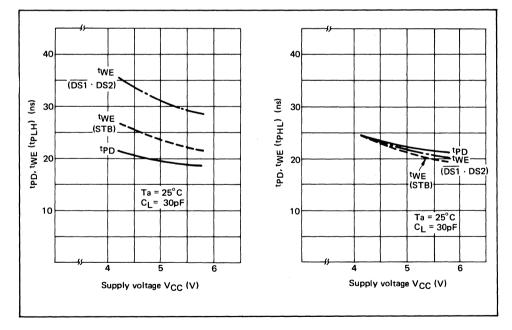
Note: The direction of flow in is taken as positive for output current.

# **OUTPUT CHARACTERISTICS** (AC Characteristics Reference Value)

#### (1) tpD vs. load capacitance



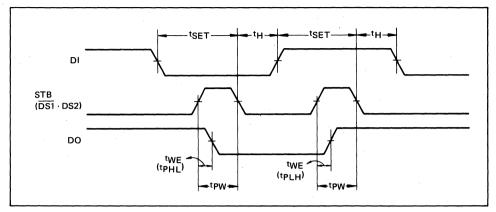
#### (2) tpD and twE vs. supply voltage



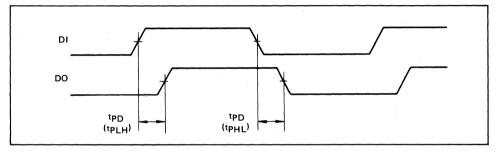
# ■ I/O·MSM82C12RS/GS ■

# **TIMING CHART**

Data Latch Operation

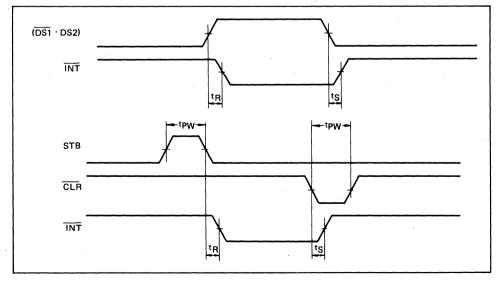


#### Gate Buffer Operation

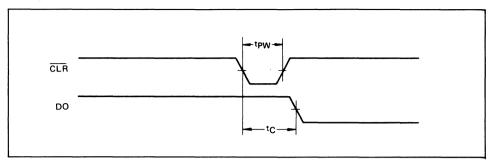


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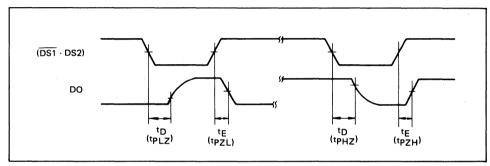
Interrupt Operation



#### **Clear Operation**



#### Output Buffer Enable/Disable (High Impedance Status) Operation

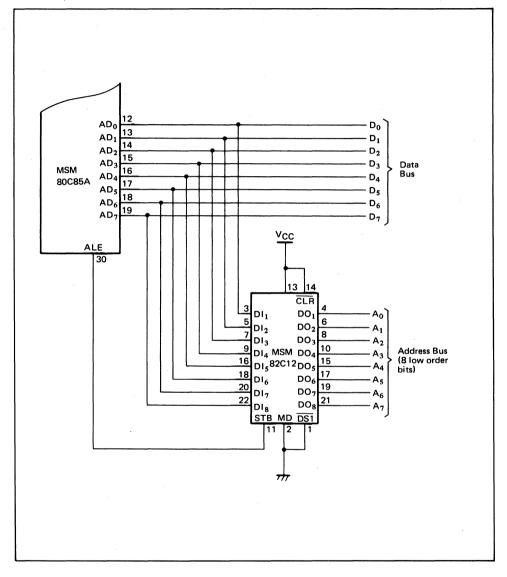


### **EXAMPLE OF APPLICATION OF MSM82C12**

#### Address Latch of MSM80C85A

Used to separate the time division data bus (8 low order bits of the address bus and 8-bit data bus) into

the address bus and data bus by means of the ALE (Address Latch Enable) signal.





# KI semiconductor MSM82C37A-5RS/GS/ 21.`

### PROGRAMMABLE DMA CONTROLLER

### GENERAL DESCRIPTION

The MSM82C37A-5RS/GS/JS, DMA (Direct Memory Access) controller is capable of high-speed data transfer without CPU intervention and is used as a peripheral device in microcomputer systems. The device features four independent programmable DMA channels.

Due to the use of silicon gate CMOS technology, standby current is 10  $\mu$ A (max.), and power consumption is as low as 10 mA (max.) when a 5 MHz clock is generated.

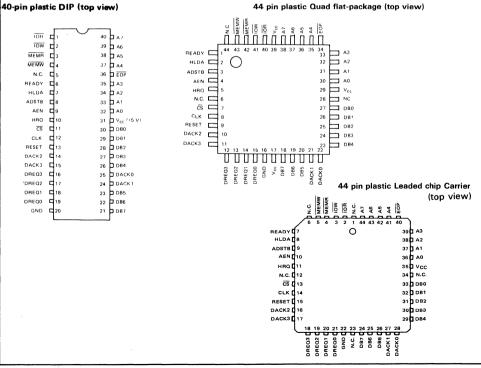
All items of AC characteristics are compatible with intel 8237A-5.

#### **FEATURES**

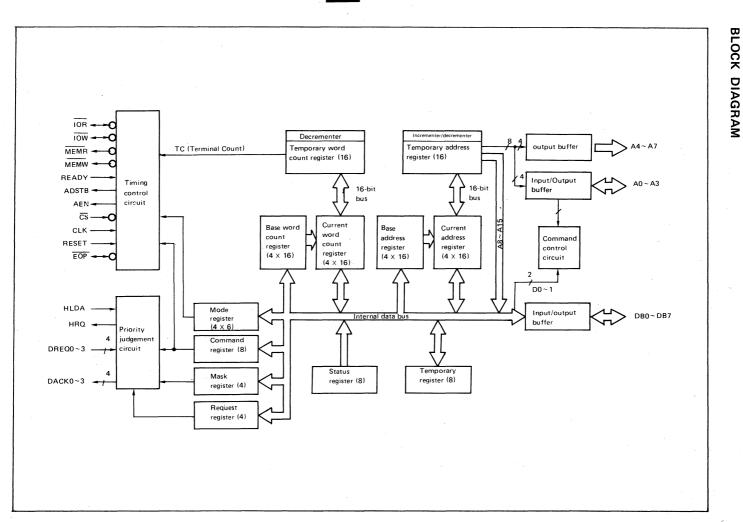
- Maximum operating frequency of 5 MHz(V<sub>cc</sub>= 5 V ± 10%) DREQ and DACK input/output logic inversion
- · High-speed operation at very low power consumption due to silicon gate CMOS technology
- Wide power supply voltage range of 3 to 6 V
- Wide operating temperature range from -40° to +85°C
- 4-channels independent DMA control
- DMA request masking and programming
- DMA request priority function

#### **PIN CONNECTIONS**

- DMA address increment/decrement selection
  - Memory-to-Memory Transfers
  - Channel extension by cascade connection
- DMA transfer termination by EOP input
- Intel 8237A-5 compatibility
- TTL Compatible
- · 40 pin Plastic DIP (DIP40-P-600)
- · 44 pin PLCC (QFJ44-P-S650)
- · 44 pin-V Plastic QFP (QFP44-P-910-VK)
- · 44 pin-VI Plastic QFP (QFP44-P-910-VIK)



Note: N.C. (No Connection)



■ I/O·MSM82C37A-5RS/GS/JS

# ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Conditions			Unit		
			MSM82C37A-5RS	MSM82C37A5GS	MSM82C37A-5JS		
Power supply voltage	Vcc			-0.5 ~ +7		v	
Input voltage	VIN	with respect to GND		$-0.5 \sim V_{cc} + 0.5$			
Output voltage	VOUT		-	$-0.5 \sim V_{cc} + 0$	0.5	v	
Storage temperature	T <sub>stg</sub>		- 55 ~ + 150		°C		
Power dissipation	PD	Ta = 25°C	1.0	0.7	1.0	w	

#### OPERATING RANGES

Parameter	Symbol	Range	Unit
Power supply voltage	Vcc	3~6	v
Operating temperature	Тор	-40 ~ 85	°C

# **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Maximum	Typical	Minimum	Unit
Power supply voltage	Vcc	4.5	5.0	5.5	v
Operating temperature	ТОР	-40	+25	+85	°c
"L" input voltage	VIL	0.5	-	+0.8	v
"H" input voltage	VIH	2.2	-	V <sub>CC</sub> + 0.5	v

# DC CHARACTERISTICS

Parameter	Symbol	Condit	ions	Maximum	Typical	Minimum	Unit
"L" output voltage	VOL	IOL = 3.2 mA		-	—	0.4	v
"H" output voltage	VOH	IOH =1.0 mA	$V_{CC} = 4.5 V$ ~ 5.5V	3.7			v
Input leak current	ILI	$0 V \leq V_{IN} \leq V_{CC}$	Ta = -40°C	-10		10	μA
Output leak current	ILO	$0 V \leq V_{OUT} \leq V_{CC}$	~ +85°C	-10	_	10	μA
Average power supply current during operations	ICC	Input frequency 5 MHz, whenRESET VIN = 0 V/V <sub>CC</sub> , C <sub>L</sub> = 0 pF				10	mA
Power supply current in standby mode	ICCS	HLDA = 0 V, VIL = 0 V, VIH = VCC		·		10	μΑ

■ I/O·MSM82C37A-5RS/GS/JS ■-

# AC CHARACTERISTICS

# DMA (MASTER) MODE

	STER) MODE		(Ta = -40	~ +85°C, V <sub>CC</sub>	= $4.5 \sim 5.5 \dot{V}$
Symbol	ltem	MIN	мах	Unit	Comments
TAEL	Delay time from CLK falling edge up to AEN leading edge		200	ns	
TAET	Delay time from CLK rising edge up to AEN trailing edge		130	'ns	
TAFAB	Delay time from CLK rising edge up to address floating status		90	ns	
TAFC	Delay time from CLK rising edge up to read/write signal floating status		120	ns	
TAFDB	Delay time from CLK rising edge up to data bus floating status		170	ns	
TAHR	Address valid hold time to read signal trailing edge	TCY-100		ns	
TAHS	Data valid hold time to ADSTB trailing edge	30		ns	
ТАНЖ	Address valid hold time to write signal trailing edge	TCY-50	_	ns	
	Delay time from CLK falling edge up to active DACK		170	ns	(Note 3)
ТАК	Delay time from CLK rising edge up to EOP leading edge		170	ns	(Note 5)
	Delay time from CLK rising edge up to EOP trailing edge		170	ns	
TASM	Time from CLK rising edge up to address valid		170	ns	
TASS	Data set-up time to ADSTB trailing edge	100		ns	
тсн	Clock high-level time	68		ns	(Note 6)

Symbol	Item	MIN	MAX	Unit	Comments
TCL	Clock low-level time	68 115		ns ns	(Note 6) (Note 8)
тсү	CLK cycle time	200		ns	(NOTE B)
TDCL	Delay time from CLK rising edge to read/write signal leading edge		190	ns	(Note 2)
TDCTR	Delay time from CLK rising edge to read signal trailing edge		190	ns	(Note 2)
TDCTW	Delay time from CLK rising edge to write signal trailing edge	_	130	ns	(Note 2)
ΤΡΟ	Delay time from CLK rising edge to HRQ valid	—	120	ns	
TEPS	EOP leading edge set-up time to CLK falling edge	40		ns	
TEPW	EOP pulse width	220		ns	
TFAAB	Delay time from CLK rising edge to address valid		170	ns	
TFAC	Time from CLK rising edge up to active read/write signal		150	ns	
TFADB	Delay time from CLK rising edge to data valid		200	ns	_
THS	HLDA valid set-up time to CLK rising edge	75		ns	
TIDH	Input data hold time to MEMR trailing edge	0		ns	
TIDS	Input data set-up time to MEMR trailing edge	170	_	ns	
торн	Output data hold time to MENW trailing edge	10		ns	
TODV	Time from output data valid to MEMW trailing edge	125	—	ns	
TQS	DREQ set-up time to CLK falling edge	0		ns	(Note 3)
TRH	READY hold time to CLK falling edge	20	—	ns	
TRS	READY set-up time to CLK falling edge	60		ns	
TSTL	Delay time from CLK rising edge to ADSTB leading edge	_	130	ns	
тэтт	Delay time from CLK rising edge to ADSTB trailing edge	_	90	ns	

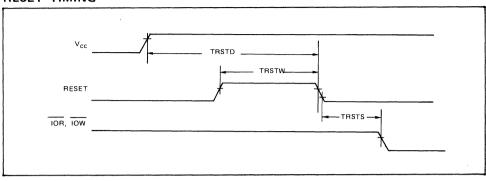
#### I/O·MSM82C37A-5RS/GS/JS =-

#### SLAVE MODE

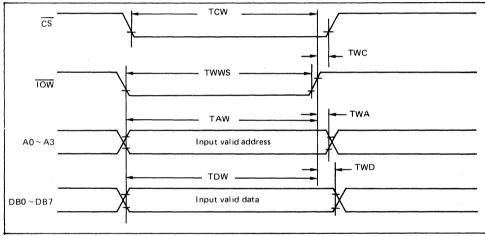
#### $(Ta = -40 \sim +85^{\circ}C, V_{CC} = 4.5 \sim 5.5V)$ Symbol Item MIN MAX Unit Comments Time from address valid or CS TAR 50 ns leading edge to IOR leading edge Address valid set-up time to IOW TAW 130 ns trailing edge CS leading edge set-up time to TCW 130 ns IOW trailing edge Data valid set-up time to IOW TDW 130 ns trailing edge Address or CS hold time to IOR TRA n ns trailing edge Data access time to IOR leading TRDE 140 ns edge Delay time to data floating status TRDF 0 70 ns from IOR trailing edge Supply power leading edge set-up TRSTD 500 ns time to RESET trailing edge Time to first active IOR or IOW TRSTS 2TCY ns from RESET trailing edge TRSTW **RESET** pulse width 300 ns TRW IOR pulse width 200 ns Address hold time to IOW trailing TWA 20 ns edae CS trailing edge hold time to IOW TWC 20 ns trailing edge TWD Data hold time to IOW trailing edge 30 ns TWWS IOW pulse width 160 ns

- Note:
- 1. Output load capacitance of 150 (pF).
- IOW and MEMW pulse widths of TCY-100 (ns) for normal writing, and 2TCY-100 (ns) for extended writing. IOR and MEMR pulse widths of 2TCY-50 (ns) for normal timing, and TCY-50 (ns) for compressed timing.
- 3. DREQ and DACK signal active level can be set to either low or high. In the timing chart, the DREQ signal has been set to active-high, and the DACK signal to active-low.
- 4. When the CPU executes continuous read or write in programming mode, the interval during which the read or write pulse becomes active must be set to at least 400 ns.
- EOP is an open drain output. The value given is obtained when a 2.2 kohm pull-up resistance is connected to VCC.
- 6. Rise time and fall time is less than 10 ns.
- 7. Waveform measurement points for both input and output signals are 2.2 V for HIGH and 0.8 V for LOW, unless otherwise noted.
- 8. When auto initialize is enabled.

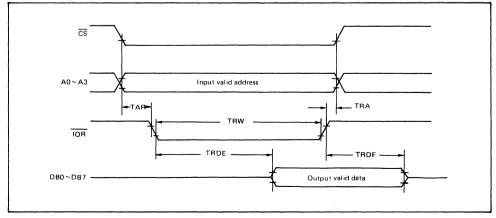
# TIME CHART RESET TIMING



# SLAVE MODE WRITE TIMING

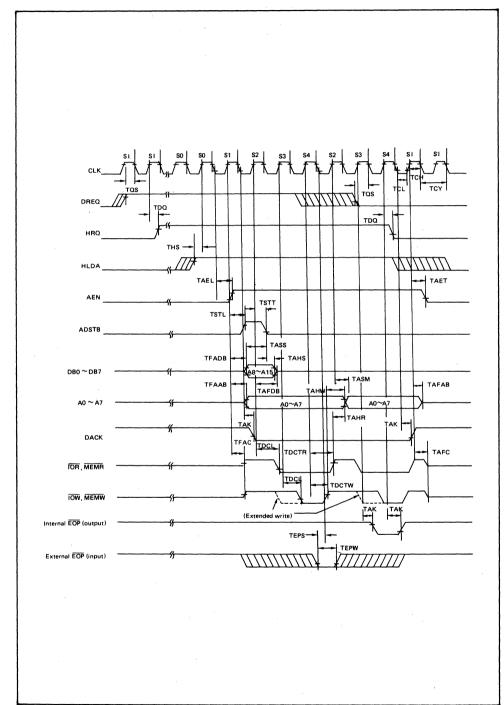


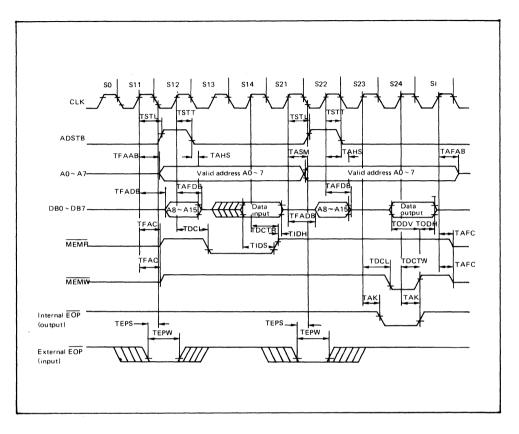
# SLAVE MODE READ TIMING



#### ■ I/O·MSM82C37A-5RS/GS/JS ■-

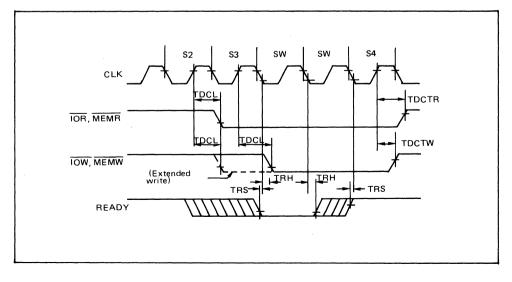
# DMA TRANSFER TIMING





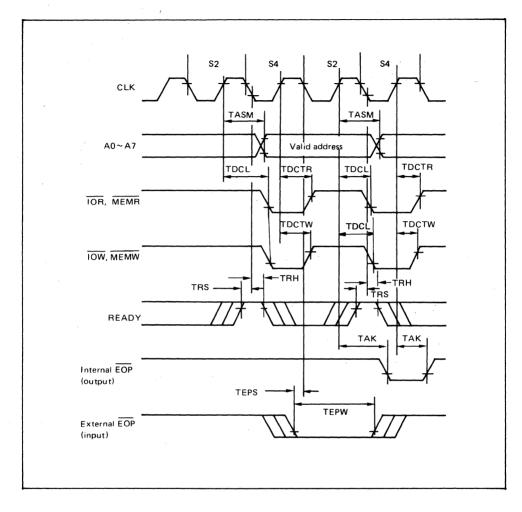
# MEMORY TO MEMORY TRANSFER TIMING

# **READY TIMING**



# ■ I/O·MSM82C37A-5RS/GS/JS ■-

# COMPRESSED TRANSFER TIMING



# PIN FUNCTIONS

Symbol	Pin name	Input/ output	Function
V <sub>cc</sub>	Power		+5 V power supply.
GND	Ground		Ground (0 V) connection.
CLK	Cłock	Input	Control of MSM82C37A-5 internal operations and data transfer speed.
<del>CS</del>	Chip select	Input	CS is active-low input signal used for the CPU to select the MSM82C37A-5 as an I/O device in an idle cycle.
RESET	Reset	Input	RESET is active-high asynchronous input signal used to clear command, status, request, temporary registers, and first/last F/F, and to set mask register. The MSM82C37A-5 enters an idle cycle following a RESET.
READY	Ready	Input	The read or write pulse width can be extended to accomodate slow access memories and I/O devices when this input is switched to low level. Note this input must not change within the prescribed set-up/hold time.
HLDA	Hold acknowledge	Input	HLDA is active-high input signal used to indicate that system bus control has béen released when a hold request is received by the CPU.
DREQ0 ~ DREQ3	DMA request 0 ~ 3 channels	Input	DREQ is asychronous DMA transfer request input signals. Although these pins are switched to active-high by reset, they can be programmed to become active-low. DMA requests are received in accordance with a prescribed order of priority. DREQ must be held until DACK becomes active.
DB0 ~ DB7	Data bus 0 ~ 7	Input/ output	DB is bidirectional three-state signals connected to the system data bus, and which is used as an input/output of MSM82C37A-5 internal registers during idle cycles, and as an output of the eight higher order bits of transfer addresses during active cycles. Also used as input and output of transfer data during memory-memory transfers.
IOR	I/O read	Input/ output	10R is active-low bidirectional three-state signal used as an input control signal for CPU reading of MSM82C37A-5 internal registers during idle cycles, and as an output control signal for reading I/O device transfer data in writing transfers during active cycles.
IOW	I/O write	Input/ output	IOW is active-low bidirectional three-state signal used as an input control signal for CPU writing of MSM82C37A-5 internal registers during idle cycles, and as an output control signal for writing I/O device transfer data in writing transfers during active cycles.

E

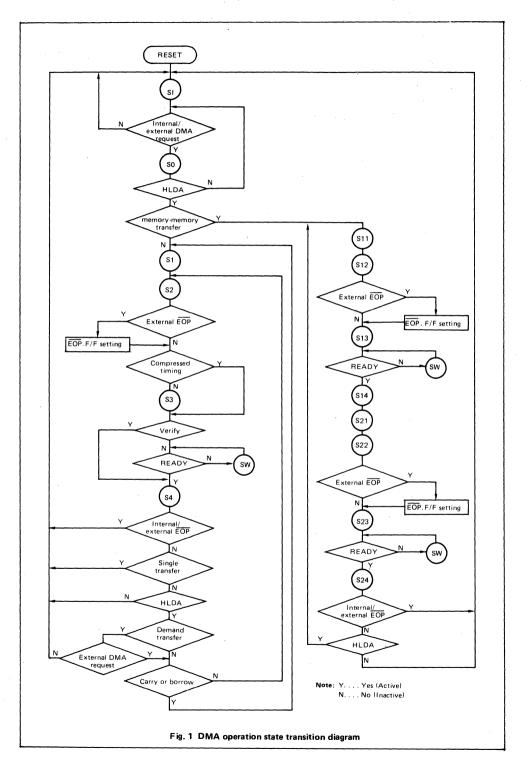
# ■ I/O·MSM82C37A-5RS/GS/JS ■

Symbol	Pin name	Input/ output	Function
ĒŌP	End of process	Input/ output	FEOP is active-low bidirectional three-state signal. Unlike other pins, this pin is an N-channel open drain. During DMA operations, a low-level output pulse is obtained from this pin if the channel word count changes from 0000H to FFFFH.
			And DMA transfers can be terminated by pulling the EOP input to low level. Both of these actions are called terminal count (TC).
			When an internal or external EOP is generated, the MSM82C37A-5 terminates the transfer and resets the DMA request.
			When the EOP pin is not used, it is necessary to hold the pin at high level by pull-up resistance to prevent the input of an EOP by error. Also note that the EOP function cannot be satisfied in cascade mode.
A0 ~ A3	Address 0 ~ 3	İnput/ output	A0~A3 is bidirectional three-state signals used as input signals for specifying the MSM82C37A-5 internal register to be accessed by the CPU during idle cycles, and as an output the four lower order bits of the transfer address during active cycles.
A4 ~ A7	Address 4 ~ 7	Output	A4~A7 is three-state signals used as an output the four higher order bits of the transfer address during active cycles.
HRQ	Hold request	Output	HRQ is active-high signal used as an output of hold request to the CPU for system data bus control purposes. After HRQ has become active, at least one clock cycle is required before HLDA becomes active.
DACK0~DACK3	DMA acknowledge 0 ~ 3 channels	Output	DACK is output signals used to indicate that DMA transfer to peripheral devices has been permitted. (Available in each channel.) Although these pins are switched to active-low when reset, they can be programmed to become active-high.
			Note that there is no DACK output signal during memory-memory transfers.
AEN	Address enable	Output	AEN is active-high output signal used to indicate that output signals sent from the MSM82C37A-5 to the system are valid. And in addition to enabling external latch to hold the eight higher order bits of the transfer address, this signal is also used to disable other system bus buffers.

-

Symbol	Pin name	Input/ output	Function
ADSTB	Address strobe	Output	ADSTB is active-high signal used to strobe the eight higher order bits of the transfer address by external latch.
MEMR	Memory read	Output	MEMR is active-low three-state output signal used as a control signal in reading data from memory during read transfers and memory- memory transfers.
MEMW	Memory write	Output	MEMW is active-low three-state output signal used as a control signal in writing data into memory during write transfers and memory- memory transfers.

■ I/O·MSM82C37A-5RS/GS/JS ■-



#### OUTLINE OF FUNCTIONS

The MSM82C37A-5 consists of five blocks = three logic sections, an internal register section, and a counter section.

The logic sections include a timing control block where the internal timing and external control signals are generated, a command control block where each instruction from the CPU is decoded, and a priority decision block where the order of DMA channel priority is determined. The purpose of the internal register section is to hold internal states and instructions from the CPU, while the counter section computes addresses and word counts.

#### DESCRIPTION OF OPERATIONS

The MSM82C37A-5 operates in two cycles (called the idle and active cycles) which are divided into independent states. Each state is commenced by a clock falling edge and continues for a single clock cycle. The transition from one state to the next in DMA operations is outlined in Figure 1.

#### IDLE CYCLE

The idle cycle is entered from the SI state when there is no valid DMA request on any MSM82C37A-5 channel. During this cycle, DREQ and CS inputs are monitored during each cycle. When a valid DMA request is then received, an active cycle is commenced. And if the HLDA and CS inputs are at low level, a programming state is started with MSM82C37A-5 reading or writing executed by IOR or IOW. Programming details are described later.

#### ACTIVE CYCLE

If a DMA request is received in an unmasked channel while the MSM82C37A-5 is in an idle cycle, or if a software DREQ is generated, the HRQ is changed to high level to commence an active cycle. The initial state of an active cycle is the S0 state which is repeated until the HLDA input from the CPU is changed to high level. (But because of internal operational reasons, a minimum of one clock cycle is required for the HLDA is be changed to high level by the CPU after the HRQ has become high level. That is, the S0 state must be repeated at least twice.)

After the HLDA has been changed to high level, the S0 state proceeds to operational states S1 thru S4 during I/O-memory transfers, or to operational states S11 thru S14 and S21 thru S24 during memory-memory transfers.

If the memory or I/O device cannot be accessed within the normal timing, an SW state (wait state) can be inserted by a READY input to extend the timing.

#### **DESCRIPTION OF TRANSFER TYPES**

MSM82C37A-5 transfers between an I/O and memory devices, or transfers between memory devices. The three types of transfers between I/O and memory devices are read, write, and verify.

#### **I/O-MEMORY TRANSFERS**

The operational states during an I/O-memory transfer are S1, S2, S3, and S4.

In the S1 state, an AEN output is changed to high level to indicate that the control signal from the MSM82C37A-5 is valid. The eight lower order bits of the transfer address are obtained from A0 thru A7, and the eight higher order bits are obtained from DB0 thru DB7. The ADSTB output is changed to high level at this time to set the eight higher order bits in an external address latch, and the DACK output is made active for the channel where the DMA request is acknowledged. Where there is no change in the eight higher bit transfer address during demand and block mode transfers, however, the S1 state is omitted.

In the S2 state, the IOR or MEMR output is changed to low level.

In the S3 state, IOW or MEMW is changed to low level. Where compressed timing is used, however, the S3 state is omitted.

The S2 and S3 states are I/O or memory input/output timing control states.

In the S4 state, IOR, IOW, MEMR, and MEMW are changed to high level, and the word count register is decremented by 1 while the address register is incremented (or decremented) by 1. This completes the DMA transfer of one word.

Note that in I/O-memory transfers, data is transferred directly without being taken in by the MSM82C37A-5. The differences in the three types of I/O-memory transfers are indicated below.

#### I/O·MSM82C37A-5RS/GS/JS =-

#### **READ TRANSFER**

Data is transferred from memory to the I/O device by changing MEMR and IOW to low level. MEMW and IOR are kept at high level during this time.

#### WRITE TRANSFER

Data is transferred from the I/O device to memory by changing MEMW and IOR to low level. MEMR and IOW are kept at high level during this time.

Note that writing and reading in these write and read transfers are with respect to the memory.

#### VERIFY TRANSFER

Although verify transfers involve the same operations as write and read transfers (such as transfer address generation and EOP input responses), they are in fact pseudo transfers where all I/O and memory reading/writing control signals are kept inactive. READY inputs are disregarded in verify transfers.

#### MEMORY-MEMORY TRANSFERS

Memory-memory transfers are used to transfer data blocks from one memory area to another.

Memory-memory transfers require a total of eight states to complete a single transfer four states (S11 thru S14) for reading from memory, and four states (S21 thru S24) for writing into memory. These states are similar to I/O-memory transfer states, and are distinguished by using two-digit numbers.

In memory-memory transfers, channel 0 is used for reading data from the source area, and channel 1 is used for writing data into the destination area. During the initial four states, data specified by the channel 0 address is read from the memory when MEMR is made active, and is taken in the MSM82C37A-5 temporary register. Then during the latter four states, the data in the temporary register is written in the address specified by channel 1. This completes the transfer of one byte of data. With channel 0 and channel 1 addresses subsequently incremented (or decremented) by 1, and channel 0, 1 word count decremented by 1, this operation is repeated. The transfer is terminated when the word count reaches FFF(H) from OOO0(H), or when an EOP input is applied from an external source. Note that there is no DACK output signal during this transfer.

The following preparations in programming are requiring to enable memory-memory transfers to be started.

#### COMMAND REGISTER SETTING

Memory-memory transfers are enabled by setting bit 0. Channel 0 address can be held for all transfers by setting bit 1. This setting can be used to enable 1-word contents of the source area to be written into the entire destination area.

#### MODE REGISTER SETTING

The transfer type destination is disregarded in channels 0 and 1. Memory-memory transfers are always executed in block transfer mode.

#### **REQUEST REGISTER SETTING**

Memory-memory transfers are started by setting the channel 0 request bit.

#### MASK REGISTER SETTING

Mask bits for all channels are set to prevent selection of any other channel apart from channel 0.

#### WORD COUNT REGISTER SETTING

The channel 1 word count is validated, while the channel 0 word count is disregarded. In order to autoinitialize both channels, it is necessary to write the same values into both word count registers.

### DESCRIPTION OF OPERATION MODES

#### SINGLE TRANSFER MODE

In single transfer mode, only one word is transferred, and the addresses are incremented (or decremented) by 1 while the word count is decremented by 1. The HRQ is then changed to low level to return the bus control to the CPU. If DREQ remains active after completion of a transfer, the HRQ is changed to low level. After the HLDA is changed to low level by the CPU, and then changes the HRQ back to high level to commence a fresh DMA cycle. For this reason, a machine cycle can be inserted between DMA cycles by the CPU.

#### **BLOCK TRANSFER MODE**

Once a DMA transfer is started in block mode, the transfer is continued until terminal count (TC) status is reached.

If DREQ remains active until DACK becomes active, the DMA transfer is continued even if DREQ becomes inactive.

#### DEMAND TRANSFER MODE

The DMA transfer is continued in demand transfer mode until DREQ is no longer active, or until TC status is reached.

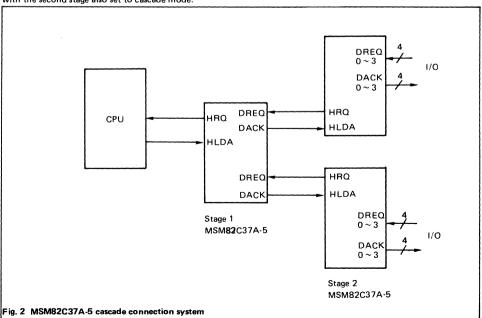
During a DMA transfer, intermediate address and word count values are held in the current address and current word count registers. Consequently, if the DMA transfer is suspended as a result of DREQ becoming inactive before TC status is reached, and the DREQ for that channel is then made active again, the suspended DMA transfer is resumed.

#### CASCADE TRANSFER MODE

When DMA transfers involving more than four channels are required, connecting a multiple number of MSM82C37A-5 devices in a cascade connection (see Figure 2) enables a simple system extension. This mode is set by setting the first stage MSM82C37A-5 channel to cascade mode. The DREQ and DACK lines for the first stage MSM82C37A-5 channel set to cascade mode are connected to the HRQ and HLDA lines of the respective MSM82C37A-5 devices in the second stage. The first stage MSM82C37A-5 DACK signal must be set to active-high, and the DREQ signal to active-low.

Since the first stage MSM82C37A-5 is only used functionally in determining the order of priority of each channel when cascade mode is set, only DREQ and DACK are used – all other inputs are disregarded. And since the system may be hung up if the DMA transfer is activated by software DREQ, do not set a software DREQ for channels where cascade mode has been set.

In addition to the dual stage cascade connection shown in Figure 2, triple stage cascade connections are possible with the second stage also set to cascade mode.



#### I/O·MSM82C37A-5RS/GS/JS =

#### AUTOINITIALIZE MODE

Setting bit 4 of the mode register enables autoinitialization of that channel. Following TC generation, autoinitialize involves writing of the base address and the base word count register values in the respective current address and current word count registers. The same values as in the current registers are written in the base registers by the CPU, and are not changed during DMA transfers.

When a channel has been set to autoinitialize, that channel may be used in a second transfer without involving the CPU and without the mask bit being reset after the TC generation.

#### PRIORITY MODES

The MSM82C37A-5 makes use of two priority decision modes, and acknowledges the DMA channel of highest priority among the DMA requesting channels.

#### FIXED PRIORITY MODE

In fixed priority mode, channel 0 has the highest priority, followed by channel 1, 2, and 3 in that order.

#### ROTATING PRIORITY MODE

In rotating priority mode, the order of priority is changed so that the channel where the current DMA transfer has been completed is given lowest priority. This is to prevent any one channel from monopolizing the system. The fixed priority is regained immediately after resetting.

Priorit	Priority mode		Rotating				
Service termin	ated channel	. —	СНО	· CH1	CH2	СНЗ	
Order of priority for next DMA	Highest Lowest	СН0 СН1 СН2 СН3	СН1 СН2 СН3 СН0	СН2 СН3 СН0 СН1	СН3 СН0 СН1 СН2	СН0 СН1 СН2 СН3	

#### Table 1 MSM82C37A-5 priority decision modes

#### COMPRESSED TIMING

Setting the MSM82C37A-5 to compressed timing mode enables the S3 state used in extension of the read pulse access time to be omitted (if permitted by system structure) for two or three clock cycle DMA transfers. If the S3 state is omitted, the read pulse width becomes the same as the write pulse width with the address updated in S2 and the read or write operation executed in S4. This mode is disregarded if the transfer is a memory-memory transfer. transfer.

#### EXTENDED WRITING

When this mode is set, the  $\overline{IOW}$  or  $\overline{MEMW}$  signal which normally appears during the S3 state is obtained during the S2 state, thereby extending the write pulse width. The purpose of this extended write pulse is to enable the system to accomodate memories and I/O devices where the access time is slower. Although the pulse width can also be extended by using READY, that involves the insertion of a SW state to increase the number of states.

### DESCRIPTION OF INTERNAL REGISTERS.

#### CURRENT ADDRESS REGISTER

Each channel is equipped with a 16-bit long current address register where the transfer address is held during DMA transfers. The register value is incremented (or decremented) in each DMA cycle. Although this register is 16 bits long, the CPU is accessed by the MSM82C37A-5 eight bits at a time, therefore necessitating two successive 8-bit (lower and higher order bits) reading or writing operations using internal first/last flip-flops.

When autoinitialize has been set, the register is automatically initialized to the original value after TC.

#### CURRENT WORD COUNT REGISTER

Each channel is also equipped with a 16 bit-long current word count register where the transfer count is held during DMA transfers. The register value is decremented in each DMA cycle. When the word count value reaches FFF(H) from OOOO(H), a TC is generated. Therefore, a word count vaue which is one less than the actual number of transfers must be set.

Since this register is also 16 bits long, it is accessed by first/last flip-flops control in the same way as the address register. And if autoinitialize has been set, the register is automatically initialized to the original value after TC.

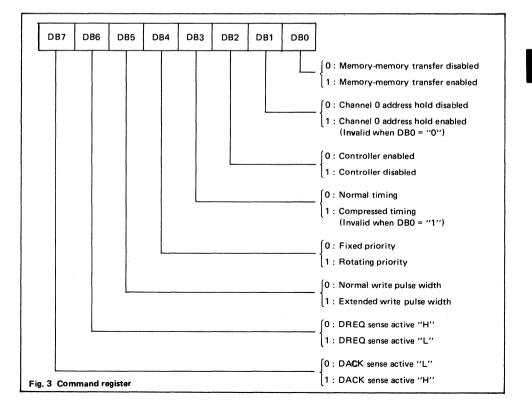
#### BASE ADDRESS REGISTER AND BASE WORD COUNT REGISTER

Each channel is equipped with a 16-bit long base address register and base word count register where the initial value of each current register is held. The same values are written in each base register and the current register by the CPU. The contents of the current register can be made ready by the CPU, but the content of the base register cannot be read.

#### COMMAND REGISTER

This 8-bit write-only register prescribes DMA operations for all MSM82C37A-5 channels. An outline of all bits is given in Figure 3. When the controller is disabled by setting DB2, there is no HRQ output even if DMA request is active.

DREQ and DACK signals may be active high or active low by setting DB6 and DB7.



### ■ I/O·MSM82C37A-5RS/GS/JS ■-

#### MODE REGISTER

Each channel is equipped with a 6-bit write-only mode register, which is decided by setting DB0, DB1 which channel is to be written when writing from the CPU is programming status. The bit description is outlined in Figure 4.

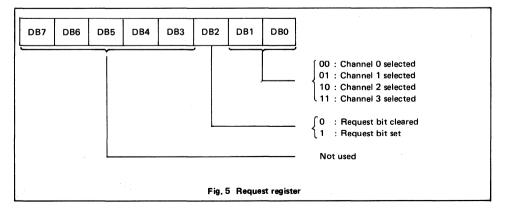
DB7 DB6 DB5 DB4 DB3-DB2 DB1 DB0 00 : Channel 0 selected 01 : Channel 1 selected 10 : Channel 2 selected 11 : Channel 3 selected 00 : Verify transfer 01 : Write transfer 10 : Read transfer 11 : Disabled (Invalid when DB6·DB7 = "11") 0 : Auto initialize disabled 1 : Auto initialize enabled 0 : Address increment (+1) selected 1 : Address decrement (-1) selected 00 : Demand transfer mode selected 01 : Single transfer mode selected 10 : Block transfer mode selected 11 : Cascade mode selected Fig. 4 Mode register

This register is not cleared by Reset or Master Clear instruction.

#### REQUEST REGISTER

In addition to using the DREQ signal, the MSM82C37A-5 can request DMA transfers by software means. This involves setting the request bit of request register. Each channel has a corresponding request bit in the request register, and the order of priority of these bits is determined by the priority decision circuit irrespective of the mask register. DMA transfers are acknowledged in accordance with the decided order of priority.

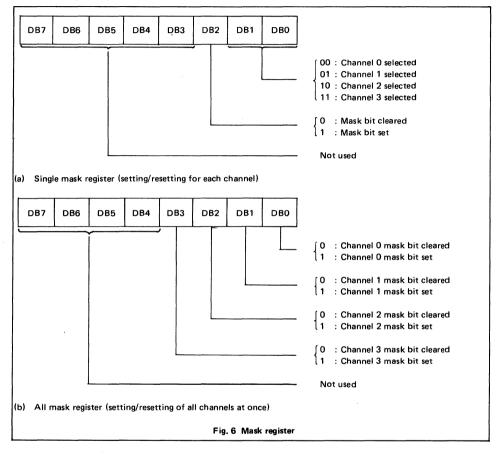
All request bits are reset when the TC is reached, and when the request bit of a certain channel has been received, all other request bits are cleared. When a memory-memory transfer is commenced, the channel 0 request bit is set. The bit description is outlined in Figure 5.



### MASK REGISTER

This register is used in disabling and enabling of DMA transfers in each channel. Each channel includes a corresponding mask bit in the mask register, and each bit is set when the TC is reached if not in autoinitialize mode. This mask register can be set in two different ways.

The method for setting/resetting the register for each channel is outlined in Figure 6(a), while the method for setting/resetting the register for all channels at once is outlined in Figure 6(b).

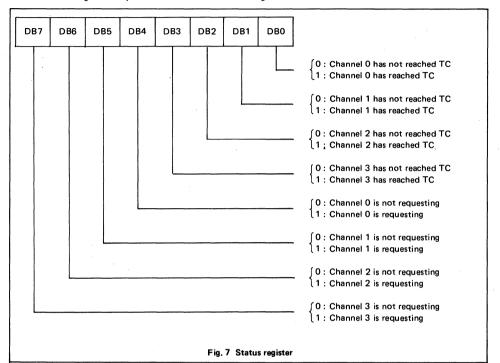


### I/O·MSM82C37A-5RS/GS/JS =

#### STATUS REGISTER

This register is a read-only register used in CPU reading of the MSM82C37A-5 status. The four higher order bits indicate the DMA transfer request status for each channel, '1' being set when the DREQ input signal is active.

The four lower order bits indicate whether the corresponding channel has reached the TC or not, '1' being set when the TC status is reached. These four lower order bits are reset by status register reading, or RESET input and master clearing. A description of each bit is outlined in Figure 7.



#### **TEMPORARY REGISTER**

The temporary register is a register where transfer data is held temporarily during memory-memory transfers. Since the last item of data to be transferred is held after completion of the transfer, this item can be read by the CPU.

#### SOFTWARE COMMAND

The MSM82C37A-5 is equipped with software commands for executing special operations to ensure proper programming. Software command is irrespective of data bus contents.

#### CLEAR FIRST/LAST FLIP-FLOP

16-bit address and word count registers are read or written in two consecutive operations involving eight bits each (higher and lower order bits) under data bus port control. The fact that the lower order bits are accessed first by the MSM82C37A-5, followed by accessing of the higher order bits, is discerned by the internal first/last flip-flop. This command resets the first/last flip-flop with the eight lower order bits being accessed immediately after execution.

#### MASTER CLEAR

The same operation as when the hardware RESET input is applied. This command clears the contents of the command, status (for lower order bits), request, and temporary registers, also clears the first/last flip-flop, and sets the mask register. This command is followed by an idle cycle.

#### **CLEAR MASK REGISTER**

When this command is executed, the mask bits for all channels are cleared to enable reception of DMA transfers.

### PROGRAMMING

The MSM82C37A-5 is switched to programming status when the HLDA input and  $\overline{CS}$  are both at low level. In this state,  $\overline{IOR}$  is changed to low level with  $\overline{IOW}$  held at high level to enable reading by the CPU, or else  $\overline{IOW}$  is changed to low level while  $\overline{IOR}$  is held at high level to enable writing by the CPU.

A list of command codes for reading from the MSM82C37A-5 is given in Table 2, and a list of command codes for writing in the MSM82C37A-5 is given Table 3.

Note: If a DMA transfer request is received from an I/O device during MSM82C37A-5 programming, that DMA transfer may be commenced to prevent proper programming.

To prevent this interference, the DMA channel must be masked, or the controller disabled by the command register, or the system set so as to prevent DREQ becoming active during the programming.

cs	IOR	A3	A2	A1	A0	Internal first/last flip/flop		Read out data			
0	0	0	0	0	0	0		Current address	8 lower order bits		
0	0	0	0	0	0	1	Channel 0	register	8 higher order bits		
0	0	0	0	0	1	0	Channel U	Current word count	8 lower order bits		
0	0	0	0	0	1	1		register	8 higher order bits		
0	0	0	0	1	0	0		Current address	8 lower order bits		
0	0	0	0	1	0	1		register	8 higher order bits		
0	0	0	0	1	1	0	Channel 1	Current word count	8 lower order bits		
0	0	0	0	1	1	1		register	8 higher order bits		
0	0	0	1	0	0	0		Current address register Current word count	8 lower order bits		
0	0	0	1	0	0	1			8 higher order bits		
0	0	0	1	0	1	0	Channel 2		8 lower order bits		
0	0	0	1	0	1	1		register	8 higher order bits		
0	0	0	1	1	0	0		Current address	8 lower order bits		
0	0	0	1	1	0	1	Observed 2	register	8 higher order bits		
0	0	0	1	1	1	0	Channel 3	Current word count	8 lower order bits		
0	0	0	1	1	1	1		register	8 higher order bits		
0	0	1	0	0	0	×	Status register				
0	0	1	1	0	1	х	Temporary register				
0	0	Oth	er com	binatio	ns	×	Output data invalid				

Table 2 List of MSM82C37A-5 read commands

# ■ I/O·MSM82C37A-5RS/GS/JS ■-

cs	iow	A3	AŻ	A1	A0	Internal first/last flip-flop		Written data			
0	0	0	0	. 0	0	0		Current and base	8 lower order bits		
0	0	0	0	0	0	1	Channel 0	address registers	8 higher order bits		
0	0	0	0	0	1	0	Channel U	Current and base	8 lower order bits		
0	0	0	0	0	1	1		word count registers	8 higher order bits		
0	0	0	0	1	0	0		Current and base	8 lower order bits		
0	0	0	0	1	0	1	Channel 1	address registers	8 higher order bits		
0	0	0	0	1	1	0	Channer	Current and base	8 lower order bits		
0	0	0	0	1	1	1		word count registers	8 higher order bits		
0	0	0	1	0	0	0		Current and base	8 lower order bits		
0	0	0	1	0	0	1	address registers	8 higher order bits			
0	0	0	1	0	1	0	Channel 2	Current and base word count registers Current and base	8 lower order bits		
0	0	0	1	0	1 ·	1			8 higher order bits		
0	0	0	1	1	0	0 ·			8 lower order bits		
0	0	0	1	1	Ó	1	address registers	address registers	8 higher order bits		
0	0	0	1	1	1	0	Channel 3	Current and base	8 lower order bits		
0	0	0	1	1	1	1		word count registers	8 higher order bits		
0	0	1	0	0	0	×	Command r	egister			
0	0	1	0	0	1	×	Request reg	ister	••		
0	0	1	0	1	0	×	Single mask	register			
0	0	1	0	1	1	×	Mode register				
0	0	1	1	0	0	×	Clear first/last flip-flop (software command)				
0	0	1	1	0	1	×	Master clear (software command)				
0	0	1	1	1	0	×	Clear mask register (software command)				
0	0	1	1	1	1	×	All mask re	gister			

#### Table 3 List of MSM82C37A-5 write commands

# **OKI** semiconductor MSM82C37B-5RS/GS/VJS

PROGRAMMABLE DMA CONTROLLER

# **GENERAL DESCRIPTION**

The MSM82C37B-5RS/GS/JS, DMA (Direct Memory Access) controller is capable of high-speed data transfer without CPU intervention and is used as a peripheral device in microcomputer systems. The device features four independent programmable DMA channels.

Due to the use of silicon gate CMOS technology, standby current is 10  $\mu$ A (max.), and power consumption is as low as 10 mA (max.) when a 5 MHz clock is generated.

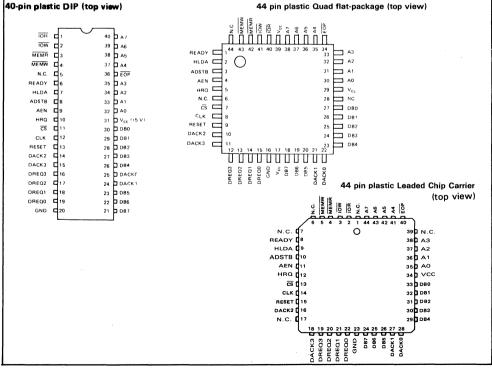
All items of AC characteristics are compatible with intel 8237B-5.

# **FEATURES**

- Maximum operating frequency of 5 MHz(V<sub>cr</sub>= 5 V ±10%) DMA address increment/decrement selection
- · High-speed operation at very low power consumption due to silicon gate CMOS technology
- Wide operating temperature range from -40° to +85°C
- 4-channels independent DMA control
- DMA request masking and programming
- DMA request priority function
- DREQ and DACK input/output logic inversion

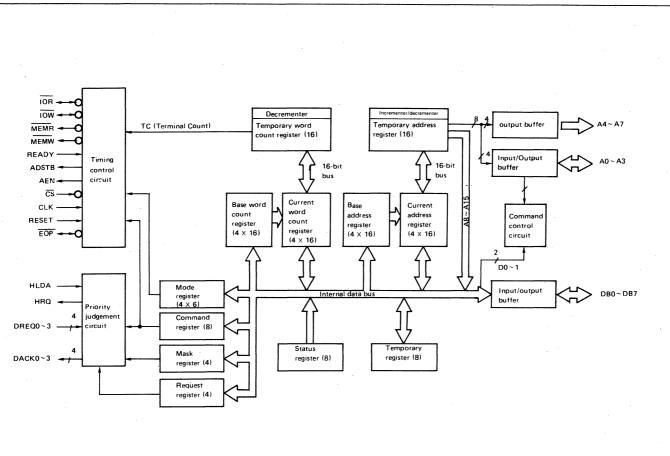
- Memory-to-Memory Transfers
- Channel extension by cascade connection
- DMA transfer termination by EOP input
- Intel 8237A-5 compatibility
- TTL Compatible
- · 40 pin Plastic DIP (DIP40-P-600)
- · 44 pin PLCC (QFJ44-P-S650)
- · 44 pin-V Plastic QFP (QFP44-P-910-VK)
- · 44 pin-VI Plastic QFP (QFP44-P-910-VIK)

# **PIN CONNECTIONS**



#### Note: N.C. (No Connection)





I/O·MSM82C37B-5RS/GS/VJS

**BLOCK DIAGRAM** 

# ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Conditions		Unit			
			MSM82C37B-5RS MSM82C37B5GS MSM82C37B-5V.				
Power supply voltage	Vcc			-0.5 ~ +7			
Input voltage	VIN	with respect to GND	_	<b>).5</b>	V		
Output voltage	Vout	GIND	$-0.5 \sim V_{cc} + 0.5$			v	
Storage temperature	T <sub>stg</sub>			-55 ~ +150		°C	
Power dissipation	PD	Ta = 25°C	1.0	0.7	1.0	w	

# RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Maximum	Typical	Minimum	Unit
Power supply voltage	Vcc	4.5	5.0	5.5	v
Operating temperature	ТОР	-40	+25	+85	°c
"L" input voltage	VIL	0.5		+0.8	v
"H" input voltage	VIH	2.2	-	V <sub>CC</sub> + 0.5	V

# DC CHARACTERISTICS

Parameter	Symbol	Condit	ions	Maximum	Typical	Minimum	Unit
"L" output voltage	VOL	IOL = 3.2 mA		-	_	0.4	v
"H" output voltage	VOH	IOH = -1.0 mA	V <sub>CC</sub> = 4.5 V ~ 5.5V	3.7	—	-	v
Input leak current	ILI	$0 \vee \leq V_{IN} \leq V_{CC}$	$T_0 = 40^{\circ}C$	-10		10	μA
Output leak current	ILO	0 V ≦ V <sub>OUT</sub> ≦ V <sub>CC</sub>	~ +85°C	-10	_	10	μA
Average power supply current during operations	ICC	Input frequency 5 MHz, whenRESET VIN = 0 V/VCC, CL = 0 pF			_	10	mA
Power supply current in standby mode	ICCS	HLDA = 0 V, VIL = 0 V, VIH = VCC		_	-	10	μΑ

■ I/O·MSM82C37B-5RS/GS/VJS ■

# AC CHARACTERISTICS

# DMA (MASTER) MODE

# (Ta = -40 $\sim$ +85 $^{\circ}$ C, V<sub>CC</sub> = 4.5 $\sim$ 5.5V)

	,				
Symbol	Item	MIN	МАХ	Unit	Comments
TAEL	Delay time from CLK falling edge up to AEN leading edge		200	ns	
TAET	Delay time from CLK rising edge up to AEN trailing edge		130	ns	
TAFAB	Delay time from CLK rising edge up to address floating status		90	ns	
TAFC	Delay time from CLK rising edge up to read/write signal floating status		120	ns	
TAFDB	Delay time from CLK rising edge up to data bus floating status		170	ns	
TAHR	Address valid hold time to read signal trailing edge	TCY-100		ns	
TAHS	Data valid hold time to ADSTB trailing edge	30		ns	
ТАНЖ	Address valid hold time to write signal trailing edge	TCY-50		ns	
	Delay time from CLK falling edge up to active DACK		170	ns	(Note 3)
ТАК	Delay time from CLK rising edge up to EOP leading edge	-	170	ns	(Note 5)
	Delay time from CLK rising edge up to EOP trailing edge		170	ns	
TASM	Time from CLK rising edge up to address valid		170	ns	
TASS	Data set-up time to ADSTB trailing edge	100		ns	
тсн	Clock high-level time	68	·	ns	(Note 6)

# - I/O·MSM82C37B-5RS/GS/VJS =

Symbol	Item	MIN	MAX	Unit	Comments
TCL	Clock low-level time	68	—	ns	(Note 6)
тсү	CLK cycle time	200		ns	
TDCL	Delay time from CLK rising edge to read/write signal leading edge		190	ns	(Note 2)
TDCTR	Delay time from CLK rising edge to read signal trailing edge	—	190	ns	(Note 2)
тости	Delay time from CLK rising edge to write signal trailing edge		130	ns	(Note 2)
τρα	Delay time from CLK rising edge to HRQ valid	—	120	ns	
TEPS	EOP leading edge set-up time to CLK falling edge	40		ns	
TEPW	EOP pulse width	220	—	ns	_
TFAAB	Delay time from CLK rising edge to address valid		170	ns	
TFAC	Time from CLK rising edge up to active read/write signal		150	ns	
TFADB	Delay time from CLK rising edge to data valid		200	ns	
тнѕ	HLDA valid set-up time to CLK rising edge	75	_	ns	
TIDH	Input data hold time to MEMR trailing edge	0		ns	_
TIDS	Input data set-up time to MEMR trailing edge	170	_	ns	
торн	Output data hold time to MENW trailing edge	10	_	ns	_
TODV	Time from output data valid to MEMW trailing edge	125		ns	
TOS	DREQ set-up time to CLK falling edge	0		ns	(Note 3)
TRH	READY hold time to CLK falling edge	20	—	ns	
TRS	READY set-up time to CLK falling edge	60		ns	_
TSTL	Delay time from CLK rising edge to ADSTB leading edge	·	130	ns	
тотт	Delay time from CLK rising edge to ADSTB trailing edge		90	ns	

### ■ I/O·MSM82C37B-5RS/GS/VJS

### SLAVE MODE

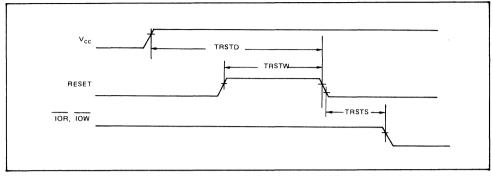
# $(Ta = -40 \sim +85^{\circ}C, V_{CC} = 4.5 \sim 5.5V)$

·····					
Symbol	Item	MIN	MAX	Unit	Comments
TAR	Time from address valid or CS leading edge to IOR leading edge	50		ns	
TAW	Address valid set-up time to IOW trailing edge	130		ns	
тсw	CS leading edge set-up time to IOW trailing edge	130		ns	
TDW	Data valid set-up time to IOW trailing edge	130		ns	
TRA	Address or CS hold time to IOR trailing edge	0		ns	
TRDE	Data access time to IOR leading edge		140	ns	
TRDF	Delay time to data floating status from IOR trailing edge	0	70	ns	
TRSTD	Supply power leading edge set-up time to RESET trailing edge	500		· ns	
TRSTS	Time to first active IOR or IOW from RESET trailing edge	2709	. —	ns	
TRSTW	RESET pulse width	300		ns	
TRW	IOR pulse width	200		ns	
TWA	Address hold time to IOW trailing edge	20		ns	
тwс	CS trailing edge hold time to IOW trailing edge	20		ns	
TWD	Data hold time to IOW trailing edge	30		ns	
TWWS	IOW pulse width	160		ns	

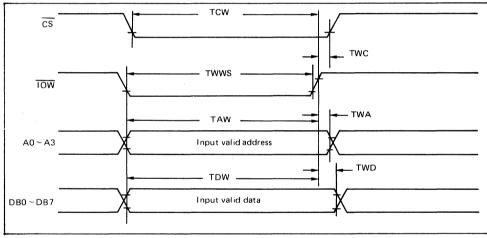
#### Note:

- 1. Output load capacitance of 150 (pF).
- IOW and MEMW pulse widths of TCY-100 (ns) for normal writing, and 2TCY-100 (ns) for extended writing.
   IOR and MEMR pulse widths of 2TCY-50 (ns) for normal timing, and TCY-50 (ns) for compressed timing.
- DREQ and DACK signal active level can be set to either low or high. In the timing chart, the DREQ signal has been set to active-high, and the DACK signal to active-low.
- 4. When the CPU executes continuous read or write in programming mode, the interval during which the read or write pulse becomes active must be set to at least 400 ns.
- EOP is an open drain output. The value given is obtained when a 2.2 kohm pull-up resistance is connected to VCC.
- 6. Rise time and fall time is less than 10 ns.
- 7. Waveform measurement points for both input and output signals are 2.2 V for HIGH and 0.8 V for LOW, unless otherwise noted.

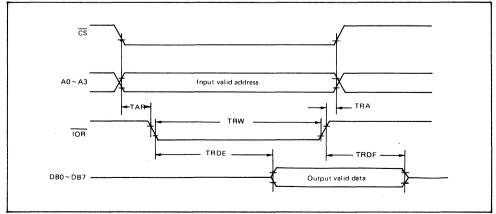
# TIME CHART RESET TIMING



# SLAVE MODE WRITE TIMING

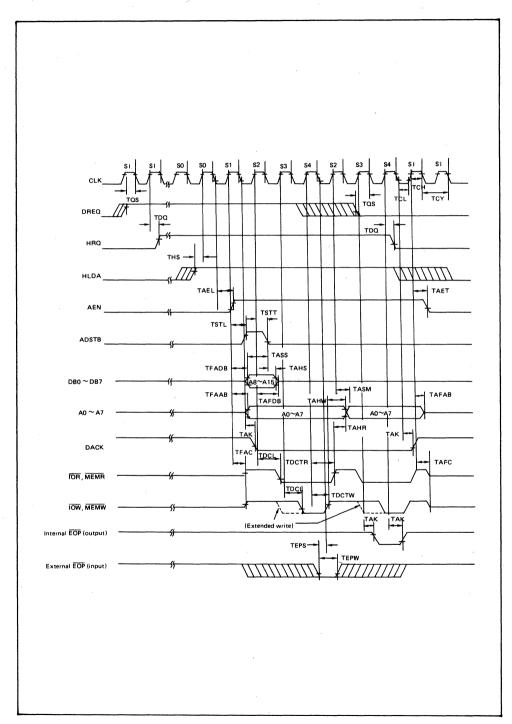


# SLAVE MODE READ TIMING

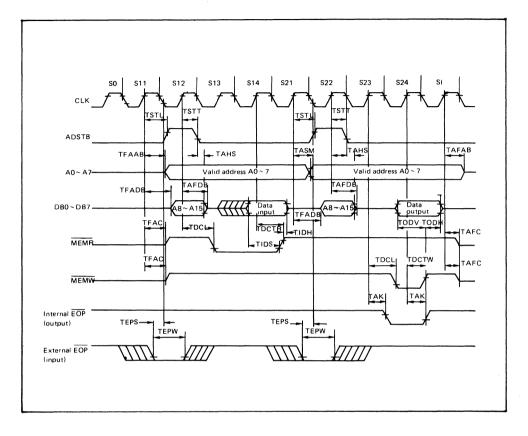


## ■ I/O·MSM82C37B-5RS/GS/VJS ■ -

# DMA TRANSFER TIMING

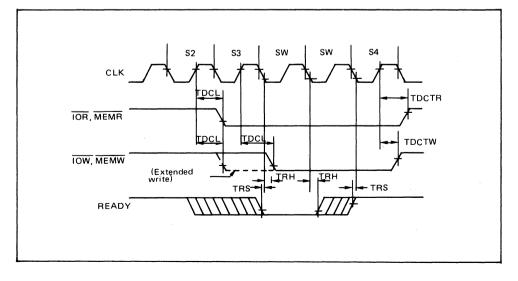


IJ



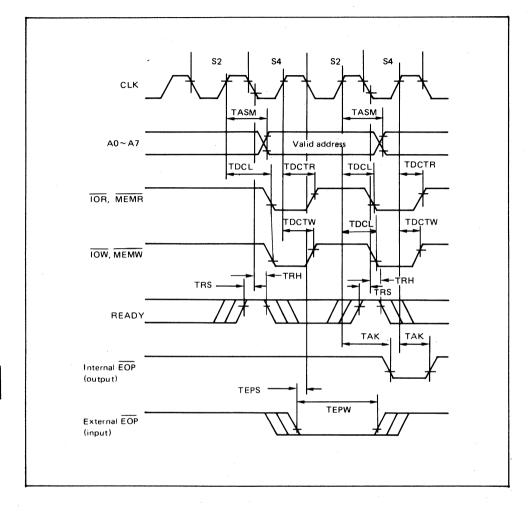
# MEMORY TO MEMORY TRANSFER TIMING

# **READY TIMING**



# ■ I/O·MSM82C37B-5RS/GS/VJS ■

# COMPRESSED TRANSFER TIMING



# PIN FUNCTIONS

Symbol	Pin name	Input/ output	Function	
V <sub>cc</sub>	Power		+5 V power supply.	
GND	Ground		Ground (0 V) connection.	
CLK	Clock	Input	Control of MSM82C37B-5 internal operat and data transfer speed.	
<del>cs</del>	Chip select	Input	CS is active-low input signal used for the CPU to select the MSM82C37B-5 as an I/O device in an idle cycle.	
RESET	Reset	Input	RESET is active-high asynchronous input signal used to clear command, status, request, temporary registers, and first/last F/F, and to set mask register. The MSM82C37B-5 enters an idle cycle following a RESET.	
READY	Ready	Input	The read or write pulse width can be extended to accomodate slow access memories and I/O devices when this input is switched to low level. Note this input must not change within the prescribed set-up/hold time.	
HLDA	Hold acknowledge	Input	HLDA is active-high input signal used to indicate that system bus control has been released when a hold request is received by the CPU.	
DREQ0 ~ DREQ3	DMA request 0 ~ 3 channels	Input	DREQ is asychronous DMA transfer request input signals. Although these pins are switched to active-high by reset, they can be programmed to become active-low. DMA requests are received in accordance with a prescribed order of priority. DREQ must be held until DACK becomes active.	
DB0 ~ DB7	Data bus 0 ~ 7	Input/ output	DB is bidirectional three-state signals connected to the system data bus, and which is used as an input/output of MSM82C37B-5 internal registers during idle cycles, and as an output of the eight higher order bits of transfer addresses during active cycles. Also used as input and output of transfer data during memory-memory transfers.	
IOR	I/O read	Input/ output	IOR is active-low bidirectional three-state signal used as an input control signal for CPU reading of MSM82C37B-5 internal registers during idle cycles, and as an output control signal for reading I/O device transfer data in writing transfers during active cycles.	
IOW I/O write Input/ output			IOW is active-low bidirectional three-state signal used as an input control signal for CPU writing of MSM82C37B-5 internal registers during idle cycles, and as an output control signal for writing I/O device transfer data in writing transfers during active cycles.	

### I/O·MSM82C37B-5RS/GS/VJS =

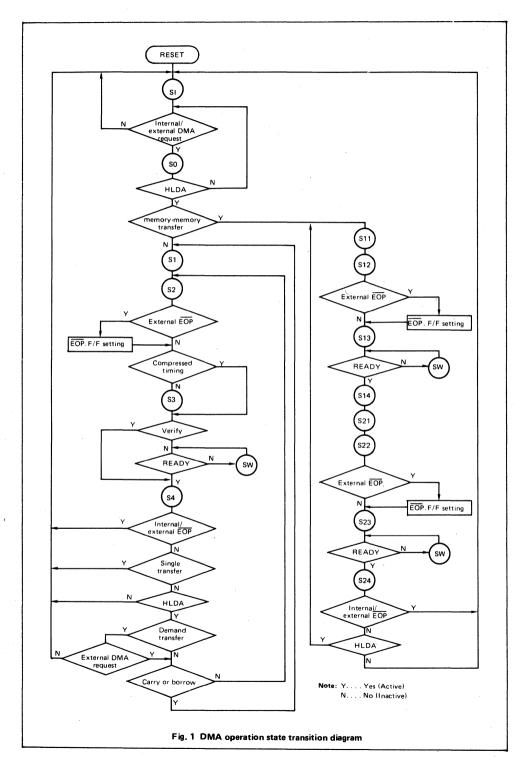
Symbol	Pin name	Input/ output	Function
EOP	End of process	Input/ output	EOP is active-low bidirectional three-state signal. Unlike other pins, this pin is an N-channel open drain. During DMA operations, a low-level output pulse is obtained from this pin if the channel word count changes from 0000H to FFFFH.
			And DMA transfers can be terminated by pulling the EOP input to low level. Both of these actions are called terminal count (TC).
			When an internal or external EOP is generated, the MSM82C37B-5 terminates the transfer and resets the DMA request.
			When the $\overline{\text{EOP}}$ pin is not used, it is necessary to hold the pin at high level by pull-up resistance to prevent the input of an $\overline{\text{EOP}}$ by error. Also note that the $\overline{\text{EOP}}$ function cannot be satisfied in cascade mode.
A0 ~ A3	Address 0 ~ 3	Input/ output	A0~A3 is bidirectional three-state signals used as input signals for specifying the MSM82C37B-5 internal register to be accessed by the CPU during idle cycles, and as an output the four lower order bits of the transfer address during active cycles.
A4 ~ A7	Address 4 ~ 7	Output	A4~A7 is three-state signals used as an output the four higher order bits of the transfer address during active cycles.
HRQ	Hold request	Output	HRQ is active-high signal used as an output of hold request to the CPU for system data bus control purposes. After HRQ has become active, at least one clock cycle is required before HLDA becomes active.
DACK0~DACK3	DMA acknowledge 0 ~ 3 channels	Output	DACK is output signals used to indicate that DMA transfer to peripheral devices has been permitted. (Available in each channel.)
			Although these pins are switched to active-low when reset, they can be programmed to become active-high.
			Note that there is no DACK output signal during memory-memory transfers.
AEN	Address enable	Output	AEN is active-high output signal used to indicate that output signals sent from the MSM82C37B-5 to the system are valid. And in addition to enabling external latch to hold the eight higher order bits of the transfer address, this signal is also used to disable other system bus buffers.

# · ■ I/O·MSM82C37B-5RS/GS/VJS ■

Symbol	Pin name	Input/ output	Function
ADSTB	Address strobe	Output	ADSTB is active-high signal used to strobe the eight higher order bits of the transfer address by external latch.
MEMR	Memory read	Output	MEMR is active-low three-state output signal used as a control signal in reading data from memory during read transfers and memory- memory transfers.
MEMW	Memory write	Output	MEMW is active-low three-state output signal used as a control signal in writing data into memory during write transfers and memory- memory transfers.

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■ I/O·MSM82C37B-5RS/GS/VJS ■-



### OUTLINE OF FUNCTIONS

The MSM82C37B-5 consists of five blocks = three logic sections, an internal register section, and a counter section.

The logic sections include a timing control block where the internal timing and external control signals are generated, a command control block where each instruction from the CPU is decoded, and a priority decision block where the order of DMA channel priority is determined. The purpose of the internal register section is to hold internal states and instructions from the CPU, while the counter section computes addresses and word counts.

### DESCRIPTION OF OPERATIONS

The MSM82C37B-5 operates in two cycles (called the idle and active cycles) which are divided into independent states. Each state is commenced by a clock falling edge and continues for a single clock cycle. The transition from one state to the next in DMA operations is outlined in Figure 1.

### IDLE CYCLE

The idle cycle is entered from the SI state when there is no valid DMA request on any MSM82C37B-5 channel. During this cycle, DREQ and CS inputs are monitored during each cycle. When a valid DMA request is then received, an active cycle is commenced. And if the HLDA and CS inputs are at low level, a programming state is started with MSM82C37B-5 reading or writing executed by IOR or IOW. Programming details are described later.

### ACTIVE CYCLE

If a DMA request is received in an unmasked channel while the MSM82C37B-5 is in an idle cycle, or if a software DREQ is generated, the HRQ is changed to high level to commence an active cycle. The initial state of an active cycle is the S0 state which is repeated until the HLDA input from the CPU is changed to high level. (But because of internal operational reasons, a minimum of one clock cycle is required for the HLDA is be changed to high level by the CPU after the HRQ has become high level. That is, the S0 state must be repeated at least twice.)

After the HLDA has been changed to high level, the S0 state proceeds to operational states S1 thru S4 during I/O-memory transfers, or to operational states S11 thru S14 and S21 thru S24 during memory-memory transfers.

If the memory or I/O device cannot be accessed within the normal timing, an SW state (wait state) can be inserted by a READY input to extend the timing.

### DESCRIPTION OF TRANSFER TYPES

MSM82C37B-5 transfers between an I/O and memory devices, or transfers between memory devices. The three types of transfers between I/O and memory devices are read, write, and verify.

#### **I/O-MEMORY TRANSFERS**

The operational states during an I/O-memory transfer are S1, S2, S3, and S4.

In the S1 state, an AEN output is changed to high level to indicate that the control signal from the MSM82C37B-5 is valid. The eight lower order bits of the transfer address are obtained from A0 thru A7, and the eight higher order bits are obtained from DB0 thru DB7. The ADSTB output is changed to high level at this time to set the eight higher order bits in an external address latch, and the DACK output is made active for the channel where the DMA request is acknowledged. Where there is no change in the eight higher bit transfer address during demand and block mode transfers, however, the S1 state is omitted.

In the S2 state, the IOR or MEMR output is changed to low level.

In the S3 state,  $\overline{\text{IOW}}$  or  $\overline{\text{MEMW}}$  is changed to low level. Where compressed timing is used, however, the S3 state is omitted.

The S2 and S3 states are I/O or memory input/output timing control states.

In the S4 state, IOR, IOW, MEMR, and MEMW are changed to high level, and the word count register is decremented by 1 while the address register is incremented (or decremented) by 1. This completes the DMA transfer of one word.

Note that in I/O-memory transfers, data is transferred directly without being taken in by the MSM82C37B-5. The differences in the three types of I/O-memory transfers are indicated below.

### ■ I/O·MSM82C37B-5RS/GS/VJS ■

#### **READ TRANSFER**

Data is transferred from memory to the I/O device by changing MEMR and IOW to low level. MEMW and IOR are kept at high level during this time.

#### WRITE TRANSFER

Data is transferred from the I/O device to memory by changing MEMW and IOR to low level. MEMR and IOW are kept at high level during this time.

Note that writing and reading in these write and read transfers are with respect to the memory.

#### VERIFY TRANSFER

Although verify transfers involve the same operations as write and read transfers (such as transfer address generation and EOP input responses), they are in fact pseudo transfers where all I/O and memory reading/writing control signals are kept inactive. READY inputs are disregarded in verify transfers.

#### MEMORY-MEMORY TRANSFERS

Memory-memory transfers are used to transfer data blocks from one memory area to another.

Memory-memory transfers require a total of eight states to complete a single transfer four states (S11 thru S14) for reading from memory, and four states (S21 thru S24) for writing into memory. These states are similar to I/O-memory transfer states, and are distinguished by using two-digit numbers.

In memory-memory transfers, channel 0 is used for reading data from the source area, and channel 1 is used for writing data into the destination area. During the initial four states, data specified by the channel 0 address is read from the memory when MEMR is made active, and is taken in the MSM82C378-5 temporary register. Then during the latter four states, the data in the temporary register is written in the address specified by channel 1. This completes the transfer of one byte of data. With channel 0 and channel 1 address subsequently incremented (or decremented) by 1, and channel 0, 1 word count decremented by 1, this operation is repeated. The transfer is terminated when the word count reaches FFF(H) from OOOO(H), or when an EOP input is applied from an external source. Note that there is no DACK output signal during this transfer.

The following preparations in programming are requiring to enable memory-memory transfers to be started.

#### COMMAND REGISTER SETTING

Memory-memory transfers are enabled by setting bit 0. Channel 0 address can be held for all transfers by setting bit 1. This setting can be used to enable 1-word contents of the source area to be written into the entire destination area.

#### MODE REGISTER SETTING

The transfer type destination is disregarded in channels 0 and 1. Memory-memory transfers are always executed in block transfer mode.

#### **REQUEST REGISTER SETTING**

Memory-memory transfers are started by setting the channel 0 request bit.

#### MASK REGISTER SETTING

Mask bits for all channels are set to prevent selection of any other channel apart from channel 0.

#### WORD COUNT REGISTER SETTING

The channel 1 word count is validated, while the channel 0 word count is disregarded. In order to autoinitialize both channels, it is necessary to write the same values into both word count registers.



### DESCRIPTION OF OPERATION MODES

#### SINGLE TRANSFER MODE

In single transfer mode, only one word is transferred, and the addresses are incremented (or decremented) by 1 while the word count is decremented by 1. The HRQ is then changed to low level to return the bus control to the CPU. If DREQ remains active after completion of a transfer, the HRQ is changed to low level. After the HLDA is changed to low level by the CPU, and then changes the HRQ back to high level to commence a fresh DMA cycle. For this reason, a machine cycle can be inserted between DMA cycles by the CPU.

#### **BLOCK TRANSFER MODE**

Once a DMA transfer is started in block mode, the transfer is continued until terminal count (TC) status is reached.

If DREQ remains active until DACK becomes active, the DMA transfer is continued even if DREQ becomes inactive.

#### DEMAND TRANSFER MODE

The DMA transfer is continued in demand transfer mode until DREQ is no longer active, or until TC status is reached.

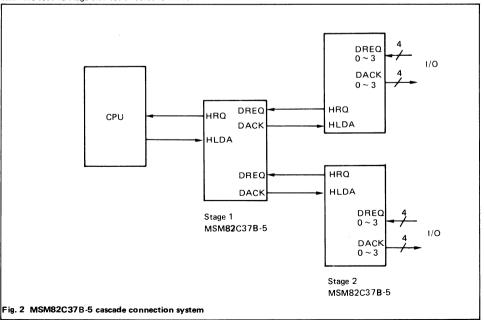
During a DMA transfer, intermediate address and word count values are held in the current address and current word count registers. Consequently, if the DMA transfer is suspended as a result of DREQ becoming inactive before TC status is reached, and the DREQ for that channel is then made active again, the suspended DMA transfer is resumed.

#### CASCADE TRANSFER MODE

When DMA transfers involving more than four channels are required, connecting a multiple number of MSM82C37A-5 devices in a cascade connection (see Figure 2) enables a simple system extension. This mode is set by setting the first stage MSM82C37B-5 channel to cascade mode. The DREQ and DACK lines for the first stage MSM82C37B-5 channel set to cascade mode are connected to the HRQ and HLDA lines of the respective MSM82C37B-5 devices in the second stage. The first stage MSM82C37B-5 DACK signal must be set to active-high, and the DREQ signal to active-low.

Since the first stage MSM82C37B-5 is only used functionally in determining the order of priority of each channel when cascade mode is set, only DREQ and DACK are used – all other inputs are disregarded. And since the system may be hung up if the DMA transfer is activated by software DREQ, do not set a software DREQ for channels where cascade mode has been set.

In addition to the dual stage cascade connection shown in Figure 2, triple stage cascade connections are possible with the second stage also set to cascade mode.



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#### AUTOINITIALIZE MODE

Setting bit 4 of the mode register enables autoinitialization of that channel. Following TC generation, autoinitialize involves writing of the base address and the base word count register values in the respective current address and current word count registers. The same values as in the current registers are written in the base registers by the CPU, and are not changed during DMA transfers.

When a channel has been set to autoinitialize, that channel may be used in a second transfer without involving the CPU and without the mask bit being reset after the TC generation.

#### PRIORITY MODES

The MSM82C37B-5 makes use of two priority decision modes, and acknowledges the DMA channel of highest priority among the DMA requesting channels.

#### FIXED PRIORITY MODE

In fixed priority mode, channel 0 has the highest priority, followed by channel 1, 2, and 3 in that order.

#### ROTATING PRIORITY MODE

In rotating priority mode, the order of priority is changed so that the channel where the current DMA transfer has been completed is given lowest priority. This is to prevent any one channel from monopolizing the system. The fixed priority is regained immediately after resetting.

Priority mode		Fixed		Rotating				
Service terminated channel			сно	СН1	CH2	СНЗ		
Order of priority for next DMA	Highest Lowest	СН0 СН1 СН2 СН3	СН1 СН2 СН3 СН0	СН2 СН3 СН0 СН1	СН3 СН0 СН1 СН2	СН0 СН1 СН2 СН3		

#### Table 1 MSM82C37B-5 priority decision modes

### COMPRESSED TIMING

Setting the MSM82C37B-5 to compressed timing mode enables the S3 state used in extension of the read pulse access time to be omitted (if permitted by system structure) for two or three clock cycle DMA transfers. If the S3 state is omitted, the read pulse width becomes the same as the write pulse width with the address updated in S2 and the read or write operation executed in S4. This mode is disregarded if the transfer is a memory-memory transfer. transfer.

#### EXTENDED WRITING

When this mode is set, the  $\overline{IOW}$  or  $\overline{MEMW}$  signal which normally appears during the S3 state is obtained during the S2 state, thereby extending the write pulse width. The purpose of this extended write pulse is to enable the system to accomodate memories and I/O devices where the access time is slower. Although the pulse width can also be extended by using READY, that involves the insertion of a SW state to increase the number of states.

### DESCRIPTION OF INTERNAL REGISTERS.

#### CURRENT ADDRESS REGISTER

Each channel is equipped with a 16-bit long current address register where the transfer address is held during DMA transfers. The register value is incremented (or decremented) in each DMA cycle. Although this register is 16 bits long, the CPU is accessed by the MSM82C37B-5 eight bits at a time, therefore necessitating two successive 8-bit (lower and higher order bits) reading or writing operations using internal first/last flip-flops.

When autoinitialize has been set, the register is automatically initialized to the original value after TC.

#### CURRENT WORD COUNT REGISTER

Each channel is also equipped with a 16 bit-long current word count register where the transfer count is held during DMA transfers. The register value is decremented in each DMA cycle. When the word count value reaches FFF(H) from OOOO(H), a TC is generated. Therefore, a word count vaue which is one less than the actual number of transfers must be set.

Since this register is also 16 bits long, it is accessed by first/last flip-flops control in the same way as the address register. And if autoinitialize has been set, the register is automatically initialized to the original value after TC.

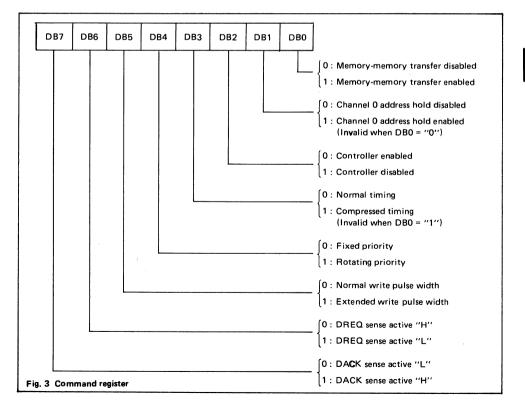
#### BASE ADDRESS REGISTER AND BASE WORD COUNT REGISTER

Each channel is equipped with a 16-bit long base address register and base word count register where the initial value of each current register is held. The same values are written in each base register and the current register by the CPU. The contents of the current register can be made ready by the CPU, but the content of the base register cannot be read.

#### COMMAND REGISTER

This 8-bit write-only register prescribes DMA operations for all MSM82C37B-5 channels. An outline of all bits is given in Figure 3. When the controller is disabled by setting DB2, there is no HRQ output even if DMA request is active.

DREQ and DACK signals may be active high or active low by setting DB6 and DB7.

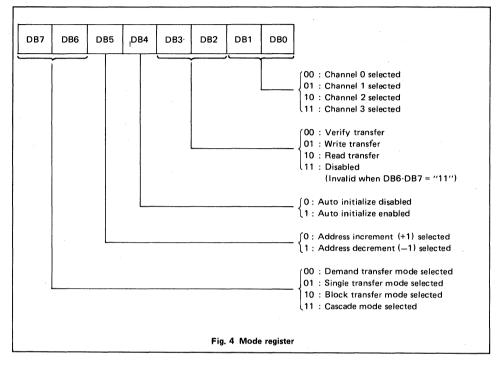


### I/O·MSM82C37B-5RS/GS/VJS I

#### MODE REGISTER

Each channel is equipped with a 6-bit write-only mode register, which is decided by setting DB0, DB1 which channel is to be written when writing from the CPU is programming status. The bit description is outlined in Figure 4.

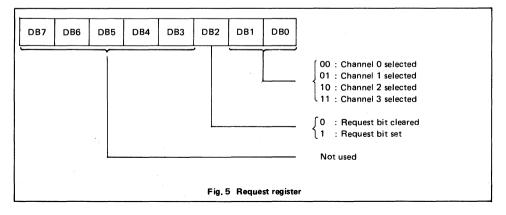
This register is not cleared by Reset or Master Clear instruction.



#### REQUEST REGISTER

In addition to using the DREQ signal, the MSM82C37B-5 can request DMA transfers by software means. This involves setting the request bit of request register. Each channel has a corresponding request bit in the request register, and the order of priority of these bits is determined by the priority decision circuit irrespective of the mask register. DMA transfers are acknowledged in accordance with the decided order of priority.

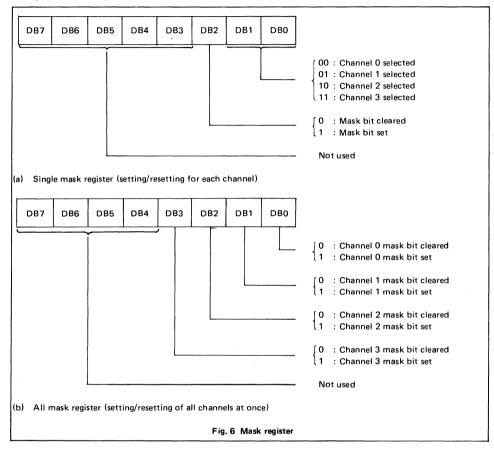
All request bits are reset when the TC is reached, and when the request bit of a certain channel has been received, all other request bits are cleared. When a memory-memory transfer is commenced, the channel 0 request bit is set. The bit description is outlined in Figure 5.



#### MASK REGISTER

This register is used in disabling and enabling of DMA transfers in each channel. Each channel includes a corresponding mask bit in the mask register, and each bit is set when the TC is reached if not in autoinitialize mode. This mask register can be set in two different ways.

The method for setting/resetting the register for each channel is outlined in Figure 6(a), while the method for setting/resetting the register for all channels at once is outlined in Figure 6(b).

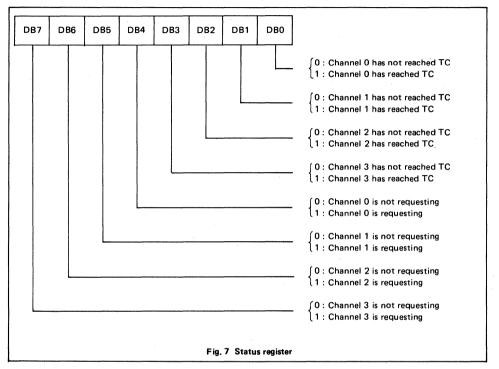


### I/O·MSM82C37B-5RS/GS/VJS = -

#### STATUS REGISTER

This register is a read-only register used in CPU reading of the MSM82C37B-5 status. The four higher order bits indicate the DMA transfer request status for each channel, '1' being set when the DREQ input signal is active.

The four lower order bits indicate whether the corresponding channel has reached the TC or not, '1' being set when the TC status is reached. These four lower order bits are reset by status register reading, or RESET input and master clearing. A description of each bit is outlined in Figure 7.



#### **TEMPORARY REGISTER**

The temporary register is a register where transfer data is held temporarily during memory-memory transfers. Since the last item of data to be transferred is held after completion of the transfer, this item can be read by the CPU.

#### SOFTWARE COMMAND

The MSM82C37B-5 is equipped with software commands for executing special operations to ensure proper programming. Software command is irrespective of data bus contents.

#### CLEAR FIRST/LAST FLIP-FLOP

16-bit address and word count registers are read or written in two consecutive operations involving eight bits each (higher and lower order bits) under data bus port control. The fact that the lower order bits are accessed first by the MSM82C37B-5, followed by accessing of the higher order bits, is discerned by the internal first/last flip-flop. This command resets the first/last flip-flop with the eight lower order bits being accessed immediately after execution.

#### MASTER CLEAR

The same operation as when the hardware RESET input is applied. This command clears the contents of the command, status (for lower order bits), request, and temporary registers, also clears the first/last flip-flop, and sets the mask register. This command is followed by an idle cycle.

#### **CLEAR MASK REGISTER**

When this command is executed, the mask bits for all channels are cleared to enable reception of DMA transfers.

### PROGRAMMING

The MSM82C37B-5 is switched to programming status when the HLDA input and  $\overline{CS}$  are both at low level. In this state,  $\overline{IOR}$  is changed to low level with  $\overline{IOW}$  held at high level to enable reading by the CPU, or else  $\overline{IOW}$  is changed to low level while  $\overline{IOR}$  is held at high level to enable writing by the CPU.

A list of command codes for reading from the MSM82C37B-5 is given in Table 2, and a list of command codes for writing in the MSM82C37B-5 is given Table 3.

Note: If a DMA transfer request is received from an I/O device during MSM82C37B-5 programming, that DMA transfer may be commenced to prevent proper programming.

To prevent this interference, the DMA channel must be masked, or the controller disabled by the command register, or the system set so as to prevent DREQ becoming active during the programming.

cs	IOR	A3	A2	A1	A0	Internal first/last flip/flop	Read out data					
0	0	0	0	0	0	0		Current address	8 lower order bits			
0	0	0	0	0	0	1	Observat 0	register	8 higher order bits			
0	0	0	0	0	1	0	Channel 0	Current word count	8 lower order bits			
0	0	0	0	0	1	1		register	8 higher order bits			
0	0	0	0	1	0	0		Current address	8 lower order bits			
0	0	0	0	1	0	1		register	8 higher order bits			
0	0	0	0	1	1	0	Channel 1	Current word count	8 lower order bits			
0	0	0	0	1	1	1		register	8 higher order bits			
0	0	0	1	0	0	0		Current address	8 lower order bits			
0	0	0	1	0	0	1		register	8 higher order bits			
0	0	0	1	0	1	0	Channel 2	Current word count	8 lower order bits			
0	0	0	1	0	1	1		register	8 higher order bits			
0	0	0	1	1	0	0		Current address	8 lower order bits			
0	0	0	1	1	0	1	01	register	8 higher order bits			
0	0	0	1	1	1	0	Channel 3	Current word count	8 lower order bits			
0	0	0	1	1	1	1		register	8 higher order bits			
0	0	1	0	0	0	×	Status regist	er				
0	0	1	1	0	1	X	Temporary	register				
0	0	Oth	er com	binatio	ns	х	Output data invalid					

#### Table 2 List of MSM82C37B-5 read commands

# ■ I/O·MSM82C37B-5RS/GS/VJS ■-

cs	IOW	A3	A2	A1	A0	Internal first/last flip-flop	Written data					
0	0	0	0	0	0	0		Current and base	8 lower order bits			
0	0	0	0	0	0	1 .	Channel 0	address registers	8 higher order bits			
0	Ō	0	0	0	1	0	Channel U	Current and base	8 lower order bits			
0	0	0	0	0	1	1		word count registers	8 higher order bits			
0	0	0	0	1	0	0		Current and base	8 lower order bits			
0	0	0	0	1	0	1	Channel 1	address registers	8 higher order bits			
0	0	0	0	1	1	0	Channel I	Current and base	8 lower order bits			
0	0	0	0	1	1	1	:	word count registers	8 higher order bits			
0	0	0	1	0	0	0		Current and base	8 lower order bits			
0	0	0	1	0	0	1	Channel 2	address registers	8 higher order bits			
0	0	0	1	0	1	0	Current and base		8 lower order bits			
0	0	0	1	0	1	1		word count registers	8 higher order bits			
0	0	0	1	1	0	0		Current and base	8 lower order bits			
0	0	0	1	1	0	1	Channel 3	address registers	8 higher order bits			
0	0	0	1	1	1	0	Charmer 5	Current and base	8 lower order bits			
0	0	0	1	1	1	1		word count registers	8 higher order bits			
0	0	1	0	0	0	×	Command r	egister				
0	0	1	0	0	1	×	Request reg	ister				
0	0	1	0	1	0	×	Single mask	register				
0	0	1	0	1	1	×	Mode regist	er				
0	0	1	1	0	0	×	Clear first/l	ast flip-flop (software co	ommand)			
0	0	1	1	0	1	×	Master clear	r (software command)				
0	0	1	1	1	0	×	Clear mask	register (software comm	hand)			
0	Ó	1	1 .	1	1	×	All mask re	gister				

#### Table 3 List of MSM82C37B-5 write commands

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# **OKI semiconductor** MSM82C43RS/GS

INPUT/OUTPUT PORT EXPANDER

## **GENERAL DESCRIPTION**

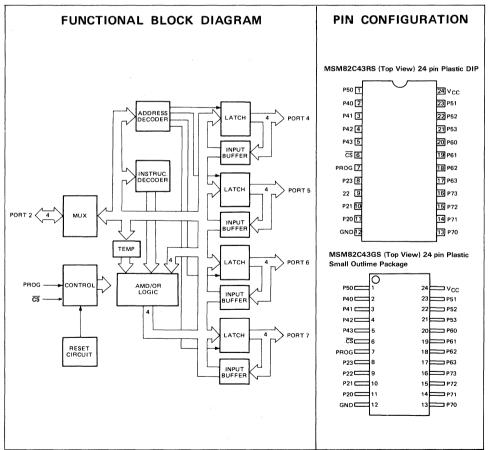
The MSM82C43 is an input/output port expander device based on  $3\mu$  silicon gate CMOS technology and designed to operate at low power consumption levels.

In systems employing the MSM80C48/49 8-bit 1-chip microcomputers, 4-bit data can be expanded by dividing between four I/O lines by executing the MOVDPp. A, MOVDA, Pp, ANLDPp, A and ORLDPp, A instructions.

### FEATURES

- $\bullet$  3 $\mu$  silicon gate CMOS technology for low power consumption
- 2.5 to 6 V single power supply (dependent on MSM80C 48/49 operating frequency.)
- Fully static operation

- Bidirectional I/O ports
- TTL compatible (ports 4 thru 7)
- Functional compatibility with Intel i8243
- •24 pin Plastic DIP (DIP24-P-600)
- •24 pin Plastic SOP (SOP24-P-430-K)
- •24 pin-V Plastic SOP (SOP24-P-430-VK)



### ■ I/O·MSM82C43RS/GS ■-

# **ELECTRIC CHARACTERISTICS**

### Absolute Maximum Ratings

Parameter	Symbol	Conditions	Rating	Unit
Supply Voltage	Vcc	Ta = 25° C	-0.5 ~ 7	v
Input Voltage	V <sub>1</sub>	Ta = 25° C	$-0.3 \sim V_{CC}$	v
Storage Temperature	Tstg	-	-65 ~ +150	°C

#### • Operating Conditions

Parameter	Symbol	Conditions	Rating	Unit
Supply Voltage	Vcc	-	2.5 ~ 6*1	V
Ambient Temperature	TA	-	-40 ~ +85	°C
F		MOS load	10	-
Fan-out	N	TTL load	3*2	_

### • DC Characteristics

 $(V_{CC} = 4.0V \sim 6.0V, Ta = -40^{\circ}C \sim +85^{\circ}C)$ 

Parameter	Symbol	Conditions	MIN	ТҮР	MAX	Unit
"L" Input Voltage	VIL		0.5		0.13Vcc	v v
"H" Input Voltage	VIH		0.4Vcc		Vcc	v v
"L" Output Voltage Ports 4-7	VOL1	1 <sub>0L</sub> = 5mA	-		0.45	v
"L" Output Voltage Port 7	VOL2	I <sub>OL</sub> = 20mA		-	1	v
"L" Output Voltage Port 2	V <sub>OL3</sub>	I <sub>OL</sub> = 0.9mA	<del>.                                    </del>		0.45	v
"L" Total Output Current from Ports 4-7 <sup>*3</sup>	IOL	5mA/1PIN	-	-	80	mA
"H" Output Voltage Ports 4-7	VOH1	l <sub>OH</sub> = -240μA	0.75V <sub>CC</sub>		-	v
"H" Output Voltage Port 2	V <sub>OH2</sub>	l <sub>OH</sub> = -100μA	0.75V <sub>CC</sub>	-	-	v
"H" Output Voltage Ports 4-7	VOH1	I <sub>OH</sub> = -40μA	0.93V <sub>CC</sub>		-	v
"H" Output Voltage Port 2	V <sub>OH2</sub>	l <sub>OH</sub> = -20μA	0.93V <sub>CC</sub>	-	-	v
Input Leak Current <sup>*3</sup>	IL1	$0 \leq V_{IN} \leq V_{CC}$	-10	-	20	μA
Input Leak Current <sup>*6</sup>	IL2	$0 \leq V_{IN} \leq V_{CC}$	10		10	μA
		Standby stop No accessing	-	5	100	μA
Power Supply Current	'cc	For continuous MSM80C49 access- ing at 11 MHz	_	1	2	mA

NOTE: \*1 The supply voltage during operation is dependent on MSM80C49 operating frequency.

\*2 Except P20 thru P23.

\*3 P40 thru P43, P50 thru P53, P60 thru P63, P70 thru P73.

\*4 P70 thru P73.

\*5 P20 thru P23.

\*6 P20 thru P23, CS, PROG.

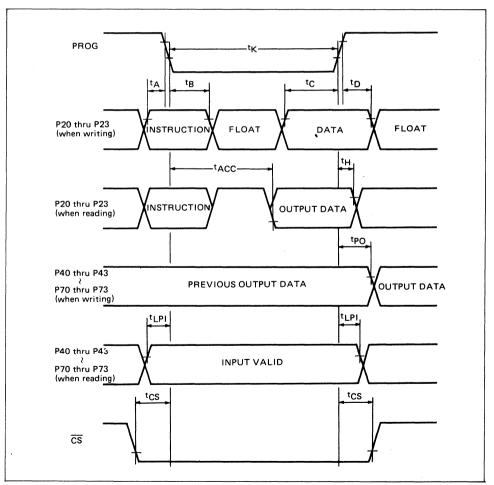
I/O·MSM82C43RS/GS =

#### • AC Characteristics

 $(V_{CC} = 4.0V \sim 6.0V, Ta = -40^{\circ}C \sim +85^{\circ}C)$ 

Parameter	Symbol	Conditions	MIN	MAX	Unit
Port Control Setting Time (up to PROG Falling Edge)	tд	80pF LOAD	50	-	ns
Port Control Holding Time (From PROG Falling Edge)	tв	20pF LOAD	60		ns
Output Data Setting Time	tC	80pF LOAD	200	-	ns
Output Data Holding Time	tD	20pF LOAD	20	-	ns
Input Data Holding Time	tн	20pF LOAD	0	150	ns
PROG Pulse Width	<sup>t</sup> κ	_	700	-	ns
CS Valid Time (before and after PROG)	tCS	_	50	-	ns
Output Data Valid Time (at Ports 4-7)	tPO	100pF LOAD	-	700	ns
Input Data Holding Time (at Ports 4-7)	tLP1	-	100	-	ns
Input Data Valid Time (from PROG Falling Edge)	<sup>t</sup> ACC	80pF LOAD	-	650	ns

# TIMING CHART



### **PIN FUNCTIONS**

Pin	Function
PROG	Clock input from MSM80C49. When PROG is changed from "H" to "L", MSM82C43 STARTS operating in accordance with an order from MSM80C49.
CS	Input for chip select. Outputs and internal status cannot be changed when $\overline{\text{CS}}$ is "H".
P20 - P23	4-bit bidirectional I/O ports. When connected to P20 thru P23 of MSM80C49, direct data transfer from port to accumulator and from accumulator to port is possible.
P40 - P43 P50 - P53 P60 - P63 P70 - P73	4-bit bidirectional I/O ports. Data is latched statistically when output to ports, but is only valid while PROG is at "L" level when input.
Vcc	+5V power supply
GND	GROUND

### **FUNCTIONS**

#### • Write mode

Execution of MOVDPp, A, ORLDPp, A, ANLDPp, and A by MSM80C49 enables direct output of accumulator contents to ports 4 thru 7, and output to the ports after ORing or ANDing with port data. The port data is latched statistically at this time and remains unchanged until execution of the next instruction.

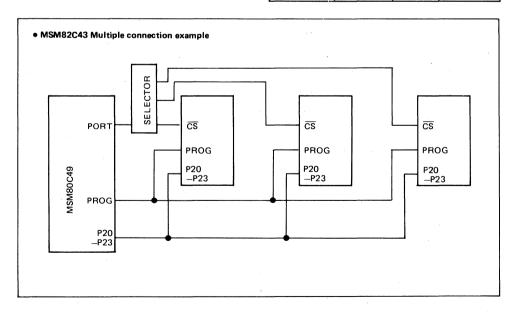
#### Read mode

Execution of MOVDA and Pp results in data of ports 4 thru 7 being accepted by the accumulator. Note that port data is valid only while PROG is at "L"

level. When at "H" level, ports 4 thru 7 are switched to tristate and port 2 is switched to input mode.

• Address and instruction code

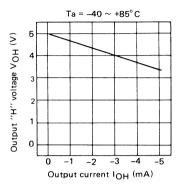
Instruction	P23	P22	Port	P21	P20
Read	0	0	Port 4	0	0
Write	0	1	Port 5	0	1
OR	1	0	Port 6	1	0
AND	1	1	Port 7	1	1



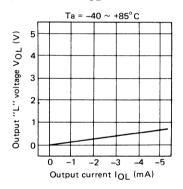
# OUTPUT CHARACTERISTICS

#### • Standard DC characteristics

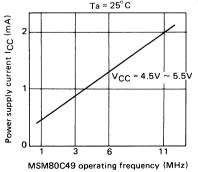
Output "H" voltage (V\_OH) vs. output current (I\_OH)



Output "L" voltage (VOL) vs. output current (IOL)



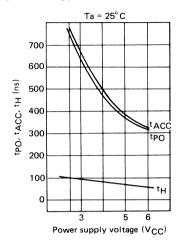
Operating frequency vs. power supply voltage (I<sub>CC</sub>)



Note: The direction which the output current flows through the device is taken as the positive direction.

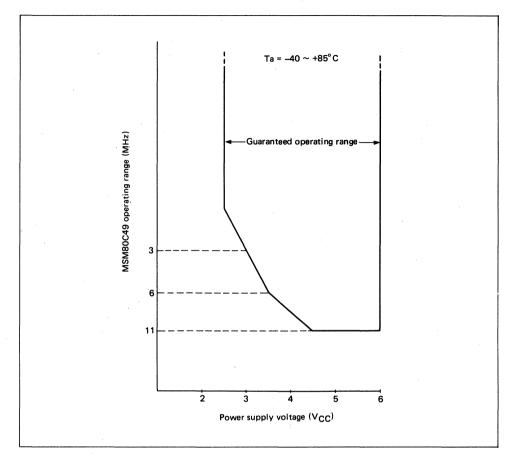
• Standard AC characteristics

 $t_{\text{PO}},\,t_{\text{H}},\,\text{and}\,\,t_{\text{ACC}}\,\,\text{vs.}$  power supply voltage (V\_CC)



# ■ I/O·MSM82C43RS/GS =-





# **OKI** semiconductor MSM82C51A-2RS/GS/JS

UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER

# **GENERAL DESCRIPTION**

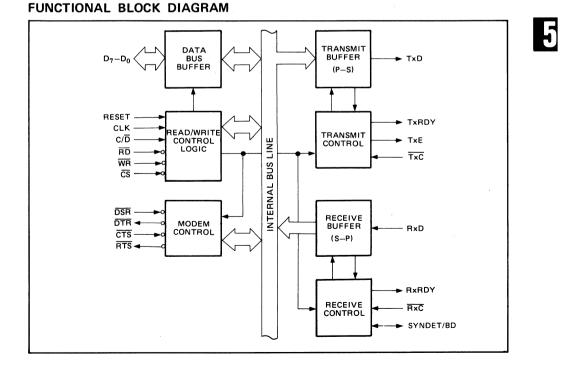
The MSM82C51A is a USART (Universal Synchronous Asynchronous Receiver Transmitter) for serial data communication.

As a peripheral device of a microcomputer system, the MSM82C51A receives parallel data from the CPU and transmits serial data after conversion. This device also receives serial data from the outside and transmits parallel data to the CPU after conversion.

The MSM82C51A configures a fully static circuit using silicon gate CMOS technology. Therefore, it operates on extremely low power at 100  $\mu$ A (max) of standby current by suspending all operations.

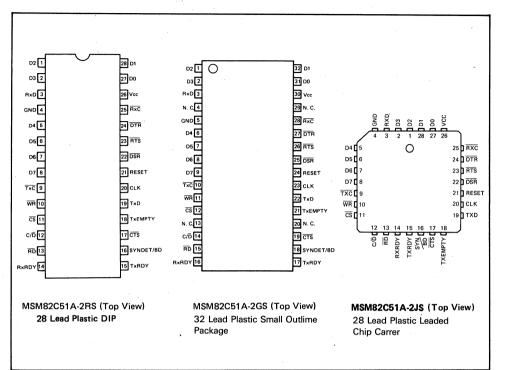
# **FEATURES**

- Wide power supply voltage range from 3 V to 6 V.
- Wide temperature range from -40° C to 85° C.
- Synchronous communication upto 64K baud.
- Asynchronous communication upto 38.4K baud.
- Transmitting/receiving operations under double buffered configuration.
- Error detection (parity, overrun and framing)
- •28 pin Plastic DIP (DIP28-P-600)
- 28 pin PLCC (QFJ28-P-S450)
- 32 pin-V Plastic SOP (SSOP32-P430-VK)



# I/O·MSM82C51A-2RS/GS/JS =

# **PIN CONFIGURATION**



# FUNCTION

#### Outline

The MSM82C51A's functional configuration is programed by software.

Operation between the MSM82C51A and a CPU is executed by program control. Table 1 shows the operation between a CPU and the device.

Table 1 Operation between MSM82C51A and C
---

<u>cs</u>	C/D	RD	WR	
1	x	x	x	Data bus 3-state
0	x	1	1	Data bus 3-state
0	1	0	1	Status → CPU
0	1	1	0	Control word ← CPU
0	0	0	1	Data → CPU
0	0	1	0	Data ← CPU

It is necessary to execute a function-setting sequence after resetting the MSM82C51A. Fig. 1 shows the function-setting sequence.

If the function was set, the device is ready to receive a command, thus enabling the transfer of data.

by setting a necessary command, reading a status and reading/writing data.

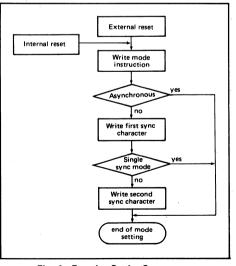


Fig. 1 Function-Setting Sequence (Mode Instruction Sequence)

I/O·MSM82C51A-2RS/GS/JS =

### **Control Words**

There are two types of control word.

- 1. Mode instruction (setting of function)
- 2. Command (setting of operation)

#### 1) Mode Instruction

Mode instruction is used for setting the function of the MSM82C51A. Mode instruction will be in ''wait for write'' at either internal reset or external reset. That is, the writing of a control word after resetting will be recognized as a ''mode instruction.''

Items set by mode instruction are as follows:

• Synchronous/asynchronous mode

- Stop bit length (asynchronous mode)
- Character length
- Parity bit
- Baud rate factor (asynchronous mode)
- Internal/external synchronization (synchronous mode)
- No. of synchronous characters (synchronous mode)

The bit configuration of mode instruction is shown in Fig.'s 2 and 3. In the case of synchronous mode, it is necessary to write one- or twobyte sync characters.

If sync characters were written, a function will be set because the writing of sync characters constitutes part of mode instruction.

S <sub>2</sub>					D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	ו			
02	S <sub>1</sub>	EP	PEN	L <sub>2</sub>	L1	B <sub>2</sub>	B1				
								•			
								Baud rate	factor		
								0	1	0	1
								0	0	1	1
								Refer to Fig. 3 SYNC	1×	16×	64×
								Character 0		0	1
								0	1	1	1
									0		
								5 bits	6 bits	7 bits	8 bits
								Parity che	eck		
						· · · · · · · · · · · · · · · · · · ·		0	. 1	0	1
						·		0	0	1	1
								Disable	Odd parity	Disable	Even parity
								Stop bit I	ength		
								0	1	0	1
L	un da esta esta da est					· · · · · · · · · · · · · · · · · · ·		0	0	1	1
								Inhibit	1 bit	1.5 bits	2 bits

Fig. 2 Bit Configuration of Mode Instruction (Asynchrnous)



■ I/O·MSM82C51A-2RS/GS/JS ■

D5 D4 D3  $D_2$  $D_1$ D<sub>0</sub>  $D_7$  $D_6$ PEN scs ESD EΡ  $L_2$ L1 0 0 Character length 0 0 1 1 0 0 1 1 7 bits 5 bits 6 bits 8 bits Parity 0 0 1 1 0 0 1 1 Odd Even Disable Disable parity parity Synchronous Mode 0 1 Internal External synchro-synchro-nization nization No. of synchronous characters 0 1 2 char-1 characters acter

Fig. 3 Bit Configuration of Mode Instruction (Synchronous)

#### 2) Command

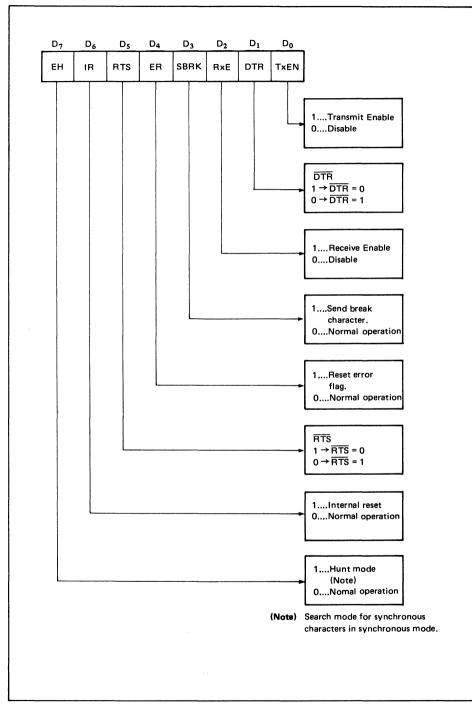
Command is used for setting the operation of the MSM82C51A.

It is possible to write a command whenever necessary after writing a mode instruction and sync characters.

Items to be set by command are as follows: • Transmit Enable/Disable

- Receive Enable/Disable
- DTR, RTS Output of data.
- Resetting of error flag.
- Sending of break characters
- Internal resetting
- Hunt mode (synchronous mode)

The bit configuration of a command is shown in Fig. 4.

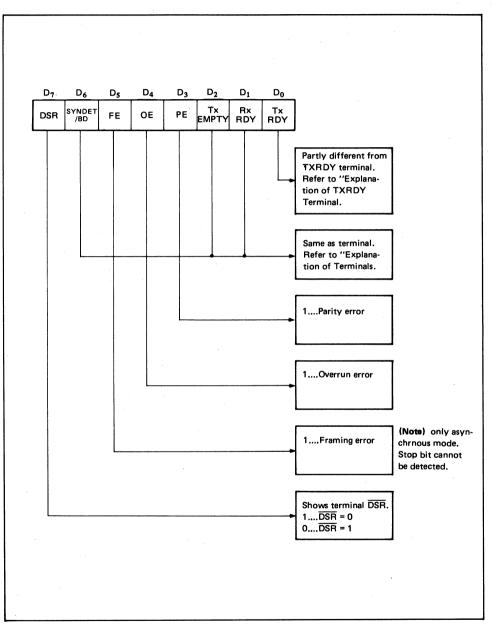




# ■ I/O·MSM82C51A-2RS/GS/JS ■-

#### Status Word

It is possible to see the internal status of MSM-82C51A by reading a status word. The bit configuration of status word is shown in Fig. 5.



### Fig. 5 Bit Configuration of Status Word

I/O·MSM82C51A-2RS/GS/JS =

It is possible to put the MSM82C51A in ''standby status''.

When the following conditions have been satisfied the MSM82C51A is in "standby status."

- (1) CS terminal is fixed at Vcc level.
- (2) Input pins other than CS, D<sub>0</sub> to D<sub>7</sub>, RD, WR and C/D are fixed at Vcc or GND level (including SYNDET in external synchronous mode).
- Note When all output currents are 0, ICCS specification is applied.

#### **Pin Description**

#### Do to D7 (I/O terminal)

This is bidirectional data bus which receive control words and transmits data from the CPU and sends status words and received data to CPU.

#### **RESET** (Input terminal)

A ''High'' on this input forces the MSM82C51A into ''reset status.''

The device waits for the writing of "mode instruction."

The min. reset width is six clock inputs during the operating status of CLK.

#### CLK (Input terminal)

CLK signal is used to generate internal device timing.

CLK signal is independent of  $\overline{RXC}$  or  $\overline{TXC}$ .

However, the frequency of CLK must be greater than 30 times the RXC and TXC at Synchronous mode and Asynchronous ''x1'' mode, and must be greater than 5 times at Asynchronous ''x16'' and ''x64'' mode.

#### WR (Input terminal)

This is the "active low" input terminal which receives a signal for writing transmit data and control words from the CPU into the MSM82C51A.

#### RD (Input terminal)

This is the "active low" input terminal which receives a signal for reading receive data and status words from the MSM82C51A.

#### C/D (Input terminal)

This is an input terminal which receives a signal for selecting data or command words and status words when the MSM82C51A is accessed by the CPU.

If  $C/\overline{D} = low$ , data will be accessed.

If  $C/\overline{D}$  = high, command word or status word will be accessed.

#### CS (Input terminal)

This is the "active low" input terminal which selects the MSM82C51A at low level when the CPU accesses.

Note The device won't be in "standby status"; only setting  $\overline{CS} = High$ .

Refer to "Explanation of Standby Status."

#### TXD (Output terminal)

This is an output terminal for transmitting data from which serial-converted data is sent out.

The device is in ''mark status'' (high level) after resetting or during a status when transmit is disabled.

It is also possible to set the device in "break status" (low level) by a command.

#### **TXRDY** (Output terminal)

This is an output terminal which indicates that the MSM82C51A is ready to accept a transmitted data character. But the terminal is always at low level if CTS = high or the device was set in ''TX disable status'' by a command.

Note TXRDY status word indicates that transmit data character is receivable, regardless of CTS or command.

IF the CPU writes a data character, TXRDY will be reset by the leading edge or  $\overline{WR}$  signal.

#### **TXEMPTY** (Output terminal)

This is an output terminal which indicates that the MSM82C51A has transmitted all the characters and had no data character.

In "synchronous mode," the terminal is at high level, if transmit data characters are no longer remaining and sync characters are automatically transmitted.

If the CPU writes a data character, TXEMPTY will be reset by the leading edge of WR signal.

Note As the transmitter is disabled by setting CTS "High" or command, data written before disable will be sent out. Then TXD and TXEMPTY will be "High".

> Even if a data is written after disable, that data is not sent out and TXE will be ''High''. After the transmitter is enabled, it sent out. (Refer to Timing Chart of Transmitter Control and Flag Timing)

#### TXC (Input terminal)

This is a clock input signal which determines the transfer speed of transmitted data.

In "synchronous mode," the baud rate will be the same as the frequency of TXC.

In "asynchronous mode", it is possible to select the baud rate factor by mode instruction.

It can be 1, 1/16 or 1/64 the TXC.

The falling edge of  $\overline{\mathsf{TXC}}$  sifts the serial data out of the MSM82C51A.

#### RXD (Input terminal)

This is a terminal which receives serial data.

#### **RXRDY** (Output terminal)

This is a terminal which indicates that the MSM82C51A contains a character that is ready to READ.

If the CPU reads a data <u>character</u>, RXRDY will be reset by the leading edge of RD signal.

Unless the CPU reads a data character before the next one is received completely, the preceding data will be lost. In such a case, an overrun error flag status word will be set.

# I/O·MSM82C51A-2RS/GS/JS =

#### RXC (Input terminal)

This is a clock input signal which determines the transfer speed of received data.

In "synchronous mode," the baud rate is the same as the frequency of  $\overline{RXC}$ .

In "asynchronous mode," it is possible to select the baud rate factor by mode instruction.

It can be 1, 1/16, 1/64 the  $\overline{RXC}$ .

SYNDET/BD (Input or output terminal)

This is a terminal whose function changes according to mode.

In "internal synchronous mode," this terminal is at high level, if sync characters are received and synchronized. If a status word is read, the terminal will be reset.

In ''external synchronous mode,'' this is an input terminal.

A "High" on this input forces the MSM82C51A to start receiving data characters.

In ''asynchronous mode,'' this is an output terminal which generates ''high level'' output upon the detection of a ''break'' character if receiver data contains a ''low-level'' space between the stop bits of two continuous characters. The terminal will be reset, if RXD is at high level. DSR (Input terminal)

This is an input port for MODEM interface. The input status of the terminal can be recognized by the CPU reading status words.

### DTR (Output terminal)

This is an output port for MODEM interface. It is possible to set the status of DTR by a command.

#### CTS (Input terminal)

This is an input terminal for MODEM interface which is used for controlling a transmit circuit. The terminal controls data transmission if the device is set in "TX Enable" status by a command. Data is transmitable if the terminal is at low level.

#### RTS (Output terminal)

This is an output port for MODEM interface. It is possible to set the status of RTS by a command.

Parameter	Symbol	Limits			Limits		Unit	Conditions
		MSM82C51A-2RS	MSM82C51A-2GS	MSM82C51A-2JS				
Power supply voltage	V <sub>CC</sub>	-0.5 ~ +7						
Input voltage	VIN	$-0.5 \sim V_{\rm cc} + 0.5$				With respect to GND		
Output voltage	VOUT	$-0.5 \sim V_{\rm CC} + 0.5$						
Storage temperature	T <sub>stg</sub>	-55 ~ +150			°C	_		
Power dissipation	PD	0.9	0.7	0.9	w	Ta = 25°C		

# ABSOLUTE MAXIMUM RATINGS

# OPERATING RANGE

Parameter	Symbol	Limits	Unit
Power supply voltage	Vcc	3~6	v
Operating temperature	т <sub>ОР</sub>	-40 ~ 85	°C

# **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Power supply voltage	V <sub>CC</sub>	4.5	5	5.5	v
Operating temperature	тор	-40	+25	+85	°C
"L" input voltage	VIL	-0.3		+0.8	v
"H" input voltage	ViH	2.2		V <sub>CC</sub> + 0.3	v

# DC CHARACTERISTICS

 $(Vcc = 4.5 \sim 5.5V Ta = -40^{\circ}C \sim +85^{\circ}C)$ 

Parameter	Symbol	Min.	Тур.	Max.	Unit	Measurement Conditions
"L" output voltage	VOL			0.45	v	IOL = 2.5 mA
"H" output voltage	V <sub>OH</sub>	3.7			v	<b>I<sub>OH</sub> = –2.5</b> mA
Input leak current	۱LI	-10		10	μA	$0 \le V_{IN} \le V_{CC}$
Output leak current	ILO	-10		10	μA	0 ≤ V <sub>OUT</sub> ≤ V <sub>CC</sub>
Operating supply current	lcco			5	mA	Asynchronous X64 during transmitting/receiving
Standby supply current	<sup>I</sup> CCS			100	μΑ	All input voltage shall be fixed at $V_{CC}$ or GND level.

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■ I/O·MSM82C51A-2RS/GS/JS ■-

# AC CHARACTERISTICS

 $(Vcc = 4.5 \sim 5.5V, Ta = -40 \sim 85^{\circ}C)$ 

CPU Bus Interface Part

Parameter	Symbol	Min.	Max.	Unit	Remarks
Address stable before RD	tAR	20		NS	Note 2
Address hold time for RD	tRA	20		NS	Note 2
RD pulse width	tRR	130		NS	
Data delay from RD	tRD		100	NS	
RD to data float	tDF	10	75	NS	
Recovery time between RD	tRVR	6		тсу	Note 5
Address stable before WR	tAW	20		NS	Note 2
Address hold time for WR	tWA	20		NS	Note 2
WR pulse width	tww	100		NS	
Data set-up time for WR	tDW	100		NS	
Data hold time for WR	twD	0		NS	
Recovery time between WR	<sup>t</sup> RVW	- 6		тсу	Note 4
RESET pulse width	tRESW	6		Тсу	

## Serial Interface Part

Parameter		Symbol	Min.	Max.	Unit	Remarks
Main clock period		t <sub>cy</sub>	160		NS	Note 3
Clock low time		tφ	50		NS	
Clock high time		tφ	70	t <sub>cy</sub> -50	NS	
Clock rise/fall time		t <sub>R</sub> , t <sub>F</sub>		20	NS	
TXD delay from falling edge of TXC		<sup>t</sup> DTX		1	μS	
Transmitter clock frequency	1X Baud	fтх	DC	64	kHz	
	16X, Baud	<sup>f</sup> тх	DC	615	ķНz	Note 3
	64X, Baud	<sup>f</sup> тх	DC	615	kHz	
Transmitter clock low time	1 X Baud	<sup>t</sup> TPW	13		Тсу	
	16X, 64X Baud	<sup>t</sup> TPW	2		тсу	
Transmitter clock high time	1 X Baud	<sup>t</sup> TPD	15		Тсу	
	16X, 64X Baud	<sup>t</sup> TPD	3		Тсу	
Receiver clock frequency	1X Baud	fRX	DC	64	kHz	
	16X Baud	fRX	DC	615	kHz	Note 3
	64X Baud	fRX	DC	615	kHz	].
Receiver clock low time	1X Baud	tRPW	13		тсу	
	16X, 64X Baud	tRPW	2		тсу	
Receiver clock high time	1X Baud	tRPD	15		Тсу	
	16X, 64X Baud	tRPD	3		тсу	
Time from the center of last bit to the rise of TXRDY		<sup>t</sup> TXRDY		8	т <sub>су</sub>	
Time from the leading edge of $\overline{WR}$ to the fall of TXRDY		<sup>t</sup> TXRDY CLEAR	· ·	400	NS	
Time from the center of last bit to the rise of RXRDY		<sup>t</sup> RXRDY		26	тсу	

Parameter	Symbol	Min.	Max.	Unit	Remarks
Time from the leading edge of $\overline{RD}$ to the fall of RXRDY	<sup>t</sup> RXRDY CLEAR		400	NS	
Internal SYNDET delay time from rising edge of RXC	tis		26	т <sub>су</sub>	
SYNDET setup time for RXC	tES	18		Тсу	
TXE delay time from the center of last bit	<sup>t</sup> TXEMPTY	20		Тсу	
MODEM control signal delay time from rising edge of WR	twc	8		т <sub>су</sub>	
MODEM control signal setup time for falling edge of $\overline{\text{RD}}$	<sup>t</sup> CR	20		т <sub>су</sub>	
RXD setup time for rising edge of $\overline{RXC}$ (1X Baud)	<sup>t</sup> RXDS	11		т <sub>су</sub>	
RXD hold time for falling edge of RXC (1X Baud)	<sup>t</sup> RXDH	17		т <sub>су</sub>	

Caution 1) AC characteristics are measured at 150 pF capacity load as an output load based on 0.8 V at low level and 2.2 V at high level for output and 1.5 V for input.

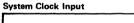
2) Addresses are  $\overline{CS}$  and  $C/\overline{D}$ .

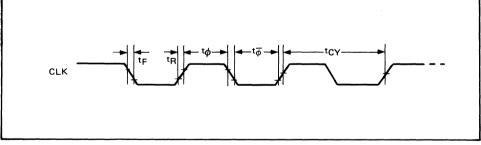
4) This recovery time is mode Initialization only. Recovery time between command writes for Asynchronous Mode is 8 t<sub>CY</sub> and for Synchronous Mode is 18 t<sub>CY</sub>. Write Data is allowed only when TXRDY = 1.

 This recovery time is Status read only. Read Data is allowed only when RXRDY = 1.

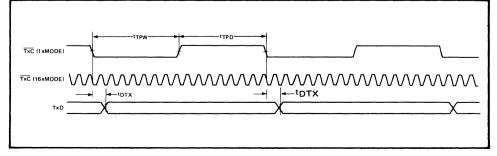
6) Status update can have a maximum delay of 28 clock periods from event affecting the status.

# TIMING CHART

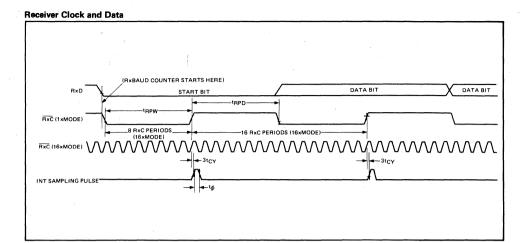


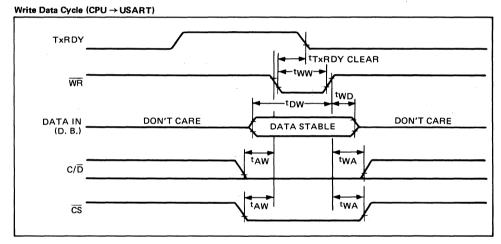


#### Transmitter Clock and Data

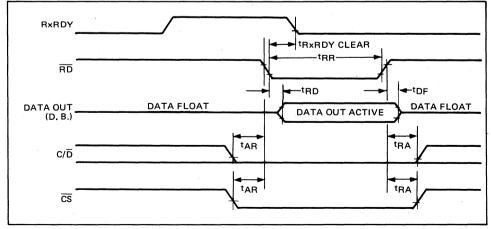


■ I/O·MSM82C51A-2RS/GS/JS ■---

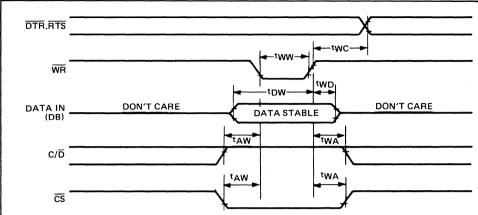




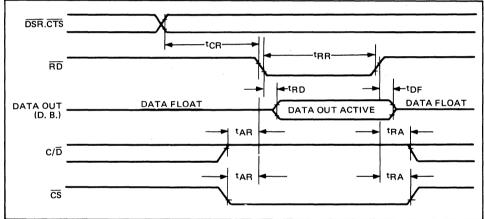
Read Data Cycle (CPU ← USART)



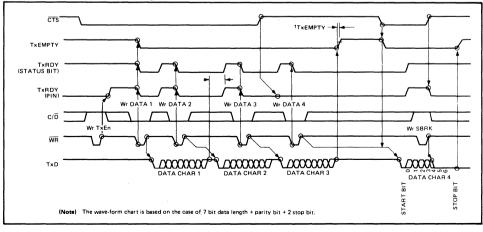


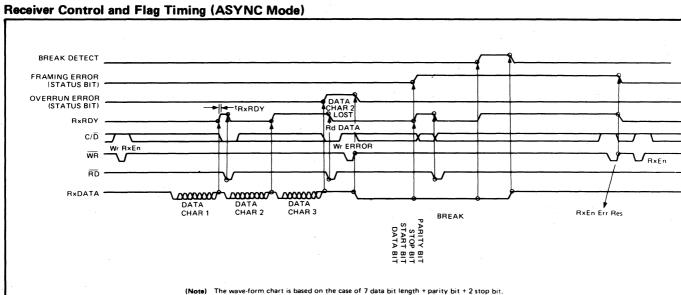


Read Control or Input Port (CPU ← USART)



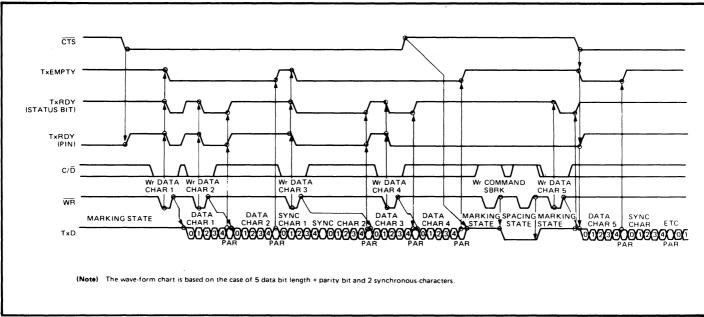
Transmitter Control and Flag Timing (ASYNC Mode)





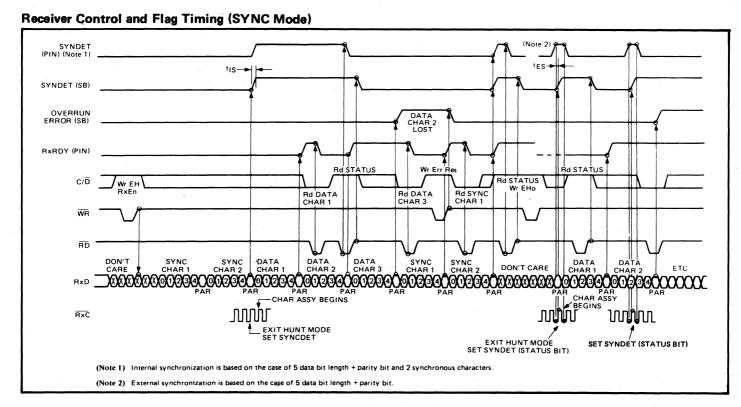
I/O·MSM82C51A-2RS/GS/JS





# C1





I/O·MSM82C51A-2RS/GS/JS

#### NOTE

#### 1. Half-bit processing for the start bit

When the 82C51A is used in the asynchronous mode, some problems are caused in the processing for the start bit whose length is smaller than the 1-data bit length. (See Fig. 1.)

Start bit length	Mode	Operation
Smaller than 7-receiver clock length	×16	The short start bit is ignored. (Normal)
Smaller than 31-receiver clock length	×64	The short start bit is ignored. (Normal)
8-receiver clock length	×16	Data cannot be received correctly due to a malfunction.
32-receiver clock length	×64	Data cannot be received correctly due to a malfunction.
9 to 16-receiver clock length	×16	The bit is regarded as a start bit. (Normal)
33 to 64-receiver clock legth	×64	The bit is regarded as a start bit. (Normal)

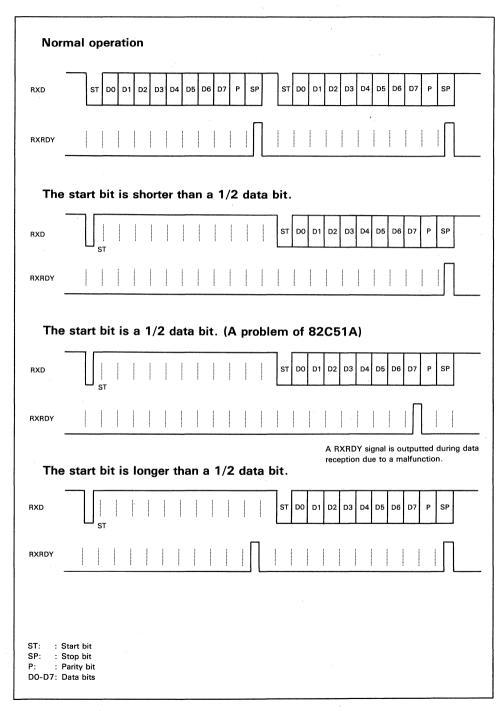
#### 2. Parity flag after a break signal is received (See Fig.2.)

When the 82C51A is used in the asynchrous mode, a parity flag may be set when the next normal data is read after a break signal is received. (This occurs when odd parity is set.)

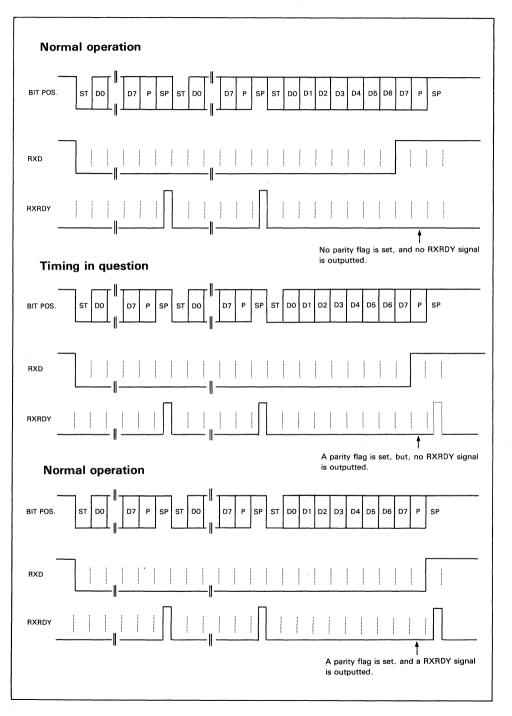
A parity flag is set when the rising edge of the break signal (end of the break signal) is changed between the final data bit and the parity bit, though a RXRDY signal may not be outputted.

If this occurs, the parity flag is left set when the next normal dats is received, and the received data seems to be a parity error.

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Half-bit processing timing chart for the start bit (Fig.1)



# Break signal reception timing and parity flag (Fig. 2)

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# **OKI** semiconductor MSM82C53-2RS/GS/JS

CMOS PROGRAMMABLE INTERVAL TIMER

# **GENERAL DESCRIPTION**

The MSM82C53-2RS/GS/JS are programmable universal timers designed for use in microcomputer systems. Based on silicon gate CMOS technology, it requires a standby current of only  $100\mu$ A (max.) when the chip is in the nonselected state. During timer operation, power consumption is still very low with only 8 mA (max.) at 8 MHz of current required.

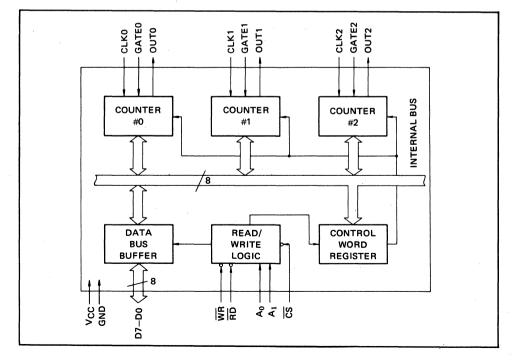
The devices consist of three independent counters, and can count up to a maximum of 8 MHz (MSM82C53-2) The timer features six different counter modes, and binary count/BCD count functions. Count values can be set in byte or word units, and all functions are freely programmable.

# **FEATURES**

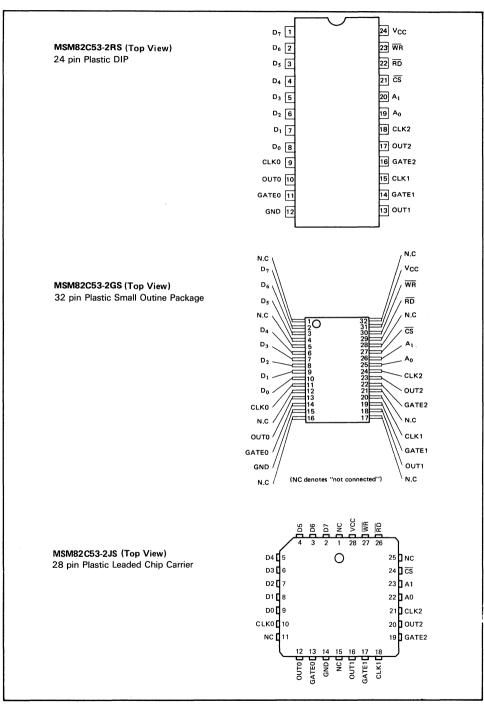
- Maximum operating frequency of 8 MHz (MSM82C53-2)
- High speed and low power consumption achieved
- through silicon gate CMOS technology. • Completely static operation
- Completely static operation
- Three independent 16-bit down-counters
- 3V to 6V single power supply

- Six counter modes available for each counter
- Binary and decimal counting possible
- •24 pin Plastic DIP (DIP24-P-600)
- •28 pin PLCC (QFJ28-P-S450)
- •32 pin-V Plastic SOP (SSOP32-P-430-VK)





# **PIN CONFIGURATION**



# ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol Conditions			Unit		
Farameter			MSM82C53-2RS	MSM82C53-2GS	MSM82C53-2JS	Unit
Ssupply Voltage	Vcc			v		
Input Voltage	VIN	Respect to GND	· -	.5	v	
Output Voltage	VOUT		-	0.5 to V <sub>CC</sub> + 0.5		v
Storage Temperature	T <sub>stg</sub>		- 55 to + 150			
Power Dissipation	PD	Ta = 25°C	0.9	0.7	0.9	w

# **OPERATING RANGES**

Parameter	Symbol	Limits	Conditions	Unit
Supply Voltage	Vcc	3 to 6	VIL = 0.2V, VIH = VCC - 0.2V, operating frequency 2.6 MHz	v
Operating Temperature	тор	-40 to +85		°C

# RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage	Vcc	4.5	5	5.5	v
Operating Temperature	TOP	-40	+25	+85	°C
"L" Input Voltage	VIL	-0.3		+0.8	v
"H" Input Voltage	ViH	2.2		V <sub>CC</sub> + 0.3	v

# **DC CHARACTERISTICS**

Parameter	Symbol	Cond	itions	Min.	Тур.	Max.	Unit
"L" Output Voltage	VOL	IOL = 4mA				0.45	V
"H" Output Voltage	∨он	I <sub>OH</sub> = -1mA		3.7			V
Input Leak Current	LI	$0 \le V_{IN} \le V_{CC}$	V <sub>CC</sub> =4.5V to 5.5V	-10		10	μA
Output Leak Current	1LO	0 ≤ V <sub>OUT</sub> ≤ V <sub>CC</sub>	Ta=40°C to +85°C	-10		10	μA
Standby Supply Current	Iccs				-	100	μA
Operating Supply Current	ICC	<sup>t</sup> CLK = 125 ns C <sub>L</sub> = 0pF				8	mA

# AC CHARACTERISTICS

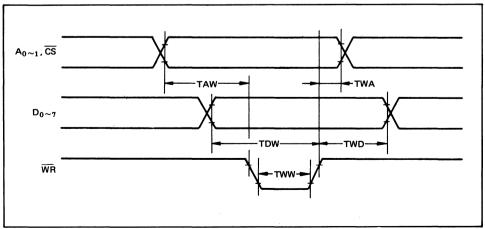
 $(V_{CC} = 4.5V \sim 5.5V, Ta = -40 \sim +85^{\circ}C)$ 

		MSM8	2C53-2			
Parameter	Symbol	Min.	Max.	Unit	Co	onditions
Address Set-up Time before reading	TAR	30		ns		C <sub>L</sub> = 150pF
Address Hold Time after reading	TRA	0		ns	Read	
Read Pulse Width	TRR	150		ns	cycle	
Read Recovery Time	TRVR	200		ns		
Address Set-up Time before writing	TAW	0		ns		
Address Hold Time after writing	TWA	20		ns		
Write Pulse Width	TWW	150		ns	Write	
Data Input Set-up Time before writing	TDW	100		ns	cycle	
Data Input Hold Time after writing	TWD	20		ns		
Write Recovery time	TRVW	200		ns		
Clock Cycle Time	TCLK	125	D.C.	ns		
Clock "H" Pulse Width	трwн	60		ns		
Clock "L" Pulse Width	TPWL	60		ns	Clock	
"H" Gate Pulse Width	TGW	50		ns	and gate	
"L" Gate Pulse Width	TGL	50		ns	timing	
Gate Input Set-up Time before clock	TGS	50		ns		
Gate Input Hold Time after clock	TGH	50		ns	]	
Output Delay Time after reading	TRD		120	ns		
Output Floating Delay Time after reading	TDF	5	90	ns	]	
Output Delay Time after gate	TODG		120	ns	Delay time	
Output Delay Time after clock	TOD		150	ns		
Output Delay Time after address	TAD		180	ns		

Note: Timing measured at  $V_L$  = 0.8V and  $V_H$  = 2.2V for both inputs and outputs.

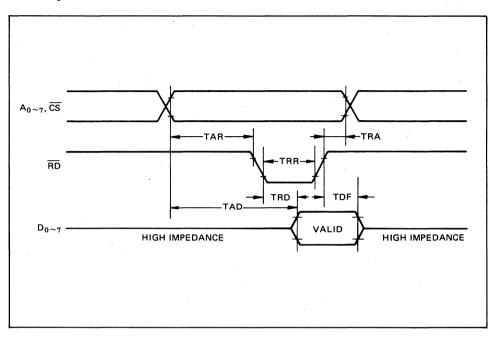
# TIME CHART

Write Timing

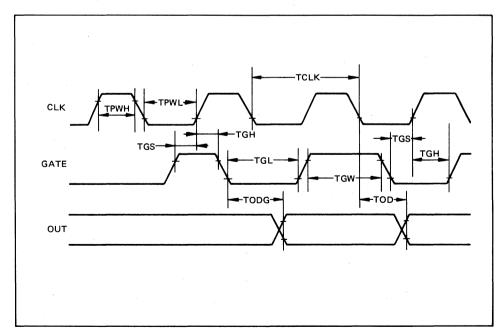


# MSM82C53-2RS/GS/JS =

Read Timing



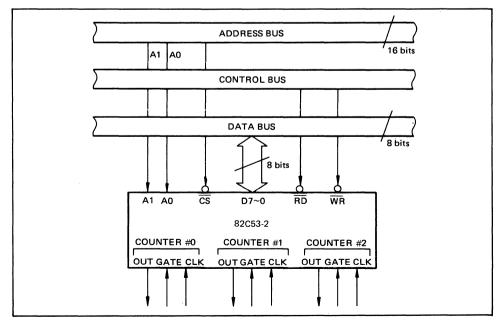
### **Clock & Gate Timing**



#### Pin Symbol Name Input/output Function D7 ~ D0 Bidirectional Input/output Three-state 8-bit bidirectional data bus used when writing data bus control words and count values, and reading count values upon reception of WR and RD signals from CPU. CS Chip select Input Data transfer with the CPU is enabled when this pin is at low level. When at high level, the data bus ( $D_0$ thru $D_7$ ) is input switched to high impedance state where neither writing nor reading can be executed. Internal registers, however, remain unchanged. RD Read input Input Data can be transferred from MSM82C53 to CPU when this pin is at low level. WR Data can be transferred from CPU to MSM82C53 when Write input Input this pin is at low level. One of the three internal counters or the control word regis-A0. A1 Address input Input ter is selected by A0/A1 combination. These two pins are normally connected to the two lower order bits of the address bus. CLK0~2 Clock input Input Supply of three clock signals to the three counters incorporated in MSM82C53. GATE0~2 Gate input Input Control of starting, interruption, and restarting of counting in the three respective counters in accordance to the set control word contents. OUT0~2 Counter output Output Output of counter output waveform in accordance with the set mode and count value.

# DESCRIPTION OF PIN FUNCTIONS

# SYSTEM INTERFACING



# DESCRIPTION OF BASIC OPERATIONS

Data transfers between the internal registers and the external data bus is outlined in the following table.

CS	RD	WR	A1	A0	Function
0	1	0	0	0	Data bus to counter #0 Writing
0	1	0	0	1	Data bus to counter # 1 Writing
0	1	0	1	0	Data bus to counter # 2 Writing
0	1	0	1	1	Data bus to control word register Writing
0	0	1	0	0	Data bus from counter # 0 Reading
0	0	1	0	1	Data bus from counter # 1 Reading
0	0	1	1	0	Data bus from counter # 2 Reading
0	0	1	1	1	
1	x	x	x	x	Data bus in high impedance status
0	1	1	x	×	

x denotes "not specified".

# DESCRIPTION OF OPERATION

82C53 functions are selected by a control word from the CPU. In the required program sequence, the control word setting is followed by the count value setting and execution of the desired timer operation.

#### **Control Word and Count Value Program**

Each counter operation mode is set by control word programming. The control word format is outlined below.

	D7	D6	D5	D4	D3	D2	D1	D0	
	SC1	SC0	RL1	RLO	M2	M1	мо	BCD	]
Ì	Select Counter		Read	/Load	Mode BCD				1
	$(\overline{CS} = 0, A0, A1 = 1, 1, \overline{RD} = 1, \overline{WR} = 0)$								

• Select Counter (SCO, SC1): Selection of set counter

SC1	SC0	Set Contents
0	0	Counter # 0 selection
0	1	Counter # 1 selection
1	0	Counter # 2 selection
1	1	Illegal combination

 Read/Load (RL1, RL0): Count value Reading/ Loading format setting

RL1	RL0	Set Contents
0	0	Counter Latch operation
0	1	Reading/Loading of Least Significant byte (LSB)
1	0	Reading/Loading of Most Significant byte (MSB)
1	1	Reading/Loading of LSB followed by MSB

Mode (M2, M1, M0): Operation waveform mode setting

M2	M1	мо	Set Contents
0	0	0	Mode 0 (Interrupt on Terminal Count)
0	0	1	Mode 1 (Programmable One-Shot)
×	1	0	Mode 2 (Rate Generator)
×	1	1	Mode 3 (Square Wave Generator)
1	0	0	Mode 4 (Software Triggered Strobe)
1	0	1	Mode 5 (Hardware Triggered Strobe)

x denotes "not specified".

BCD: Operation count mode setting

BCD	Set Contents
0	Binary Count (16-bits Binary)
1	BCD Count (4-decades Binary Coded Decimal)

After setting Read/Load, Mode, and BCD in each counter as outlined above, next set the desired count value. (In some Modes, counting is started immediately after the count value has been written). This count value setting must conform with the Read/Load format set in advance. Note that the internal counters are reset to OOOOH during control word setting. The counter value (OOOOH) can.t be read.

If the two bytes (LSB and MSB) are written at this stage (RL0 and RL1 = 1,1), take note of the following precaution.

Although the count values may be set in the three counters in any sequence after the control word has been set in each counter, count values must be set consecutively in the LSB – MSB order in any one counter.



#### • Example of control word and count value setting

and count funds setting
Counter # 0: Read/Load LSB only, Mode 3, Binary count, count value 3H
Counter # 1: Read/Load MSB only, Mode 5, Binary count, count value AA00H
Counter # 2: Read/Load LSB and MSB, Mode 0, BCD count, count value 1234
MVIA, 1EH OUT n3 Counter #0 control word setting
MVIA, 6AH OUT n3
MVIA, B1H OUT n3 Counter #2 control word setting
MVI A, 03H OUT n0
MVI A, AAH OUT n1 Counter #1 count value setting
MVI A, 34H ] OUT n2   Counter #2 count value setting MVI A, 12H   (LSB then MSB)
MVI A, 12H   (LSB then MSB) OUT n2 _

- Note: n0: Counter #0 address
  - n1: Counter #1 address
  - n2: Counter #2 address
  - n3: Control word register address
- The minimum and maximum count values which can be counted in each mode are listed below.

Mode	Min.	Max.	Remarks
0	1	o	0 executes 10000H count (ditto in other modes)
1	1	0	
2	2	0	1 cannot be counted
3	2	1	1 executes 10001H count
4	1	0	
5	1	0	

#### **Mode Definition**

Mode 0 (terminal count)

The counter output is set to "L" level by the mode setting. If the count value is then written in the counter with the gate input at "H" level (that is, upon completion of writing the MSB when there are two bytes), the clock input counting is started. When the terminal count is reached, the output is switched to "H" level and is maintained in this status until the control word and count value are set again.

Counting is interrupted if the gate input is switched to "L" level, and restarted when switched back to "H" level.

When Count Values are written during counting, the operation is as follows:

- 1 byte Read/Load.... When the new count value is written, counting is stopped immediately, and then restarted at the new count value by the next clock.
- 2-byte Read/Load.... When byte 1 (LSB) of the new count value is written, counting is stopped immediately. Counting is restarted at the new count value when byte 2 (MSB) is written.

#### Mode 1 (programmable one-shot)

The counter output is switched to "H" level by the mode setting. Note that in this mode, counting is not started if only the count value is written. Since counting has to be started in this mode by using the leading edge of the gate input as a trigger, the counter output is switched to "L" level by the next clock after the gate input trigger. This "L" level status is maintained during the set count value, and is switched back to "H" level when the terminal count is reached.

Once counting has been started, there is no interruption until the terminal count is reached, even if the gate input is switched to "L" level in the meantime. And although counting continues even if a new count value is written during the counting, counting is started at the new count value if another trigger is applied by the gate input.

#### Mode 2 (rate generator)

The counter output is switched to "H" level by the mode setting. When the gate input is at "H" level, counting is started by the next clock after the count value has been written. And if the gate input is at "L" level, counting is started by using the rising edge of the gate input as a trigger after the count value has been set.

An "L" level output pulse appears at the counter output during a single clock duration once every n clock inputs where n is the set count value. If a new count value is written during while counting is in progress, counting is started at the new count value following output of the pulse currently being counted. And if the gate input is switched to "L" level during counting, the counter output is forced to switch to "H" level, the counting being restarted by the rising edge of the gate input.

#### Mode 3 (square waveform rate generator)

The counter output is switched to "H" level by the mode setting. Counting is started in the same way as described for mode 2 above.

The repeated square wave output appearing at the counter output contains half the number of counts as the set count value. If the set count value (n) is an odd number, the repeated square wave output consists of only (n + 1)/2 clock inputs at "H" level and (n - 1)/2 clock inputs at "L" level.

If a new count value is written during counting, the new count value is reflected immediately after the

# I/O·MSM82C53-2RS/GS/JS =-

change ("H" to "L" or "L" to "H") in the next counter output to be executed. The counting operation at the gate input is done the same as in mode 2.

#### • Mode 4 (software trigger strobe)

The counter output is switched to "H" level by the mode setting. Counting is started in the same way as described for mode 0. A single "L" pulse equivalent to one clock width is generated at the counter output when the terminal count is reached.

This mode differs from 2 in that the "L" level output appears one clock earlier in mode 2, and that pulses are not repeated in mode 4. Counting is stopped when the gate input is switched to "L" level, and restarted from the set count value when switched back to "H" level.

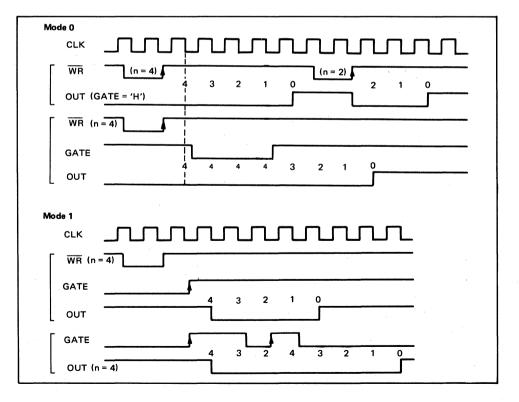
### • Mode 5 (hardware trigger strobe)

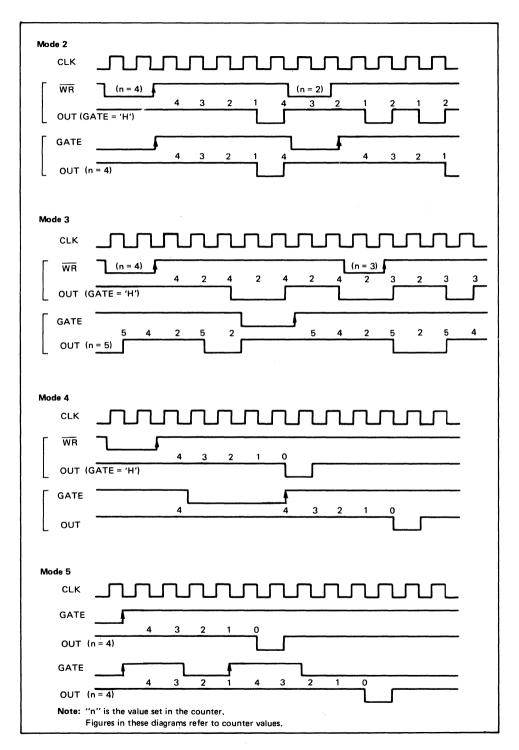
The counter output is switched to "H" level by the mode setting. Counting is started, and the gate input used, in the same way as in mode 1.

The counter output is identical to the mode 4 output.

The various roles of the gate input signals in the above modes are summarized in the following table.

Gate Mode	"L" Level Falling Edge	Rising Edge	"H" Level
0	Counting not possible		Counting possible
1		<ol> <li>(1) Start of counting</li> <li>(2) Retriggering</li> </ol>	
2	<ol> <li>Counting not possible</li> <li>Counter output forced to "H" level</li> </ol>	Start of counting	Counting possible
3	<ol> <li>Counting not possible</li> <li>Counter output forced to "H" level</li> </ol>	Start of counting	Counting possible
4	Counting not possible		Counting possible
5		(1) Start of counting (2) Retriggering	





# I/O·MSM82C53-2RS/GS/JS

#### **Reading of Counter Values**

All 82C53 counting is down-counting, the counting being in steps of 2 in mode 3. Counter values can be read during counting by (1) direct reading, and (2) counter latching ("read on the fly").

#### • Direct reading

Counter values can be read by direct reading operations,

Since the counter value read according to the timing of the  $\overline{RD}$  and CLK signals is not guaranteed, it is necessary to stop the counting by a gate input signal, or to interrupt the clock input temporarily by an external circuit to ensure that the counter value is correctly read.

#### Counter latching

In this method, the counter value is latched by writing a counter latch command, thereby enabling a stable value to be read without effecting the counting in any way at all. An example of a counter latching program is given below.

Counter latching executed for counter #1 (Read/ Load 2-byte setting)

MVI A	01 <u>00</u> x x x x	

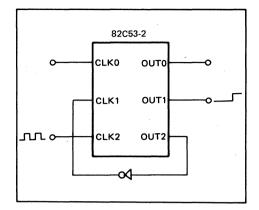
Denotes counter latching

- OUT n3 Write in control word address (n3) — The counter value at this point
  - is latched
- IN n1 Reading of the LSB of the counter value latched from counter #1. n1: Counter #1 address

MOV B, A	Reading of	MCD	from coun	tor
IN n1	 #1.	WIGD	nom coun	161
MOV C. A	#1.			

#### **Example of Practical Application**

• 82C53 used as a 32-bit counter.



Use counter #1 and counter #2

Counter	#1:	mode	0, upper	order	16-bit	counter
		value	•			

Counter #2: mode 2, lower order 16-bit counter value

This setting enables counting up to a maximum of  $2^{32}$ .

# **OKI** semiconductor MSM82C54-2RS/GS/JS

CMOS PROGRAMMABLE INTERVAL TIMER

# **GENERAL DESCRIPTION**

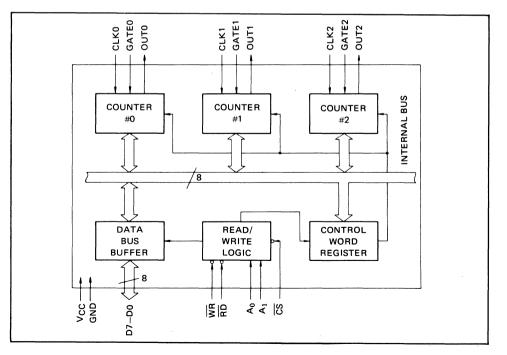
The MSM82C54-2RS/GS/JS is a programmable universal timer designed for use in microcomputer systems. Based on silicon gate CMOS technology, it requires a standby current of only 10  $\mu$ A (max.) when the chip is in the non-selected state. And during timer operation, the power consumption is still very low with only 10mA (max.) of current required.

It consists of three independent counters, and can count up to a maximum of 10 MHz. The timer features six different counter modes, and binary count/BCD count functions. Count values can be set in byte or word units, and all functions are freely programmable.

# FEATURES

- Maximum operating frequency of 10 MHz ( $V_{CC}$ =5V)
- High speed and low power consumption achieved by silicon gate CMOS technology.
- Completely static operation
- Three independent 16-bit down-counters
- Status Read Back Commound

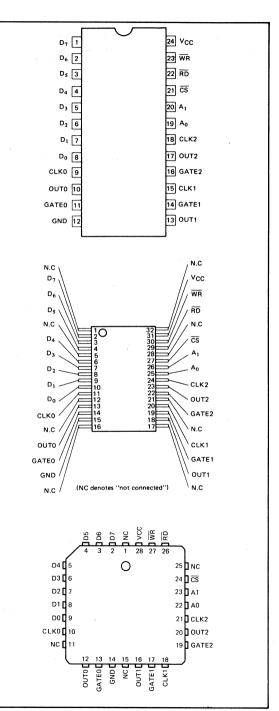
- Six counter modes available for each counter
- Binary and decimal counting possible
- 24 pin Plastic DIP (DIP24-P-600)
- •28 pin PLCC (QFJ28-P-S450)
- 32 pin-V Plastic SOP (SSOP32-P-430-VK)



# FUNCTIONAL BLOCK DIAGRAM

# PIN CONFIGURATION

MSM82C54-2RS (TOP VIEW) 24 pin Plastic DIP



MSM82C54-2GS (TOP VIEW) 32 pin Plastic Small Outline Package

MSM82C54-2JS (TOP VIEW)

28 pin Plastic Leaded Chip Carrier



# ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Conditions	Limits			
			MSM82C54-2RS	MSM82C54-2GS	MSM82C54-2JS	
Supply voltage	Vcc		$\frac{-0.5 \text{ to } +7}{-0.5 \text{ to } V_{CC} + 0.5}$			
Input Voltage	VIN	Respect to GND				
Output Voltage	VOUT		-0.5 to V <sub>cc</sub> + 0.5			
Storage Temperature	T <sub>stg</sub>		- 55 to + 150			°C
Power Dissipation	PD	Ta = 25°C	0.9	0.7	0.9	w

# RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Тур	Max	Unit
Supply Voltage	Vcc	4.5	5	5.5	v
Operating Temperature	т <sub>ор</sub>	-40	+25	+85	°C
"L" Input Voltage	VIL	-0.5		+0.8	v
"H" Input Voltage	ViH	2.2		V <sub>CC</sub> + 0.5	v

# DC CHARACTERISTICS

Parameter	Symbol	Conditions		Min	Тур	Max	Unit
"L" Output Voltage	VOL	I <sub>OL</sub> = 2.5mA				0.40	v
		IOH = -2.5mA	]	3.0			v
"H" Output Voltage	Vон			Vcc-0.4			
Input Leak Current	1 <sub>L1</sub>	$0 \leqq \mathbf{V}_{IN} \leqq \mathbf{V}_{CC}$	V <sub>CC</sub> =4.5V to 5.5V	-10		10	μA
Output Leak Current	1LO	0≦V <sub>OUT</sub> ≦V <sub>CC</sub>	Ta=-40°C to +85°C	-10		10	μA
Standby Supply Current	Iccs					10	μA
Operating Supply Current	1cc	tCLK=100ns CL=0pF				10	mA

# AC CHARACTERISTICS

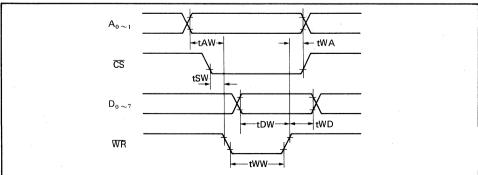
 $(V_{CC} = 4.5V \sim 5.5V, Ta = -40 \sim +85^{\circ}C)$ 

	Symbol	82C54-2				O	
Parameter		Min	Ņах	Unit		Conditions	
Address set-up time to falling edge of RD	tAR	30		nS			
Chip select input set-up time to falling edge of RD	tSR	0		nS			
Address hold time from rising edge of RD	tRA	0		nS	p D		
RD pulse width	tRR	95		nS	Reed timing		
Data access time from falling edge of RD	tRD		94	nS	ed t		
Data access time after address determination	tAD		185	nS	В		
Delay time from rising edge of $\overline{RD}$ to data floating state	tDF	5	65	nS			
RD recovery time	tRV	165		nS			
Address set-up time to falling edge of WR	tAW	0		nS			
Chip select input set-up time to falling edge of WR	tSW	0		nS			
Address hold time from rising edge of WR	tWA	0		nS	ing		
WR pulse width	tWW	95		nS	Write timing		
Data determination set-up time to rising edge of $\overline{WR}$	tDW	85		nS	Vrite		
Data hold time after rising edge of WR	tWD	0		nS	>		
WR recovery time	tRV	165	-	nS		CL=150pF	
CLK cycle time	tCLK	100	D.C.	nS			
CLK "H" level width	tPWH	30		nS			
CLK "L" level width	tPWL	50		nS			
CLK rise time	tR		25	nS			
CLK fall time	tF		25	nS			
GATE "H" level width	tGW	50		nS			
GATE "L" level width	tGL	50		nS	6		
GATE input set-up time before rising edge of CLK	tGS	40		nS	timing		
GATE input hold time before rising edge of CLK	tGH	50		nS	gate t		
Output delay time after falling edge of CLK	tOD		100	nS	¥		
Output delay time after falling edge of GATE	tODG		100	nS	Clock		
CLK rise delay time after rising edge of $\overline{WR}$ for count value loading	tWC	0	55	nS			
$GATE \ sampling \ delay \ time \ after \ rising \ edge \ of \ \overline{WR} \ for \ count \ value \ loading$	tWG	-5	40	nS	].		
Output delay time after falling edge of $\overline{WR}$ for mode set	tWO		240	nS			
CLK fall set-up time to falling edge of for counter latch command	tCL	-40	40	nS			

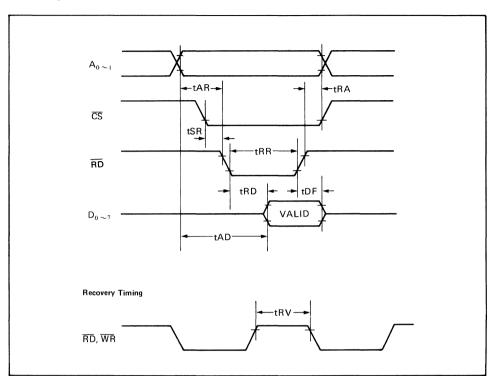
Note: Timing measured at V<sub>L</sub> = 0.8V and V<sub>H</sub> = 2.2V for both inputs and outputs.

# TIME CHART

# Write Timing

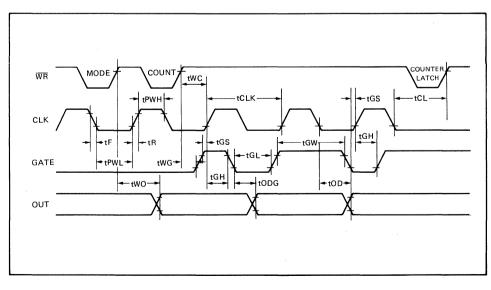






#### **Read Timing**

Clock & Gate Timing



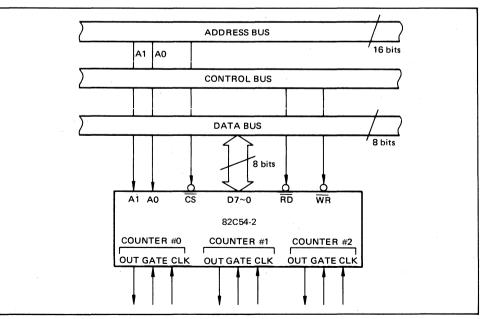
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# DESCRIPTION OF PIN FUNCTIONS

Pin Symbol	Name	Input/output	Function
D7 ~ D0	Bidirectional data bus	Input/output	Three-state 8-bit bidirectional data bus used when writing control words and count values, and reading count values upon reception of WR and RD signals from CPU.
CS	Chip select input	Input	Data transfer with the CPU is enabled when this pin is at low level. When at high level, the data bus $(D_0 \text{ thru } D_7)$ is switched to high impedance state where neither writing nor reading can be executed. Internal registers, however, remain unchanged.
RD	Read input	Input	Data can be transferred from MSM82C54-2 to CPU when this pin is at low level.
WR	Write input	Input	Data can be transferred from CPU to MSM82C54-2 when this pin is at low level.
A0, A1	Address input	Input	One of the three internal counters or the control word regis- ter is selected by A0/A1 combination. These two pins are normally connected to the two lower order bits of the address bus.
CLK0~2	Clock input	Input	Supply of three clock signals to the three counters incorporated in MSM82C54-2.
GATE0~2	Gate input	Input	Control of starting, interruption, and restarting of counting in the three respective counters in accordance to the set con- trol word contents.
OUT0~2	Counter output	Output	Output of counter output waveform in accordance with the set mode and count value.

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## SYSTEM INTERFACING



## DESCRIPTION OF BASIC OPERATIONS

Data transfers between the internal registers and the external data bus is outlined in the following table.

<del>cs</del>	RD	WR	A1	A0	Function
0	1	0	0	0	Data bus to counter #0 Writing
0	1	0	0	1	Data bus to counter # 1 Writing
0	1	0	1	0	Data bus to counter # 2 Writing
0	1	0	1	1	Data bus to control word register Writing
0	0	1	0	0	Data bus from counter # 0 Reading
0	0	1	0	1	Data bus from counter # 1 Reading
0	0	1	1	0	Data bus from counter # 2 Reading
0	0	1	1	1	J
1	x	x	x	×	Data bus in high impedance status
0	1	1	x	x	

x denotes "not specified".

## DESCRIPTION OF OPERATION

82C54-2 functions are selected by control words from the CPU. In the required program sequence, the control word setting is followed by the count value setting and execution of the desired timer operation.

#### **Control Word and Count Value Program**

Each counter operating mode is set by control word programming. The control word format is outlined below.

	D7	DĢ	D5	D4	D3	D2	D1	DO	_
	SC1	SC0	RL1	RL0	M2	M1	MO	BCD	].
ī	Sele Cour		Read,	/Load	L	Mode		BCD	j
	$(\overline{CS} = 0, A0, A1 = 1, 1, \overline{RD} = 1, \overline{WR} = 0)$								

Select Counter (SC0, SC1): Selection of set counter

SC1	SC0	Set Contents
0	0	Counter # 0 selection
0	1	Counter # 1 selection
1	0	Counter # 2 selection
1	1	READ BACK COMMAND

 Read/Load (RL1, RL0): Count value Reading/ Loading format setting

RL1	RL0	Set Contents
0	0	Counter Latch operation
0	1	Reading/Loading of Least Significant byte (LSB)
· 1	0	Reading/Loading of Most Significant byte (MSB)
1	1	Reading/Loading of LSB followed by MSB

Mode (M2, M1, M0): Operation waveform mode setting

M2	M1	мо	Set Contents
0	0	0	Mode 0 (Interrupt on Terminal Count)
0	0	1	Mode 1 (Programmable One-Shot)
×	1	0	Mode 2 (Rate Generator)
x	1	1	Mode 3 (Square Wave Generator)
1	0	0	Mode 4 (Software Triggered Strobe)
1	0	1	Mode 5 (Hardware Triggered Strobe)

x denotes "not specified".

• BCD: Operation count mode setting

BCD	Set Contents
0	Binary Count (16-bits Binary)
1	BCD Count (4-decades Binary Coded Decimal)

After setting Read/Load, Mode, and BCD in each counter as outlined above, next set the desired count value. (In some Modes, the count value is set first. In next clock, loading is performed, then counting starts.) This count value setting must conform with the Read/Load format set in advance. Note that the internal counters are reset to OOOOH during control word setting. The counter value (OOOOH) can't be read.

The program sequence of the 82C54-2 is flexible. Free sequence programming is possible as long as the two following rules are observed:

- (i) Write the control word before writing the initial count value in each counter.
- (ii) Write the initial count value according to the count value read/write format specified by the control word.
- (Note) Unlike the 82C53-5, the 82C54-2 allows count value setting for another counter between LSB and MSB settings.

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#### • Example of control word and count value setting

Counter	# 0:	Read/Load	LSB	only,	Mode	З,
		Binary count,	, count	value	зн	

Counter # 1: Read/Load MSB only, Mode 5, Binary count, count value AA00H

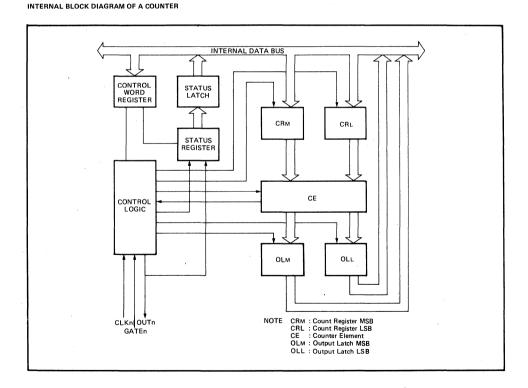
Counter # 2: Read/Load LSB and MSB, Mode 0, BCD count, count value 1234

	Counter #0 control word setting
	Counter #1 control word setting
MVI A, B1H OUT n3	Counter #2 control word setting
MVI A, 03H OUT n0	Counter #0 count value setting
MVIA, AAH OUT n1	Counter #1 count value setting
MVI A, 34H ] OUT n2	Counter #2 count value setting
MVIA, 12H OUT n2	(LSB then MSB)

#### Note: n0: Counter #0 address

- n1: Counter #1 address
- n2: Counter #2 address
- n3: Control word register address
- The minimum and maximum count values which can be counted in each mode are listed below.

Mode	Min	Max	Remarks
0	1	0	0 executes 10000H count (ditto in other modes)
1	1	0	
2	2	0	1 cannot be counted
3	2	0	1 cannot be counted
4	1	0	
5	1	0	



#### Mode definition

#### Mode 0

- Use: Event counter
- Output operation: The output is set to "L" level by the control word setting, and kept at "L" level until the counter value becomes 0.
- Gate function: "H" level validates the count operation, and "L" level invalidates it. The gate does not affect the output.
- Count value load timing: after the control word and initial count value are written, the count value is loaded to the CE at the falling edge of the next clock pulse. The first clock pulse does not cause the count value to be decremented. In other words, if the initial count value is N, the output is not set to "H" level until the input of (N+1) the clock pulse after the initial count value writing.
- Count value writing during counting:

The count value is loaded in the CE at the falling edge of the next clock, and counting with the new count value continues. The operation for 2-byte count is as follows:

- The counting operation is suspended when the first byte is written. The output is immediately set to "L" level. (no clock pulse is required.)
- After the scond byte is written, the new count value is loaded to the CE at the falling edge of the next clock.

For the output to go to "H" level again, N+1 clock pulses are necessary after new count value N is written.

• Count value writing when the gate signal is "L" level:

The count value is also loaded to the CE at the falling edge of the next clock pulse in this case. When the gate signal is set to "H" level, the output is set to "H" level after the lapse of N clock pulses. Since the count value is already loaded in the CE, no clock pulse for loading in the CE is necessary.

#### Mode 1

- Use: Digital one-shot
- Output operation: The output is set to "H" level by the control word setting. It is set to "L" level at the falling edge of the clock succeeding the igate trigger, and kept at "L" level until the counter value becomes 0. Once the output is set to "H" level, it is kept at "H" level until the clock pulse succeeding the next trigger pulse.
- Count value load timing:

After the control word and initial count value are written, the count value is loaded to the CE at the falling edge of the clock pulse succeeding the gate trigger and set the output to "L" level. The one-shot pulse starts in this way. If the initial count value is N, the one-shot pulse interval equals N clock pulses. The one-shot pulse is not repetitive.

• Gate function: The gate signal setting to "L" level after the gate trigger does not affect the output. When it is set to "H" level again from "L" level, gate retriggering occurs, the CR count value is loaded again, and counting continues.  Count value writing during counting It does not affect the one-shot pulse being counted until retriagering occurs.

#### Mode 2

- Use: Rate generator, real-time interrupt clock.
- Output operation: The output is set to "H" level by control word setting. When the initial count value is decremented to 1, the output is set to "L" level during one clock pulse, and is then set to "H" level again. The initial count value is reloaded, and the above sequence repeats. In mode 2, the same sequence is repeated at intervals of N clock pulses if the initial count value is N for example.
- Gate function: "H" level validates counting, and "L" level invalidates it. If the gate signal is set to "L" level when the output pulse is "L" level, the output is immediately set to "H" level. At the falling edge of the clock pulse succeeding the trigger, the count value is reloaded and counting starts. The gate input can be used for counter synchronization in this way.
- Count value load timing:

After the control word and initial count value is written, the count value is loaded to the CE at the falling edge of the next clock pulse. The output is set to "L" level upon lapse of N clock pulses after writing the initial count value N. Counter synchronization by software is possible in this way.

Count value writing during counting:

Count value writing does not affect the current counting operation sequence. If new count value writing completes and the gate trigger arrives before the end of current counting operation, the count value is loaded to the CE at the falling edge of the next clock pulse and counting continues from the new count value. If no gate trigger arrives, the new count value is loaded to the CE at the end of the current counting operation cycle. In mode 2, count value of 1 is prohibited.

#### Mode 3

- Use: Baud rate generator, square wave generator
- Output operation: Same as mode 2 except that the output duty is different.

The output is set to "H" level by control word setting. When the count becomes half the initial count value, the output is set to "L" level and kept at "L" level during the remainder of the count.

Mode 3 repeats the above sequence periodically. If the initial count value is N, the output becomes a square wave with a period of N.

• Gate operation: "H" level validates counting, and "L" level invalidates it. If the gate signal is set to "L" level when the output is "L" level, the output is immediately set to "H" level.

The initial count value is reloaded at the falling edge of the clock pulse succeeding the next gate trigger. The gate can be used for counter synchronization in this way.

- Count value load timing: After the control word and initial count value are written, the count value is loaded to the CE at the falling edge of the next clock pulse. Counter synchronization by software is possible in this way.
- Count value writing during counting:

The count value writing does not affect the current counting operation. When the gate trigger input arrives before the end of a half cycle of the square wave after writing the new count value, the new count value is loaded in the CE at the falling edge of the next clock pulse, and counting continues using the new count value. If there is no gate trigger, the new count value is loaded at the end of the half cycle and counting continues.

• Even number counting operation:

The output is initially set to "H" level. The initial count value is loaded to the CE at the falling edge of the next clock pulse, and is decremented by 2 by consecutive clock pulses. When the counter value becomes 2, the output is set to "L" level, the initial value is reloaded and then the above operation is repeated.

• Odd number counting operation:

The output is initially set to "H" level. At the falling edge of the next clock pulse, the initial count value minus one is loaded in the CE, and then the value is decremented by 2 by consecutive clock pulses. When the counter value becomes 0, the output is set to "L" level, and then the initial count value minus 1 is reloaded to the CE. The value is then decremented by 2 by consecutive clock pulses. When the counter value becomes 2, the output is again set to "H" level and the initial count value minus 1 is again reloaded. The above operations are repeated. In other words, the output is set to "H" level during (N+1)/2 counting and to "L" level during (N-1)/2 counting in the case of odd number counting.

#### Mode 4

- Use: Software trigger strobe
- Output operation: The output is initially set to "H" level. When the counter value becomes 0, the output goes to "L" level during one clock pulse, and then restores "H" level again.

The count sequence starts when the initial count value is written.

- Gate function: "H" level validates counting, and "L" level invalidates counting. The gate signal does not affect the output.
- Count value load timing:

After the control word and initial count value are written, the count value is loaded to the CE at the falling edge of the next clock pulse. The clock pulse does not decrement the initial count value. If the initial count value is N, the strobe is not output unless N+1 clock pulses are input after the initial count value is written.

• Count value writing during counting:

The new count value is written to the CE at the falling edge of the next clock pulse, and counting continues using the new count value. The operation for 2-byte count is as follows:

- 1) First byte writing does not affect the counting operation.
- After the second byte is written, the new count value is loaded to the CE at the falling edge of the next clock pulse.

This means that the counting operation is retriggered by software. The output strobe is set to "L" level upon input of N+1 clock pulses after the new count value N is written.

#### Mode 5

- Use: Hardware trigger strobe
- Output operation: The output is initially set to "H" level. When the counter value becomes 0 after triggering by the rising edge of the gate pulse, the output goes to "L" level during one clock pulse, and then restores "H" level.
- Count value load timing:

Even after the control word and initial count value are written, loading to the CE does not occur until the input of the clock pulse succeeding the trigger. For the clock pulse for CE loading, the count value is not decremented. If the initial count value is N, therefore, the output is not set to "L" level until N+1 clock pulses are input after triggering.

Gate function:

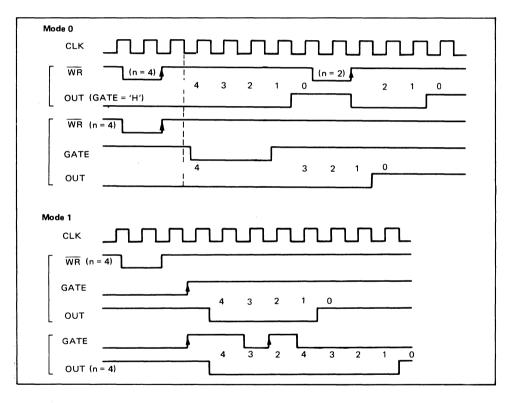
The initial count value is loaded to the CE at the falling edge of the clock pulse succeeding gate triggering. The count sequence can be retriggered. The gate pulse does not affect the output.

• Count value writing during counting:

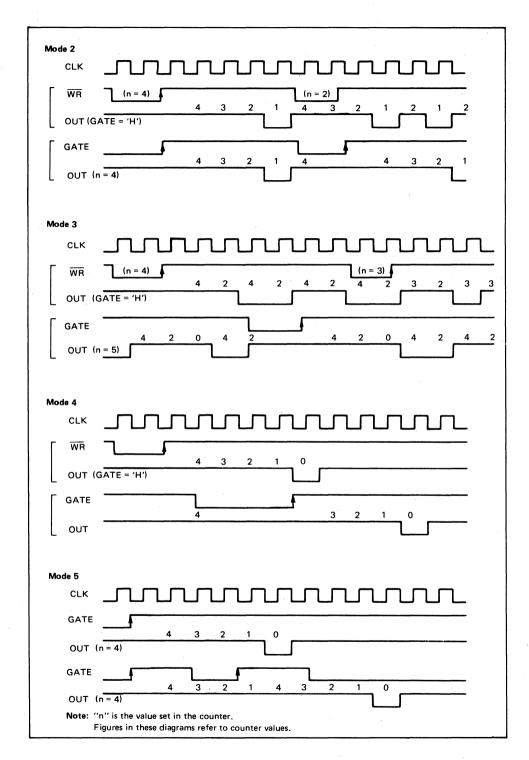
The count value writing does not affect the current counting sequence. If the gate trigger is generated after the new count value is written and before the current counting ends, the new count value is loaded to the CE at the falling edge of the next clock pulse, and counting continues using the new count value.

The various roles of the gate input signals in the above modes are summarized in the following table.

Gate Mode	"L" Level Falling Edge	Rising Edge	"H" Level
0	Counting not possible		Counting possible
1		<ol> <li>(1) Start of counting</li> <li>(2) Retriggering</li> </ol>	
2	<ol> <li>Counting not possible</li> <li>Counter output forced to "H" level</li> </ol>	Start of counting	Counting possible
3	<ol> <li>Counting not possible</li> <li>Counter output forced to "H" level</li> </ol>	Start of counting	Counting possible
4	Counting not possible		Counting possible
5		<ol> <li>(1) Start of counting</li> <li>(2) Retriggering</li> </ol>	



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#### **Reading Counter Values**

All 82C54-2 counting is down-counting, the counting being in steps of 2 in mode 3. Counter values can be read during counting by (1) direct reading, (2) counter latching ("read on the fly"), and (3) read back command.

#### (1) Direct reading

Counter values can be read by direct reading operations

Since the counter value read according to the timing of the RD and CLK signals is not guaranteed, it is necessary to stop the counting by a gate input signal, or to interrupt the clock input temporarily by an external circuit to ensure that the counter value is correctly read.

#### (2) Counter latching

In this method, the counter value is latched by writing a counter latch command, thereby enabling a stable value to be read without effecting the counting in any way at all. The output latch (OL) of the selected counter latches the count value when a counter latch command is written. The count value is held until it is read by the CPU or the control word is set again.

If a counter latch command is written again before reading while a certain counter is latched, the second counter latch command is ignored and the value latched by the first counter latch command is maintained

#### The 82C54-2 features independent reading and writing from and to the same counter.

When a counter is programmed for the 2-byte counter value, the following sequence is possible:

- 1. Count value (LSB) reading
- 2. New count value (LSB) writing
- 3. Count value (MSB) reading
- 4. New count value (MSB) writing

An example of a counter latching program is given below.

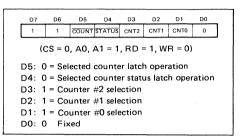
Counter latching executed for counter #1 (Read/ Load 2-byte setting)

MVIA 0100 x x x x Denotes counter latching	
OUT n3 Write in control word addre (n3) The counter value at this poin is latched	
IN n1	
MOV B, A Reading of MSB from counter IN n1 Reading of MSB from counter MOV C, A #1.	ðr

#### (3) Read Back Command Operation

Use of the read back command enables the user to check the count value, program mode, output pin state and null count flag of the selected counter.

The command is written in the control word register, and the format is as shown below. For this command, the counter selection occurs according to bits D3. D2 and D1.



It is possible to latch multiple counters by using the read back command. Latching of a read counter is automatically cancelled but other counters are kept latched. If multiple read back commands are written for the same counter, commands other than the first one are ignored.

It is also possible to latch the status information of each counter by using the read back command. The status of a certain counter is read when the counter is read.

The counter status format is as follows:

Bits D5 to D0 indicates the mode programmed by the most recently written control word.

Bit D7 indicates the status of the output nin

Use of this bit makes it possible to monitor the counter output, so the corresponding hardware may be omitted.

D7	D6	D5	D4	D3	D2	D1	D0			
OUTPUT	NULL COUNT	RL1	RL0	м2	М1	MO	BCD			
D7: 1		• •								
	= Out = Out	• •								

- 0 = Count value reading is effective
- D5 D0: Programmed mode of counter (See the control word format.)

Null count indicates the count value finally written in the counter register (CR) has been loaded in the counter element (CE). The time when the count value was loaded in the CE depends on the mode of each counter, and it cannot be known by reading the counter value because the count value does not tell the new count value if the counter is latched. The null count operation is shown below.

## ■ I/O·MSM82C54-2RS/GS/JS

Op	peration	
А.	Control word register writing	Null
в.	Count register (CR) writing	Null

B. Count register (CR) writing C. New count loading to Null count = 1

CE (CR → CE)

(Note) The null count operation for each counter is independent. When the 2byte count is programmed, the null count is set to 1 when the count value of the second byte is written. If status latching is carried out multiple times before status reading, other than the first status latch is ignored.

Simultaneous latching of the count and status of the selected counter is also possible. For this purpose, set bits D4 and D3, COUNT and STATUS bits, to 00. This is functionally the same as writing two separate read back commands at the same time. If counter/status latching is carried out multiple times before each reading, other than the first one is ignored here again. The example is shown below.

		С	om	mar	d			Contents	Coun	ter O	Counter 1		Counter 2	
D7	D6	D5	D4	D3	D2	D1	D0	Contents	Count	Status	Count	Status	Count	Status
1	1	0	0	0	0	1	0	Read back status and count (counter 0)	L	L	-	-	-	-
1	1	1	0	0	1	0	0	Read back status (counter 1)	L	L	-	L	-	-
1	1	1	0	1	1	0	0	Read back status (counters 1 and 2)	L	L	-	L (NOTE)	-	L
1	1	0	1	1	0	0	0	Read back count (counter 2)	L	L	. –	L	L	L
1	1	0	0	0	1	0	0	Read back status and count (counter 1)	L	L	L	(NOTE)	L	L.
1	1	1	0	0	0	1	0	Read back status (counter 0)	L	(NOTE)	L	L	L	L

L: Latched, -: Not latched

(Note) The latch command at this time point is ignored, and the first latch command is valid.

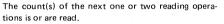
Result

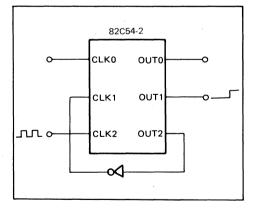
count = 1

If both the count and status are latched, the status latched in the first counter read operation is read. The order of count latching and status latching is irrelevant.

### Example of Practical Application

• 82C54-2 used as a 32-bit counter.





Use counter #1 and counter #2

Counter #1: mode 0, upper order 16-bit counter value

Counter #2: mode 2, lower order 16-bit counter value

This setting enables counting up to a maximum of  $2^{32}$ .

# **OKI** semiconductor MSM82C55A-2RS/GS/VJS

CMOS PROGRAMMABLE PERIPHERAL INTERFACE

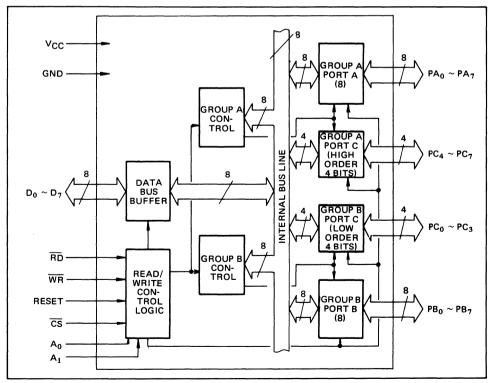
# GENERAL DESCRIPTION

The MSM82C55A is a programmable universal I/O interface device which operates as high speed and on low power consumption due to 3  $\mu$  silicon gate CMOS technology. It is the best fit as an I/O port in a system which employs the 8-bit parallel processing MSM80C85A CPU. This device has 24-bit I/O pins equivalent to three 8-bit I/O ports and all inputs/outputs are TTL interface compatible.

# **FEATURES**

- $\bullet$  High speed and low power consumption due to 3  $\mu$  silicon gate CMOS technology
- 3 V to 6 V single power supply
- Full static operation
- Programmable 24-bit I/O ports
- Bidirectional bus operation (Port A)

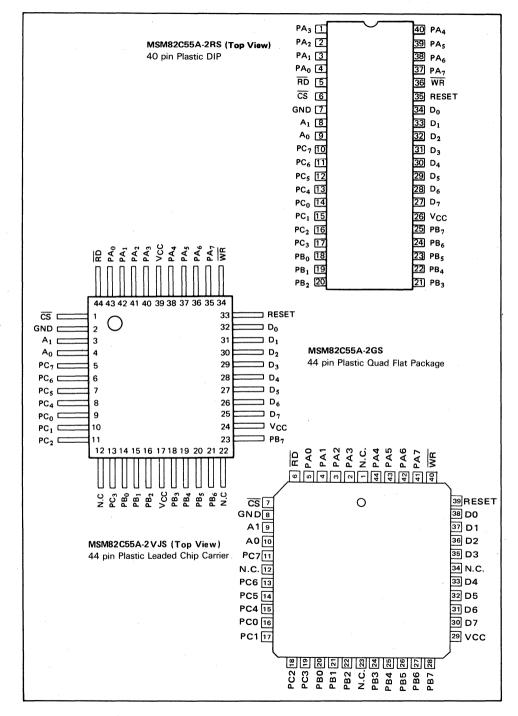
- Bit set/reset function (Port C)
- TTL compatible
- Compatible with 8255A-5
- •40 pin Plastic DIP (DIP40-P-600)
- •44 pin PLCC (QFJ44-P-S650)
- •44 pin-V Plastic QFP (QFP44-P-910-VK)
- •44 pin-VI Plastic QFP (QFP44-P-910-VIK)



# CIRCUIT CONFIGURATION

## I/O·MSM82C55A-2RS/GS/VJS

PIN CONFIGURATION



¢

Parameter	Sumbol	Conditions		Limits		Unit		
Farameter	Symbol	Conditions	MSM82C55A-2RS	MSM82C55A-2GS	MSM82C55A-2vJS	Unit		
Ssupply Voltage	V <sub>CC</sub>	Ta = 25°C		-0.5 to +7				
Input Voltage	∨ <sub>IN</sub>	with respect	-	).5	v			
Output Voltage	VOUT	to GND	-	V.				
Storage Temperature	⊤stg	-	- 55 to + 150			- 55 to + 150		°C
Power Dissipation	PD	Ta = 25°C	1.0	0.7	1.0	w		

# ABSOLUTE MAXIMUM RATINGS

# OPERATING RANGE

Parameter	Symbol	Limits	Unit
Supply Voltage	Vcc	3 to 6	v
Operating Temperature	Тор	-40 to 85	°C

# RECOMMENDED OPERATING RANGE

Parameter	Symbol	Min.	Typ.	Max.	Unit	
Supply Voltage	Vcc	4.5	5	5.5	v	
Operating Temperature	Тор	-40	+25	+85	°C	
"L" Input Voltage	VIL	-0.3		+0.8	v	
"H" Input Voltage	VIH	2.2		V <sub>CC</sub> +0.3	V	

# DC CHARACTERISTICS

0	0	Olitic	MSN	182C5	5A-2	Unit	
Parameter	Symbol	Conditio	Min.	Тур.	Max.	Onit	
"L" Output Voltage	VOL	I <sub>OL</sub> = 2.5 mA				0.4	~
"H" Output Voltage	∨он	I <sub>OH</sub> = -40 μA		4.2			v
"H" Output Voltage	∙он	I <sub>OH</sub> = -2.5 mA	Vcc = 4.5V to	3.7			v
Input Leak Current	ILI	$0 \le V_{\text{IN}} \le V_{\text{CC}}$	5.5V	-1		1	μA
Output Leak Current	ILO	$0 \leq V_{OUT} \leq V_{CC}$	$Ta = -40^{\circ}C$ to	-10		10	μA
Supply Current (standby)	Iccs	$\label{eq:cs_loss} \begin{split} \overline{\text{CS}} & \geq \text{V}_{\text{CC}} \ \text{-0.2V} \\ \text{V}_{\text{IH}} & \geq \text{V}_{\text{CC}} \ \text{-0.2V} \\ \text{V}_{\text{IL}} & \leq 0.2\text{V} \end{split}$	+85°C (C <sub>L:</sub> = OpF)		0.1	10	μA
Average Supply Current (active)	Icc	I/O wire cycle 82C55A-2 8MHzCPU timing				8	mA

# ■ I/O MSM82C55A-2RS/GS/VJS ■

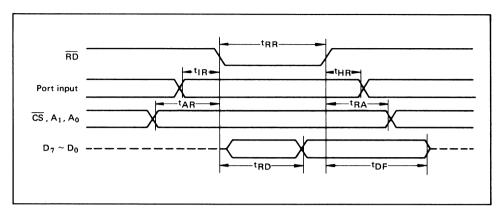
## AC CHARACTERISTICS

 $(V_{CC} = 4.5 \text{ to } 5.5 \text{V}, \text{ Ta} = -40 \text{ to } +80^{\circ} \text{C})$ 

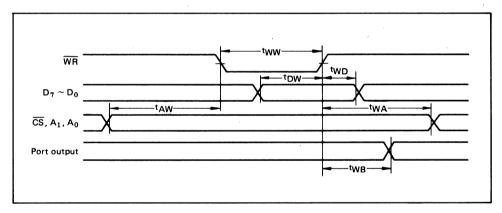
	Symbol	MSM82	C55A-2		
Parameter	Symbol	Min.	Max.	Unit	Remarks
Setup Time of address to the falling edge of $\overline{RD}$	tAR	20		ns	
Hold Time of address to the rising edge of RD	<sup>t</sup> RA	0		ns	1
RD Pulse Width	tRR	100		ns	]
Delay Time from the falling edge of $\overline{\text{RD}}$ to the output of defined data	tRD		120	ns	
Delay Time from the rising edge of $\overline{RD}$ to the floating of data bus	<sup>t</sup> DF	10	75	ns	
Time from the rising edge of $\overline{RD}$ or $\overline{WR}$ to the next falling edge of $\overline{RD}$ or $\overline{WR}$	<sup>t</sup> RV	200		ns	
Setup Time of address before the falling edge of $\overline{\text{WR}}$	tAW	0		ns	]
Hold Time of address after the rising edge or $\overline{\text{WR}}$	tWA	20		ns	
WR Pulse Width	tww	150		ns	
Setup Time of bus data before the rising edge of $\overline{\text{WR}}$	tDW	50		ns	
Holt Time of bus data after the rising edge of $\overline{WR}$	twd	30		ns	
Delay Time from the rising edge of $\overline{\rm WR}$ to the output of defined data	twв		200	ns	-
Setup Time of port data before the falling edge of RD	ЧR	20		ns	
Hold Time of port data after the rising edge of $\overline{\text{RD}}$	tHR	10		ns	
ACK Pulse Width	<sup>t</sup> AK	100		ns	
STB Pulse Width	tST	100		ns	Load
Setup Time of port data before the rising edge of STB	tPS	20		ns	150 pF
Hold Time of port data after the rising edge of STB	tPH	50		ns	]
Delay Time from the falling edge of $\overline{\text{ACK}}$ to the output of defined data	tAD		150	ns	
Delay Time from the rising edge of $\overline{ACK}$ to the floating of port (Port A in mode 2)	<sup>t</sup> KD	20	250	ns	_
Delay Time from the rising edge of WR to the falling edge of $\overline{\text{OBF}}$	twob		150	ns	
Delay Time from the falling edge of ACK to the rising edge of $\overrightarrow{\text{OBF}}$	<sup>t</sup> AOB		150	ns	
Delay Time from the falling edge of STB to the rising edge of IBF	<sup>t</sup> SIB		150	ns	
Delay Time from the rising edge of $\overline{\text{RD}}$ to the falling edge of IBF	<sup>t</sup> RIB		150	ns	_
Delay Time from the falling edge of RD to the falling edge of INTR	<sup>t</sup> RIT		200	ns	_
Delay Time from the rising edge of $\overline{\text{STB}}$ to the rising edge of INTR	<sup>t</sup> SIT		150	ns	
Delay Time from the rising edge of $\overline{\text{ACK}}$ to the rising edge of INTR	<sup>t</sup> AIT		150	ns	
Delay Time from the falling edge of WR to the falling edge of INTR	twit		250	ns	

Note: Timing is measured at V  $_{L}$  = 0.8 V and V  $_{H}$  = 2.2 V for both input and outputs.

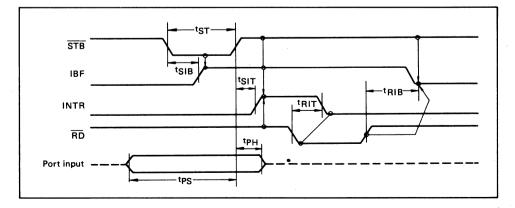
#### Basic Input Operation (Mode 0)



## Basic Output Operation (Mode 0)

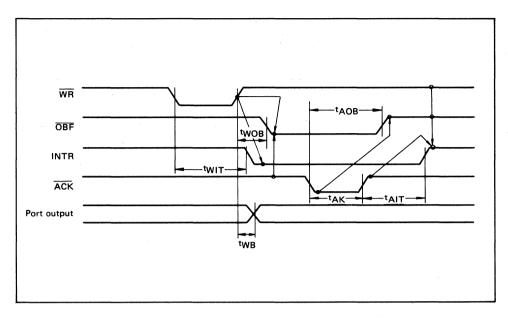


## Strobe Input Operation (Mode 1)

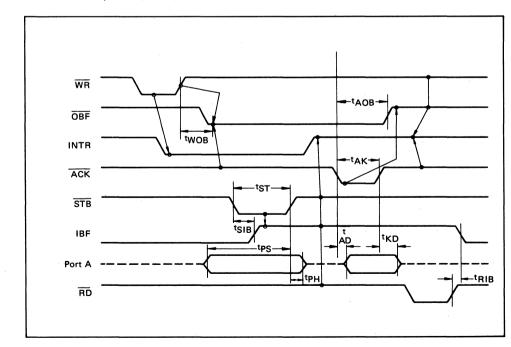


# ■ I/O·MSM82C55A-2RS/GS/VJS ■-

Strobe Output Operation (Mode 1)

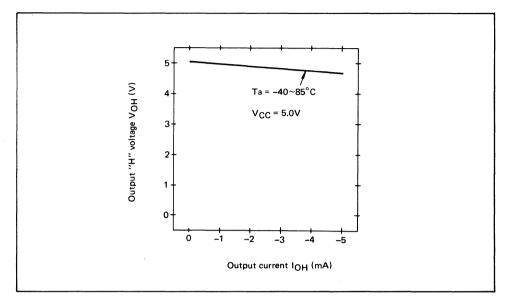


#### **Bidirectional Bus Operation (Mode 2)**

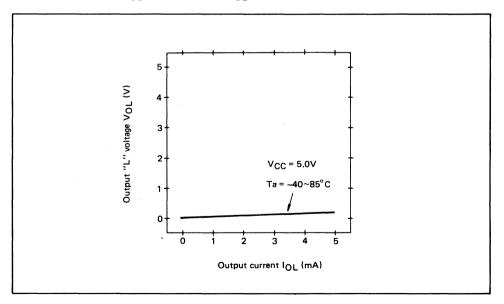


# **OUTPUT CHARACTERISTICS (REFERENCE VALUE)**

1 Output "H" Voltage (VOH) vs. Output Current (IOH)



## 2 Output "L" Voltage (VOL) vs. Output Current (IOL)



Note: The direction of flowing into the device is taken as positive for the output current.

# I/O MSM82C55A-2RS/GS/VJS

## FUNCTIONAL DESCRIPTION OF PIN

Pin No.	Item	Input/Output	Function
D7 ~ D0	Bidirectional data bus	Input and output	These are three-state 8-bit bidirectional buses used to write and read data upon receipt of the WR and RD signals from CPU and also used when control words and bit set/reset data are transferred from CPU to MSM82C55A.
RESET	Reset input	Input	This signal is used to reset the control register and all internal registers when it is in high level. At this time, ports are all made into the input mode (high impedance status). all port latches are cleared to 0. and all ports groups are set to mode 0.
CS	Chip select input	Input	When the $\overline{CS}$ is in low level, data transmission is enabled with CPU. When it is in high level, the data bus is made into the high impedance status where no write nor read operation is performed. Internal registers hold their previous status, however.
RD	Read input	Input	When RD is in low level, data is transferred from MSM82C55A to CPU.
WR	Write input	Input	When WR is in low level, data or control words are transferred from CPU to MSM82C55A.
A0, A1	Port select input (address)	Input	By combination of A0 and A1, either one is selected from among port A, port B, port C, and control register. These pins are usually connected to low order 2 bits of the address bus.
PA7 ~ PA0	Port A	Input and output	These are universal 8-bit I/O ports. The direction of inputs/out- puts can be determined by writing a control word. Especially, port A can be used as a bidirectional port when it is set to mode 2.
PB7 ~ PB0	Port B	Input and output	These are universal 8-bit I/O ports. The direction of inputs/out- puts can be determined by writing a control word.
PC7 ~ PC0	Port C	Input and output	These are universal 8-bit I/O ports. The direction of inputs/out- puts can be determined by writing a control word as 2 ports with 4 bits each. When port A or port B is used in mode 1 or mode 2 (port A only), they become control pins. Especially when port C is used as an output port, each bit can be set/reset independently.
Vcc			+5 V power supply.
GND			GND

## BASIC FUNCTIONAL DESCRIPTION

## Group A and Group B

When setting a mode to a port having 24 bits, set it by dividing it into two groups of 12 bits each.

- Group A: Port A (8 bits) and high order 4 bits of port C (PC7 ~ PC4)
  - Group B: Port B (8 bits) and low order 4 bits of port C (PC3 ~ PC0)

### Mode 0, 1, 2

There are 3 types of modes to be set by grouping as follows:

- Mode 0:
   Basic input operation/output operation (Available for both groups A and B)

   Mode 1:
   Strobe input operation/output operation (Available for both groups A and B)
- Mode 2: Bidirectional bus operation (Available for group A only)

When used in mode 1 or mode 2, however, port C has bits to be defined as ports for control signal for operation ports (port A for group A and port B for group B) of their respective groups.

#### Port A, B, C

The internal structure of 3 ports is as follows:

- Port A: One 8-bit data output latch/buffer and one 8-bit data input latch
- Port B: One 8-bit data input/output latch/buffer and one 8-bit data input buffer
- Port C: One 8-bit data output latch/buffer and one 8-bit data input buffer (no latch for input)

#### Single bit set/reset function for port C

When port C is defined as an output port, it is possible to set (to turn to high level) or reset (to turn to low level) any one of 8 bits individually without affecting other bits.

# OPERATIONAL DESCRIPTION

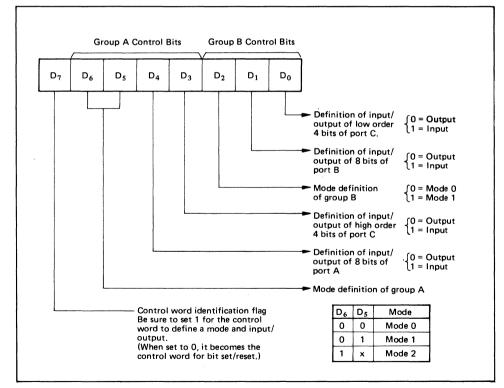
## **Control Logic**

Operations by addresses and control signals, e.g., read and write, etc. are as shown in the table below:

Operation	A1	A0	cs	WR	RD	Operation
	0	0	0	1	0	Port A →Data Bus
Input	it 0 1		0	1	0	Port B → Data Bus
	1	0	0	1	0	Port C → Data Bus
	0	0	0	0	1	Data Bus → Port A
Output	0	1	0	0	1	Data Bus → Port B
	1	0	0	0	1	Data Bus →Port C
Control	1	1	0	0	1	Data Bus → Control Register
	1	1	0	1	0	Illegal Condition
Others	x	×	1	×	×	Data bus is in the high impedance status.

#### Setting of Control Word

The control register is composed of 7-bit latch circuit and 1-bit flag as shown below.



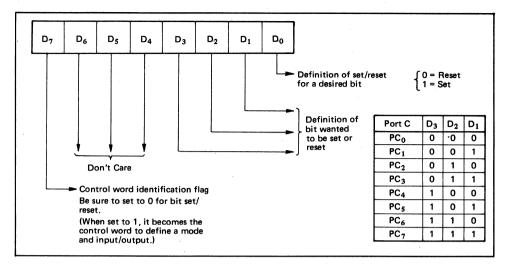
#### Precaution for mode selection

#### **Bit Set/Reset Function**

The output registers for ports A and C are cleared to  $\phi$  each time data is written in the command register and the mode is changed, but the port B state is undefined.

When port C is defined as output port, it is possible to set (set output to 1) or reset (set output to 0) any one of 8 bits without affecting other bits as shown next page.

## I/O·MSM82C55A-2RS/GS/VJS



#### Interrupt Control Function

When the MSM82C55A is used in mode 1 or mode 2, the interrupt signal for the CPU is provided. The interrupt request signal is output from port C. When the internal flip-flop INTE is set beforehand at this time, the desired interrupt request signal is output. When it is reset beforehand, however, the interrupt request signal is not output. The set/reset of the internal flip-flop is made by the bit set/reset operation for port C virtually.

Bit set  $\rightarrow$  INTE is set  $\rightarrow$  Interrupt allowed Bit reset  $\rightarrow$  INTE is reset  $\rightarrow$  Interrupt inhibited

#### Operational Description by Mode

#### 1. Mode 0 (Basic input/output operation)

Mode 0 makes the MSM82C55A operate as a basic input port or output port. No control signals such as interrupt request, etc. are required in this mode. All 24 bits can be used as two-8-bit ports and two 4-bit ports. Sixteen combinations are then possible for inputs/outputs. The inputs are not latched, but the outputs are.

			Ç	ontro	l Wor	d			Gr	oup A	G	roup B
Туре	D7	D <sub>6</sub>	D5	D4	D3	$D_2$	D1	Do	Port A	High Order 4 Bits of Port C	Port B	Low Order 4 Bits of Port C
1	1	0	0	0	0	0	0	0	Output	Output	Output	Output
2	1	0	0	0	Ο.	0	0	1	Output	Output	Output	Input
3	1	0	0	0	0	0	1	0	Output	Output	Input	Output
4	1	0	0	0	0	0	1	1	Output	Output	Input	Input
5	1	0	0	0	1	0	0	0	Output	Input	Output	Output
6	1	0	0	0	1	0	0	1	Output	Input	Output	Input
7	1	0	0	0	1	0	1	0	Output	Input	Input	Output
8	1	0	0	0	1	0	1	1	Output	Input	Input	Input
9	1	0	0	1	0	0	0	0	Input	Output	Output	Output
10	1	0	0	1	0	0	0	1	Input	Output	Output	Input
11	1	0	0	1	0	0	1	0	Input	Output	Input	Output
12	1	0	0	1	0	0	1	1	Input	Output	Input	Input
13	1	0	0	1	1	0	0	0	Input	Input	Output	Output
14	1	0	0	1	1	0	0	1	Input	Input	Output	Input
15	1	0	0	1	1	0	1	0	Input	Input	Input	Output
16	1	0	0	1	1	0	1	1	Input	Input	Input	Input

Note: When used in mode 0 for both groups A and B



#### 2. Mode 1 (Strobe input/output operation)

In mode 1, the strobe, interrupt and other control signals are used when input/output operations are made from a specified port. This mode is available for both groups A and B. In group A at this time, port A is used as the data line and port C as the control signal.

Following is a descrption of the input operation in mode 1.

#### STB (Strobe input)

 When this signal is low level, the data output from terminal to port is fetched into the internal latch of the port. This can be made independent from the CPU, and the data is not output to the data bus until the RD signal arrives from the CPU.

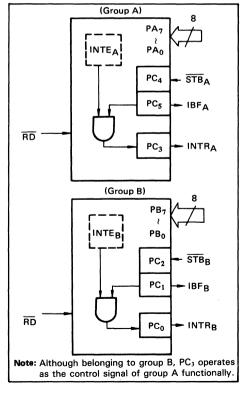
#### IBF (Input buffer full flag output)

 This is the response signal for the STB. This signal when turned to high level indicates that data is fetched into the input latch. This signal turns to high level at the falling edge of STB and to low level at the rising edge of RD.

#### INTR (Interrupt request output)

 This is the interrupt request signal for the CPU of the data fetched into the input latch. It is indicated by high level only when the internal INTE flip-flop is set. This signal turns to high level at the rising edge of the STB (IBF = 1 at this time)

#### Mode 1 Input



and low level at the falling edge of the RD when the INTE is set.

 $INTE_A$  of group A is set when the bit for PC<sub>4</sub> is set, while  $INTE_B$  of group B is set when the bit for PC<sub>2</sub> is set.

Following is a description of the output operation of mode 1.

## OBF (Output buffer full flag output)

 This signal when turned to low level indicates that data is written to the specified port upon receipt of the WR signal from the CPU. This signal turns to low level at the rising edge of the WR and high level at the falling edge of the ACK.

#### ACK (Acknowledge input)

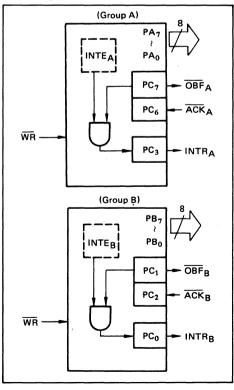
• This signal when turned to low level indicates that the terminal has received data.

## INTR (Interrupt request output)

 This is the signal used to interrupt the CPU when a terminal receives data from the CPU via the MSM82C55A-5. It indicates the occurrence of the interrupt in high level only when the internal INTE flip-flop is set. This signal turns to high level at the rising edge of the ACK (OBF = 1 at this time) and low level at the falling edge of WR when the INTE<sub>B</sub> is set.

 $INTE_A$  of group A is set when the bit for PC<sub>6</sub> is set, while  $INTE_B$  of group B is set when the bit for PC<sub>2</sub> is set.

#### Mode 1 output

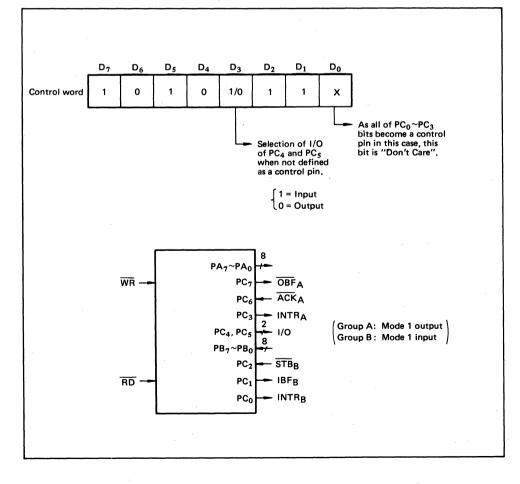


Port C Function Allocation in Mode 1

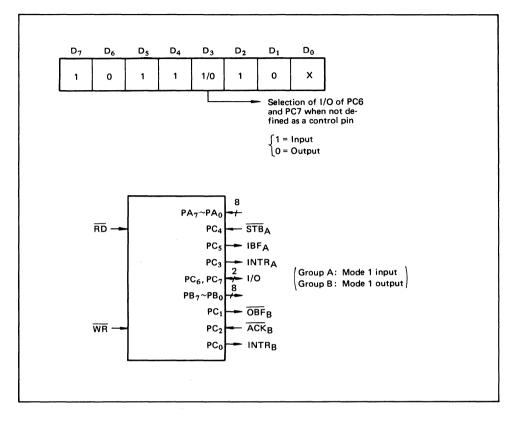
Combination of Input/Output Port C	Group A: Input Group B: Input	Group A: Input Group B: Output	Group A: Output Group B: Input	Group A: Output Group B: Output
PCo	INTRB	INTRB	INTRB	
PC1	IBFB	OBFB	IBFB	OBFB
PC <sub>2</sub>	STBB	ACKB	STBB	ACKB
PC3	INTRA	INTRA	INTRA	INTRA
PC4	STBA	STBA	I/O	1/0
PC5	IBFA	IBFA	1/0	1/0
PC <sub>6</sub>	1/0	I/O	ACKA	ACKA
PC <sub>7</sub>	1/0	1/0	OBFA	OBFA

Note: I/O is a bit not used as the control signal, but it is available as a port of mode 0.

Examples of the relation between the control words and pins when used in mode 1 is shown below: (a) When group A is mode 1 output and group B is mode 1 input.



(b) When group A is mode 1 input and group B is mode 1 output.



#### 3. Mode 2 (Strobe bidirectional bus I/O operation)

In mode 2, it is possible to transfer data in 2 directions through a single 8-bit port. This operation is akin to a combination between input and output operations. Port C waits for the control signal in this case, too. Mode 2 is available only for group A, however.

#### Next, a description is made on mode 2. OBF (Output buffer full flag output)

 This signal when turned to low level indicates that data has been written to the internal output latch upon receipt of the WR signal from the CPU. At this time, port A is still in the high impedance status and the data is not yet output to the outside. This signal turns to low level at the rising edge of the WR and high level at the falling edge of the ACK.

#### ACK (Acknowledge input)

 When a low level signal is input to this pin, the high impedance status of port A is cleared, the buffer is enabled, and the data written to the internal output latch is output to port A. When the input returns to high level, port A is made into the high impedance status.

#### STB (Strobe input)

When this signal turns to low level, the data output to the port from the pin is fetched into the internal input latch. The data is output to the data bus upon receipt of the RD signal from the CPU, but it remains in the high impedance status until then.

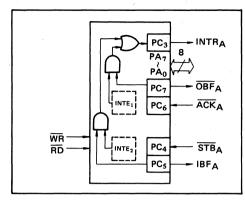
#### IBF (Input buffer full flag output)

 This signal when turned to high level indicates that data from the pin has been fetched into the input latch. This signal turns to high level at the falling edge of the STB and low level at the rising edge of the RD.

#### INTR (Interrupt request output)

 This signal is used to interrupt the CPU and its operation in the same as in mode 1. There are two INTE flip-flops internally available for input and output to select either interrupt of input or output operation. The INTE1 is used to control the interrupt request for output operation and it can be reset by the bit set for PC6. INTE2 is used to control the interrupt request for the input operation and it can be set by the bit set for PC4.

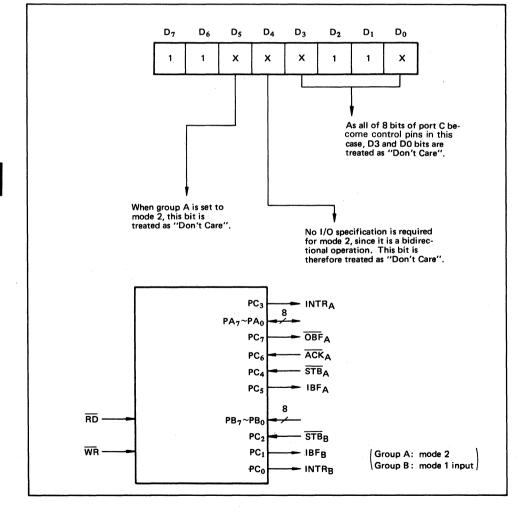
#### Mode 2 I/O Operation



Port C Function Allocation in Mode 2

Port C	Function
PC <sub>0</sub>	O
PC1	Confirmed to the group B mode
PC <sub>2</sub>	group o mode
PC <sub>3</sub>	
PC <sub>4</sub>	STBA
PC <sub>5</sub>	IBFA
PC <sub>6</sub>	ACKA
PC <sub>7</sub>	OBFA

Following is an example of the relation between the control word and the pin when used in mode 2. When input in mode 2 for group A and in mode 1 for group B.



4. When Group A is Different in Mode from Group B Group A and group B can be used by setting them in different modes each other at the same time. When either group is set to mode1 or mode 2, it is possible to set the one not defined as a control pin in port C to both input and output as a port which operates in mode 0 at the 3rd and 0th bits of the control word.

		0 0				Poi	rt C			
	Group A	Group B	PC7	PC <sub>6</sub>	PC <sub>5</sub>	PC4	PC3	PC <sub>2</sub>	PC <sub>1</sub>	PC <sub>0</sub>
1	Mode 1 input	Mode 0	1/0	1/0	IBFA	STBA		1/0	1/0	ı/o
2	Mode 0 output	Mode 0	OBFA	ACKA	I/O	1/0	INTRA	1/0	1/0	I/O
3	Mode 0	Mode 1 input	1/0	I/O	1/0	1/0	1/0	STBB	IBFB	
4	Mode 0	Mode 1 output	1/0	1/0	I/ <u>(</u> 0	1/0	1/0	ACKB	OBFB	INTRB
5	Mode 1 input	Mode 1 input	I/O	1/0	IBFA	STBA	INTRA	STBB	IBFB	
6	Mode 1 input	Mode 1 output	1/0	1/0	IBFA	STBA	INTRA	ACKB	OBFB	INTR
7	Mode 1 output	Mode 1 input	OBFA	ACKA	1/0	1/0	INTRA	STBB	IBFB	
8	Mode 1 output	Mode 1 output	OBFA	ĀCKĄ	1/0	1/0	INTRA	ACKB	OBFB	INTRB
9	Mode 2	Mode 0	OBFA	ACKA	IBFA	STBA	INTRA	1/0	1/0	1/0

(Mode combinations that define no control bit at port C)

Controlled at the 3rd bit (D3) of the control word

Controlled at the 0th bit (D0) of the control word

When the I/O bit is set to input in this case, it is possible to access data by the normal port C read operation.

When set to output,  $PC7 \sim PC4$  bits can be accessed by the bit set/reset function only. Meanwhile, 3 bits from PC2 to PC0 can be accessed by normal write operation. The bit set/reset function can be used for all of PC3  $\sim$  PC0 bits. Note that the status of port C varies according to the combination of modes like this.

# ■ I/O·MSM82C55A-2RS/GS/VJS ■

#### 5. Port C Status Read

When port C is used for the control signal, that is, in either mode 1 or mode 2, each control signal and bus status signal can be read out by reading the content of port C.

The status read out is as follows:

	0	0			Sta	tus read o	n the data	bus		
	Group A	Group B	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	Do
1	Mode 1 input	Mode 0	1/0	1/0	IBFA	INTEA	INTRA	1/0	1/0	1/0
2	Mode 1 output	Mode.0	OBFA	INTEA	1/0	1/0	INTRA	I/O	1/0	I/O
3	Mode 0	Mode 1 input	1/0	1/0	1/0	1/0	1/0	INTEB	IBFB	INTRB
4	Mode 0	Mode 1 output	1/0	I/O	1/0	1/0	1/0	INTEB	OBFB	INTRB
5	Mode 1 input	Mode 1 input	1/0	1/0	IBFA	INTEA	INTRA	INTEB	IBFB	
6	Mode 1 input	Mode 1 output	١/٥	1/0	IBFA	INTEA	INTRA	INTEB	OBFB	
7	Mode 1 output	Mode 1 input		INTEA	I/O	1/0	INTRA	INTEB	IBFB	
8	Mode 1 output	Mode 1 output		INTEA	I/O	I/O	INTRA	INTEB	$\overline{OBF}_{B}$	INTRB
9	Mode 2	Mode 0	OBFA	INTE1	IBFA	INTE <sub>2</sub>	INTRA	1/0	1/0	1/0
10	Mode 2	Mode 1 input	OBFA	INTE <sub>1</sub>	IBFA	INTE <sub>2</sub>	INTRA	INTEB	IBFB	
11	Mode 2	Mode 1 output	OBFA	INTE1	IBFA	INTE <sub>2</sub>	INTRA	INTEB	OBFB	

#### 6. Reset of MSM82C55A

Be sure to keep the RESET signal at power ON in the high level at least for 50  $\mu s.$  Subsequently, it

becomes the input mode at a high level pulse above 500 ns.

## Note:

## MSM82C55A-5

After a write command is executed to the command register, the internal latch is cleared in PORTA PORTC. For instance, 00H is output at the beginning of a write command when the output port is assigned. However, if PORTB is not cleared at this time, PORTB is unstable. In other words, PORTB only outputs ineffective data (unstable value according to the device) during the period from after a write command is executed till the first data is written to PORTB.

#### MSM82C55A-2

After a write command is executed to the command register, the internal latch is cleared in All Ports(PORTA,PORTB,PORTC). 00H is ontput at the beginning of a write command when the output port is assigned.

# **OKI** semiconductor MSM82C59A-2RS/GS/JS

PROGRAMMABLE INTERRUPT CONTROLER

# GENERAL DESCRIPTION

The MSM82C59A-2 is a programmable interrupt controller for use in MSM80C85A/A-2 and MSM80C86/88 microcomputer systems.

Based on CMOS silicon gate technology, this device features an extremely low standby current of 100  $\mu$ A (max.) in chip non-selective status. During interrupt control status, the power consumption is very low with only 5 mA (max.) being required.

Internally, the MSM82C59A-2 can control priority interrupts up to 8 levels, and can be expanded up to 64 levels by cascade connection of a number of devices.

# FEATURES

- Silicon gate CMOS technology for high speed and low power consumption.
- 3 V to 6 V single power supply
- 80C85A system compatibility (MAX5MHz)
- 80C86/88 system compatibility (MAX8MHz)
- 8-level priority interrupt control
- Interrupt levels expandable up to 64 levels
- 32 pin Plastic SOP (SSOP32-P-430-K)

Programmable interrupt mode

•28 pin Plastic DIP (DIP28-P-600)

•28 pin PLCC (QFJ28-P-S450)

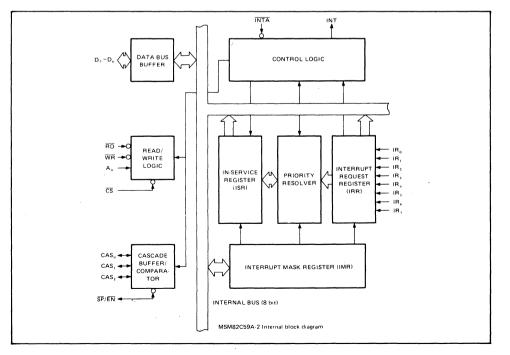
Maskable interrupt

TTL compatible

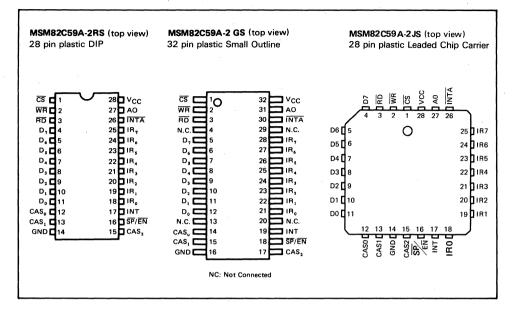
•32 pin-V Plastic SOP (SSOP32-P-430-VK)

Automatically generated CALL code (85 mode)





## **PIN CONNECTIONS**



# **ELECTRICAL CHARACTERISTICS**

## Absolute Maximum Ratings

Parameter	Symbol	Conditions		Limits					
	•		MSM82C59A-2RS	MSM82C59A-2GS	MSM82C59A-2JS				
Power supply voltage	Vcc			-0.5 ~ +7					
Input voltage	VIN	Respect to GND		$0.5 \sim V_{cc} + 0$	~ V <sub>cc</sub> + 0.5				
Output voltage	VOUT		-	v					
Storage temperature	T <sub>stg</sub>		-55 ~ +150						
Power dissipation	PD	Ta = 25°C	0.9	0.7	0.9	w			

## **Operating Ranges**

Parameter	Symbol	Range	Unit
Power supply voltage	Vcc	3 ~6	v
Operating temperature	TOP	-40 ~ +85	°C

## **Recommended Operating Conditions**

Parameter	Symbol	Max.	Тур.	Min.	Unit
Power supply voltage	Vcc	4.5	5	5.5	v
Operating temperature	Тор	-40	+25	+85	°C
"L" level input voltage	VIL	-0.5		+0.8	v
"H" level input voltage	VIH	2.2		V <sub>CC</sub> +0.5	v

I/O MSM82C59A-2RS/GS/JS =

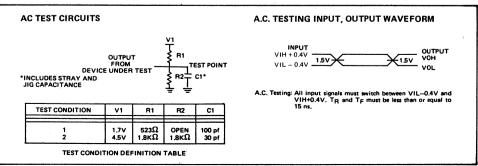
## **DC** Characteristics

Parameter	Symbol	Condi	tions	Min.	Тур.	Max.	Unit
"L" level output voltage	VOL	I <sub>OL</sub> = 2.5 mA				0.4	V
		<sup>I</sup> OH = -2.5 mA	]	3.0			v
"H" level output voltage	Vон	I <sub>OH</sub> = -100 μA	]	V <sub>CC</sub> - 0.4			
Input leak current	LI	01/2 1/10/21/22	V <sub>CC</sub> =4.5V~5.5V	-1		1	μA
IR Input leak current	LIR	0V≦VIN≦VCC	Ta=-40°C~+85°C	-300		10	μA
Output leak current	<sup>1</sup> LO	0V≦V <sub>OUT</sub> ≦V <sub>CC</sub>	]	-10		10	μA
Standby power supply current	Iccs	$\overline{CS}=V_{CC}, IR = V_{CC}$ $V_{1L}=0V, V_{1H}=V_{CC}$			0.1	100	μА
Average operation power supply current	<sup>I</sup> CC	V <sub>IN</sub> =0V/V <sub>CC</sub> C <sub>L</sub> = 0 pF			-	5	mA

## **AC Characteristics**

Ta = -40° C  $\sim$  +85° C, V\_{CC} = 5V  $\pm 10\%$ 

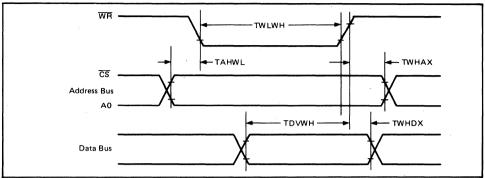
Parameter	Symbol	Min.	Max.	Unit	TEST (	Conditions
Address setup time (to $\overline{RD}$ )	TAHRL	10		nS		
Address hold time (after RD)	TRHAX	5		nS		Read INTA timing
RD/INTA pulse width	TRLRH	160		nS		
Address setup time (to $\overline{WR}$ )	TAHWL	0		nS		
-Address hold time (after WR)	TWHAX	0		nS		
WR pulse width	TWLWH	190		nS		Write timing
Data setup time (to WR)	тоумн	160		nS		
Data hold time (after WR)	тwнdx	0		nS		
IR input width (Low)	TJLJH	100		nS		INTA sequence
CAS input setup time (to INTA) (slave)	TCVIAL	40		nS		IN TA sequence
End of RD to Next RD End of INTA to Next INTA	TRHRL	160		nS		
End of WR to Next WR	TWHWL	190		nS		Other timing
End of Command to Next command	TCHCL	400		nS		
Data valid following RD/INTA	TRLDV		120	nS	1	
Data floating following RD/INTA	TRHDZ	10	85	nS	2	]
INT output delay time	тјнін		300	nS	1	Delau diana
CAS valid following 1st. INTA (master)	TIALCV		360	nS	1	Delay times
EN active following RD/INTA	TRLEL		100	nS	1	
EN inactive following RD/INTA	TRHEH		150	nS	1	
Data valid after address	TAHDV		200	nS	1	1
Data valid after CAS	тсуру		200	nS	1	1



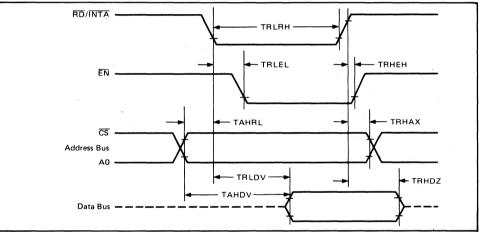
## TIME CHART

2

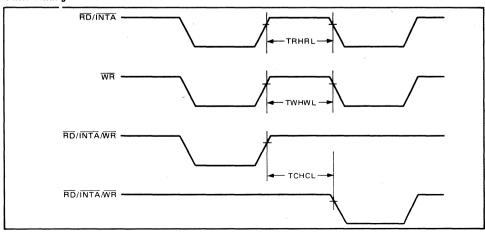
Write Timing



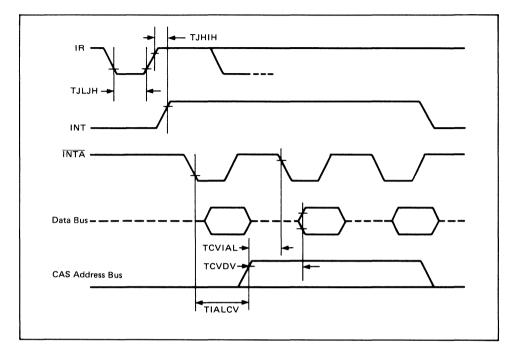




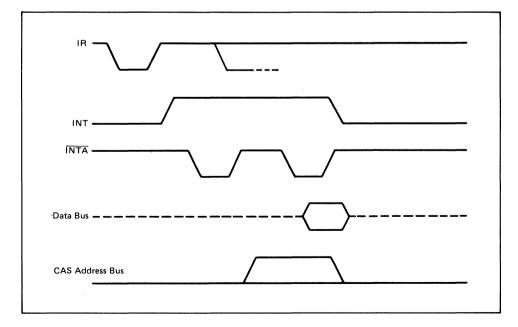




# INTA Sequence (85 mode)



# INTA Sequence (86 mode)

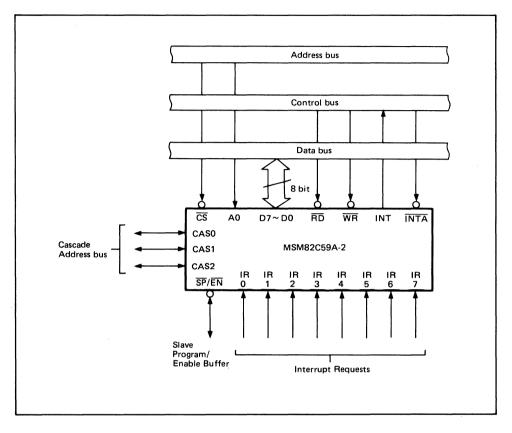


Pin Symbol	Name	Input/output	Function
D7 ~ D0	Bidirectional data bus	Input/output	This 3-state 8-bit bidirectional data bus is used in reading sta- tus registers and writing command words through the RD/WR signal from the CPU, and also in reading the CALL instruc- tion code by the INTA signal from the CPU.
<u>cs</u>	Chip select input	Input	Data transfer with the CPU is enabled by $\overline{RD}\overline{MR}$ when this pin is at low level. The data bus (D0 thru D7) is switched to high impedance when the pin is at high level. Note that $\overline{CS}$ does not effect INTA.
RD	Read input	Input	Data is transferred from the 82C59A to the CPU when this pin is at low level. IRR (Interrupt Request Register), ISR (In-Service Register), IMR (Interrupt Mask Register), or a Poll word is selected by OCW3 and A0.
WR	Write input	Input	Commands are transferred from the CPU to the 82C59A when this pin is at low level.
A0	Address input	Input	This pin is used together with the $\overrightarrow{CS}$ , $\overrightarrow{WR}$ , and $\overrightarrow{RD}$ signals to write commands in the command registers, and to select and read status registers. This is normally connected to the least significant bit of the address bus. (A0 for 80C85A, and A1 for 80C86/88).
CAS0 ~ 2	Cascade address	Input/output	These pins are outputs when the 82C59A is used as the master, and inputs when used as a slave (in cascade mode). These pins are outputs when in single mode.
SP/EN	Slave program input/enable buffer output	Input/output	This dual function pin is used as an output to enable the data bus buffer in Buffered mode, and as an input for deciding whether the 82C59A is to be master ( $\overline{SP}/\overline{EN} = 1$ ) or a slave ( $\overline{SP}/\overline{EN} = 0$ ) during Non-buffered mode.
INT	Interrupt output	Output	When an interrupt request is made to the 82C59A, the INT output is switched to high level, and INT interrupt is sent to the CPU.
INTA	Interrupt acknowledge input	Input	When this pin is at low level, the CALL instruction code or the interrupt vector data is enabled onto the data bus. When the CPU acknowledges the INT Interrupt, INTA is sent to the 82C59A. (Interrupt acknowledge sequence).
IR0 ~ 7	Interrupt request input	Input	These interrupt request input pins for the 82C59A can be set to edge trigger mode or level trigger mode (by ICW1). In edge trigger mode, interrupt request is executed by the rising edge of the IR input and holds it until that input is acknowledged by the CPU. In level trigger mode, interrupt requests are ex- ecuted by high level IR inputs and holds them until that input is acknowledged by the CPU. These pins have a pull up resistor.

# PIN FUNCTION DESCRIPTION



## SYSTEM INTERFACE



# BASIC OPERATION DESCRIPTION

Data transfers between the 82C59A internal registers and the data bus are listed below.

A0	D4	D3	RD	WR	CS	Function	Operation
0	×	x	0	1	0	IRR, ISR, or Poll word $\rightarrow$ Data bus	Read
1	x	x	0	1	0	$IMR \to Data$ bus	Read
0	0	0	1	0	0	Data bus → OCW2	Write
0	0	1	1	0	0	Data bus → OCW3	Write
0	1	x	1	0	0	'Data bus → ICWI	Write
٦	×	x	1	0	0	Data bus → OCW1, ICW2, ICW3, ICW4	Write
×	x	x	1	1	0	Data bus set to high impedance (when INTA = 1)	
×	x	x	х	x	1	Data bus set to high impedance (when INTA - T)	-
×	x	х	0	0	х	Combinations prohibited	-

## **OPERATION DESCRIPTION**

The 82C59A has been designed for real time interrupt driven microcomputer systems. The 82C59A is capable of handling up to 8 levels of interrupt requests, and can be expanded to cover a maximum of 64 levels when connected to other 82C59A devices.

Programming involves the use of system software in the same way as other microcomputer peripheral I/O

#### (1) Functional Description of Each Block

devices. Selection of priority mode involves program execution, and enables the method of requesting interrupts to be processed by the 82C59A to be suitably configured for system requirements. That is, the priority mode can be dynamically updated or reconfigured during the main program at any time. A complete interrupt structure can be defined as required, based on the entire system environment.

Block name	Description of function
IRR, ISR	IR input line interrupts are processed by a cascaded interrupt request register (IRR) and the in-service register (ISR). The IRR stores all request levels where interrupt service is requested, and the ISR stores all interrupt levels being serviced.
Priority resolver	This logic block determines the priority level of the bits set in the IRR. The highest priority level is selected, and the corresponding ISR bit is set during INTA pulses.
Read/write logic	This block is capable of receiving commands from the CPU. These command words (ICW) and the operation command words (OCW) store the various control formats for 82C59A operations. This block is also used to transfer the status of the 82C59A to the Data Bus.
Cascade buffer comparator	This functional block is involved in the output and comparison of all 82C59A IDs used in the system. These three I/O pins (CAS0 thru CAS2) are outputs when the 82C59A operates as a master, and inputs when it operates as a slave. When operating as a master, the 82C59A sends a slave ID output to the slave where an interrupt has been applied. Furthermore, the selected slave sends the preprogrammed subroutine address onto the data bus during next one or two INTA pulses from the CPU.

#### (2) Interrupt Sequence

The major features of the 82C59A used in microcomputer systems are the programmability and the addressing capability of interrupt routines. This latter feature enables direct or indirect jumping to specific interrupt routines without polling the interrupt devices. The operational sequence during an interrupt varies for different CPUs.

The procedure for the 85 system (8085A/80C85A) is outlined below.

- (i) One or more interrupt requests (IR0 thru IR7) becomes high, and the corresponding IRR bit is set.
- (ii) The 82C59A evaluates these requests, and sends an INT signal to the CPU if the request is judged to be suitable.
- (iii) The CPU issues an INTA output pulse upon reception of the INT signal.
- (iv) Upon reception of the INTA signal from the CPU, the 82C59A releases the CALL instruction code (11001101) to the 8-bit data bus.
- (v) A further two INTA pulses are then sent to the 82C59A from the CPU by this CALL instruction.

(vi) These two INTA pulses result in a preprogrammed subroutine address being sent from the 82C59A to the data bus. The lower 8bit address is released by the first INTA pulse, and the higher 8-bit address is released by the second pulse.

The Falling Edge of the second INTA signal sets the ISR bit with the highest priority, and the Rising Edge of it resets the IRR bit.

(vii) 3-byte CALL instructions are thus released by the 82C59A. In Automatic End Of Interrupt (AEOI) mode, the ISR bit is reset at the end of the third INTA pulse. In other cases, the ISR bit remains set until reception of a suitable EOI command at the end of the interrupt routine.

The procedure for the 86 system (80C86/88) is identical to the first three steps of the 85 system. The subsequent steps are described below.

(iv) Upon reception of the INTA signal from the CPU, the ISR bit with the highest priority is set, and the corresponding IRR bit is reset. In this cycle, the 82C59A sets the data bus to high impedance without driving the Data Bus.

## ■ I/O·MSM82C59A-2RS/GS/JS ■

(v) The CPU generates a second INTA output pulse, resulting in an 8-bit pointer to the data bus by the 82C59A. The Falling Edge of the INTA signal sets the

ISR bit with the highest priority, and the Rising Edge of it resets the IRR bit.

(vi) This completes the interrupt cycle. In AEOI mode, the ISR bit is reset at the end of the second  $\overline{\text{INTA}}$  pulse. In other cases, the ISR bit remains set until reception of a suitable EOI command at the end of the interrupt routine.

If the interrupt request is cancelled prior to step (iv), that is, before the first  $\overline{INTA}$  pulse has been received, the 82C59A operates as if a level 7 interrupt has been received, and the vector byte and CAS line operate as if a level 7 interrupt has been requested.

#### (3) Interrupt Sequence Output 85 Mode (80C85A)

The sequence in this case consists of three  $\overline{INTA}$  pulses. A CALL operation code is released to the data bus by the first  $\overline{INTA}$  pulse.

Contents of the first interrupt vector byte

	D7	D6	D5	D4	D3	D2	D1	D0
CALL code	1	1	0	0	1	1	0	1

The lower address of the interrupt service routine is released to the data bus by the second INTA pulse. If  $A5 \sim A7$  is programmed with an address interval of 4,  $A0 \sim A4$ , is automatically inserted. And if A6 and A7 are programmed at an address interval of 8,  $A0 \sim A5$  is automatically inserted.

Contents of the second interrupt vector byte

IR	Interval = 4								
	D7	D6	D5	D4	D3	D2	D1	D0	
7	A7	A6	A5	1	1	1	0	0	
6	A7	A6	A5	1	1	0	0	0	
5	A7	A6	A5	1	0	1	0	0	
4	A7	A6	A5	1	0	0	0	0	
3	A7	A6	A5	0	1	1	0	0	
2	Å7	A6	A5	0	1	0	0	0	
1	A7	A6	A5	0	0	1	0	0	
0	Α7	A6	A5	0	0	0	0	0	

IR	Interval = 8								
	D7	D6	D5	D4	D3	D2	D1	D0	
7	A7	A6	1	1	1	0	0	0	
6	Α7	A6	1	1	0	0	0	0	
5	A7	A6	1	0	1	0	0	0	
4	A7	A6	1	0	0	0	0	0	
3	A7	A6	0	1	1	0	0	0	
2	A7	A6	0	1	0	0	0	0	
1	A7	A6	0	0	1	0	0	0	
0	A7	A6	0	0	0	0	0	0	

The higher address of the interrupt service routine programmed by the second byte (A8  $\sim$  A15) of the initialization sequence is released to the data bus.

Contents of the third interrupt vector byte

D7	D6	D5	D4	D3	D2	D1	00
A15	A14	A13	A12	A11	A10	A9	A8

#### 86 Mode (80C86/88)

Apart from the two interrupt acknowledge cycles and the absence of a CALL operation code, the 86 mode is the same as the 85 mode. The first INTA cycle freezes interrupt status to resolve the priority internally in the same way as in 85 mode. When the device is used as a master, an interrupt code is issued to the cascade line at the end of the INTA pulse. During this first cycle, the data bus buffer is kept at high impedance without any data to the CPU. During the second INTA cycle, the 82C59A sends a byte of interrupt code to the CPU. Note that in 86 mode, the Address Interval (ADI) control status is ignored and A5 ~ A10 is not used.

	D7	D6	D5	D4	D3	D2	D1	D0
IR7	<b>T</b> 7	т6	Т5	Т4	тз	1	1	1
IR6	т7	т6	Т5	Т4	тз	1	1	0
IR5	T7	т6	Т5	Т4	тз	1	0	1
IR4	т7	т6	Т5	Т4	тз	1	0	0
IR3	Т7	т6	Т5	Т4	тз	0	1	1
IR2	т7	т6	Т5	Т4	т3	0	1	0
IR1	т7	т6	Т5	Т4	тз	0	0	1
IR0	<b>T</b> 7	т6	Т5	T4	т3	0	0	0

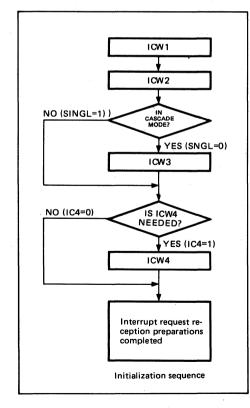
Contents of interrupt vector byte in 86 system mode

#### (4) Programming the 82C59A

The 82C59A receives two types of command words generaed by the CPU.

(i) Initialization Command Words (ICW1 thru ICW4)

Before commencing normal operations, each 82C59A in the system must be initialized by two to four  $\overline{WR}$  pulse sequence.



(ii) Operation Command Words (OCW1 thru OCW3)

These commands are used in operating the 82C59A in the following modes.

- a. Fully Nested Mode
- b. Rotating Priority Mode
- c. Special Mask Mode
- d. Polled Mode

The OCW can be written into the 82C59A any time after initialization has been completed.

#### (5) Initialization Command Words (ICW1 thru ICW4)

When a command is issued with D4 = 1 and A0 = 0, it is always regarded as an Initialization Command Word 1 (ICW1). Starting of the initialization sequence by ICW1 results in automatic execution of the following steps.

- The edge sense circuit is reset, and a low to high transition is necessary to generate an interrupt.
- b. The interrupt mask register is cleared.
- c. The IR7 input is assigned priority 7 (lowest priority)
- d. Slave mode address is set to 7.
- e. The Special Mask Mode is cleared, and the Status Read is set to IRR.
- All ICW4 functions are cleared if IC4 = 0, resulting in a change to Non-Buffered mode, no-Auto EOI, and 85 mode.
- Note: Master/slave in ICW4 can only be used in buffered mode.
- (i) Initialization Command Words 1 and 2 (ICW1 and ICW2)
  - A4 thru (Starting address of interrupt A15: service routines)

In 85 mode, 8 request levels CALL 8 locations at equivalent intervals in the memory. The memory location interval can be set at this stage to 4 or 8 by program. ( $\rightarrow$  ADI) Hence, either 32 or 64 bytes/page respectively are used in the 8 routines.

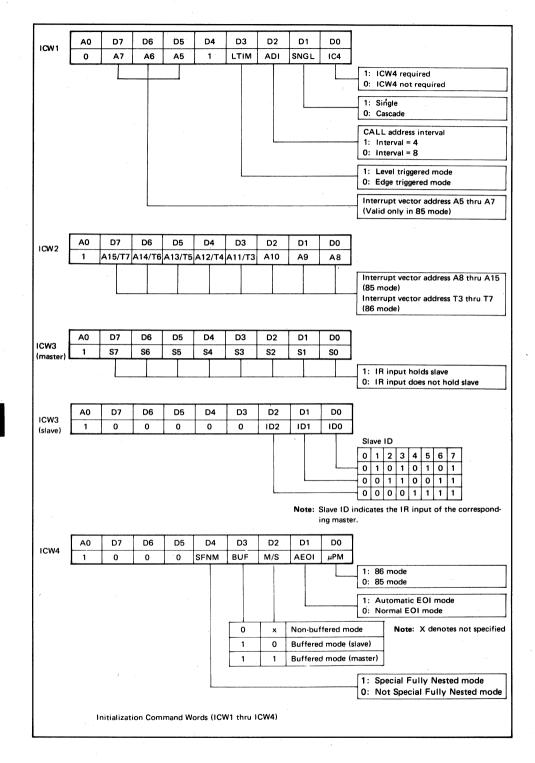
The address format is 2 bytes long (A0 thru A15). When the routine interval is 4, A0 thru A4 is inserted automatically by the 82C59A, and A5 thru A15 is programmed externally. When the interval is 8, on the other hand, A0 thru A5 are inserted automatically by the 82C59A, and A6 thru A15 are programmed externally. In 86 mode, T3 thru T7 are inserted in the 5 most significant bits of the vector type, and the 82C59A sets the 3 least significant bits according to the interrupt level. A0 thru A10 are ignored, and the ADI (address interval) has no effect.

## I/O·MSM82C59A-2RS/GS/JS

- LTIM: The 82C59A is operated in level triggered mode when LTIM = 1, and the interrupt input edge circuit becomes disabled.
- ADI: Designation of the CALL address interval. Interval = 4 when ADI = 1, and interval = 8 when ADI = 0.
- SNGL: SNGL = 1 indicates the existence of only one 82C59A in the system. ICW3 is not required when SNGL = 1.
- IC4: ICW4 is required when this bit is set, but not required when IC4 = 0.
- (ii) Initialization Command Word 3 (ICW3) This command word is written when there is more than one 82C59A used in cascade connections in the system, and is loaded into an 8-bit slave register. The functions of this slave register are listed below.
  - a. In a master mode system (BUF = 1 and M/ S = 1 in ICW4 or SP/EN = 1). "1" is set in each bit where a slave has been connected.
    - In 85 mode, the master 82C59A releases byte 1 of the CALL sequence to enable the corresponding slave to release byte 2 or 3 (only byte 2 in 86 mode) through the cascade line.

- b. In slave mode (BUF = 1 and M/S = 0 in ICW4 or  $\overline{SP}/\overline{EN}$  = 0). Bits 0 thru 2 identify the slave. The slave compares these bits with the cascade input, and releases bytes 2 and 3 of the CALL sequence (only byte 2 in 86 mode) if a matching result is obtained.
- (iii) Initialization Command Word 4 (ICW4)
  - SFNM: Special Fully Nested Mode is programmed when SFNM = 1.
  - BUF: Buffered mode is programmed when BUF = 1. In Buffered mode, SP/EN is an output, and Master/ slave is selected by the M/S bit.
  - M/S: If buffered mode is selected, the 82C59A is programmed as the master when M/S = 1, and as a slave when M/S = 0. M/S is ignored, however, when BUF = 0.
  - AEOI: Automatic End Of Interrupt mode is programmed by AEOI = 1.
  - μPM: (Microprocessor mode) The 82C59A is set to 85 system operation when μPM = 0, and to 86 system operation when μ PM = 1.

#### ■ I/O·MSM82C59A-2RS/GS/JS ■



#### (6) Operation Command Words (OCW1 thru OCW3)

When Initialization Command Words (ICW) are programmed in the 82C59A, the interrupt input line is ready to receive interrupt requests. The Operation Command Words (OCWs) enable the 82C59A to be operated in various modes while the device is in operation.

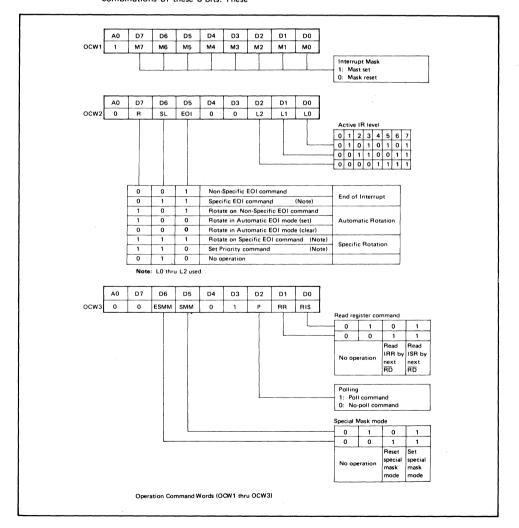
- (i) Operation Command Word 1 (OCW1) OCW1 sets and resets the mask bits of the Interrupt Mask Register (IMR). M0 thru M7 represent 8 mask bits. The channel is masked when M = 1, but is enabled when M = 0.
- (ii) Operation Command Word 2 (OCW2)
   R, SL, The Priority Rotation and the End
   EOI: of Interrupt mode plus combinations of the two are controlled by combinations of these 3 bits. These

combinations are listed in the operation command word format table.

- L2, L1, These bits indicate the specified L0: interrupt level when SL = 1.
- (iii) Operation Command Word 3 (OCW3)

ESMM: This enables the Special Mask Mode. The special mask mode can be set and reset by the SMM bit when ESMM = 1. The SMM bit is ignored when ESMM = 0.

SMM: (Special Mask Mode) The 82C59A is set to Special Mask Mode when ESMM = 1 and SMM = 1, and is returned to normal mask mode when ESMM = 1 and SMM = 0. SMM is ignored when ESMM = 0.



#### (7) Fully Nested Mode

As long as the 82C59A has not been programmed to another mode, this Fully Nested mode is set automatically after initialization. The interrupt requests are ordered in priority sequentially from 0 to 7 (where 0 represents highest priority). If an interrupt is then requested and is acknowledged highest priority, a corresponding vector address is released, and the corresponding bit in the in-service register (ISR) is set. The IS bit remains set until an End of Interrupt (EOI) command is issued from the microprocessor before returning from the interrupt service routine, or until the rising edge of the last INTA pulse arrives when the AEOI bit has been set.

When the IS bit is set, interrupts of the same or lower priority are inhibited - only interrupts of higher priority can be generated. In this case, interrupts can be ackowledged only when the internal interrupt enable F/F in the microprocessor has been enabled again through software. Following the initialization sequence, IRO has the highest priority, and IR7 has the lowest. This priority can be changed by rotating priority mode in OCW2.

#### (8) End of Interrupt (EOI)

When the AEOI bit in ICW4 is set, the in-service (IS) bit is automatically reset by the rising edge of the last  $\overline{INTA}$  pulse, or else is reset only when an EOI command is issued to the 82C59A prior to returning from the interrupt service routine.

And in cascade mode, the EOI command must be issued twice - once for the master, and once for the corresponding slave.

EOI commands are classified into specific EOI commands and Non-Specific EOI commands. When the 82C59A is operated in Fully Nested mode, the IS bit to be reset can be determined on EOI. If the Non-Specific EOI command is issued. the highest IS bit of those that are set is reset automatically, because the highest IS level is always the last servicing level in the Fully Nested mode. If, however, it is not in the fully Nested mode, the 82C59A will no longer be able to determine the last acknowledged level. In this case, it will be necessary to issue a Specific EOI which includes the IS level to be reset as part of the command. When the 82C59A is in Special Mask mode, care must be taken to ensure that IS bits masked by the IMR bit can not reset by the Non-Specific EOI.

#### (9) Automatic End of Interrupt (AEOI) Mode

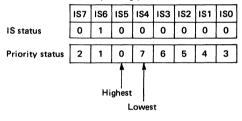
When AEOI = 1 in ICW4, the 82C59A continues to operate in AEOI mode until programmed again by ICW4. In this mode, the 82C59A automatically performs Non-Specific EOI operation at the rising edge of the last INTA pulse (the third pulse in 85 systems, and the second pulse in 86 systems). In terms of systems, this mode is best used in nested multiple level interrupt configurations. It is not necessary when there is only one 82C59A. AEOI mode is only used in a master 82C59A device, not in a slave.

#### (10) Automatic Rotation (Devices with Equal Priority) In some applications, there is often a number of devices with equal priority. In this mode, the device where an interrupt service has just been completed is set to the lowest priority. At worst, therefore, a particular interrupt request device may have to wait for seven other devices to be serviced at least once each. There are two methods for Automatic Rotation using OCW2 - Rotation on Non-Specific EOI command, and Rotation in Automatic EOI mode.

Before Rotation (IR4 the highest priority requesting service)



After Rotation (IR4 was serviced, all other priorities rotated correspondingly)



#### (11) Specific Rotation (Specific Priority)

All priority levels can be changed by programming the lowest priority level (Set Priority Command in OCW2). For example, if IR5 is programmed as the device of lowest priority, IR6 will have the highest priority. In this mode, the internal status can be updated during OCW2 by software control. This is unrelated, however, to the EOI command in the same OCW2.

Priority level can also be changed by using the OCW2 Rotate On Specific EOI command.

#### (12) Interrupt Mask

Interrupt inputs can be masked individually by Interrupt Mask Registers (IMR) programmed through the OCW1. Each interrupt channel is masked (disabled) when the respective IMR bit is set to "1". IRO is masked by bit 0, and IR1 is masked by bit 1. Masking of any particular channel has no effect on other channels.

#### (13) Special Mask Mode

In some applications, there is a need for dynamic updating of the system's priority level structure by software control during execution of an interrupt service routine. For example, it may be necessary to inhibit the lower priority requests for part of the execution of a certain routine while enabling for another part. In this case, it is difficult to enable all lower priority requests if the IS bit has not yet been reset by the EOI command after an interrupt request has been acknowledged (during execution of a service routine). All of these requests would normally be disabled.

Hence the use of the Special Mask mode. When a mask bit is set by OCW1 in this mode, the corresponding interrupt level requests are disabled. And all other unmasked level requests (at both higher and lower priority levels) are enabled. Interrupts can thus be enabled selectively by loading the mask register.

In this mode, the specific EOI Command should be used.

This Special Mask mode is set by OCW3 ESMM = 1 and SMM = 1, and reset by ESMM = 1 and SMM = 0.

#### (14) POLL Command

In this mode, the INT output in not used, the internal interrupt enable F/F of the microprocessor is reset, and interrupt inputs are disabled. Servicing the I/O device is executed by software using the Poll command.

The Poll command is issued by setting P in OCW3 to "1". The 82C59A regards the next  $\overline{RD}$  pulse as reception of an interrupt, and if there is a request, the corresponding IS bit is set and the priority level is read out. Interrupts are frozen between  $\overline{WR}$  and  $\overline{RD}$ .

	D7	D6	D5	D4	D3	D2	D1	D0
Poll word	1	0	0	0	0	W2	W1	WO

W0 thru W2: Binary coded highest priority level of service being requested.

1: Set to "1" when there is an interrupt.

This mode is useful when there is a common routine for a number of levels, and the  $\overline{\text{INTA}}$  sequence is not required. ROM space can thus be saved.

#### (15) Reading 82C59A Status

The status of a number of internal registers can be read out for updating user information on the system. The following registers can be read by means of OCW3 (IRR and ISR) and OCW1 (IMR).

- a. IRR: (Interrupt Request Register) 8-bit register for storing interrupt requesting levels.
- b. ISR: (In-Service Register) 8-bit register for storing priority levels being serviced.

c. IMR: (Interrupt Mask Register) 8-bit register for storing interrupt request lines to be masked.

The IRR can be read when a Read Register Command is issued with OCW3 (RR = 1 and RIS = 0) prior to the  $\overline{RD}$  pulse, and the ISR can be read when a Read Register Command is issued with OCW3 (RR = 1 and RIS = 1) prior to the  $\overline{RD}$  pulse. And as long as the read status does not change, OCW3 is not required each time before the status is read. This is because the 82C59A remembers whether IRR or ISR was selected by the previous OCW3. But this is not true when poll is used.

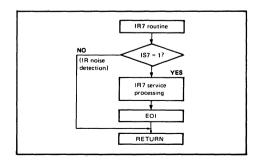
The 82C59A is set to IRR after initialization. OCW3 is not required to read IMR. IMR is issued to the data bus if  $\overline{RD} = 0$  and A0 = 1 (OCW1). Reading status is disabled by polling when P = 1 and RR = 1 in OCW3.

#### (16) Edge and Level Trigger Mode

This mode is programmed by using bit 3 (LTIM) in ICW1. When LTIM = 0, the interrupt request is recognized by the IR input transition from Low to High. As long as the IR input is kept at High, no other interrupt is generated. Since interrupt requests are recognized by the IR input "H" level when LTIM = 1, edge detection is not required.

The interrupt request must be cancelled before output of the EOI command, and before the interrupt is enabled in order to prevent the generation of a second interrupt by the CPU.

The IR input must be held at High level until the falling edge of the first INTA pulse, irrespective of whether edge sense or level sense is employed. If the IR input is switched to Low level before the first INTA pulse, the default IR7 is generated when the interrupt is acknowledged by the CPU. This can be an effective safeguard to be adopted to detect interrupts generated by the noise glitches on the IR inputs. To take advantage of this feature, the IR7 routine is used as a "clean up" routine where the routine is simply executing a return instruction and the interrupt is subsequently ignored. When the IR7 is required for other purposes, the default IR7 can be detected by reading the ISR. Although correct IR7 interrupts involve setting of the corresponding ISR bit, the default IR7 is not set.



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#### (17) Special Fully Nested Mode

This mode is used in large systems where the cascade mode is used and the respective Interrupt Requests within each slave have to be given priority levels. In this case, the Special Fully Nested mode is programmed to the master by using ICW4. This mode is practically identical to the normal Fully Nested mode, but differs in the following two respects.

- a. When an interrupt request is received from a particular slave during servicing, a new interrupt request from an IR with a higher priority level than the interrupt level of the slave being serviced is recognized by the master and the interrupt is applied to the processor without the master priority logic being inhibited by the slave. In normal Fully Nested mode, if the request is in service, a slave is masked and no other requests can be recognized from the same slave.
- b. When exiting from an interrupt service routine, it is first necessary to check whether or not the interrupt which has just been serviced by software was the only interrupt from that slave. This is done by sending a Non-Specific EOI command to that slave, followed by reading of the In-Service Register (ISR) to see whether that register has become all 'O'. A Non-Specific EOI is sent to the master too if the ISR is empty, and if not no EOI should be sent.

#### (18) Buffered Mode

Control for buffer enabling is required when the 82C59A is used in a large system where a data bus drive buffer is needed and cascade mode is used. When buffered mode is selected, the 82C59A sends an enable signal on the  $\overline{SP}/\overline{EN}$  pin to enable the buffer. In this mode, the  $\overline{SP}/\overline{EN}$  output always becomes active while the 82C59A's data bus output is enabled. Therefore, the 82C59A requires programming to enable it to distinguish master from slave. Buffered mode is programmed by bit 3 in ICW4, and the ability to distinguish master from slave is programmed by bit 2 in ICW4.

#### (19) Cascade Mode

To enable the 82C59A to handle up to 64 priority levels, a maximum of 8 slaves can be easily connected to one master device.

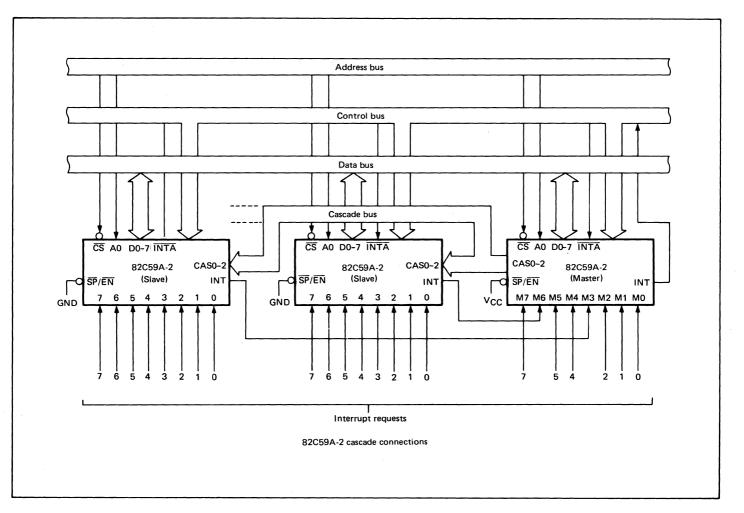
The master controls the slaves through three cascade lines, the cascade bus executes like a slave chip select during the INTA sequence.

In cascade configuration, slave interrupt outputs (INT) are connected to master interrupt request inputs (IR). When a slave IR becomes active and is acknowledged, the master enables the corresponding slave to release the routine address for that device during bytes 2 and 3 (only byte 2 in 86 mode) of the INTA sequence.

The cascade bus line is normally kept at low level, and holds the slave address during the period from the rising edge of the  $\frac{first}{INTA}$  pulse up to the rising edge of the third  $\overline{INTA}$  pulse (or the second  $\overline{INTA}$  pulse in 86 mode).

Each 82C59A device in the system can operate in different modes in accordance with their initialization sequences. EOI commands must be issued twice, once for the master once for the corresponding slave. Each 82C59A requires an address decoder to activate the respective chip select (CS) inputs.

Since the cascade line is normally kept at low level, note that slaves must be connected to the master IRO only after all slaves have been connected to the other IRs.

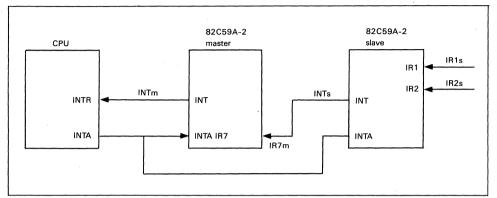


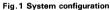
## ■ I/O·MSM82C59A-2RS/GS/JS

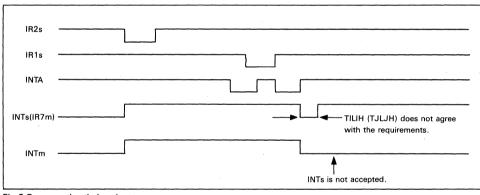
#### Precautions for operation

Contents: In the case of a cascade edge trigger, the low level width (TILIH) of a slave INT signal may be less than the low level width (TJLJH:100 nS min.) of a master IR input signal.

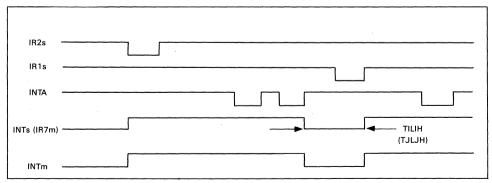
This occurs when an interruption request with high order priority is provided to the slave unit before the INTA cycle ends. Fig.1 shows a system configuration, Fig.2 a bug operation timing chart, and Fig.3 a normal operation timing chart. TILIH is not specified.

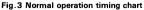












# **OKI semiconductor** MSM82C84A-2RS/GS/JS

CLOCK GENERATOR AND DRIVER

## GENERAL DESCRIPTION

The MSM82C84A-2RS/GS is a clock generator designed to generate MSM80C86 and MSM80C88 system clocks. Due to the use of silicon gate CMOS technology, standby current is only 40 μA (MAX.), and the power consumption is very low with 16 mA (MAX.) when a 8 MHz clock is generated.

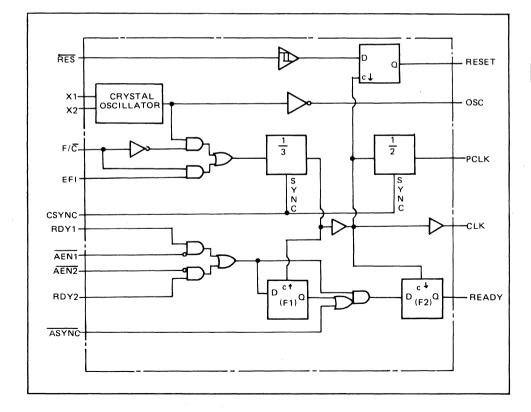
## FEATURES

- Operating frequency of 6 to 24 MHz (CLK output 2 to 8 MHz)
- $^{\bullet}\,3\mu$  silicon gate CMOS technology for low power consumption

FUNCTIONAL BLOCK DIAGRAM

- \* Built-in crystal oscillator circuit
- \* 3V ~ 6V single power supply

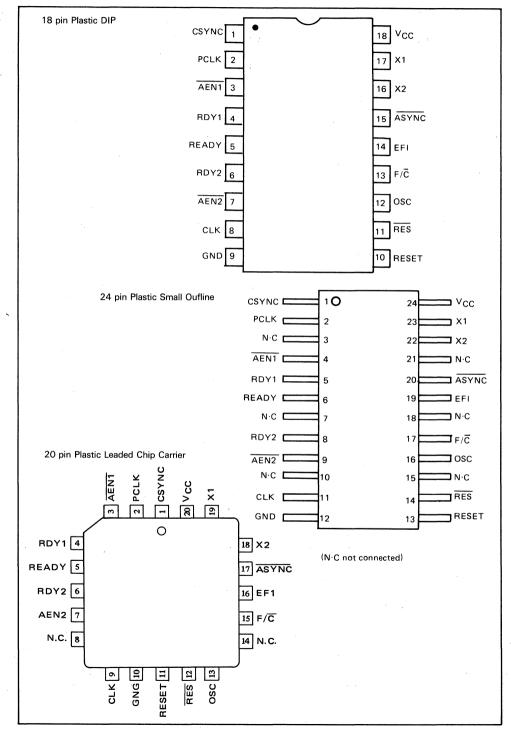
- \*Built-in synchronized circuit for MSM80C86 and MSM80C88 READY and RESET
- TTL compatible
- \* Built-in Schmitt trigger circuit (RES input)
- 18 pin Plastic DIP (DIP18-P-300)
- · 20 pin PLCC (QFJ20-P-S350)
- · 24 pin-V Plastic SOP (SOP24-P-430-VK)



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I/O·MSM82C84A-2RS/GS/JS =-

## **PIN CONFIGURATION**



5

Parameter	Symbol	Li	mits	Unit	Conditions	
		MSM82C84A-2RS/JS	MSM82C84A-2GS			
Supply Voltage	Vcc	-0.5	5~+7	V		
Input Voltage	VIN	-0.5 ~	V <sub>CC</sub> +0.5	v	Respect to GND	
Output Voltage	Vout	$-0.5 \sim V_{CC}$ +0.5		v		
Storage Temperature	Tstg	-55 ~ +150		°C		
Power Dissipation	PD	0.8	0.7	w	Ta = 25° C	

## ABSOLUTE MAXIMUM RATINGS

## **OPERATING RANGES**

Parameter	Symbol	Limits	Unit
Supply Voltage	V <sub>CC</sub>	3~6	V
Operating Temperature	Т <sub>ОР</sub>	-40 ~ +85	°C

## RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN	ТҮР	MAX	Unit
Supply Voltage	V <sub>CC</sub>	4.5	5	5.5	v
Operating Temperature	ТОР	-40	+25	+85	°C
"L" Level Input Voltage	VIL	-0.5		+0.8	v
"H" Level Input Voltage (except RES)		2.2		N 105	V
"H" Level Input Voltage (RES)	VIH	0.6*V <sub>CC</sub>		V <sub>CC</sub> +0.5	v

## **DC CHARACTERISTICS**

 $(V_{CC} = 5V \pm 10\%, Ta = -40 \sim 85^{\circ}C)$ 

Parameter	Symbol	MIN	MAX	Unit	Conditions
"L" Level Output Voltage (CLK)	VOL		0.4	v	l <sub>OL</sub> <b>= 4</b> mA
"L" Level Output Voltage (OTHERS)	VOL	_	0.4	V	1 <sub>0L</sub> = 2.5mA
"H" Level Output Voltage (CLK)	∨он	V <sub>CC</sub> -0.4	-	v	I <sub>OH</sub> = -4mA
"H" Level Output Voltage (OTHERS)	∨он	V <sub>CC</sub> -0.4		v	IOH = -1mA
RES Input Hysteresis	V <sub>IHR</sub> V <sub>ILR</sub>	0.2 * V <sub>CC</sub>		v	
Input Leak Current (EXCEPT ASYNC)	ILI	-1	+1	μA	$0 \le V_{in} \le V_{CC}$
Input Current ( ASYNC )	LIA -	-100	+10	μΑ	$0 \le V_{in} \le V_{CC}$
Standby Supply Current	Iccs		40	μA	NOTE 1
Operating Supply Current	<sup>I</sup> cc		16	mA	f = 24MHz, C <sub>L</sub> = O <sub>p</sub> F
Input Capacitance	C <sub>in</sub>		7	pF	f = 1 MHz

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## AC CHARACTERISTICS

 $(V_{CC} = 5V \pm 10\%, Ta = -40 \sim 85^{\circ}C)$ 

(1)

Parameter	Symbol	MIN	MAX	Unit	Conc	litions
EFI "H" Pulse Width	TEHEL	13		ns	90%-90%	5
EFI "L" Pulse Width	tELEH	17		ns	10%-10%	
EFI Cycle Time	TELEL	36		ns		
Crystal Oscillator Frequency		6	24	MHz		
Set Up Time of RDY1 or RDY2 to CLK Falling Edge (Active)	<sup>t</sup> R1VCL	35		ns	ASYNC = High	
Set Up Time of RDY1 or RDY2 to CLK Rising Edge (Active)	<sup>t</sup> R1VCH	35		ns	ASYNC = Low	
Set Up Time of RDY1 or RDY2 to CLK Falling Edge (Inactive)	<sup>t</sup> R1VCL	35		ns		Output load
Hold Time of RDY1 or RDY2 to CLK Falling Edge	<sup>t</sup> CLR1X	0		ns		capacitance CLK output
Set Up Time of ASYNC to CLK Falling Edge	TAYVCL	50		ns		C <sub>L</sub> = 100pF Others 30pF
Hold Time of ASYNC to CLK Falling Edge	<sup>t</sup> CLAYX	0		ns		
Set Up Time of AEN1 (AEN2) to RDY1 (RDY2) Rising Edge	<sup>t</sup> A1.R1V	15		ns		
Hold Time of AEN1 (AEN2) to CLK Falling Edge	<sup>t</sup> CLA1X	0		ns		
Set Up Time of CSYNC to EFI Rising Edge	<sup>t</sup> YHEH	20		ns		
Hold Time of CSYNC to EFI Rising Edge	tEHYL	10		ns		
CSYNC Pulse Width	<sup>t</sup> YHYL	2 × tELEL		ns		
Set Up Time of RES to CLK Falling Edge	ti1HCL	65		ns		
Hold Time of $\overline{\text{RES}}$ to CLK Falling Edge	<sup>t</sup> CLI1H	20		ns		
Input Rising Edge Time	тісін		15	ns		
Input Falling Edge Time	<sup>t</sup> IHIL		15	ns		

Note: Parameters where timing has not been indicated in the above table are measured at  $V_L$  = 1.5V and  $V_H$  = 1.5V for both inputs and outputs.

## AC CHARACTERISTICS

 $(V_{CC} = 5V \pm 10\%, Ta = -40 \sim 85^{\circ}C)$ 

(2)

Parameter	Symbol	MIN	MAX	Unit	Conc	litions
CLK Cycle Time	<sup>t</sup> CLCL	125		ns		
CLK "H" Pulse Width	<sup>t</sup> CHCL	$\frac{1}{3}$ TCLCL + 2		ns		
CLK "L" Pulse Width	<sup>t</sup> CLCH	$\frac{2}{3}T_{CLCL} - 15$		ns		
CLK Rising and Falling Edge Times	<sup>t</sup> CH1CH2 <sup>t</sup> CL2CL1		10	ns	1.0V-3.5V	
PCLK "H" Pulse Width	<sup>t</sup> PHPL	T <sub>CLCL</sub> – 20		ns		
PCLK "L" Pulse Width	<sup>t</sup> PLPH	T <sub>CLCL</sub> - 20		ns		
Time from READY Falling Edge to CLK Falling Edge	<sup>t</sup> RYLCL	8		ns		Output load
Time from READY Rising Edge to CLK Rising Edge	<sup>t</sup> RYHCH	$\frac{2}{3}$ T <sub>CLCL</sub> – 15		ns		capacitance CLK output
Delay from CLK Falling Edge to RESET Falling Edge	<sup>t</sup> CLIL		40	ns		C <sub>L</sub> = 100pF Others 30pF
Delay from CLK Falling Edge to PCLK Rising Edge	<sup>t</sup> CLPH		22	ns		
Delay from CLK Falling Edge to PCLK Falling Edge	<sup>t</sup> CLPL		22	ns		
Delay from OSC Falling Edge to CLK Rising Edge	<sup>t</sup> OLCH	—5	22	ns		
Delay from OSC Falling Edge to CLK Falling Edge	tOLCL	2	35	ns		
Output Rising Edge Time (Except CLK)	<sup>t</sup> OLOH		15	ns	0.8V~2.2V	
Output Falling Edge Time (Except CLK)	<sup>t</sup> OHOL		15	ns	2.2V~0.8V	

Note: Parameters where timing has not been indicated in the above table are measured at  $V_L$  = 1.5V and  $V_H$  = 1.5V for both inputs and outputs.

## ■ I/O·MSM82C84A-2RS/GS/JS ■-

## PIN DESCRIPTION

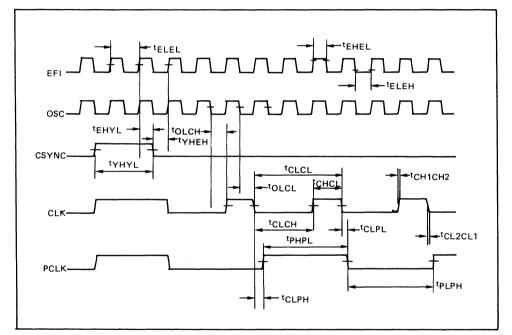
Pin symbol	Name	Input/ output	Function
CSYNC	Clock synchronization singal	Input	Synchronizing signal for output of in-phase CLK signals when more than one MSM82C84A-2 is used. The internal counter is reset when this signal is at high level, and a high level CLK output is generated. The internal counter is sub- seqently activated and a 33% duty CLK output is generated when this signal is switched to low level. When this signal is used, external synchronization of EFI is necessary. When the internal oscillator is used, it is necessary for this pin to b kept to be low level.
PCLK	Peripheral clock output	Output	This peripheral circuit clock signal is output in a 50% duty cycle at a frequency half that of the clock signal.
AEN1 AEN2	Address enable signals	Input	The AEN1 signal enables RDY1, and the AEN2 signal enables RDY2. The respective RDY inputs are activated when the level applied to these pins is low. Although two separate inputs are used in multi-master systems, only the AEN which enables the RDY input to be used is to be switched to low level in the case of not using multi-master systems.
RDY1 RDY2	Bus ready signals	Input	Completion of data bus reading and writing by the device connected to the system data bus is indicated when one of these signals is switched to high level. The relevant RDY input is enables only when the corresponding $\overline{\text{AEN}}$ is at low level.
READY	Ready output	Output	This signal is obtained by synchronizing the bus ready signal with CLK. This signal is output after guaranteeing the hold time for the CPU in phase with the RDY input.
CLK	Clock output	Output	This signal is the clock used by the CPU and peripheral devices con- nected to the CPU system data bus. The output waveform is gener- ated in a 33% duty cycle at a frequency 1/3 the oscillating frequency of the crystal oscillator connected to the X1 and X2 pins, or at a frequency 1/3 the EFI input frequency.
RES	Reset in	Input	This low-level active input is used to generate a CPU reset signal. Since a Schmitt trigger is included in the input circuit for this signal, "power on resetting" can be achieved by connection of a simple RC circuit.
RESET	Reset output	Output	This signal is obtained by CLK synchronization of the input signal applied to RES and is output in opposite phase to the RES input. This signal is applied to the CPU as the system reset signal.
F/C	Clock select signal	Input	This signal selects the fundamental signal for generation of the CLK signal. The CLK is generated from the crystal oscillator output when this signal is at low level, and from the EFI input signal when at high level.
EFI	External clock signal	Input	The signal applied to this input pin generates the CLK signal when $F/\overline{C}$ is at high level. The frequency of the input signal needs to be three times greater than the desired CLK frequency.
X1, X2	Crystal oscillator connecting pins	Input	Crystal oscillator connections. The crystal oscillator frequency needs to be three times greater than the desired CLK frequency.
OSC	Crystal resonator output	Output	Crystal oscillator output. This output frequency is the same as the oscillating frequency of the oscillator connected to the X1 and X2 pins. As long as a Xtal oscillator is connected to the X1 and X2 pins, this output signal can be obtained independently even if F/C is set to high level to enable the EFI input to be used for CLK generation purposes.

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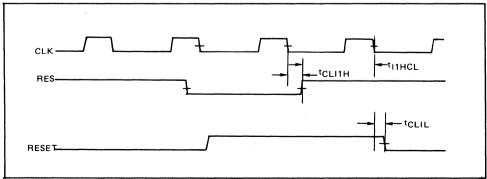
Pin symbol	Name	Input/ output	Function
ASYNC	Ready synchronization select signal	Input	Signal for selection of the synchronization mode of the READY signal generator circuit. When this signal is at low level, the READY signal is generated by double synchronization. And When at high level, the READY signal is generated by single synchronization. This pin is equipped with internal pull-up resister.
Vcc			+5V power supply
GND			GND

#### TIMING CHART

#### CLK · PCLK · OSC waveforms



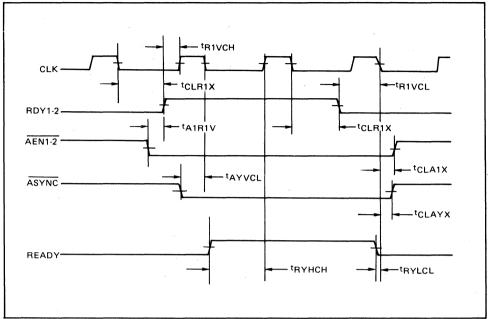




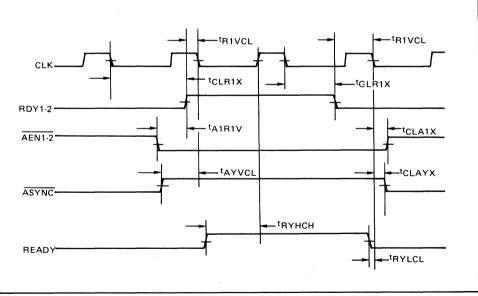
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READY waveform  $(\overline{\text{ASYNC}} = H)$ 



ĥ

### DESCRIPTION OF OPERATION

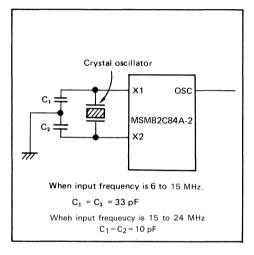
#### (1) Oscillator Circuit

The MSM82C84A-2 internal oscillator circuit can be driven by connecting a crystal oscillator to the X1 and X2 pins.

The frequency of the crystal oscillator in this case needs to be three times greater than the desired CLK frequency.

Since the oscillator circuit output (the same output as for the crystal resonator frequency) appears at the OSC pin, independent use of this output is also possible.

#### Recommended Oscillator Circuit



#### (2) Clock Generator Circuit

This circuit generates two clock outputs-CLK obtained by dividing the input external clock or crystal oscillator circuit output by three, and PCLK obtained by halving CLK. CLK and PCLK are generated from the external clock applied to the EFI pin when F/C is at high level, and are generated from the crystal oscillator circuit when at low level.

#### (3) Reset Circuit

Since a Schmitt trigger circuit is used in the  $\overline{\text{RES}}$  input, the MSM82C84A-2 can be reset by "power on" by connection to a simple RC circuit. If the 80C86 or 80C88 is used as the CPU in this case, it is necessary to keep the  $\overline{\text{RES}}$  input at low level for at least 50 ms after  $V_{CC}$  reaches the 4.5V level.

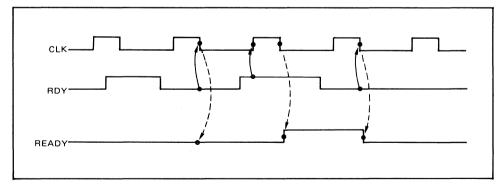
#### (4) Ready Circuit

The READY signal generator circuit can be set to synchronization mode by  $\overrightarrow{\text{ASYNC}}$ .

- (i) When ASYNC is at low level
  - The RDY input is output as the READY signal by double synchronization.

The high-level RDY input is synchronized once by the rising edge of the CLK of the first stage flipflop (F1 in the circuit diagram), and then synchronized again by the falling edge of the CLK of the next stage flip-flop (F2 in the circuit diagram), resulting in output of a high-level READY output signal (see diagram below).

 The low-level RDY input is synchronized directly by the falling edge of the CLK of the next stage flip-flop, resulting in output of a low-level READY output signal (see diagram below).

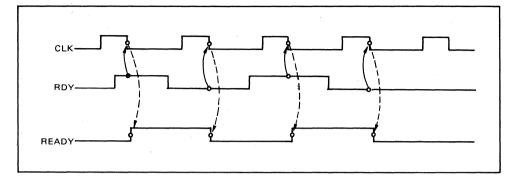


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 When ASYNC is at high level The RDY input is output as the READY signal by single synchronization.

Both low-level and high-level RDY inputs are

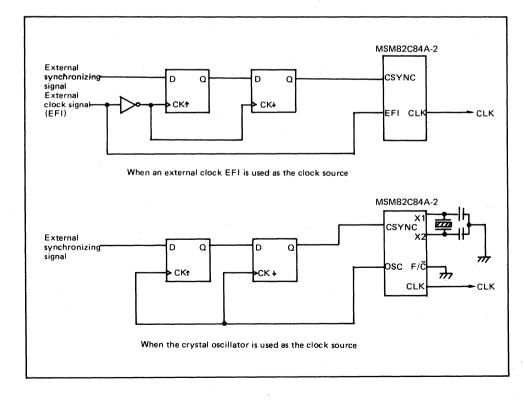
synchronized by the falling edge of the CLK of the next stage flip-flop, resulting in output of respective low-level and high-level READY output signals (see diagram below).



#### EXAMPLE OF USE (CSYNC)

The 82C84A-2 1/3 frequency divider counter is unsettled when the power is switched on. Therefore, the CSYNC pin has been included to synchronize CLK with another signal. When CSYNC is at high level, both CLK and PCLK are high-level outputs. If CSYNC is then switched to low level, CLK is output from the next input clock rising edge, and is divided by 3.

If CSYNC has not been synchronized with the input clock, use the following circuit to achieve the required synchronization



## **OKI** semiconductor MSM82C88-2RS/GS/JS

**BUS CONTROLLER** 

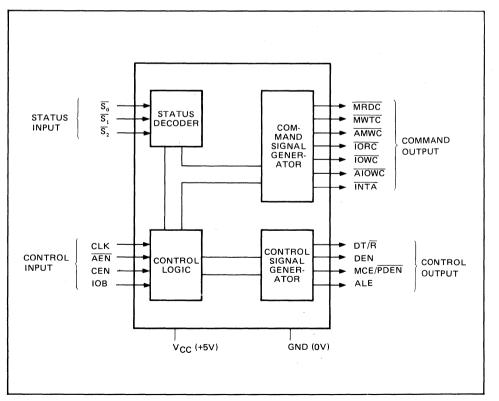
## **GENERAL DESCRIPTION**

The MSM82C88 is a bus controller for the MSM80C86 and the MSM80C88 CPUs. Based on silicon gate CMOS technology, a low-power 16-bit microprocessor system can be realized.

The MSM82C88 generates commands contol timing signals on reception of status signals from the CPU.

## FEATURES

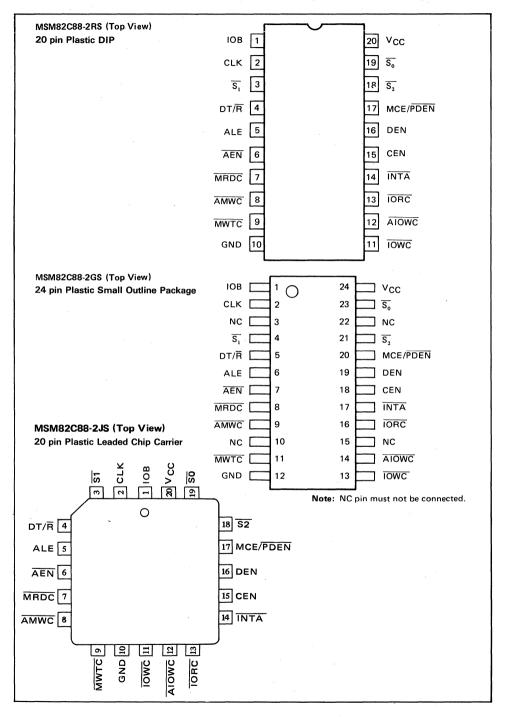
- Silicon gate CMOS technology for low power consumption
- 3 to 6V wide voltage range and single power supply
- -40 to 85°C wide guaranteed operating temperature range
- Advanced write control output
- Three-state command output driver
- System bus mode & I/O bus mode
- •20 pin Plastic Skinny DIP (DIP20-P-300-SI)
- •20 pin PLCC (QFJ20-P-S350)
- 24 pin Plastic SOP (SOP24-P)
- •24 pin-V Plastic SOP (SOP24-P-430-VK)



**CIRCUIT CONFIGURATION** 

I/O·MSM82C88-2RS/GS/JS =

#### **PIN CONFIGURATION**



## ABSOLUTE MAXIMUM RATINGS

Parameter	Cumbel	Que disient	Lin	1.1-:+	
	Symbol	Conditions	MSM82C88-2RS/JS	MSM82C88-2GS	Unit
Power Supply Voltage	VCC		-0.5	v	
Input Voltage	VIN	With respect to GND	-0.5 ~ \	V	
Output Voltage	Vout		-0.5 ~ \	V	
Storage Temperature	Tstg	-	-55 ~ 150		°C
Power Dissipation	PD	Ta = 25°C	0.7	0.7	w

## OPERATING RANGES

Parameter	Symbol	Limits	Unit
Power Supply Voltage	Vcc	4.5 ~ 5.5	V
Operating Temperature	T <sub>OP</sub>	-40 ~ 85	°C

## **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Min.	Тур.	Ma×.	Unit
Power Supply Voltage	Vcc	4.5	5	5.5	V
Operating Temperature	Тор	-40	+25	+85	°C
"L" Input Voltage	VIL1	-0.3	—	+0.8	v
"H" Input Voltage	VIH1	3.0	-	V <sub>CC</sub> +0.3	v
"L" Input Voltage	VIL2	0.3	-	+0.8	v
"H" Input Voltage	VIH2	2.2		V <sub>CC</sub> +0.3	V

Note:  $V_{1L1}$  and  $V_{1H1}$  are input voltages for CLK,  $\overline{s_0}$ ,  $\overline{s_1}$ , and  $\overline{s_2}$ . V<sub>1L2</sub> and V<sub>1H2</sub> are input voltages for  $\overline{\text{AEN}}$ , CEN, and IOB.

## DC CHARACTERISTICS

 $(V_{CC} = 4.5V \text{ to } 5.5V, \text{ Ta} = -40^{\circ}\text{C to } +85^{\circ}\text{C})$ 

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remarks
"L" Output Voltage	Vol	Command output I <sub>OL</sub> = 20mA	-	-	0.5	v	
	VOL	Control output I <sub>OL</sub> = 8mA	-	-	0.45	v	
"H" Output Voltage	Nou	Command output IOH = -8mA	3.7	-	. –	v	
H Output vonage	vон	Control output I <sub>OH</sub> = -4mA	3.7	-		v	
Input Leak Current	ILI.	$0 \le V_{IN} \le V_{CC}$	10	-	10	μA	Note 1
Output Leak Current	ILO.	$0 \le V_{OUT} \le V_{CC}$	-10	-	10	μA	
Status Input Current	LIS	$0 \le V_{IN} \le V_{CC}$	-100	-	10	μA	Note 2
Operation Power Supply Current	lcco	C <sub>L</sub> = 0pF t <sub>CLCL</sub> = 200ns	_	_	10	mA	
Standby Power Supply Current	lccs	Note 3	_	-	100	μA	

Note 1. This input leak current is the leak current on input pins except status inputs ( $\overline{s}_0$ ,  $\overline{s}_1$ , and  $\overline{s}_2$ ).

Note 2. The status input leak current is the leak current at the status inputs  $(\overline{s_0}, \overline{s_1}, \text{and } \overline{s_2})$ .

Note 3. The measuring conditions for the standby power supply current include the  $\overline{s_0}$ ,  $\overline{s_1}$ , and  $\overline{s_2}$  status inputs being at V<sub>CC</sub> potential, and the other inputs being at V<sub>CC</sub> or GND. All output pins are left open.

## AC CHARACTERISTICS

 $(V_{CC} = 4.5V \text{ to } 5.5V, Ta = -40^{\circ} \text{ C to } +85^{\circ} \text{ C})$ 

#### **Timing conditions**

Parameter	Symbol	Min.	Max.	Unit
Clock Cycle	<sup>t</sup> CLCL	125	-	nS
Clock Low Time	<sup>t</sup> CLCH	66	-	nS
Clock High Time	<sup>t</sup> CHCL	40	· _	nS
Status Active Setup Time	<sup>t</sup> SVCH	35	-	nS
Status Inactive Hold Time	<sup>t</sup> CHSV	10	-	nS
Status Inactive Setup Time	<sup>t</sup> SHCL	35		nS
Status Active Hold Time	<sup>t</sup> CLSH	10		nS

#### Timing response

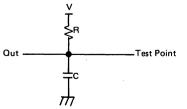
Parameter	Symbol	Min.	Max.	Unit	Test Circuit	Remarks
Delay from CLK Leading Edge to DEN, PDEN Active	<sup>t</sup> CVNV	5	45	nS	4	i
Delay from CLK Trailing Edge to DEN, PDEN Inactive	<sup>t</sup> CVNX	5	45	nS	4	
Delay from CLK Trailing to ALE Active	<sup>t</sup> CLLH	-	25	nS	4	
Delay from CLK Trailing Edge to MCE Active	<sup>t</sup> CLMCH	-	25	nS	4 ·	
Delay from Status Input Falling Edge to ALE Active	<sup>t</sup> SVLH	_	25	nS	4	
Delay from Status Input Falling Edge to MCE Active	<sup>t</sup> s∨мсн	-	30	nS	4	
Delay from CLK Leading Edge to ALE Inactive	<sup>t</sup> CHLL	4	25	nS	4	
Delay from CLK Trailing Edge to Command Output Active	<sup>t</sup> CLML	5	35	nS	3	
Delay from CLK Trailing Edge to Command Output Inactive	<sup>t</sup> CLMH	5	45	nS	3	
Delay from CLK Leading Edge to DT/R Active	<sup>t</sup> CHDTL	·	50	nS	4	
Delay from CLK Leading Edge to DT/R Inactive	<sup>t</sup> СНDТН	-	30	nS	4	
Delay from AEN Leading Edge to Command Enable	<sup>t</sup> AELCH	_	40	ņS	2	
Delay from AEN Trailing Edge to Command Disable	<sup>t</sup> AEHCZ	-	40	nS	1	
Delay from AEN Leading Edge to Command Output Active	<sup>t</sup> AELCV	100	250	nS	3	
Delay from AEN to DEN	<sup>t</sup> AEVNV	-	35	nS	4	
Delay from CEN to DEN, PDEN	<sup>t</sup> CEVNV	-	35	nS	4	
Delay from CEN to Command Output	<sup>t</sup> CELRH	-	tCLML+10	nS	3	
Output Rise Time	<sup>t</sup> OLOH	-	15	nS	3, 4	From 0.8V to 2.2V
Output Fall Time	<sup>t</sup> OHOL	-	15	nS	3, 4	From 2.2V to 0.8V

Note: AC timing measurements are made at 1.5V for both logic "1" and "0".

Input rise and fall times are

5 ± 2 nS between 0.8V and 2.2V for  $\overline{\text{AEN}}$ , CEN and IOB. 8 ± 2 nS between 0.8V and 3.0V for  $\overline{s_0}$ ,  $\overline{s_1}$ ,  $\overline{s_2}$  and CLK.

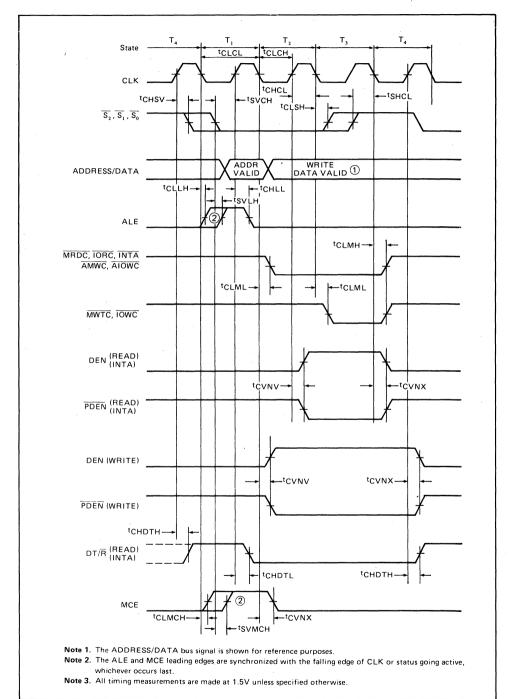
Test Circuit



Test Circuit	V(V)	R(Ω)	C <sub>(PF)</sub>
1	1.5	187	50
2	1.5	187	150
3	2.29	91	150
4	2.13	220	80

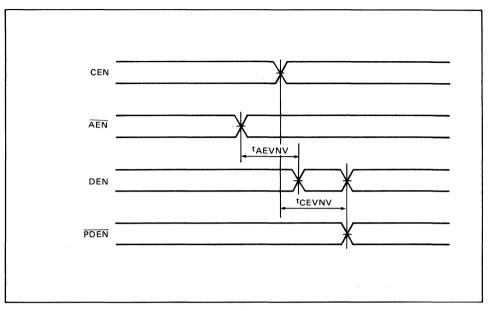
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#### TIME CHARTS

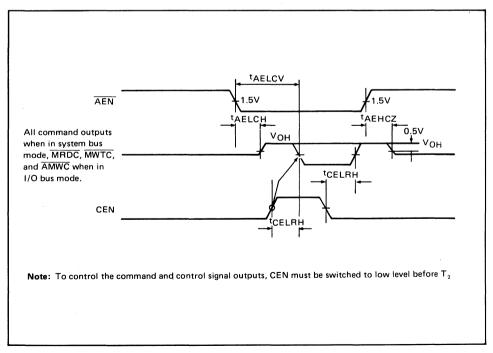


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#### DEN, PDEN Timing



#### AEN Timing



## ■ I/O·MSM82C88-2RS/GS/JS ■-

## PIN DESCRIPTION

Pin Name	Input/output	Function						
$\overline{s_0}, \overline{s_1}, \overline{s_2}$	Input	These pins are input pins for status signals $(\overline{s_0}, \overline{s_1}, \text{ and } \overline{s_2})$ , output from the CPU (MSM80C86, 80C88). The MSM82C88 generates commands and control signals after decoding these status signals. Since these pins are connected to an internal pull-up resistor, they are set to high level when the CPU status output is at high impedance.						
CLK	Input	This pin is the input pin for clock signal output from the clock generator (MSM82C84A). The timing of all MSM82C88 output signals is controlled by this clock signal.						
ALE	Output	Strobe signal for latching output address from the CPU to address latch. Address latching occurs on the trailing edge of ALE.						
DEN	Output	Control signal for setting the data bus transceiver to data enable. The local bus or system bus transceiver is enabled when this signal is high. DEN is switched to low when the CEN input is low.						
DT/R	Output	Control of the direction of data flow in the data bus transceiver. When the CPU is switched to write mode, this signal is high, and when switched to read mode, this signal is low.						
AEN	Input	<ul> <li>Address enable signal.</li> <li>IOB = L (SYSTEM BUS MODE) When the AEN input is switched to high level, all command outputs are switched to high impedance status.</li> <li>IOB = H (I/O BUS MODE) When the AEN input is switched to high level, only the MRDC, MWTC, and AMWC command outputs are switched to high impedance status.</li> </ul>						
		When $\overline{\text{AEN}}$ is switched from high to low level, high impedance command outputs are not switched to active status (low level) for at least <b>90</b> nS irrespective of the IOB input status.						
CEN	Input	Command enable signal. All command outputs, DEN and PDEN outputs are switched to inactive status when a low level input is applied to CEN. All command outputs, DEN and PDEN outputs are switched to active status when a high level input is applied to CEN.						
IOB	Input	I/O bus mode signal. The MSM82C88 is switched to I/O bus mode when a high level input is applied to IOB, and to system bus mode when a low level input is applied.						
IOWC	3-state output	This pin is active-low, and three-state output. This signal is for writing data into the I/O device.						
AIOWC	3-state output	This pin is active-low and three-state output. Although this signal is also used for writing into I/O devices like the I/O write command ( $\overline{IOWC}$ ), it is made active one clock earlier than $\overline{IOWC}$ .						
IORC	3-state output	This pin is active-low and three-state output. This signal is for reading data from I/O devices.						
MWTC	3-state output	This pin is active-low and three-state output. This signal is for writing data into memory.						
AMWC	3-state output	This pin is active-low and three-state output. Although this signal is also used for writing into memory like the memory write command (MWTC) it is made active one cycle earlier than MWTC.						
MRDC	3-state output	This pin is active low and three-state output. This signal is for reading data from memory.						
INTA	JTA         3-state         This pin is active-low and three-state output. This signal informs the output           output         rupt controller that the interrupt has been accepted, and then output of a vector address onto the data bus.							

Pin Name	Input/output	Function
MCE/PDEN	Output	This pin has two functions. MCE (IOB = Low) master cascade enable function. This is an active-high signal and is used to enable a slave PIC (priority in- terrupt controller) to read the cascade address output on the data bus by the master PIC during an interrupt sequence. PDEN (IOB = High) peripheral data enable function. This is an active-low signal and is used to enable the data bus transceiver on the I/O bus.

#### FUNCTION

#### **Command Logic**

The command output is decided by decoding status signals  $(\overline{s_0}, \overline{s_1}, \overline{s_2})$  output from the CPU.

These status signals have the following meanings.

<u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u></u>	<u>s</u> 1	s <sub>o</sub>	CPU status	Command output
0	0	0	Interrupt acknowledge	INTA
0	0	1	I/O read	IORC
0	1	0	I/O write	IOWC, AIOWC
0	1	1	Halt	—
1	0	0	Instruction fetch	MRDC
1	0	1	Memory read	MRDC
1	1	0	Memory write	MWTC, AMWC
1	1	1	Passive	-

#### I/O Bus Mode (IOB = High)

When an I/O access status signal is received from the CPU in I/O bus mode, one of the I/O commands (IORC,  $\overline{IOWC}$ ,  $\overline{AIOWC}$ , INTA) corresponding to the status signal becomes active irrespective of the  $\overline{AEN}$  status. At the same time, the  $\overline{PDEN}$  and  $DT/\overline{R}$  outputs which control the data bus transceiver are generated.

As in system bus mode, the memory commands  $(\overline{MRDC}, \overline{MWTC}, \text{ and } \overline{AMWC})$  are not switched to low level for at least 90 ns after  $\overline{AEN}$  is switched to low level.

#### System Bus Mode (IOB = Low)

When the bus is usable, the MSM82C88 is enabled by the  $\overline{AEN}$  signal from the bus arbiter. Conseuqnetly, no command output becomes active unless the  $\overline{AEN}$  signal becomes low. Also note that there is a delay of at least 90 ns before any command output becomes active after the  $\overline{AEN}$  signal is switched to low level.

System bus mode is used when more than one CPU is connected to a single bus, and the bus I/O, memory, etc. are used in common.

#### **Command Outputs**

The advanced write commands (AIOWC and AMWC) become active one cycle earlier than normal

write commands ( $\overline{\text{IOWC}}$  and  $\overline{\text{MWTC}}$ ). This prevents the CPU from being switched to an additional period of wait status.

INTA (interrupt acknowledge) is output during the interrupt acknowledge cycle in the same way as MRDC in the read cycle. The purpose of this signal is to inform the device which has requested the interrupt that the interrupt has been accepted, and requests a vector address output on the data bus.

- MRDC Memory read command
- MWTC Memory write command
- IORC I/O read command
- IOWC I/O write command
- AMWC Advanced memory write command AIOWC – Advanced I/O write command
- INTA Interrupt acknowledge

#### Control Output

The control output signals are DEN (Data Enable),  $DT/\overline{R}$  (Transmit/Receive), and MCE/PDEN (Master Cascade Enable/Peripheral Data Enable).

The DEN signal enables the local bus or system bus, when it is high.

The  $DT/\overline{R}$  signal determines the direction of the data on the local bus or system bus.

The function of the MCE/PDEN pin is switched according to IOB. The  $\overline{\text{PDEN}}$  function is selected in I/O bus mode (IOB = high) to provide the I/O or peripheral/ system bus data enable signal. When the MCE function is selected in system bus mode (IOB = low), the MCE signal is active (high) level at an interrupt acknowledge status.

The MCE signal is used when a master and slave interrupt controller exists in the system.

#### ALE (Address Latch Enable)

ALE is generated in each machine cycle to latch the current address to the address latch.

#### **CEN** (Command Enable)

This signal is used to enable command outputs. All command outputs become inactive if a low level input is applied to the CEN pin. 

# PERIPHERALS

# **OKI semiconductor** MSM5832RS

REAL TIME CLOCK/CALENDAR

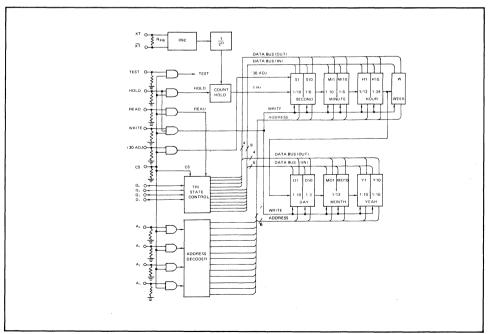
## **GENERAL DESCRIPTION**

The MSM5832RS is a metal-gate CMOS Real Time Clock/Calendar for use in bus-oriented microprocessor applications. The on-chip 32.768Hz crystal controlled oscillator time base is divided to provide addressable 4-bit I/O data of SECONDS, MINUTES, HOURS, DAY-OF-WEEK, DATE, MONTH, and YEAR. Data access is controlled by 4-bit address, chip select, read, write and hold inputs. Other functions include 12H/24H format selection, leap year identification and manual ±30 second correction.

The MSM5832RS normally operates from a 5V  $\pm$ 5% supply. Battery backup operation down to 2.2V allows continuation of time keeping when main power is off. The MSM5832RS is offered in an 18-lead dual-in-line plastic (RS suffix) package.

## **FEATURES**

- 7 Function SECOND, MINUTE, HOUR, DAY, DAY-OF-WEEK, MONTH, YEAR
- Automatic leap year calendar
- 12 or 24 hour format
- ±30 second error correction
- 4-BIT DATA BUS
- 4-BIT ADDRESS
- READ, WRITE, HOLD, and CHIP SELECT inputs
- Reference signal outputs 1024, 1, 1/60, 1/3600Hz
- \* 32.768kHz crystal controlled operation
- Single 5V power supply
- Back-up battery operation to VDD = 2.2V
- Low power dissipation 90  $\mu$ W Max. at V<sub>DD</sub> = 3V
  - 2.5 mW Max. at VDD = 5V
- 18 pin plastic DIP (DIP18-P-300)



## FUNCTIONAL BLOCK DIAGRAM

### PIN CONFIGURATION

		18 pin Plastic DIP (Top View)
A0 to A3 WRITE READ HOLD CS D0 to D3 TEST ±30 ADJ XT & XT VDD GND	<ul> <li>Write Enable</li> <li>Read Enable</li> <li>Count Hold</li> <li>Chip Select</li> <li>Data Input Output</li> <li>Test Input</li> <li>±30 Second Correction Input</li> </ul>	VDD     1     18     HOLD       WRITE     2     17     XT       READ     3     16     XT       A <sub>0</sub> 4     15     ±30 ADJ       A <sub>1</sub> 5     14     TEST       A <sub>2</sub> 6     13     GND       A <sub>3</sub> 7     12     D <sub>3</sub> CS     8     11     D <sub>2</sub> D <sub>0</sub> 9     10     D <sub>1</sub>

## **REGISTER TABLE**

	Addr Inp			Register	Dat	a Inp	ut/Oi	utput	Data	Remarks
Ao	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	Name	Do	D <sub>1</sub>	$D_2$	D <sub>3</sub>	Limit	
0	0	0	0	S1	*	*	*	*	0~9	S1 or S10 are reset to zero irrespective of input data D0–D3 when write
1	0	0	0	S10	*	*	*		0~5	instruction is executed with address selection.
0	1	0	0	MI1	*	*	*	*	0~9	
1	1	0	0	MI10	*	*	*		0~5	
0	0	1	0	H1	*	*	*	*	0~9	
1	0	1	0	H10	*	*	t	ŧ	0~1	D2 = "1" for PM D3 = "1" for 24 hour format D2 = "0" for AM D3 = "0" for 12 hour format
0	1	1	0	W	*	*.	*		0~6	÷
1	1	1	0	D1	*	*	*	*	0~9	
0	0	0	1	D10	*	*	+		0~3	D2 = "1" for 29 days in month 2 D2 = "0" for 28 days in month 2 (2)
1	0	0	1	MO1	*	*	*	*	0~9	
0	1	0	1	MO10	*				0~1	
1	1	0	1	Y1	*	*	*	*	0~9	
0	0	1	1	Y10	*	*	*	*	0~9	1

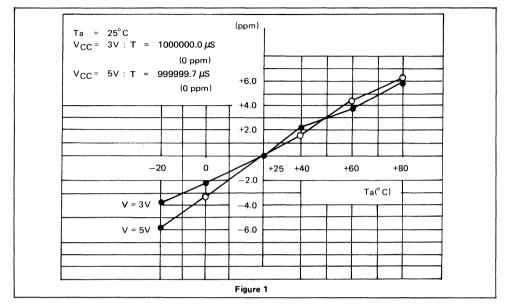
(1) \*data valid as ''0" or "1".

Blank does not exist (unrecognized during a write and held at "O" during a read) †data bits used for AM/PM, 12/24 HOUR and leap year.

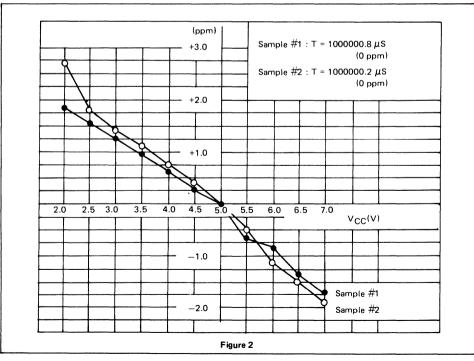
(2) If D2 previously set to "1", upon completion of month 2 day 29, D2 will be internally reset to "0".

## OSCILLATOR FREQUENCY DEVIATIONS

#### Frequency Deviation vs Temperature



#### Frequency Deviation vs Supply Voltage



## ■ PERIPHERALS MSM5832RS ■

Rating	Symbol	Value	Unit
Supply voltage	VDD	-0.3 ~ 7.0	v
Input voltage	VI	-0.3 ~ V <sub>DD</sub> + 0.3	v
Data I/O voltage	٧ō	-0.3 ~ V <sub>DD</sub> + 0.3	v
Storage Temperature	Tstg	-55 ~ 150	°C

## ABSOLUTE MAXIMUM RATINGS

## **OPERATING CONDITIONS**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Supply Voltage	VDD	4.5	5	7	v	
Standby Supply Voltage	VDH	2.2	-	7	v	
Input Signal Level	VIH	3.6	-	VDD	v	VDD = 5V ± 5%
	VIL	-0.3	-	0.8	v	Respect to GND
Crystal Oscillator Freq.	f(XT)	-	32.768		kHz	
Operating Temperature	Тор	-30	-	+85	°C	

## R

## DC CHARACTERISTICS

 $(V_{CC} = 5V \pm 5\%; T_A = -30 \text{ to } +85^{\circ}C)$ 

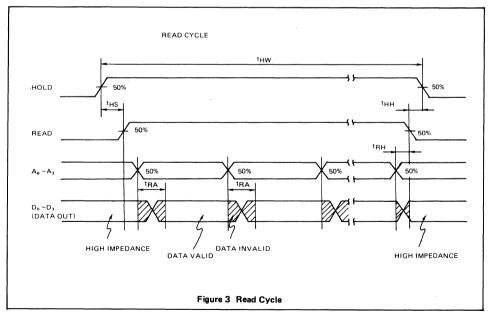
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
(.)	ЧΗ	10	25	50	μΑ	V <sub>1N</sub> =5V, V <sub>DD</sub> =5V
Input Current (1)	†IL		-	-1	μΑ	V <sub>IN</sub> = 0V
Data I/O Leakage Current	ILD.	-10	-	10	μΑ	V <sub>I/O</sub> = 0 to V <sub>DD</sub> CS = ''0''
Output Low Voltage	Vol	-	-	0.4	v	IO = 1.6 mA, CS = "1", READ = "1"
Output Low Current	IOL	1.6	_	_	mA	V <sub>O</sub> = 0.4V, CS = "1", READ = "1"
	IDDS		15	30	μΑ	$V_{CC} = 3V, T_a = 25^{\circ}C$
Operating Supply Current	IDD	-	100	500	μΑ	V <sub>CC</sub> = 5V, Ta = 25°C

(1) XT,  $\overline{XT}$  and  $D_0 \sim D_3$  excluded.

## SWITCHING CHARACTERISTICS

## (1) READ mode

				(V <sub>DD</sub> =	5V ±5%,	ra = 25°C
Parameter	Symbol	Condition	MIN	ТҮР	МАХ	Unit
HOLD Set-up Time	t <sub>HS</sub>		150	-	-	μs
HOLD Hold Time	tнн		0	-	-	μs
HOLD Pulse Width	thw		-	-	990	ms
HOLD "L" Hold Time	tHL		130	-	-	μs
READ Hold Time	<sup>t</sup> RH		0	-	-	μs
READ Set-up Time	t <sub>RS</sub>		0		-	μs
READ Access Time	<sup>t</sup> RA	R <sub>PULL-UP</sub> = 5KΩ C <sub>L</sub> = 15pF	-	-	6	μs
ADDRESS Set-up Time	tAS		3	-	-	μs
ADDRESS Hold Time	t <sub>AH</sub>		0.2	-	-	μs
READ Pulse Width	tRW	$R_{PULL-UP} = 5K\Omega$ $C_L = 15pF$	2	-	-	μs
DARA Access Time	tAC	$R_{PULL-UP} = 5K\Omega$ $C_{L} = 15pF$	-	-	0.6	μs
OUTPUT Disable Time	tOFF	R <sub>PULL-UP</sub> = 5KΩ C <sub>L</sub> = 15 pF	-	-	0.6	μs
CS Enable Delay Time	tCS1		-	-	0.6	μs
CS Disable Delay Time	t <sub>CS2</sub>		-	-	0.6	μs



Notes: 1. A Read occurs during the overlap of a high CS and a high READ.

2. CS may be a permanent "1", or may be coincident with HOLD pulse.

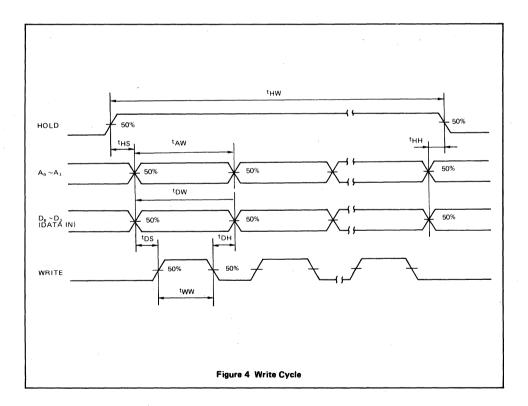
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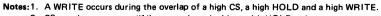
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## SWITCHING CHARACTERISTICS

## (2) WRITE mode

-,			(V <sub>DD</sub> =	DD = 5V ±5%, Ta = 25°C		
Parameter	Symbol	Condition	MIN	ТҮР	MAX	Unit
HOLD Set-up Time	tHS		150		-	μs
HOLD Bold Time	tнн		0	-	-	μs
HOLD Pulse Width	tHW		-	-	990	ms
HOLD "L" Hold Time	thl		130	-	-	μs
ADDRESS Pulse Width	tAW		1.7	-	-	μs
Data Pulse Width	tow		1.7	-	-	μs
DATA Set-up Time	t <sub>DS</sub>		0.5		-	μs
DATA Hold Time	tDH		0.2	-	. –	μs
WRITE Pulse Width	tww		1.0	-	-	μs
CS Enable Delay Time	tCS1		-		0.6	μs
CS Disoble Delay Time	tcs2		_		0.6	μs





2. CS may be permanent "1", or may be coincident with HOLD pulse.

## PIN DESCRIPTION

Name	Pin No.	Description		
VDD	1	Power supply pin. Application circuits for power supply are described in Figure 9.		
WRITE	2	Data write pin. Data write cycle is described in Figure 4.		
READ	3	Data read pin. Data read cycle is described in Figure 3.		
$A_0 \sim A_3$	4 ~ 7	Address input pins used to select internal counters for read/write operations. The address is specified by 4-bit binary code as shown in Table 1.		
CS	8	Chip slect pin which is required to interface with the external circuit. HOLD, WRITE, READ, $\pm 30$ ADJ, TEST, $D_0 \sim D_3$ and $A_0 \sim A_3$ pins are activated if CS is set at H level, while all of these pins are disabled if CS is set at L level.		
D <sub>0</sub> ~ D <sub>3</sub>	9~12	Data input/output pins (bidirectional bus). As shown in Figure 5, external pull-up registers of 4.7 kΩ ~ 10 kΩ are required by the open-drain NMOS output. D <sub>3</sub> is the MSB, while D <sub>0</sub> is the LSB $\stackrel{+5V}{\qquad \qquad $		

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#### ■ PERIPHERALS MSM5832RS ■

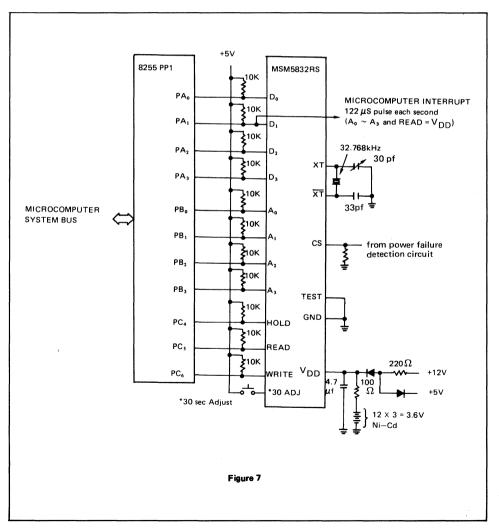
Name	Pin No.	Description
GND	13	Ground pin.
TEST	14	Test pin. Normally this pin should be left open or should be set at ground level. With CS at $V_{DD}$ , pulses to $V_{DD}$ on the TEST input will directly clock the S <sub>1</sub> , MI <sub>10</sub> , W, D <sub>1</sub> and Y <sub>1</sub> counters, depending on which counter is addressed (W and D <sub>1</sub> are selected by D <sub>1</sub> address in this mode only). Roll-over to next counter is enabled in this mode.
±30ADJ	15	This pin is used to adjust the time within the extent of $\pm$ 30 seconds. If this pin is set at H level when the seconds digits are 0 ~ 29, the seconds digits are cleared to 0. If this pin is set at H level when the seconds digits are 30 ~ 59, the second digits will be cleared to 0 and the minutes digits will be increased by +1. To enable this function, 31.25 ms or more width's pulse should be input to this pin.
хт	16	Oscillator pin. 32.768 kHz crystal, capacitor and trimmer condensor for fre- quency adjustment connected to these pins. See Figure 6. As for oscillator
хŢ	17	frequency deviation, refer to Figure 1 and Figure 2. If an external clock is to be used for the MSM5832RS's oscillation source, the external clock is to be input to XT, and XT should be left open.
	- · · ·	$\begin{array}{c} XT \\ C_1 \\ C_1 \\ C_2 \\ C_2 \\ T \\ Figure 6 \end{array}$
HOLD	18	Switching this input to V <sub>DD</sub> inhibits the internal 1 Hz clock to the S1 counter. After the specified HOLD set-up time (150 $\mu$ s), all counters will be in a static state, thus allowing error-free read or write operations. So long as the HOLD pulse width is less than 990 ms, real time accuracy will be undisturbed. Pull-down to GND is provided by an internal resistor.

Condition	Output	Reference Frequency	Pulse Width
HOLD = L	$D_0^{(1)}$	1024 Hz	duty 50%
READ = H	D1	1 Hz	122.1 μS
CS = H	D <sub>2</sub>	1/60 Hz	122.1 μS
$A_0 \sim A_3 = H$	D <sub>3</sub>	1/3600 Hz	122.1 μS

#### **REFERENCE SIGNAL OUTPUT PIN**

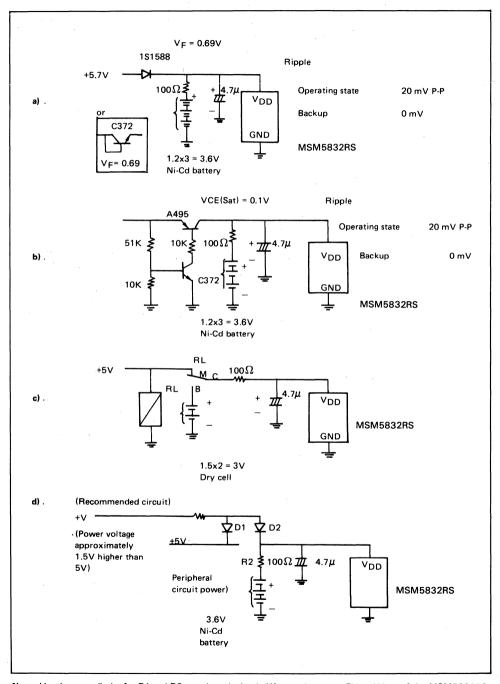
(1) 1024 Hz signal at  $D_0$  not dependent on HOLD input level.

#### APPLICATION EXAMPLE



#### APPLICATION CIRCUIT - POWER SUPPLY CIRCUIT

Open or ground unused pins (pins other than the XT,  $\overline{XT}$ , D0–D3, and  $\overline{BUSY}$  pins).



Note: Use the same diodes for D1 and D2 to reduce the level difference between +5V and VDD of the MSM5832RS.

# **OKI** semiconductor MSM58321RS

REAL TIME CLOCK/CALENDAR

### **GENERAL DESCRIPTION**

The MSM58321RS is a metal gate CMOS Real Time Clock/Calendar with a battery backup function for use in bus-oriented microprocessor applications.

The 4-bit bidirectional bus line method is used for the data I/O circuit; the clock is set, corrected, or read by accessing the memory.

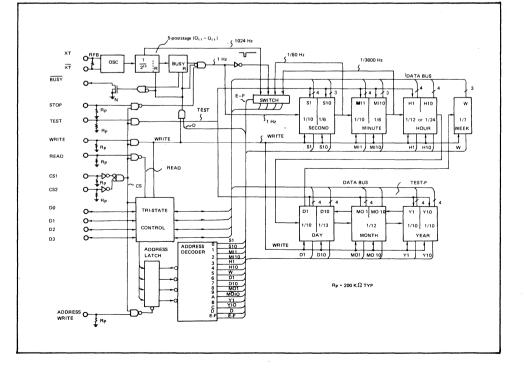
The time is read with 4-bit DATA I/O, ADDRESS WRITE, READ, and BUSY; it is written with 4-bit DATA I/O, ADDRESS WRITE, WRITE, and BUSY.

### FEATURES

- 7 Function-Second, Minute, Hour, Day, Day-of-Week, Month, Year
- Automatic leap year calender
- 12/24 hour format
- Frequency divider 5-poststage reset
- Reference signal output

- 32.768kHz crystal controlled operation
- Single 5V power supply
- Back-up battery operation to V<sub>DD</sub> = 2.2V
- Low power dissipation
  - 90 $\mu$ W max. at V<sub>DD</sub> = 3V 2.5mW max. at V<sub>DD</sub> = 5V
- 16 pin plastic DIP (DIP16-P-300)

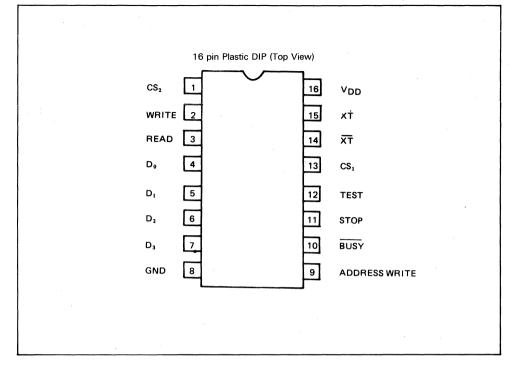
#### FUNCTIONAL BLOCK DIAGRAM



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PERIPHERALS MSM58321RS

### PIN CONFIGURATION



## REGISTER TABLE

Address		Addr	ess inpu	ıt	Register	Data input/ output																											· · · · · ·
	D <sub>0</sub> (A <sub>0</sub> )	D1 (A1)	D <sub>2</sub> (A <sub>2</sub> )	D3 (A3)	Name	D.	Dı	D <sub>2</sub>	D3	Cou	unt va	lue	Remarks																				
0	0	0	0	0	<b>S</b> 1	•	٠	*	*	0	~	9																					
1	1	0	0	0	S10	•	•	•		0	~	5																					
2	0	1	0	0	MI,	*	٠	•	٠	0	~	9																					
3	1	1	0	0	Mlio	•		•		0	~	5																					
4	0	0	1.	<u> </u>	H1	*	*	•	٠	0	~	9																					
5	1	0	1	o	H <sub>10</sub>	·	•	•	٠	0~	1 or 0	~2	D2 = 1 specifies PM, $D2 = 0$ specifies AM, $D3 = 1$ specifies 24-hour timer, and $D3 = 0$ specifies 12-hour timer. When $D3 = 1$ is written, the $D2$ bit is reset inside the IC.																				
6	0	1	1	0	w	*	*	•		0	~	6																					
7	1	1	1	0	D1	•	*	•	*	0	~	9																					
8	0	0	0	1	D1 0		*	Θ	0	0	~	3	The D2 and D3 bits in D	D10 ar	e used	to select a leap year.																	
9	1	0	0	1`	MO1	•	*	•	٠	0	~	9	Calendar	D2	D3	Remainder obtained by dividing the year number by 4																	
A	0	1	0	1	MO10			1.		0	~	1	Gregorian calendar	0	0	0																	
В	1	1	0	1	Y <sub>1</sub>				•	0	~	9	Showa	1	Q	3																	
	<u> </u>									-			4	0	1	2																	
С	0	0	1	1	Y10	•	•	•	*	0	~	9		1	1	1																	
D	1	0	1	1										when	this	he 1/2 <sup>15</sup> frequency divider and the BUSY code is latched with ADDRESS LATCH																	
E~F	. Ö/1	1	1	1												al output. Reference signals are output to with ADDRESS LATCH and READ input																	

Notes: (1) There are no bits in blank fields for data input/output. O signals are output by reading and data is not stored by writing because there are no bits. (2) The bit with marked 
(2) is used to select the 12/24-hour timer and the bits marked 
(2) are used to select a leap year. These three bits can be read or written

(3) When signals are input to bus lines D0 - D3 and ADDRESS WRITE goes to 1 for address input, ADDRESS information is latched with ADDRESS LATCH.

Parameter	Symbol	Condition	Rating	Unit
Power voltage	VDD	Ta = 25° C	-0.3 ~ 7	v
Input voltage	V,	Ta = 25° C	$\text{GND0.3} \sim \text{V}_{\text{DD}} + 0.3$	v
Output voltage	Vo	Ta = 25° C	$GND0.3 \sim V_{DD} + 0.3$	v
Storage temperature	Tstg	-	-55 ~ +150	°C

## ABSOLUTE MAXIMUM RATINGS

## **OPERATING CONDITIONS**

Parameter	Symbol	Condition	Rating	Unit
Power voltage	VDD	-	4.5 ~ 7	v
Date hold voltage	∨он	-	2.2 ~ 7	V
Crystal frequency	f(XT)	-	32.768	kHz
Operating temperature	Тор	_	-30 ~ +85	°C

Note: The data hold voltage guarantees the clock operations, though it does not guarantee operations outside the IC and data input/output.

### DC CHARACTERISTICS

 $(V_{DD} = 5 V \pm 5\%, Ta = -30 \sim +85^{\circ}C)$ 

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
H input voltage	VIH1	- Note 1	3.6	-	-	v
H mput vonage	VIH2	– Note 2	V <sub>DD</sub> 0.5		-	Ň
L input voltage	VIL	-	-	-	0.8	V
L output voltage	VOL	I <sub>O</sub> = 1.6 mA	-	-	0.4	v
L output current	IOL	V <sub>O</sub> = 0.4 V	1.6	_		mA
H input current	I <sub>IH1</sub>	V <sub>1</sub> = V <sub>DD</sub> V Note 3	10	30	80	μΑ
in input current	IIH2	V <sub>1</sub> = V <sub>DD</sub> V Note 4	-	-	1	~~~
L input current	ΗL	VI = 0 V	-	-	_1	μΑ
Input capacity	CI	f = 1 MHz	-	5	-	pF
Current consumption	IDD	f = 32.768 kHz V <sub>DD</sub> = 5V/V <sub>DD</sub> = 3V	-	100/15	500/30	μΑ

Note: 1.  $CS_2$ , WRITE, READ, ADDRESS WRITE, STOP, TEST,  $D_0 \sim D_3$ 

2. CS1

3. CS1, CS2, WRITE, READ, ADDRESS WRITE, STOP, TEST

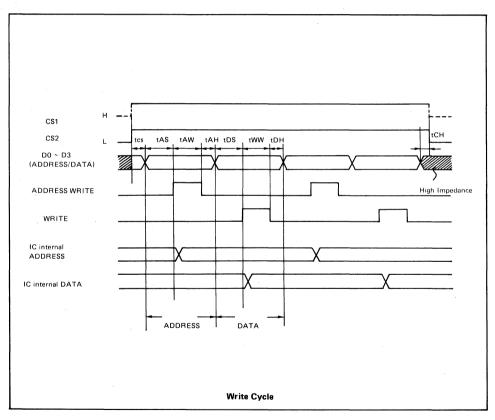
 $4. \ D_0 \sim D_3$ 

## SWITCHING CHARACTERISTICS

### (1) WRITE mode

 $(V_{DD} = 5 V \pm 5\%, Ta = 25^{\circ}C)$ 

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
CS setup time	tCS	_	0	-	_	μs
CS Hold time	<sup>t</sup> CH	-	0	-	-	μs
Address setup time	tAS	-	0	-	-	μs
Address write pulse width	tAW	. – .	0.5	-	-	μs
Address hold time	<sup>t</sup> AH	-	0.1	-	-	μs
Data setup time	tDS	-	0	-	-	μs
Write pulse width	tww	<b>-</b> .	.2	·	`	μs
Data hold time	T tDH	_ ·	0	_	· _	μs



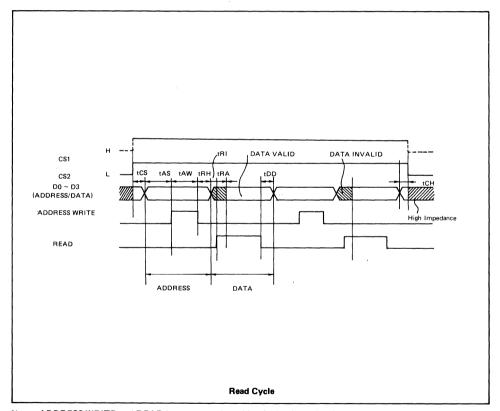
Note: ADDRESS WRITE and WRITE inputs are activated by the level, not by the edge.

#### (2) READ mode

 $(V_{DD} = 5 V \pm 5\%, Ta = 25^{\circ}C)$ 

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
CS setup time	tCS	-	0	-	_	μs
CS Hold time	<sup>t</sup> CH	_	0	_	-	μs
Address setup time	tAS	_	0	-	-	μs
Address write pulse width	tAW		0.5	-	-	μs
Address hold time	<sup>t</sup> AH	-	0.1	-	-	μs
Read access time	<sup>t</sup> RA	_	-	-	see Note 1	μs
Read delay time	tDD	-	-	-	1	μs
Read inhibit time	tRI	_	0	-	-	μs

Note 1. 
$$t_{RA} = 1 \,\mu s + CR \ln \left( \frac{V_{DD}}{V_{DD} - V_{IH} \min} \right)$$



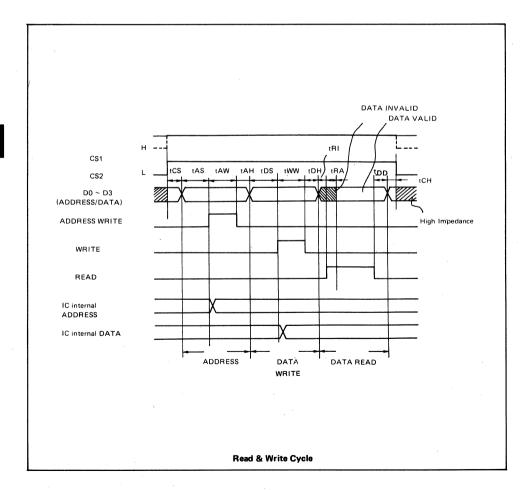
Note: ADDRESS WRITE and READ inputs are activated by the level, not by the edge.

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# (3) WRITE & READ mode

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
CS setup time	tCS	-	0	_	_ `	μs
CS hold time	<sup>t</sup> CH	_	0	-	.—	μs
Address setup time	tAS	_	0	-	-	μs
Address write pulse width	tAW		0.5	<u> </u>	<u> </u>	μs
Address hold time	<sup>t</sup> AH	_	0.1	-	-	μs
Data setup time	tDS	_ ·	0	-	-	μs
Write pulse width	tww		2	-	-	μs
Data hold time	<sup>t</sup> DH	-	0	-	-	μs
Read access time	<sup>t</sup> RA	-	_	-	see Note 1	μs
Read delay time	tDD	-	-	-	1	μs
Read inhibit time	tRI		0	-	-	μs

Note 1. 
$$t_{RA} = 1 \mu s + CR \ln \left( \frac{VDD}{VDD - V_{IH} \min} \right)$$

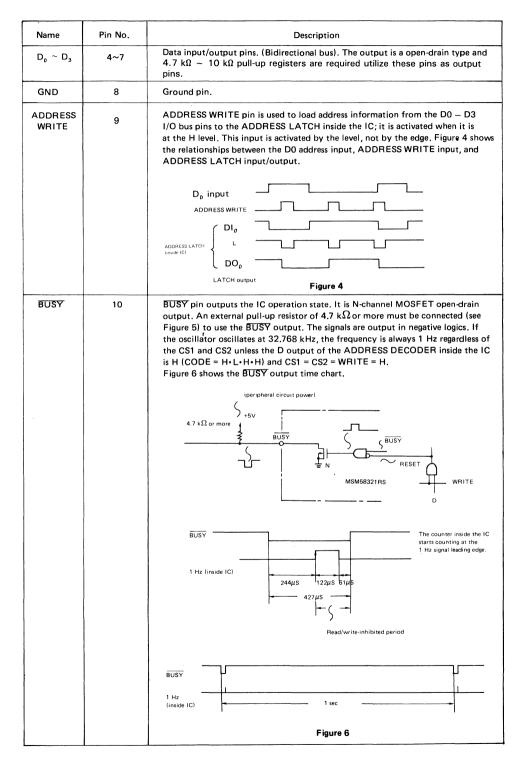


## PIN DESCRIPTION

Name	Pin No.	Description				
CS₂	1	Chip select pins. These pins enable the interface with the external circuit when both of these pins are set at H level simultanuously.				
CS1	13	If one of these pins is set at L level, STOP, TEST, WRITE, READ, ADDRESS WRITE pins and $D_0 \sim D_3$ pins are inactivated. Since the threshold voltage VT for the CS <sub>1</sub> pin is higher than that for other pins, it should be connected to the detector of power circuit and peripherals and CS <sub>2</sub> is to be connected to the microcontroller.				
WRITE	2	WRITE pin is used to write data; it is activated when it is at the H level. Data bus data inside the IC is loaded to the object digit while this WRITE pin is at the H level, not at the WRITE input edge. Refer to Figure 2 below.				
		$G_{1} = G_{2} = "H"$ $G_{1} = G_{2} = $				

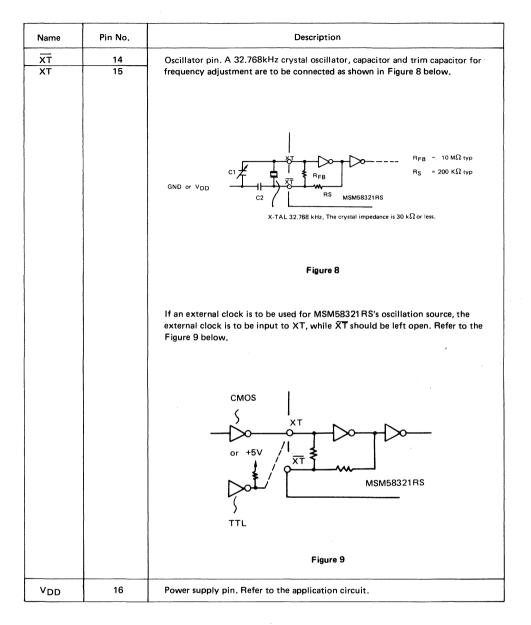
## PERIPHERALS·MSM58321RS =-

Name	Pin No.	Descrip						
READ	3	READ pin is used to read data; it is activated when it is at the H level. Address contents are latched with ADDRESS LATCH inside the IC at the D0 – D3 and ADDRESS WRITE pins to select the object digit, then an H-level signal is input to the READ pin to read data. If a count operation is continued by setting the STOP input to the L level, read operation must be performed, in principle, while the BUSY output is at the H level. While the BUSY output is at the L level, count operations are performed by digit counters and read data is not guaranteed, therefore, read operations are inhibited in this period. Figure 3 shows a time chart of the BUSY output, 1 Hz signal inside the IC, and READ input. A read operation is stopped temporarily within a period of 244 $\mu$ s from the BUSY output trailing edge and it is restarted when the BUSY output goes to the H level again.						
		BUSY       427µS       The counter inside the IC starts counting at the 1 Hz signal leading edge.         1 Hz (inside IC)       Read-enabled period       1 Hz signal leading edge.         Read-enabled period       Read-inhibited period         BUSY       Read-inhibited period         BUSY       It is used for program switching.						
		Figure 3						
		If the counter operation is stopped by setting the STOP input to the H level, read operations are enabled regardless of the BUSY output. A read operation is enabled by microcomputer software regardless of the BUSY output during the counter operation by setting the STOP input to the L level. In this method, read operations are performed two or more times continuously and data that matches twice is used as guaranteed data.						



#### PERIPHERALS·MSM58321RS

Name	Pin No.	Description
STOP	. 11	The STOP pin is used to input on/off control for a 1 Hz signal. When this pin goes to the H level, 1 Hz signals are inhibited and counting for all digits succeeding the S1 digit is stopped. When this pin goes to the L level, normal operations are performed; the digits are counted up. This STOP input controls stopping digit counting. Writing of external data in digits can be assured by setting the STOP input to the H level to stop counting, then writing sequentially from the low-order digits.
TEST	12	The TEST pin is used to test this IC; it is normally open or connected to GND. It is recommended to connect it to GND to safeguard against malfunctions from noise. The TEST pulse can be input to the following nine digits: S1, S10, MI10, H1, D1(W), M01, Y1 and Y10 When a TEST pulse is input to the D1 digit, the W digit is also counted up simultaneously.
		Input a TEST pulse as follows: Set the address to either digit explained above, then input a pulse to the TEST pin while CS1 = CS2 = STOP = H and WRITE = L. The specified and succeeding digits are counted up. (See Figure 7)
		$1 \frac{Hz}{1} \xrightarrow{C1} \frac{C1}{S1} \xrightarrow{C10} \frac{C1}{S10} \xrightarrow{C10} \frac{C10}{M11} C1$
		ן סו אף = 200 κΩ דעף <b>Figure 7</b>
		A digit is counted up at the leading edge (changing point from L to H) of a TEST pin input pulse. The pulse condition for TEST pin input at $V_{DD}$ = 5 V ±5% is described in Figure 8 below.
		$t_{H} = 10 \mu S MIN$
		τ <sub>L</sub> =10μS MIN
		Figure 8

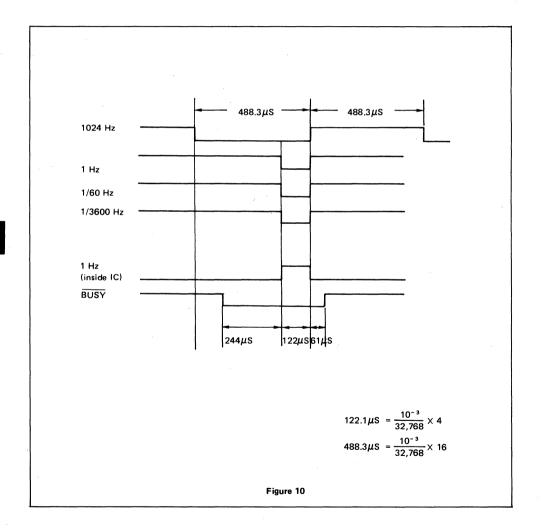


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## **REFERENCE SIGNAL OUTPUT**

Reference signals are output from the D0 - D3 pins under the following conditions:

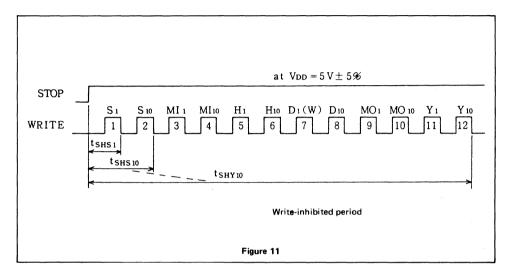
Conditions	Output pin	Reference signal frequency	Pulse width	Output logic
WRITE = L	Do	1024 Hz	488.3 μs	Positive logic
READ = H	D1	1 Hz	122.1 μs	Negative logic
CS1 = CS2 = H	D <sub>2</sub>	1/60 Hz	122.1 μs	Negative logić
ADDRESS = E or F	D <sub>3</sub>	1/3600 Hz	122.1 μs	Negative logic



#### APPLICATION NOTES

#### WRITE and STOP

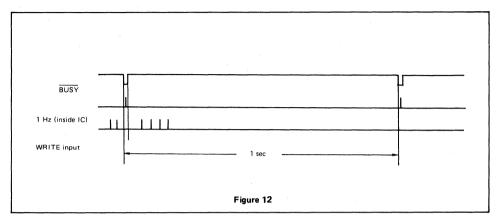
Note that the timing relationships between the STOP and WRITE inputs vary by the related digit when counting is stopped by the STOP input to write data. The time ( $t_{SH}$ ) between the STOP input leading edge and WRITE input trailing edge for each digit is limited to the minimum value. (See Figure 11)



 $t_{SHS1} = 1 \ \mu_s, t_{SHS10} = 2 \ \mu_s, t_{SHM11} = 3 \ \mu_s, t_{SHM10} = 4 \ \mu_s, t_{SHH1} = 5 \ \mu_s$  $t_{SHH10} = 6 \ \mu_s, t_{SHD1} = 7 \ \mu_s, t_{SHW} = 7 \ \mu_s, t_{SHD10} = 8 \ \mu_s, t_{SHM01} = 9 \ \mu_s$  $t_{SHM010} = 10 \ \mu_s, t_{SHY1} = 11 \ \mu_s, t_{SHY10} = 12 \ \mu_s.$ 

#### PERIPHERALS MSM58321RS

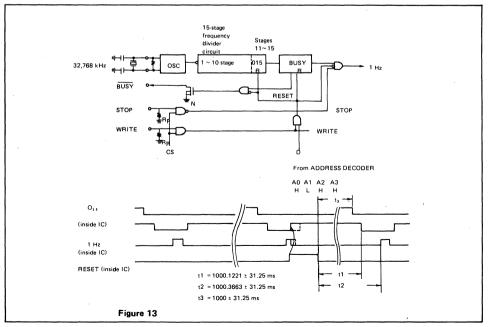
If a count operation is continued by setting the STOP input to the L level, write operation must be performed, in principle, while the BUSY output is at the H level. While the BUSY output is at the L level, count operations are performed by the digit counters and write operation is inhibited, but there is a marginal period of 244  $\mu$ s from the BUSY output trailing edge. If the BUSY output goes to the L level during a write operation, the write operation is stopped temporarily within 244  $\mu$ s and it is restarted when the BUSY output goes to the H level again. Figure 12 shows a time chart of BUSY output, 1 Hz signal inside the IC, and WRITE, input.



#### Frequency divider and BUSY circuit reset

If A0-A3 = H+L+H+H is input to ADDRESS DECODER, the DECODER output (D) goes to the H level. If CS1 = CS2 = H and WRITE = H in this state, the 5 poststages in the 15-stage frequency divider and the BUSY circuit are reset.

In this period, the BUSY output remains at the H level and the 1 Hz signal inside the IC remains at the L level, and counting is stopped. If this reset is inactivated while the oscillator operates, the BUSY output goes to the L level after 1000.1221  $\pm$ 31.25 ms and the 1 Hz signal inside the IC goes to the H level after 1000.3663  $\pm$ 31.25 ms. These times are not the same because the first ten stages in the 15-stage frequency divider are not reset. (See Figure 13)



I)

#### Selection of leap year

This IC is designed to select leap year automatically.

Four types of leap years can be selected by writing a select signal in the D2 and D3 bits of the D10 digit (CODE = L+L+L+H). (See Table 1 for the functions.)

Gregorian calendar, Japanese Showa, or other calendars can be set arbitrarily in the Y1 and Y2 digits of this IC. There is a leap year every four years and the year number varies according to whether the Gregorian calendar or Showa is used. There are four combinations of year numbers and leap years. (See the Table below).

No. 1: Gregorian calendar year. The remainder obtained by dividing the leap year number by 4 is 0.

No. 2: Showa year. The remainder obtained by dividing the leap year number by 4 is 3.

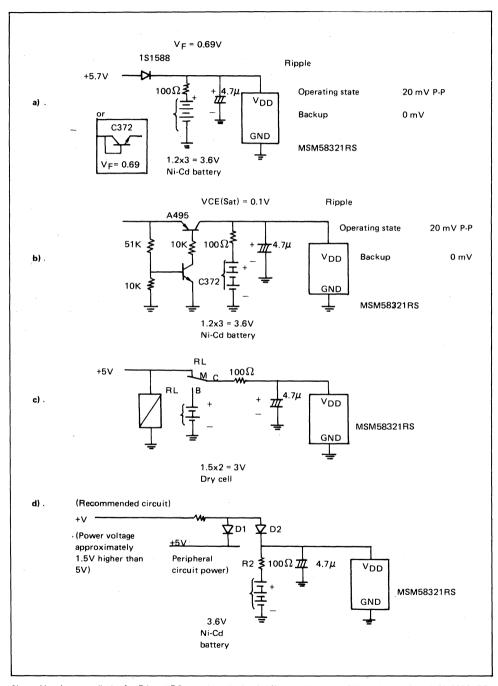
No. 3: The remainder obtained by dividing the leap year number by 4 is 2.

No. 4: The remainder obtained by dividing the leap year number by 4 is 1.

No. 1	Calendar	D10	digit	Remainder obtained by	
NO. 1	Calendar	D2	D3	dividing the leap year number by 4	Leap years (examples)
1	Gregorian	L	L	0	1980, 1984, 1988, 1992, 1996, 2000, 2004
2	Showa	н	L	3	(83) (87) (91) (95) (99) 55, 59, 63, 67, 71, 75, 79
3		L	н	2	82, 86, 90, 94, 98, 102, 106
4		н	н	1	81, 85, 89, 93, 97, 101,105

#### PERIPHERALS MSM58321RS =

#### APPLICATION EXAMPLE - POWER SUPPLY CIRCUIT



Note: Use the same diodes for D1 and D2 to reduce the level difference between +5V and VDD of the MSM58321RS.

# **OKI semiconductor** MSM6242BRS/GS-VK/JS

### DIRECT BUS CONNECTED CMOS REAL TIME CLOCK/CALENDAR

#### **GENERAL DESCRIPTION**

The MSM6242B is a silicon gate CMOS Real Time Clock/Calendar for use in direct bus-connection Microprocessor/Microcomputer applications. An on-chip 32.768KHz crystal oscillator time base is divided to provide addressable 4-bit I/O data for SECONDS, MINUTES, HOURS, DAY OF WEEK, DATE, MONTH and YEAR. Data access is controlled by 4-bit address, chip selects (CS0, CS1), WRITE, READ, and ALE. Control Registers D, E and F provide for 30 SECOND error adjustment, INTERRUPT REQUEST (IRQ FLAG) and BUSY status bits, clock STOP, HOLD, and RESET FLAG bits, 4 selectable INTERRUPTS rates are available at the STD.P (STANDARD) PULSE) output utilizing Control Register inputs T0, T1 and the ITRPT/STND (INTERRUPT/STANDARD). Masking of the interrupt output (STD.P) can be accomplished via the MASK bit. The MSM6242B can operate in a 12/24 hour format and Leap Year timing is automatic.

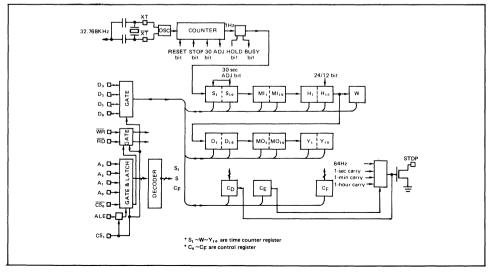
The MSM6242B normally operates from a 5V  $\pm$  10% supply at -30 to 85° C. Battery backup operation down to 2.0V allows continuation of time keeping when main power is off. The MSM6242B is offered in a 18-pin plastic DIP, a 24-pin plastic Small Outline package, and a 18-pin PLCC package.

## **FEATURES**

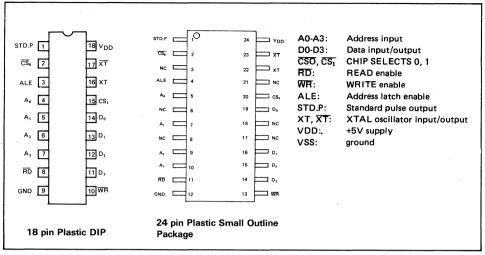
DIRECT MICROPROCESSOR/MICROCONTROLLER BUS CONNECTION

ТІМЕ	MONTH	DATE	YEAR	DAY OF WEEK
23:59:59	12	31	80	7
• 4-bit data bus			• 12/2	24 hour format
<ul> <li>4-bit address bus</li> </ul>			• Aut	o leap year
READ, WRITE, A	LE and CHIP SELE	СТ	• ±30	second error correction
INPUTS			<ul> <li>Sing</li> </ul>	le 5V supply
Status registers – I	RQ and BUSY		• Batt	ery backup down to V - 2.0V
Selectable interrup	t outputs – 1/64 s	econd,	• Low	power dissipation:
1 second, 1 minute	, 1 hour			20 μW max at V = 2V
Interrupt masking				$150 \mu\text{W}$ max at $V_{\text{DD}} = 5V$
32.768KHz crystal	controlled operati	on	• 18 p	oin Plastic DIP (DIP18-P-300)
			• 18 p	oin PLCC (QFJ18-P-R290)
			• 24 r	oin-V Plastic SOP (SOP24-P-430-

#### FUNCTIONAL BLOCK DIAGRAM



#### PIN CONFIGURATION



#### **REGISTER TABLE**

	A	ddres	s Inp	ut	Register		Data			Count value	Description
Address Input	A3	A <sub>2</sub>	$A_1^{\cdot}$	A	Name	D3	D <sub>2</sub>	D1	D₀	value	
0	0	0	0	0	S1	S <sub>8</sub>	S₄	S2	S <sub>1</sub>	0~9	1-second digit register
1	0	0	0	1	S10	*	S40	S20	S10	0~5	10-second digit register
2	0	0	1	0	MI1	mi	mi₄	mi₂	_ mi <sub>1</sub>	0~9	1-minute digit register
3	0	0	1	1	MI10	*	mi₄₀	mi <sub>20</sub>	mi <sub>10</sub>	0~5	10-minute digit register
4	0	1	0	0	H1	h <sub>8</sub>	h₄	h <sub>2</sub>	h <sub>1</sub>	0~9	1-hour digit register
5	0	1	0	1	H <sub>10</sub>	*	PM/ AM	h <sub>20</sub>	h <sub>10</sub>	$0\sim2$ or $0\sim1$	PM/AM, 10-hour digit register
6	0	1	1	0	D1	d <sub>8</sub>	d₄	d₂	dı	0~9	1-day digit register
7	0	1	1 ·	1	D <sub>10</sub>	*	*	d <sub>20</sub>	d <sub>10</sub>	0~3	10-day digit register
8	1	0	0	0	MO1	mo <sub>8</sub>	mo₄	mo₂	moı	0~9	1-month digit register
9	1	0	0	1	MO <sub>10</sub>	*	*	*	MO10	0~1	10-month digit register
A	1	0	1	0	Y <sub>1</sub>	¥8	¥4	Y <sub>2</sub>	Y1	0~9	1-year digit register
В	1	0	1	1	Y <sub>10</sub>	Y8 0	¥40	Y20	¥10	0~9	10-year digit register
с	1	1	0	0	w	*	W4	W <sub>2</sub>	w <sub>1</sub>	0~6	Week register
D	1	1	0	1	CD	30 sec. ADJ	IRQ FLAG	BUSY	HOLD	-	Control Register D
E	1	1	1	0	CE	tı	t <sub>o</sub>	ITRPT /STND	MASK	_	Control Register E
F	1	1	1	-1	CF	TEST	24/12	STOP	REST	-	Control Register F

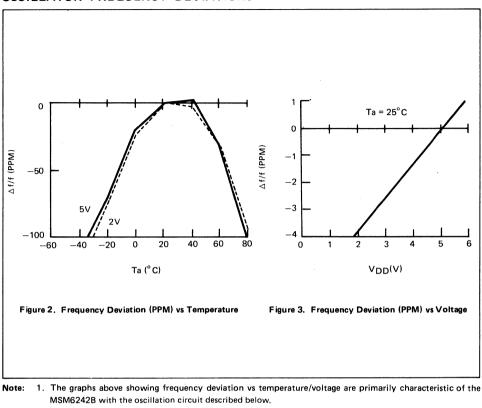
REST = RESET

ITRPT/STND = INTERRUPT/STANDARD

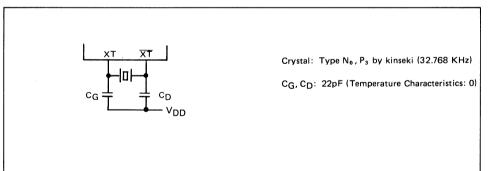
Note 1) - Bit \* does not exist (unrecognized during a write and held at "0" during a read).

Note 2) - Be sure to mask the AM/PM bit when processing 10's of hour's data.

Note 3) - BUSY bit is read only. The IRQ FLAG bit can only be set to a "0". Setting the IRQ FLAG to a "1" is done by hardware.



### OSCILLATOR FREQUENCY DEVIATIONS



## ELECTRICAL CHARACTERISTICS

## ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Rating	Unit
Power Supply Voltage	VDD		-0.3~ 7	v
Input Voltage	V <sub>1</sub>	Ta = 25° C	GND - 0.3~V <sub>DD</sub> + 0.3	v
Output Voltage	· Vo		GND - 0.3~V <sub>DD</sub> + 0.3	v
Storage Temperature	TSTG		-55~ +150	°C

#### **OPERATING CONDITIONS**

Parameter	Symbol	Condition	Rating	Unit
Power Supply Voltage	VDD	_	4~6	
Standby Supply Voltage	VBAK	-	2~6	V
Crystal Frequency	f(XT)	-	32.768	kHz
Operating Temperature	TOP	-	-30~+85	°C

## D.C. CHARACTERISTICS

V<sub>DD</sub> = 5V ± 10%, T<sub>A</sub> = -30 ~ +85

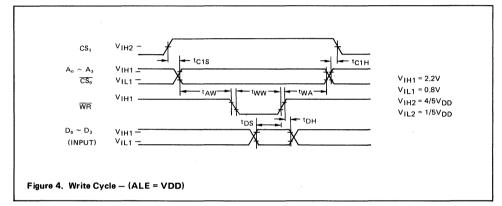
Parameter	Symbol	Conditi	on	Min.	Тур.	Max.	Unit	Applicable Terminal	
"H" Input Voltage	V <sub>IH</sub> 1	-	-		-		v	All input termin-	
"L" Input Voltage	V <sub>IL</sub> 1	-				0.8	v	als except CS <sub>1</sub>	
Input Leak Current	<sup>1</sup> LK <sup>1</sup>	V <sub>I</sub> = V <sub>DD</sub> /0V		_	-	1/_1 μA		Input terminals other than D₀ ~ D₃	
Input Leak Current	ILK2			-	-	10/—10		$D_0 \sim D_3$	
"L" Output Voltage	VOL1	I <sub>OL</sub> = 2.5	imA	-	-	0.4			
"H" Output Voltage	∨он	IOH = -4	IOH = -400μA		-		v	$D_0 \sim D_3$	
"L" Output Voltage	V <sub>OL</sub> 2	IOL = 2.5	imA	<u> </u>	-	0.4	V		
OFF Leak Current	OFFLK	V = V <sub>DD</sub>	/0V	_	-	10	μΑ	STD.P	
Input Capacitance	CI	Input free 1MH:	• •	_	5		PF	All input terminals	
Current Con- sumption	I <sub>DD</sub> 1	f <sub>(xt)</sub> = 32.768	V <sub>DD</sub> = 5V	-	-	30			
Current Con- sumption	IDD2	KHz T <sub>a</sub> =25°C	V <sub>DD</sub> = 2V	_	-	10	μΑ	V <sub>DD</sub>	
"H" Input Voltage	V <sub>IH</sub> 2				_	-			
"L" Input Voltage	V <sub>IL</sub> 2	V <sub>DD</sub> = 2	~5.5V	-	_	1/5VDD	V	CS1	

## SWITCHING CHARACTERISTICS

# (1) WRITE mode (ALE = $V_{DD}$ )

 $(V_{DD} = 5V \pm 10\% = Ta = -30 \sim +85^{\circ}C)$ 

Parameter	Symbol	Condition	Min.	Max.	Unit
CS <sub>1</sub> Set up Time	tC1S		1000	-	
CS <sub>1</sub> Hold Time	tC1H		1000		
Address Stable Before WRITE	tAW	_	20	-	ns
Address Stable After WRITE	twa	_	10	-	
WRITE Pulse Width	tww	_	120		
Data Set up Time	tDS	-	100		
Data Hold Time	<sup>t</sup> DH	_	10	-	



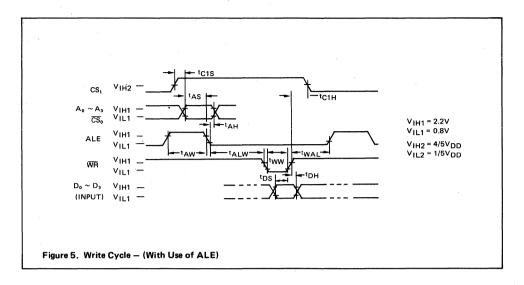
#### (2) WRITE mode (With use of ALE)

 $(V_{DD} = 5 V \pm 10\%, Ta = -3C)$ 

Parameter	Symbol	Condition	Min.	Max.	Unit
CS <sub>1</sub> Set up Time	tCIS		1000	-	
Address Set up Time	tAS		25	-	
Address Hold Time	tAH	_	25	-	
ALE Pulse Width	tAW	_	40	-	
ALE Before WRITE	tALW	_	10	_	ns
WRITE Pulse Width	tww	_	120	_	
ALE After WRITE	tWAL	<u> </u>	20	-	
DATA Set up Time	tDS	_	100	-	
DATA Hold Time	tDH		10	-	
CS <sub>1</sub> Hold Time	tC1H		1000	-	

5

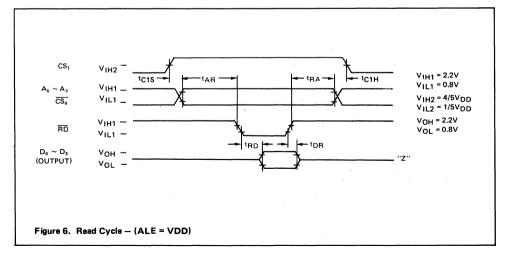
■ PERIPHERALS · MSM6242BRS/GS-VK/JS ■



## (3) READ mode (ALE = $V_{DD}$ )

(V<sub>DD</sub> = 5V ± 10%, Ta = --30 ~ +85°C)

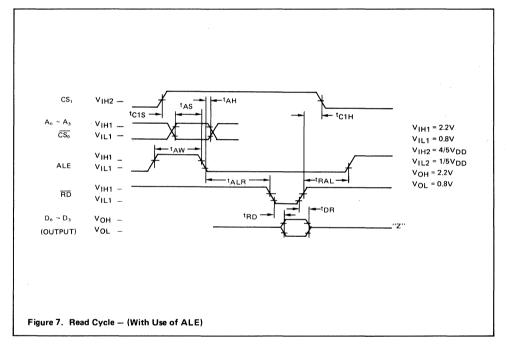
Parameter	Symbol	Condition	Min,	Max.	Unit
CS <sub>1</sub> Set up Time	<sup>t</sup> C1S	-	1000	- ·	
CS <sub>1</sub> Hold Time	<sup>t</sup> C1H	-	1000	-	
Address Stable Before READ	tAR		20	-	ns
Address Stable After READ	<sup>t</sup> RA	_	0	_	
RD to Data	tRD	C <sub>L</sub> = 150pF	-	120	
Data Hold	<sup>t</sup> DR	_	0	-	



#### (4) READ mode (With use of ALE)

 $(V_{DD} = 5V \pm 10\%, Ta = -30 \approx +85^{\circ}C)$ 

Parameter	Symbol	Condition	Min.	Max.	Unit
CS <sub>1</sub> Set up Time	tC1S	-	1000	_	
Address Set up Time	tAS	_	25	-	
Address Hold Time	tAH	_	25	-	
ALE Pulse Width	tAW	_	40	-	
ALE Before READ	tALR		10		
ALE after READ	tRAL		10	-	ns
RD to Data	tRD	CL = 150pF	-	120	
DATA Hold	<sup>t</sup> DR		0	-	
CS <sub>1</sub> Hold Time	<sup>t</sup> C1H		1000	-	



## PIN DESCRIPTION

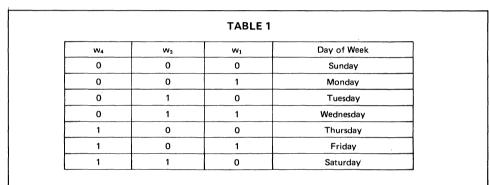
Nor	Pin	No.	Description						
Name	RS	GS	Description						
Do	14	19							
D <sub>1</sub>	13	16	Data Input/Output pins to be directly connected to a microcontroller bus for						
D <sub>2</sub>	12	15	reading and writing of the clock/calendar's registers and control registers. D0 = and D3 = MSB.						
D <sub>3</sub>	11	14							
A	4	5	· · · · · · · · · · · · · · · · · · ·						
A <sub>1</sub>	5	7	Address input pin for use by a microcomputer to select internal clock/calendar's						
A <sub>2</sub>	6	9	registers and control registers for Read/Write operations (See Function Table						
A <sub>3</sub>	7	10	Figure 1). Address input pins A0-A3 are used in combination with ALE for addressing registers.						
ALE	3	4	Address Latch Enable pin. This pin enables writing of address data when $ALE = 1$ and $\overline{CSO} = 0$ ; address data is latched when $ALE = 0$ Microcontroller/Microprocessors having an ALE output should connect to this pin; otherwise it should be connected at $V_{DD}$ .						
WR	10	13	Writing of data is performed by this pin. When $CS_1 = 1$ and $\overline{CS_0} = 0$ , $D_0 \sim D_3$ data is written into the register at the rising edge of WR.						
RD	8	11	Reading of register data is accomplished using this pin. When $CS_1 = 1$ , $\overline{CS_0} = 0$ and $\overline{RD} = 0$ , the data of the register is output to $D_0 \sim D_3$ . If both $\overline{RD}$ and $\overline{WR}$ are set at 0 simaltanuously, $\overline{RD}$ is to be inhibited.						
CS <sub>0</sub>	2	2	Chip Select Pins. These pins enable/disable ALE, $\overline{\text{RD}}$ and $\overline{\text{WR}}$ operation. $\overline{\text{CS}_0}$						
CS <sub>1</sub>	15	20	and ALE work in combination with one another, while $\ensuremath{CS}_1$ work independent						
			with ALE, CS <sub>1</sub> must be connected to power failure detection as shown in Figure 18.						
STD.P	1	1	Output pin of N-CH OPEN DRAIN type. The output data is controlled by the $D_1$ data content of CE register. This pin has a priority to $\overline{CS_0}$ and $CS_1$ . Refer to Figure 9 and FUNCTIONAL DESCRIPTION OF REGISTERS.						
хт	16	22	32.768 kHz crystal is to be connected to these pins.						
XT	17	23	When an external clock of 32.768 kHz is to be used for MSM6242's oscillation						
			source, either CMOS output or pull-up TTL output is to be input from XT, while XT should be left open.						
V <sub>DD</sub>	18	24	Power supply pin. +2 $\sim$ +6V power is to be applied to this pin.						
GND	9	12	Ground pin.						
			$V_{DD}$ $V$						

#### FUNCTIONAL DESCRIPTION OF REGISTERS

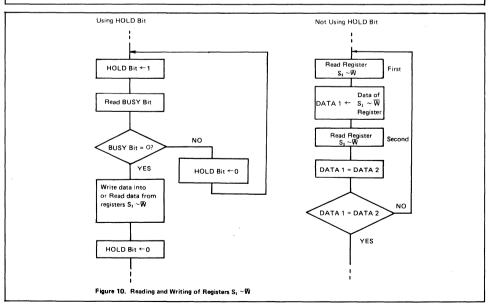
- $= S_1, S_{10}, MI_1, MI_{10}, H_1, H_{10}, D_1, D_{10}, M\overline{O}_1, M\overline{O}_{10}, Y_1, Y_{10}, W$
- a) These are abbreviations for SECOND1, SECOND10, MINUTE1, MINUTE10, HOUR1, HOUR10, DAY1, DAY10, MONTH1, MONTH10, YEAR1, YEAR10, and WEEK. These values are in BCD notation.
- b) All registers are logically positive. For example, (S8, S4, S2, S1) = 1001 which means 9 seconds.
- c) If data is written which is out of the clock register data limits, it can result in erroneous clock data being read back.
- d) PM/AM, h<sub>20</sub>, h<sub>10</sub>

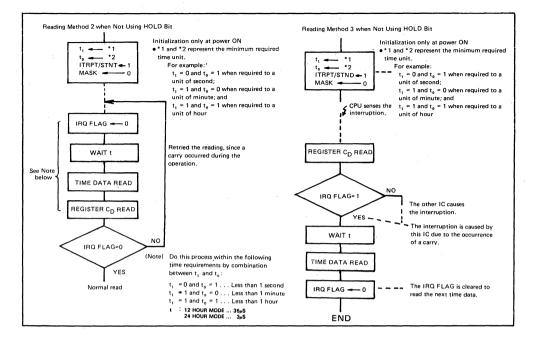
In the mode setting of 24-hour mode, PM/AM bit is ignored, while in the setting of 12-hour mode  $h_{20}$  is to be set. Otherwise it causes a discrepancy. In reading out the PM/AM bit in the 24-hour mode, it is continuously read out as 0. In reading out  $h_{20}$  bit in the 12-hour mode, 0 is written into this bit first, then it is continuously read out as 0 unless 1 is being written into this bit.

e) Registers Y1, Y10, and Leap Year. The MSM6242B is designed exclusively for the Christian Era and is capable of identifying a leap year automatically. The result of the setting of a non-existant day of the month is shown in the following example: If the date February 29 or November 31, 1985, was written, it would be changed automatically to Match 1, or December 1, 1985 at the exact time at which a carry pulse occurs for the day's diait.







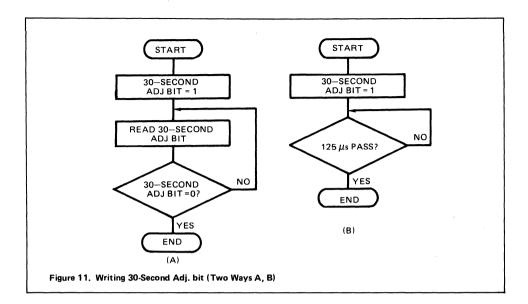


#### CD REGISTER (Control D Register)

- a) HOLD (D0) Setting this bit to a "1" inhibits the 1Hz clock to the S1 counter, at which time the Busy status bit can be read. When Busy = 0, register's S<sub>1</sub> ~ W can be read or written. During this procedure if a carry occurs the S1 counter will be incremented by 1 second after HOLD = 0 (this condition is guaranteed as long as HOLD = 1 does not exceed 1 second in duration). If CS1 = 0 then HOLD = 0 irrespective of any condition.
- b) BUSY (D1) Status bit which shows the interface condition with microcontroller/microprocessors. As for the method of writing into and reading from  $S_1 \sim \overline{W}$  (address  $\phi \sim C$ ), refer to the flow chart described in Figure 10.
- c) IRQ FLAG (D2) This status bit corresponds to the output level of the STD.P output. When STD.P = 0, then IRQ = 1; when STD.P =1, then IRQ = 0. The IRQ FLAG indicates that an interrupt has occurred to the microcomputer if IRQ = 1. When D0 of register C<sub>E</sub> (MASK) = 0, then the STD.P output changes according to the timing set by D3 (t<sub>1</sub>) and D2 (t<sub>0</sub>) of register E. When D1 of register E (ITRPT/STND) = 1 (interrupt mode), the STD.P output remains low until the IRQ FLAG is written to a "0". When IRQ = 1 and timing for a new interrupt occurs, the new interrupt is ignored. When ITRPT/STND = 0 (Standard Pulse Output mode) the STD.P output remains low until either "0" is written to the IRQ FLAG; otherwise, the IRQ FLAG automatically goes to "0" after 7.8125 ms.

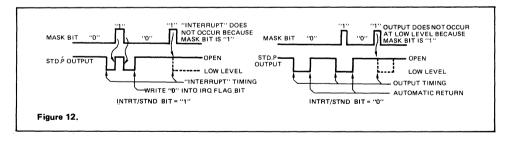
When writing the HOLD or 30 second adjust bits of register D, it is necessary to write the IRQ FLAG bit to a "1".

d) ±30 ADJ (D3) – When 30-second adjustment is necessary, a "1" is written to bit D3 during which time the internal clock registers should not be read from or written to 125µs after bit D3 = 1 it will automatically return to a "0", and at that time reading or writing of registers can occur.



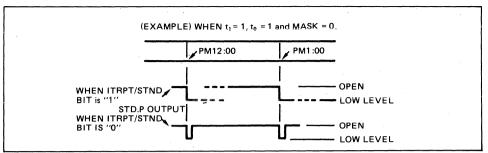
#### CE REGISTER (Control E Register)

- a) MASK (D0) This bit controls the STD.P output. When MASK = 1, then STD.P = 1 (open); when MASK = 0, then STD.P = output mode. The relationship between the MASK bit and STD.P output is shown Figure 12.
- b) INTRPT/STND (D1) The INTRPT/STND input is used to switch the STD.P output between its two modes of operation, interrupt and Standard timing waveforms. When INTRPT/STND 0 a fixed cycle waveform with a low-level pulse width of 7.8125 ms is present at the STD.P output. At this time the MASK bit must equal 0, while the period in either mode is determined by T0(D2) and T1(D3) of Register E.
- c) T0 (D2), T1 (D3) These two bits determine the period of the STD.P output in both Interrupt and Fixed timing waveform modes. The tables below show the timing associated with the T0, T1 inputs as well as their relationship to INTRPT/STND and STD.P.



tı	t <sub>o</sub>	Period	Duty CYCLE of "0" level when ITRPT/STND bit is "0".
0	0	1/64 second	1/2
0	1	1 second	1/128
1	0	1 minute	1/7680
1	1	1 hour	1/460800

TABLE 2

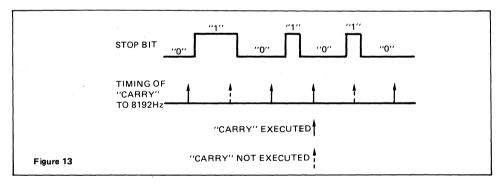


The timing of the STD.P output designated by T1 and T0 occurs the moment that a carry occurs to a clock digit.

- d) The low-level pulse width of the fixed cycle waveform (ITRPT/STND = 0) is 7.8125 ms independent of T0/T1 inputs.
- e) The fixed cycle waveform mode can be used for adjustment of the oscillator frequency time base. (See Figure 14).
- f) During ±30 second adjustment a carry can occur that will cause the STD.P output to go low when T0/T1 = 1,0 or 1,1. However, when T1/T0 = 0, 0 and ITRPT/STND = 0, carry does not occur and the STD.P output resumes normal operation.
- g) The STD.P output is held (frozen) at the point at which STOP = 1 while ITRPT/STND = 0.
- h) No STD.P output change occurs as a result of writing data to registers S1  $\sim$  H1.

#### CF REGISTER (Control F Register)

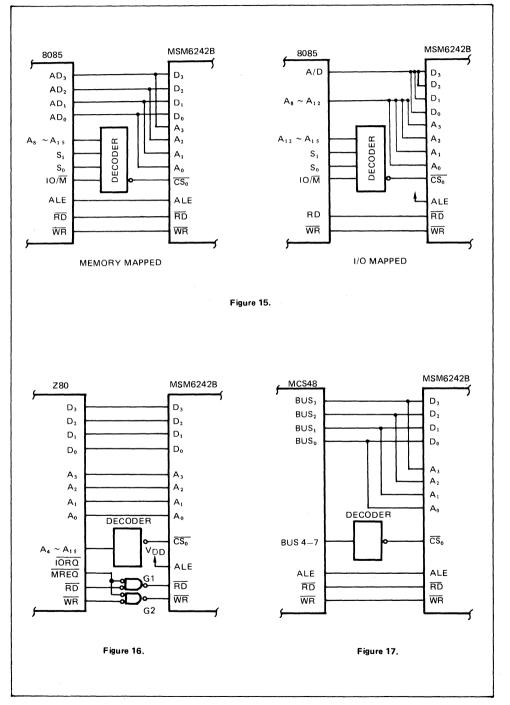
- a) REST (D0) This bit is used to clear the clock's internal divider/counter of less than a second. When "RESET" REST = 1, the counter is Reset for the duration of REST. In order to release this counter from Reset, a "0" must be written to the REST bit. If CSI = 0 then REST = 0 automatically.
- b) STOP (D1) The STOP FLAG Only inhibits carries into the 8192Hz divider stage. There may be up to 122µs delay before timing starts or stops after changing this flag; 1 = STOP/0 = RUN.



c) 24/12 (D2) - This bit is for selection of 24/12 hour time modes. If D2 = 1-24 hour mode is selected and the PM/AM bit is invalid. If D2 = 0-12 hour mode is selected and the PM/AM bit is valid.

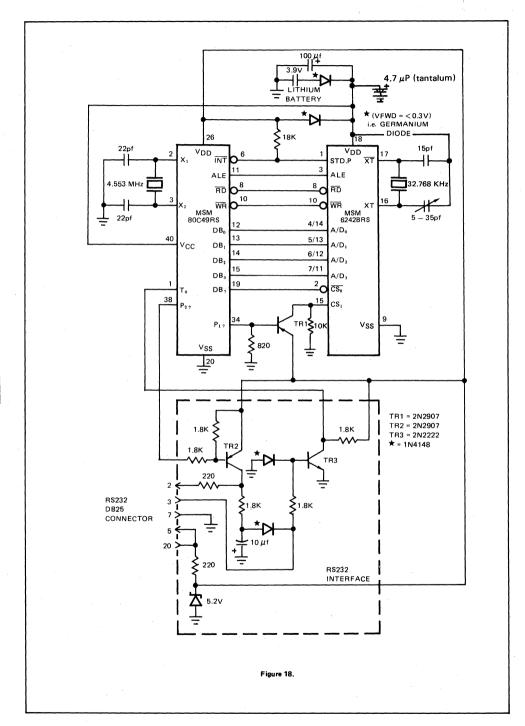
"24 HOUR/ Setting of the 24/12 hour bit is as follows:
12 HOUR" 1) REST bit = 1
24/12 hour bit = 0 or 1
3) REST bit = 0
\* REST bit must = 1 to write to the 24/12 hour bit.
d) TEST (d3) - When the TEST flag is a "1", the input to the SECONDS counter comes from the counter/divider

stage instead of the 15th divider stage. This makes the SECONDS counter count at 5.4163KHz instead of 1Hz. When TEST = 1 (Test Mode) the STOP & REST (Reset) flags do not inhibit internal counting. When Hold = 1 during Test (Test = 1) internal counting is inhibited; however, when the HOLD FLAG goes inactive (Hold = 0) counter updating is not guaranteed.



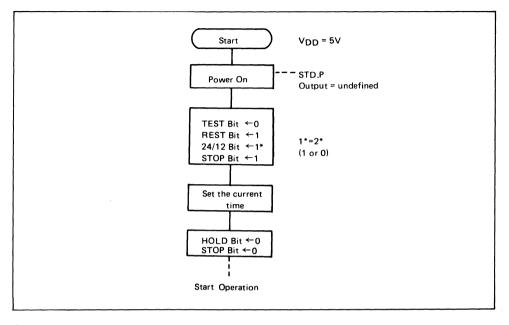
# TYPICAL APPLICATION INTERFACE WITH MSM6242B AND MICROCONTROLLERS

### TYPICAL APPLICATIONS - INTERFACE WITH MSM80C49

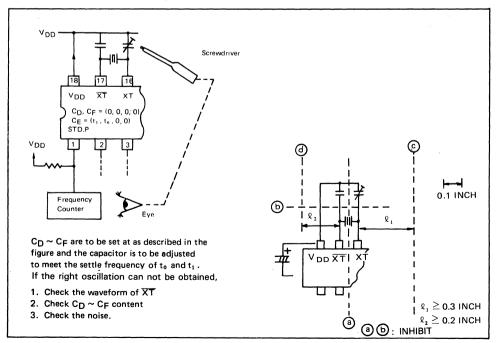


### APPLICATION NOTE

#### 1. Power Supply



## 2. Adjustment of Frequency



#### ■ PERIPHERALS · MSM6242BRS/GS-VK/JS ■

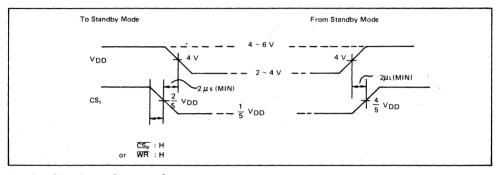
# 3. CH<sub>1</sub> (Chip Select)

VIH and VIL of CH1 has 3 functions.

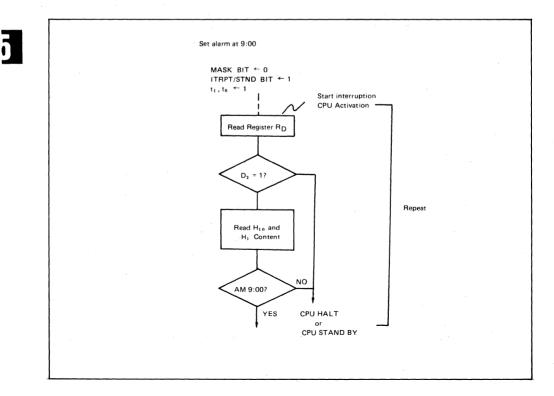
- a) To accomplish the interface with a microcontroller/microprocessor.
- b) To inhibit the control bus, data bus and address bus and to reduce input gate pass current in the stand-by mode.
- c) To protect internal data when the mode is moved to and from standby mode.

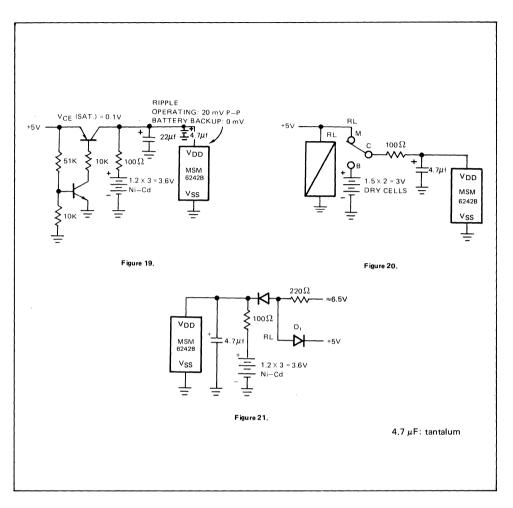
#### To realize the above functions:

- a) More than 4/5 V<sub>DD</sub> should be applied to the MSM6242B for the interface with a microcontroller/microprocessor in 5V operation.
- b) In moving to the standby mode, 1/5 V<sub>DD</sub> should be applied so that all data buses should be disabled. In the standby mode, approx. OV should be applied.
- c). To and from the standby mode, obey following Timing chart.



#### 4. Set STD.P at arlarm mode

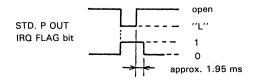




#### TYPICAL APPLICATION - POWER SUPPLY CIRCUIT

#### SUPPLEMENTARY DESCRIPTION

- <sup>O</sup> When "O" is written to the IRQ FLAG bit, the IRQ FLAG bit is cleared. However, if "O" is assigned to the IRQ FLAG bit when written to the other bits, the 30-sec ADJ bit and the HOLD bit, the IRQ FLAG = 1 and was generated before the writing and IRQ FLG = 1 generated in a moment then will be cleared. To avoid this, always set "1" to the IRQ FLAG unless "O" is written to it intentionally. By writing "1" to it, the IRQ FLAG bit does not become "1".
- $^{\circ}$  Since the IRQ FLAG bit becomes ''1'' in some cases when rewriting either of the t<sub>1</sub>, t<sub>0</sub>, or ITRPT/STND bit of register C<sub>E</sub>, be sure to write ''0'' to the IRQ FLAG bit after writing to make valid the IRQ FLAG = 1 to be generated after it.
- The relationship between SDT. P OUT and IRQ FLAG bit is shown below:





### NOTICE

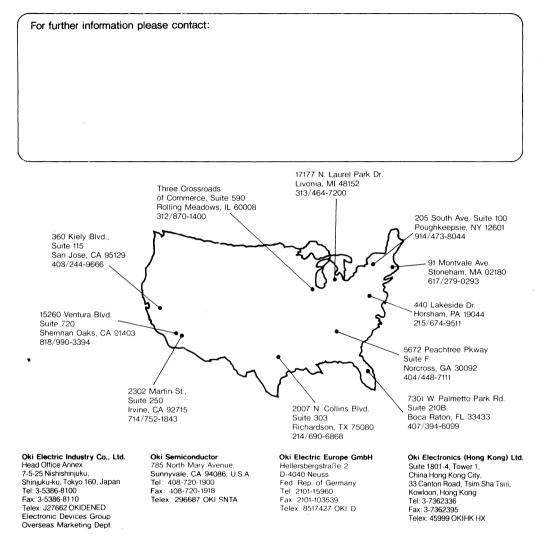
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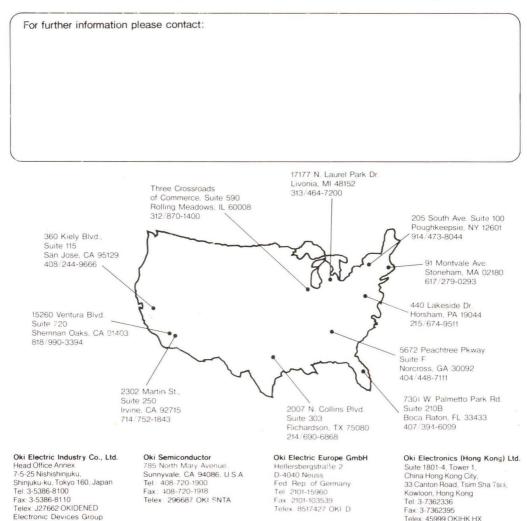
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